

# European Semiconductor Industry Conference

**June 3-5, 1992**

**Jurys Hotel  
Dublin, Ireland**

**Dataquest Europe Limited  
Roussel House, Broadwater Park  
Denham, Uxbridge, Middx UB9 5HP  
England  
0895-835050  
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## 1992 EUROPEAN SEMICONDUCTOR INDUSTRY CONFERENCE

June 3-5, 1992

Jurys Hotel  
Dublin, Ireland

WEDNESDAY, June 3

### DATAQUEST'S FORECASTS AND ANALYSIS

1200 to		
1400	Registration .....	Ball Room Foyer
1400	Welcome and Conference Introduction .....	Ball Room
	Bipin Parmar Group Director European Semiconductors and Conference Chairman Dataquest Europe Limited	
1415	Welcome to Ireland .....	Ball Room
	Desmond O'Malley Minister of Industry and Commerce	
1430	Semiconductor Market Forecast and Market Share Analysis .....	Ball Room
	Jim Eastlake/Mike Glennon/Byron Harding European Semiconductor Group Dataquest Europe Limited	
1515	Results of the 1991 European Procurement Survey .....	Ball Room
	Bipin Parmar Group Director European Semiconductors and Conference Chairman Dataquest Europe Limited	
1530	Coffee Break .....	Ball Room Foyer
1600	Investing in Electronics .....	Ball Room
	Dan Flinter Executive Director Industrial Development Authority of Ireland	
1630	Semiconductor Distribution in the '90s .....	Ball Room
	Gary Kibblewhite Managing Director Europartners Consultancy	
1700	Strategic End-User Trends .....	Ball Room
	Bipin Parmar Group Director European Semiconductors and Conference Chairman Dataquest Europe Limited	
1730	Close	
1930	Cocktails .....	Ball Room Foyer
2000	Dinner .....	Ball Room
	Evening sponsored by the Industrial Development Authority of Ireland	

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**THURSDAY, June 4**

**EMERGING APPLICATIONS AND TECHNOLOGIES**

- 0900 **Introduction** ..... *Ball Room*  
Byron Harding  
Industry Analyst  
European Semiconductor Group  
Dataquest Europe Limited
- 0915 **PC Cards** ..... *Ball Room*  
John Reimer  
Chairman and President  
PC Memory Card International Association
- 0945 **Personal Communications** ..... *Ball Room*  
Dean Evers  
Industry Analyst  
European Telecommunications Group  
Dataquest Europe Limited
- 1005 **Videophones** ..... *Ball Room*  
Jeffrey Goldberg  
Industry Analyst  
European Document Management Group  
Dataquest Europe Limited
- 1030 **Coffee Break** ..... *Ball Room Foyer*

**ENABLING TECHNOLOGIES**

- 1100 **Flash Memory Revolutionizes Portable Computing** ..... *Ball Room*  
Anthony G. Barre  
Director of Strategic Planning  
Memory Components Division  
Intel Corporation
- 1130 **Fuzzy Logic** ..... *Ball Room*  
Professor A. J. van der Wal  
Manager  
European Technical Centre  
Omron Electronics Europe BV
- 1200 **Lunch** ..... *Elm and Oak Room*

**PRODUCT MARKETS ANALYSIS—LOGIC**

- 1345 **Introduction** ..... *Ball Room*  
Mike Glennon  
Senior Industry Analyst  
European Semiconductor Group  
Dataquest Europe Limited
- 1400 **Is Standard Logic Dead?** ..... *Ball Room*  
Glenn Louch  
Director  
Standard Products Division  
National Semiconductor Europe
- 1430 **Future Trends in General Purpose Logic** ..... *Ball Room*  
Peter Dennstedt  
Manager  
European General Purpose Logic  
Texas Instruments Europe
- 1500 **Coffee Break** ..... *Ball Room Foyer*

*(over)*



- 1530 **PANEL SESSION 1: Evolution of Semiconductor Procurement** ..... *Ball Room*  
 Chairman: *Mark Giudici*  
 Director and Principal Analyst  
 Semiconductor Procurement Service  
 Dataquest Incorporated  
*John Hudson*  
 European Regional Supply Base Manager  
 Apple Computer Ltd.  
*Keith Williams*  
 European Managing Director  
 Avnet EMG  
*Earl Kitchen*  
 Purchasing Manager  
 GEC Plessey Telecoms  
*Klaus Wangerin*  
 Director  
 European Procurement  
 Sony Europa GmbH
- 1530 **PANEL SESSION 2: Semiconductor Manufacturing in Europe** ..... *Elm and Oak Room*  
 Chairman: *Bipin Parmar*  
 Group Director European Semiconductors  
 and Conference Chairman  
 Dataquest Europe Limited  
*Thomas E. Hartman*  
 General Manager  
 Ireland Components Manufacturing  
 Intel Corporation  
*George Bennett*  
 Vice President and General Manager  
 MOS Memory and Microprocessor Division (Europe)  
 Motorola Ltd.  
*Larry Murtagh*  
 Managing Director  
 NEC Semiconductors Ireland Ltd.  
*Laurent Bosson*  
 Corporate Vice President  
 Manufacturing  
 SGS-Thomson
- 1700 **Panel Session Adjourns**
- 1730 **Depart for Intel Fab Tour** ..... *Outside Main Entrance*  
 1930 **Return**
- 1945 **Cocktail Reception** ..... *The Chapel, The Royal Hospital, Kilmainham*  
 2030 **Dinner (black tie optional)** ..... *The Great Hall, The Royal Hospital*  
**and European Vendor of the Year Awards**

(over)

**FRIDAY, June 5**

**EXECUTIVE ISSUES: THE SEMICONDUCTOR INDUSTRY**

0900	<b>Introduction</b> .....	<i>Ball Room</i>
	Jim Eastlake Senior Industry Analyst and Manager European Semiconductor Group Dataquest Europe Limited	
0915	<b>Future Trends in LCD Markets and Technologies</b> .....	<i>Ball Room</i>
	Isamu Washizuka Corporate Director Sharp Electronics Europe GmbH	
0945	<b>Achieving Critical Mass Through Industrial Cooperation</b> .....	<i>Ball Room</i>
	Giulio Cesare Grata Director of Microelectronics DGXIII European Commission	
1015	<b>Coffee Break</b> .....	<i>Ball Room Foyer</i>
1045	<b>Introduction</b> .....	<i>Ball Room</i>
	Bipin Parmar Group Director European Semiconductors and Conference Chairman Dataquest Europe Limited	
1050	<b>Horizontal Integration in Europe</b> .....	<i>Ball Room</i>
	Guy Dumas Matra-MHS Honorary President Representative of the Telefunken Electronic Group for European Affairs	
1120	<b>Riding the Second Wave in Europe</b> .....	<i>Ball Room</i>
	Hans Geyer Director and General Manager Intel Europe	
1150	<b>How to Safeguard Europe's High-Technology Future</b> .....	<i>Ball Room</i>
	Heinz W. Hagmeister Chairman and CEO Philips Semiconductors International BV	
1220	<b>Closing Remarks</b> .....	<i>Ball Room</i>
	Bipin Parmar	
1230	<b>Conference Adjourns</b>	
	<b>Lunch</b> .....	<i>Elm and Oak Room</i>

# **EUROPEAN SEMICONDUCTOR INDUSTRY CONFERENCE 1992 EVALUATION QUESTIONNAIRE**

Dublin, Ireland  
June 3-5, 1992

Thank you for attending our European Semiconductor Industry Conference. Would you please assist us in planning our next conference by completing and returning this questionnaire.

1. Please rate each presentation on a scale of 1 to 10 (where 10 is highest in terms of your approval):

	<u>CONTENT</u> (1 to 10)	<u>DELIVERY</u> (1 to 10)	<u>COMMENTS</u> (Use reverse side if necessary)
<b>European Semiconductor Market Overview:</b>			
Eastlake	_____	_____	_____
Glennon	_____	_____	_____
Harding	_____	_____	_____
Flinter, Investing in Electronics	_____	_____	_____
Kibblewhite, Semiconductor Distribution in the '90s	_____	_____	_____
Parmar, Strategic End-User Trends	_____	_____	_____
Reimer, PC Cards	_____	_____	_____
Eyers, Personal Communications	_____	_____	_____
Goldberg, Videophones	_____	_____	_____
Barre, Flash Memory Revolutionizes Portable	_____	_____	_____
van der Wal, Fuzzy Logic	_____	_____	_____
Louch, Is Standard Logic Dead?	_____	_____	_____
Dennstedt, Future Trends in General Purpose Logic	_____	_____	_____
<b>PANEL SESSION 1:</b>			
Evolution of Semiconductor Procurement			
Giudici	_____	_____	_____
Hudson	_____	_____	_____
Williams	_____	_____	_____
Kitchen	_____	_____	_____
Wangerin	_____	_____	_____
<b>PANEL SESSION 2:</b>			
Semiconductor Manufacturing in Europe			
Hartman	_____	_____	_____
Bennett	_____	_____	_____
Murtagh	_____	_____	_____
Bosson	_____	_____	_____

(over)

	<u>CONTENT</u> (1 to 10)	<u>DELIVERY</u> (1 to 10)	<u>COMMENTS</u> (Use reverse side if necessary)
Washizuka, Future Trends in LCD Markets	_____	_____	_____
Grata, Achieving Critical Mass	_____	_____	_____
Dumas, Horizontal Integration in Europe	_____	_____	_____
Geyer, Riding the Second Wave in Europe	_____	_____	_____
Hagmeister, How to Safeguard Europe's	_____	_____	_____

2. Overall meeting rating (1 to 10) \_\_\_\_\_

3. What did you like most about the conference? \_\_\_\_\_  
\_\_\_\_\_

4. In what areas do you think our conference could be improved? \_\_\_\_\_  
\_\_\_\_\_  
\_\_\_\_\_

5. At our next industry conference, would you prefer more \_\_\_\_\_ or fewer \_\_\_\_\_ Dataquest speakers?

6. Suggestions for the theme for next year's European Semiconductor Industry Conference: \_\_\_\_\_  
\_\_\_\_\_

7. Do you prefer the current three-day conference format? Yes \_\_\_\_\_ No \_\_\_\_\_  
Comments: \_\_\_\_\_

8. Would you prefer a full two-day conference (example: ALL day Thursday and Friday) versus a two-day conference agenda spread over three days? Yes \_\_\_\_\_ No \_\_\_\_\_

9. How would you rate the conference facilities (1 to 10)?  
Location \_\_\_\_\_ Guest Rooms \_\_\_\_\_ Meals \_\_\_\_\_ Meeting Rooms \_\_\_\_\_

10. How would you rate the Dataquest registration staff (1 to 10)?  
Courtesy \_\_\_\_\_ Efficiency \_\_\_\_\_

11. Which of the following locations would you prefer for the 1993 Dataquest European Semiconductor Industry Conference?  
Düsseldorf \_\_\_\_\_ Frankfurt \_\_\_\_\_ Other (Please indicate) \_\_\_\_\_

12. Comments: \_\_\_\_\_  
\_\_\_\_\_  
\_\_\_\_\_  
\_\_\_\_\_

Name and Company (optional) \_\_\_\_\_

Please hand this form to a member of Dataquest's staff.

## FOR SPEAKER QUESTIONS

Name of speaker: \_\_\_\_\_

Title of speech: \_\_\_\_\_

If you have any questions, please write them down in the space provided below. A Dataquest representative will collect them at the end of the presentation.

No. 1: \_\_\_\_\_

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No. 2 \_\_\_\_\_

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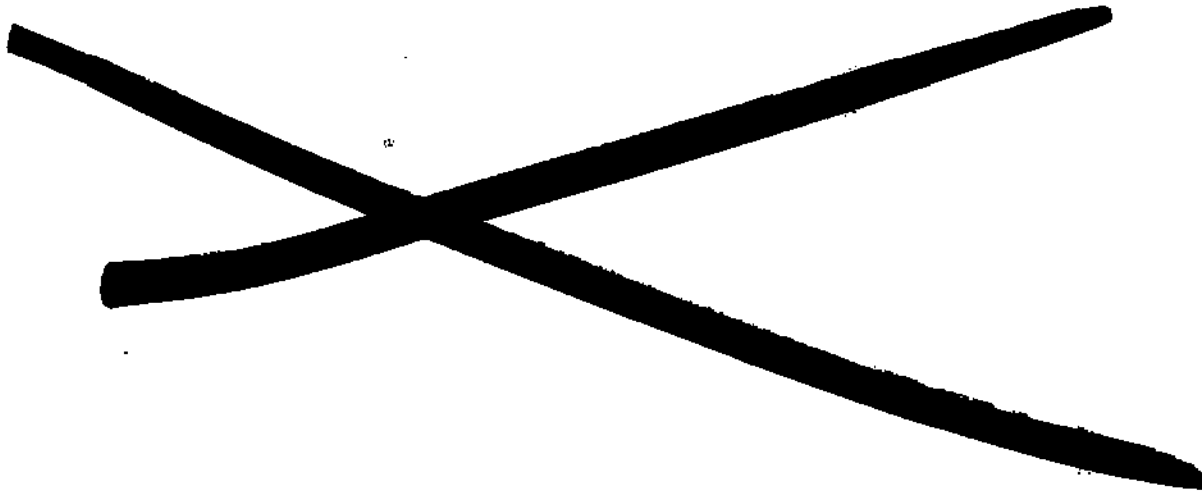
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## EUROPEAN SEMICONDUCTOR INDUSTRY CONFERENCE

June 3-5, 1992

Jurys Hotel, Dublin, Ireland

### List of Attendees by Name

Raymond Ambrose	SGS-Thomson Microelectronics Ltd
P. Anders	Samsung Semiconductor Europe GmbH
Gian Carlo Andra	Ing. C. Olivetti & C. SpA
Dave Angel	Information Storage Devices
Willi Bacher	First Components GmbH
Paul Andrew Baker	Hyundai Semiconductor
Giovanni Barbati	Finmeccanica
Anthony G. Barre	Intel Corporation
Daniel J. Barrett	Cypress Semiconductor
Glenn Bartsch	Eastman Kodak Company
George Bennett	Motorola Ltd
Gunter A. Berner	Sharp Electronics (Europe) GmbH
John Berry	Toshiba Electronics (UK) Ltd
Gerhard Beuttler	IBM
Alfred Borsig	Toshiba Electronics Europe GmbH
Laurent Bosson	SGS-Thomson Microelectronics
Bill Brandon	IDA Ireland
John Brothers	GEC Plessey Semiconductors
Robert Brown	Sony (UK) Ltd
David Brown	LTX (Europe) Ltd
Abhi Budhwar	Canon Europa NV
Sergio Castaldi	Hitachi Europe GmbH
Keith Chapple	Intel Corporation (UK) Limited
Jacques Cheviron	Alcatel Business Systems
Robert Dailey	Samsung Semiconductor Europe GmbH
Hans De Haan	VLSI Technology GmbH

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Jurgen Dietz  
Walter Dittrich  
Guy Dumas  
Doug Dunn  
Jim Eastlake  
John Evans  
Dean Eyers  
Dave Farrar  
Frederic Fassot  
Peter W. Frey  
Robert Funcke  
Masao Furuya  
Marie Noelle Gachet  
John Gearing  
Hans Geyer  
Jurgen Giessmann  
Mark Giudici  
Raymond Gleason  
Mike Glennon  
Jeffrey Goldberg  
Heinz W. Hagmeister  
John Hannah  
Paul Hanron  
Masatoshi Harada  
Byron Harding  
Tom Hartman  
Tom Hartmann  
Ruell Harwig  
Brian Heap  
Heinz Heumann  
Sugai Hidesuke  
O. Hintringer  
Heiner Hirsch

Advantest (Europe) GmbH  
IBM Germany  
Matra Harris Semiconductor  
GEC Plessey Semiconductors  
Dataquest Europe Ltd  
Johnson Matthey  
Dataquest Europe Ltd  
Hoya Europe BV  
Electronique International Hebdo  
Telefunken Electronic GmbH  
Meissner & Wurst GmbH  
Mitsubishi Electric Europe  
Ministère de l'Industrie  
Sony (UK) Ltd  
Intel GmbH  
Meissner & Wurst GmbH  
Dataquest Incorporated  
GEC Plessey Semiconductors  
Dataquest Europe Ltd  
  
Philips Semiconductors International BV  
Hitachi Europe  
IDA Ireland  
Nissin Electric Co. Ltd  
Dataquest Europ Ltd  
Intel  
Intel GmbH  
Siemens AG  
Kyocera Fineceramics Ltd  
NEC  
Mitsubishi Electric Europe GmbH  
Siemens AG, Semiconductor Group  
Texas Instruments



Steven T. W. Huang

John Hudson

H. Izumi

James Jarrett

Pat Jefferson

Kenneth Jones

Y. Kato

Earl Kitchen

Werner Koepf

Takashi Komiya

Marco Landi

Thomas Lane

Robert Lennox

S. Loe

Glenn Louch

Dave Manners

Cliff Marks

Alfred Marmann

Hikotaro Masunaga

Noel Matthews

Alan Matthews

C. McAneny

Martin Mitchell

Larry Murtagh

Dr. Y. Nakajima

Brian Nash

Robert Nikolai

Jean-Jacques Novelli

Caitriona O'Kennedy

Robin Paling

Bipin Parmar

Sylvie Pheulpin

Nick Phillon

UMC (Europe) BV

Apple Computer Ltd

Toshiba Electronics (UK) Ltd

Intel

Mitsubishi Electric UK

Sony Semiconductor Europe

Sony Semiconductor Europe Ltd

GPT Telecommunications Systems Group

European Silicon Structures GmbH

Daiwa Institute of Research

Texas Instruments

NEC Electronics

Fagor Electronica

Electronic World News

National Semiconductor (UK) Ltd

Electronics Weekly

National Semiconductor (UK) Ltd

Harris Semiconductor - Europe

Fujitsu Mikroelektronik GmbH

Meissner & Wurst ATS Ltd

Xilinx Ltd

Toshiba Electronics (UK) Ltd

International Herald Tribune

NEC Semiconductors Ireland Ltd

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Goldstar Electron

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IDA Ireland

Toshiba Electronics Europe GmbH

Dataquest Europe Ltd

Schlumberger ATE Division

LSI Logic GmbH

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Ernest Pusey  
Barbara Rash  
John Reimer  
Niall M. Reynolds  
Andy Rosenbaum  
Dicken Ross  
Robert Samsinger  
A. Sasaki  
Dan Sattler  
Arthur Sidorsky  
Mike Solomon  
Jonghoon Song  
William J. Stypa  
Kevin Taylor  
Pieter Te Booy  
Ted Terushima  
Waldo Thorn  
Matthew Trowbridge  
Gabriel van Cauwenberge  
Arien J. van der Wal  
Eduard Voorn  
Barry Waite  
Adrian Walker  
John Walsh  
Klaus Wangerin  
I. Washizuka  
Ian White  
Keith Williams  
David Wollen  
Klaus Wustrack  
Ed Wynne  
Gunter Ziegenbalg

GEC Plessey Semiconductors  
Intel GmbH  
SunDisk  
Intel Ireland Ltd  
Electronics Magazine  
European Semiconductor  
IBM - Europe  
Sharp Electronics (Europe) GmbH  
Eastman Kodak Company  
Standard Microsystems Corporation  
BOC Ltd  
Goldstar Electron  
Standard Microsystems Corporation  
Digital Equipment Co. Limited  
Philips Semiconductors  
Hoya Europe BV  
SGS-Thomson Microelectronics Ltd  
Hitachi Europe  
Alcatel Bell Telephone  
Omron  
Automatisering Gids  
Motorola Inc.  
Hitachi Europe  
IDA Ireland  
Sony Europa GmbH  
Sharp  
Intel Ireland Ltd  
Avnet Access Ltd  
Dialog Semiconductor Ltd  
Intel GmbH  
Eastman Kodak Company  
ZMD GmbH

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## List of Attendees by Company

Advantest (Europe) GmbH	Jurgen Dietz
Alcatel Bell Telephone	Gabriel van Cauwenberge
Alcatel Business Systems	Jacques Cheviron
Apple Computer Ltd	John Hudson
Automatisering Gids	Eduard Voorn
Avnet Access Ltd	Keith Williams
BOC Ltd	Mike Solomon
Canon Europa NV	Abhi Budhwar
Cypress Semiconductor	Daniel J. Barrett
Daiwa Institute of Research	Takashi Komiya
Dataquest Europe Ltd	Dean Evers
	Jeffrey Goldberg
	Jim Eastlake
	Mike Glennon
	Byron Harding
	Bipin Parmar
Dataquest Incorporated	Mark Giudici
Dialog Semiconductor Ltd	David Wollen
Digital Equipment Co. Limited	Kevin Taylor
Eastman Kodak Company	Glenn Bartzsch
	Dan Sattler
	Ed Wynne
Electronic World News	S. Loe
Electronics Magazine	Andy Rosenbaum
Electronics Weekly	Dave Manners
Electronique International Hebdo	Frederic Fassot

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European Semiconductor  
European Silicon Structures GmbH  
Fagor Electronica  
Finmeccanica  
First Components GmbH  
Fujitsu Mikroelektronik GmbH  
GEC Plessey Semiconductors

Goldstar Electron

GPT Telecommunications Systems Group  
Harris Semiconductor - Europe  
Hitachi Europe

Hitachi Europe GmbH  
Hoya Europe BV

Hyundai Semiconductor  
IBM  
IBM - Europe  
IBM Germany  
IDA Ireland

Information Storage Devices  
Ing. C. Olivetti & C. SpA  
Intel

Intel Corporation

Dicken Ross  
Werner Koepf  
Robert Lennox  
Giovanni Barbati  
Willi Bacher  
Hikotaro Masunaga  
John Brothers  
Doug Dunn  
Raymond Gleason  
Ernest Pusey  
Robert Nikolai  
Jonghoon Song  
Earl Kitchen  
Alfred Marmann  
John Hannah  
Matthew Trowbridge  
Adrian Walker  
Sergio Castaldi  
Dave Farrar  
Ted Terushima  
Paul Andrew Baker  
Gerhard Beuttler  
Robert Samsinger  
Walter Dittrich  
Bill Brandon  
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Caitriona O'Kennedy  
John Walsh  
Dave Angel  
Gian Carlo Andra  
Tom Hartman  
James Jarrett  
Anthony G. Barre

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Intel Corporation (UK) Limited  
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Intel Ireland Ltd

International Herald Tribune  
Johnson Matthey

Kyocera Fineceramics Ltd  
LSI Logic GmbH  
LTX (Europe) Ltd  
Matra Harris Semiconductor  
Meissner & Wurst ATS Ltd  
Meissner & Wurst GmbH

Ministère de l'Industrie  
Mitsubishi Electric Europe  
Mitsubishi Electric Europe GmbH  
Mitsubishi Electric UK  
Motorola Inc.  
Motorola Ltd  
National Semiconductor (UK) Ltd

NEC  
NEC Electronics  
NEC Semiconductors Ireland Ltd  
Nissin Electric Co. Ltd  
Omron  
Philips Semiconductors  
Philips Semiconductors International BV

Keith Chapple  
Hans Geyer  
Tom Hartmann  
Barbara Rash  
Klaus Wustrack  
Niall M. Reynolds  
Ian White  
Martin Mitchell  
John Evans  
Brian Nash  
Brian Heap  
Nick Phillon  
David Brown  
Guy Dumas  
Noel Matthews  
Robert Funcke  
Jurgen Giessmann  
Marie Noelle Gachet  
Masao Furuya  
Sugai Hidesuke  
Pat Jefferson  
Barry Waite  
George Bennett  
Glenn Louch  
Cliff Marks  
Heinz Heumann  
Thomas Lane  
Larry Murtagh  
Masatoshi Harada  
Arien J. van der Wal  
Pieter Te Booy  
Heinz W. Hagmeister

Samsung Semiconductor Europe GmbH

Schlumberger ATE Division

Serete Industries

SGS-Thomson Microelectronics Ltd

SGS-Thomson Microelectronics

Sharp

Sharp Electronics (Europe) GmbH

Sharp Laboratories of Europe Ltd

Siemens AG

Siemens AG, Semiconductor Group

Sony (UK) Ltd

Sony Europa GmbH

Sony Semiconductor Europe

Sony Semiconductor Europe Ltd

Standard Microsystems Corporation

SunDisk

Telefunken Electronic GmbH

Texas Instruments

Toshiba Electronics (UK) Ltd

Toshiba Electronics Europe GmbH

UMC (Europe) BV

VLSI Technology GmbH

Xilinx Ltd

ZMD GmbH

P. Anders

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Sylvie Pheulpin

Jean-Jacques Novelli

Raymond Ambrose

Waldo Thorn

Laurent Bosson

I. Washizuka

Gunter A. Berner

A. Sasaki

Dr. Y. Nakajima

Ruell Harwig

O. Hintringer

Robert Brown

John Gearing

Klaus Wangerin

Kenneth Jones

Y. Kato

Arthur Sidorsky

William J. Stypa

John Reimer

Peter W. Frey

Heiner Hirsch

Marco Landi

John Berry

H. Izumi

C. McAneny

Alfred Borsig

Robin Paling

Steven T. W. Huang

Hans De Haan

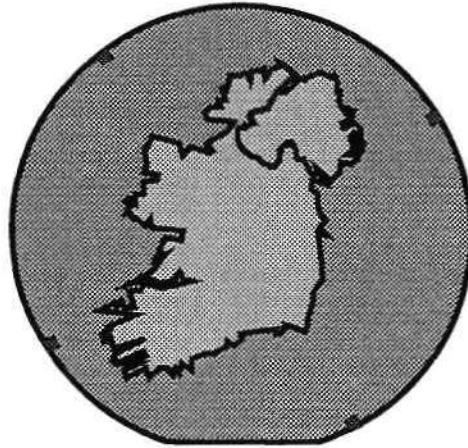
Alan Matthews

Gunter Ziegenbalg

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## **WELCOME AND CONFERENCE INTRODUCTION**

***Bipin Parmar***

Group Director European Semiconductors  
and Conference Chairman  
Dataquest Europe Limited

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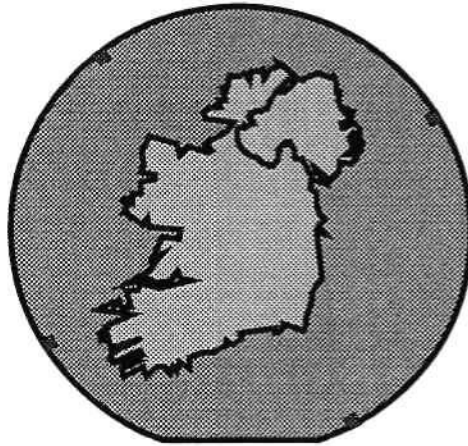
## WELCOME AND CONFERENCE INTRODUCTION



Bipin Parmar  
Group Director European Semiconductors  
and Conference Chairman  
Dataquest Europe Limited

Mr. Parmar is Group Director European Semiconductors (ESG) for Dataquest, based in Denham, England. Mr. Parmar has additional responsibility as Director of European Sales, Conferences and Dataquest's German operations. He has more than 15 years of experience in the electronics industry. Prior to joining Dataquest, he was European Product Marketing Manager for ASICs at Fairchild Europe Semiconductor. Earlier, he was Strategic Product Planning Manager at Fairchild, responsible for launching the FACT advanced CMOS logic family and silicon system compiler technology. His previous marketing management experience was gained at General Instrument and General Electric Company plc in microcomputer and semi-custom/custom logic. Mr. Parmar also worked as Communications Systems Engineer at Marconi based in the Middle East and Far East. He graduated in Electronics and Communications Engineering from the University of Essex, England, and has attended various Business Administration courses at the Management Centre Europe in Brussels.

Dataquest Europe Limited  
**EUROPEAN SEMICONDUCTOR INDUSTRY CONFERENCE**  
June 3-5, 1992  
Dublin, Ireland

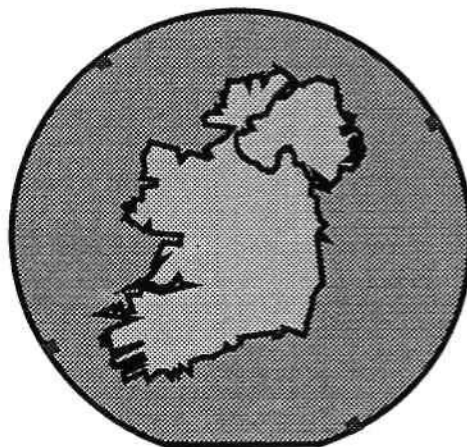


## WELCOME TO IRELAND

***Desmond O'Malley***  
Minister of Industry and Commerce

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## **SEMICONDUCTOR MARKET FORECAST AND MARKET SHARE ANALYSIS**

*Jim Eastlake  
Mike Glennon  
Byron Harding*

European Semiconductor Group  
Dataquest Europe Limited

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## SEMICONDUCTOR MARKET FORECAST AND MARKET SHARE ANALYSIS



Jim Eastlake  
Senior Industry Analyst and Manager  
European Semiconductor Group  
Dataquest Europe Limited

Mr. Eastlake is a Senior Industry Analyst and Manager of Dataquest's European Semiconductor Group (ESG) based in Denham, England. He has 12 years of experience in the electronics industry. Prior to joining Dataquest, Mr. Eastlake was with Texas Instruments' (TI) Northern European Semiconductor Division. In his most recent position at TI, he ran the European distribution program for the Linear Functions Business Group. Earlier, he managed TI's advanced bipolar logic families and was responsible for launching TI's programmable logic families and bit-slice functions in Northern Europe. He also held a product marketing position for 8- and 16-bit microprocessors and peripherals. Mr. Eastlake graduated from the University of Newcastle upon Tyne, with an honours degree in Physics.

Dataquest Europe Limited  
**EUROPEAN SEMICONDUCTOR INDUSTRY CONFERENCE**  
June 3-5, 1992  
Dublin, Ireland

## SEMICONDUCTOR MARKET FORECAST AND MARKET SHARE ANALYSIS



Michael Glennon  
Senior Industry Analyst  
European Semiconductor Group  
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Mr. Glennon is a Senior Industry Analyst for Dataquest's European Semiconductor Group (ESG) based in Denham, England. He has 12 years of design and marketing experience in the electronics industry. Prior to joining Dataquest, Mr. Glennon was with European Silicon Structures where he was North Europe Marketing Manager, with marketing responsibility for ASICs and ASIC design software. Before this he was with Fairchild Europe Semiconductor, responsible for the marketing and technical support for the company's advanced silicon compiler VLSI design tool. Mr. Glennon's design experience was gained while developing Fairchild's advanced CMOS logic family and also in the development of the company's VLSI system design tool. Before this he worked as an IC designer at Marconi Electronic Devices, developing design techniques, and as a member of the CODEC design team. Mr. Glennon graduated from the University of London with an honours degree in Electronic Engineering.

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## SEMICONDUCTOR MARKET FORECAST AND MARKET SHARE ANALYSIS

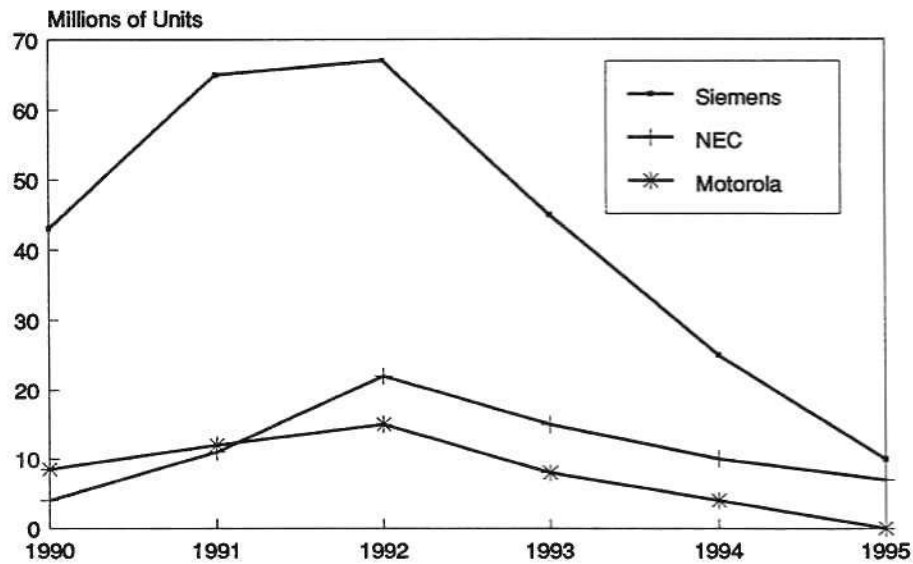


Byron Harding  
Industry Analyst  
European Semiconductor Group  
Dataquest Europe Limited

Mr. Harding is an Industry Analyst for Dataquest's European Semiconductor Group (ESG), based in Denham, England. He is responsible for the management of the European semiconductor market share database which tracks vendor rankings. He also manages all Dataquest's European memory market research, coordinating with analysts in Tokyo, Seoul and San Jose. In addition, Mr. Harding tracks European semiconductor booking prices and lead-times for end-user clients of standard services and consulting programs. He also keeps up to date with EC tariff and trade issues. Prior to joining Dataquest, Mr. Harding worked at the Royal Observatory, Edinburgh and more recently, worked in computer marketing. Mr. Harding received a B.Sc. degree in Mathematics and Physics from the University of Newcastle upon Tyne, England.

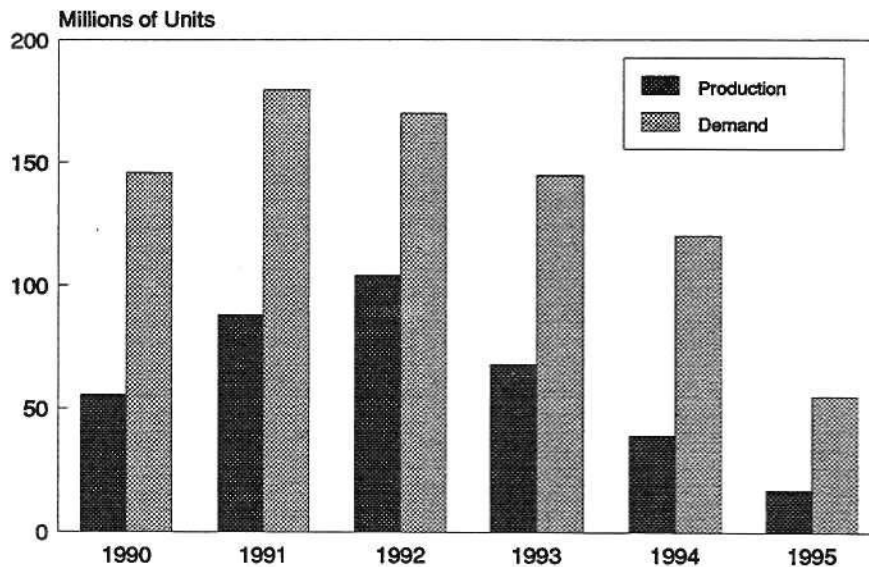
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## 1M DRAM PRODUCTION IN EUROPE (PROJECTION)



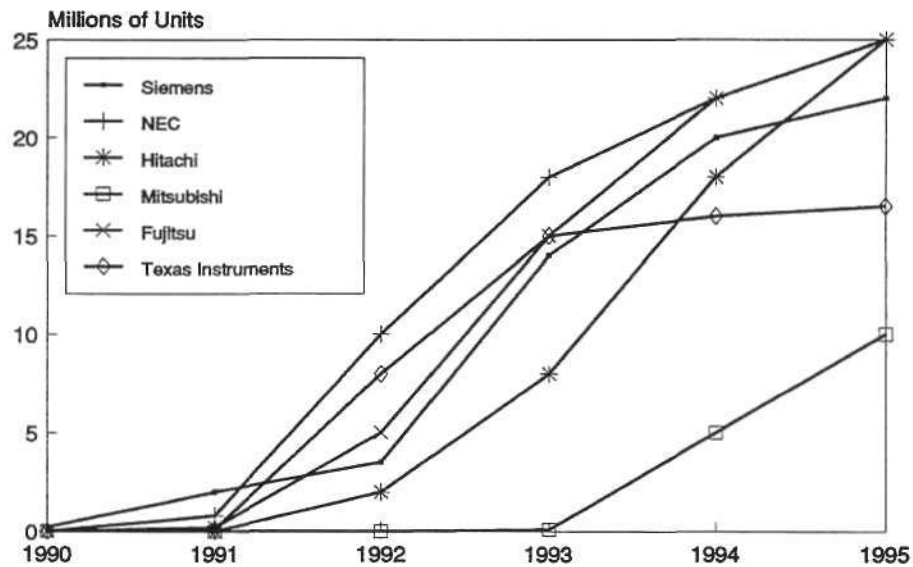
Source: Dataquest

## 1M DRAM PRODUCTION vs DEMAND IN EUROPE (PROJECTION)



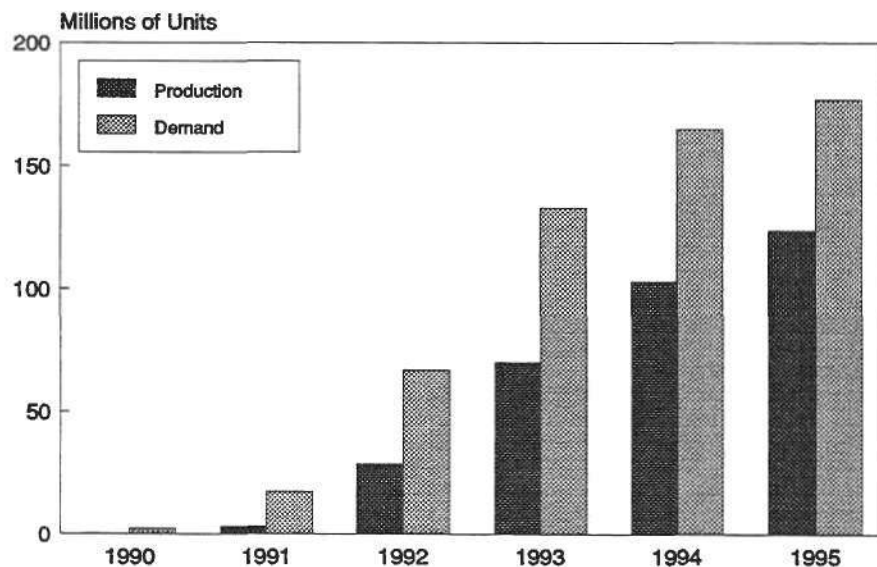
Source: Dataquest

## 4M DRAM PRODUCTION IN EUROPE (PROJECTION)



Source: Dataquest

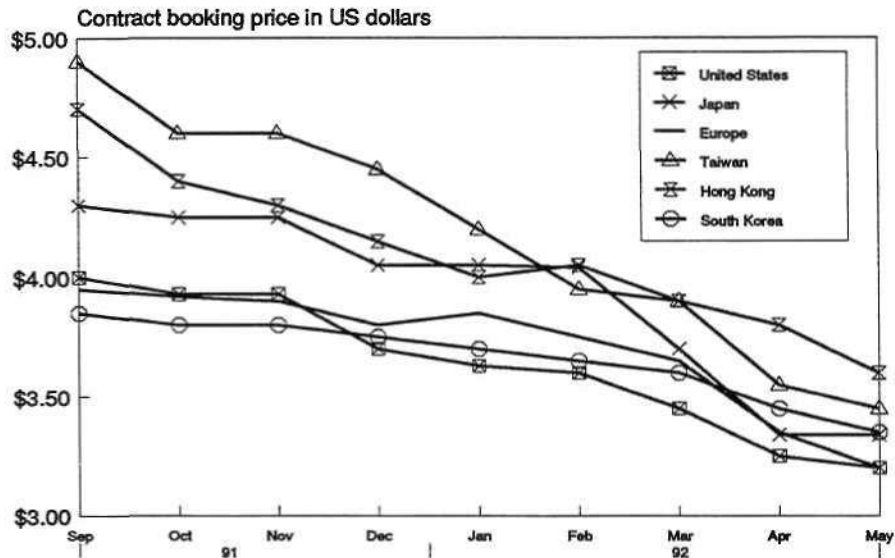
## 4M DRAM PRODUCTION vs DEMAND IN EUROPE (PROJECTION)



Source: Dataquest

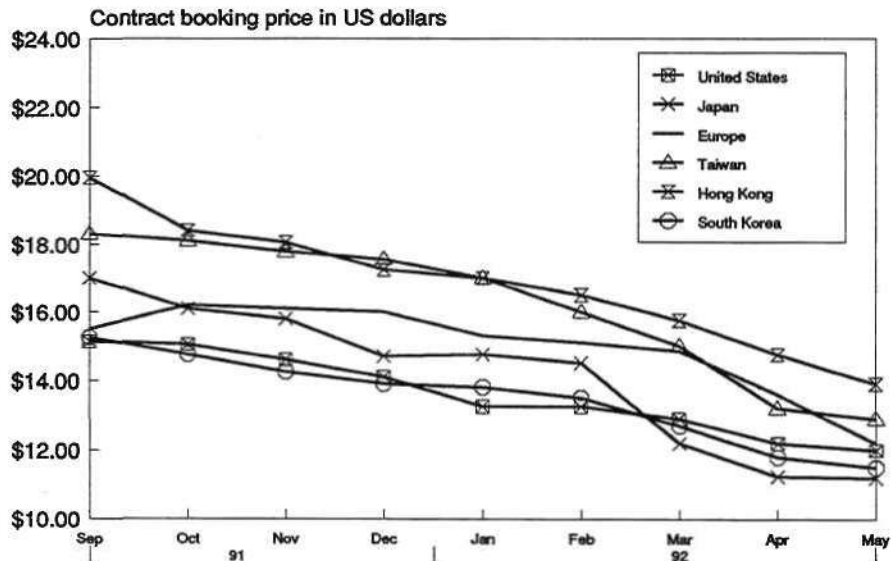


## WORLDWIDE MARKET PRICES 1M (256Kx4) DRAM



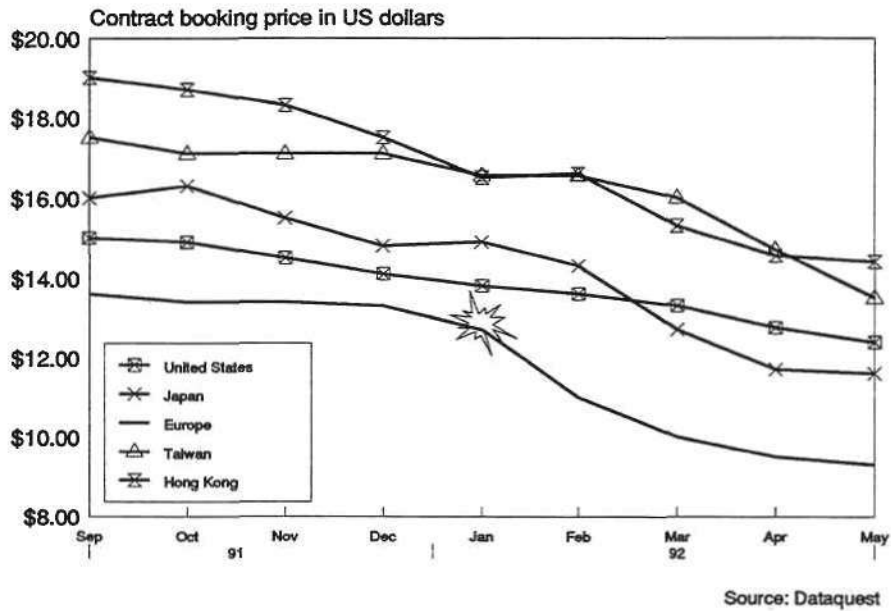
Source: Dataquest

## WORLDWIDE MARKET PRICES 4M (4Mx1) DRAM

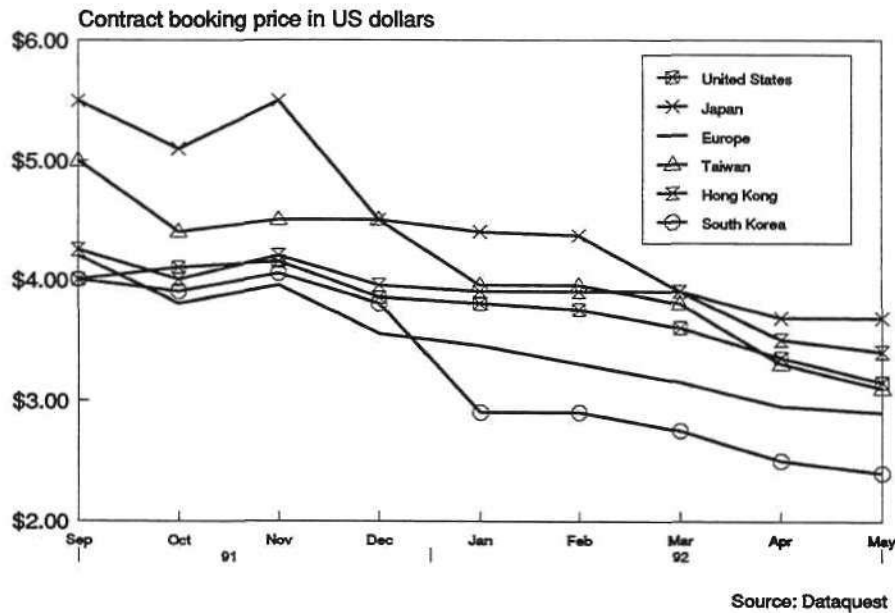


Source: Dataquest

## WORLDWIDE MARKET PRICES SLOW 1M (128Kx8) SRAM



## WORLDWIDE MARKET PRICES 1M (128Kx8) EPROM



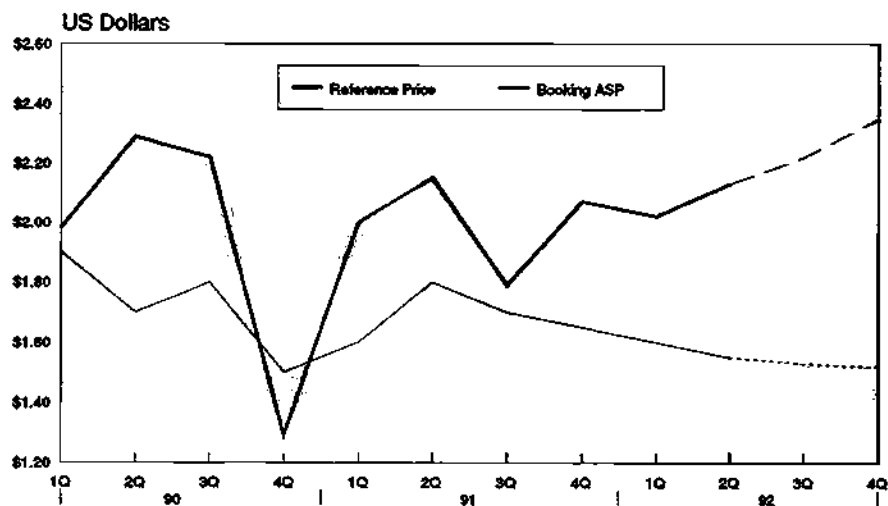
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## EC ANTI-DUMPING ACTION IN MEMORY

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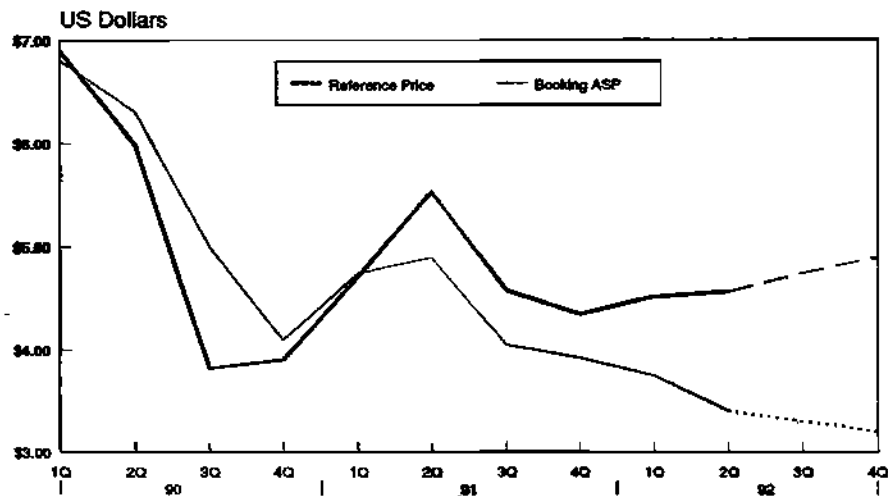
Japanese DRAMs:       Imposed January 1990  
Japanese EPROMs:      Imposed March 1991  
S Korean DRAMs:       Verdict expected in June 1992  
  
SRAMs next?

### ESTIMATED EC DRAM REFERENCE PRICE versus EUROPEAN MARKET PRICE 256K DRAM



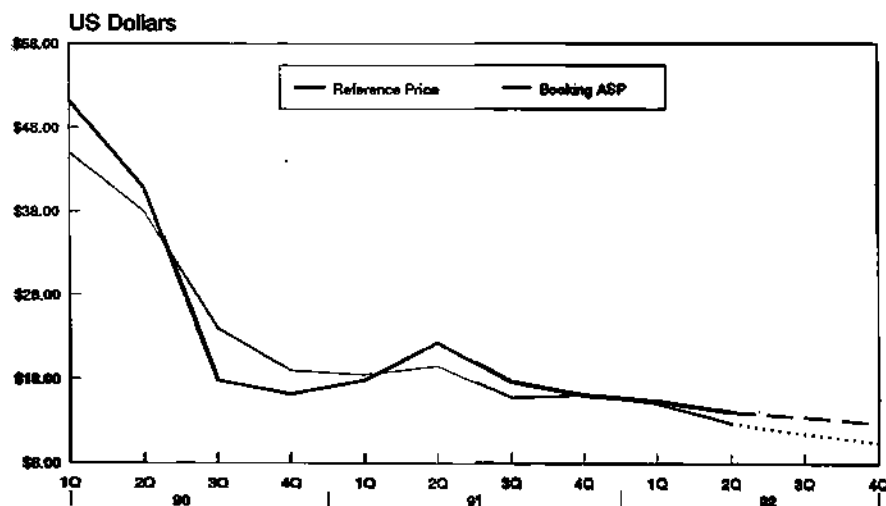
Source: Dataquest

# ESTIMATED EC DRAM REFERENCE PRICE versus EUROPEAN MARKET PRICE 1M DRAM



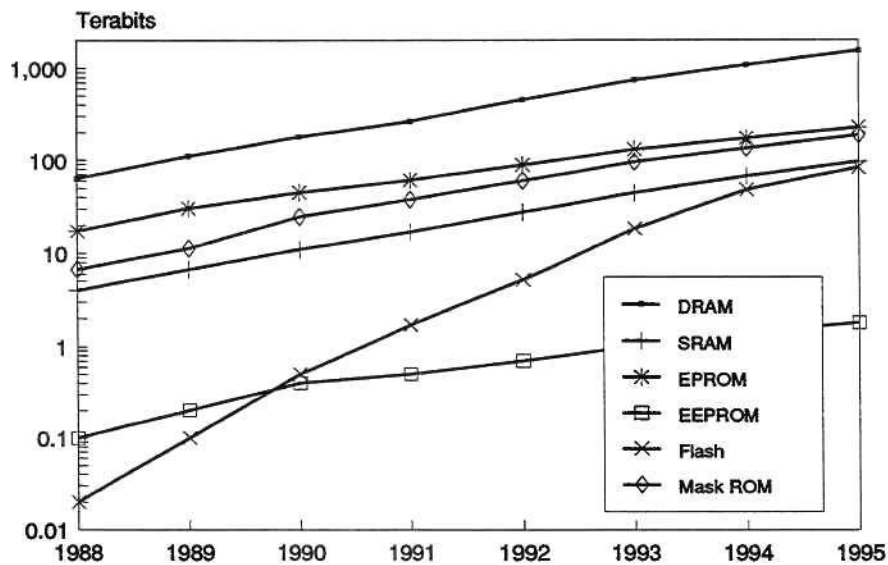
Source: Dataquest

# ESTIMATED EC DRAM REFERENCE PRICE versus EUROPEAN MARKET PRICE 4M DRAM



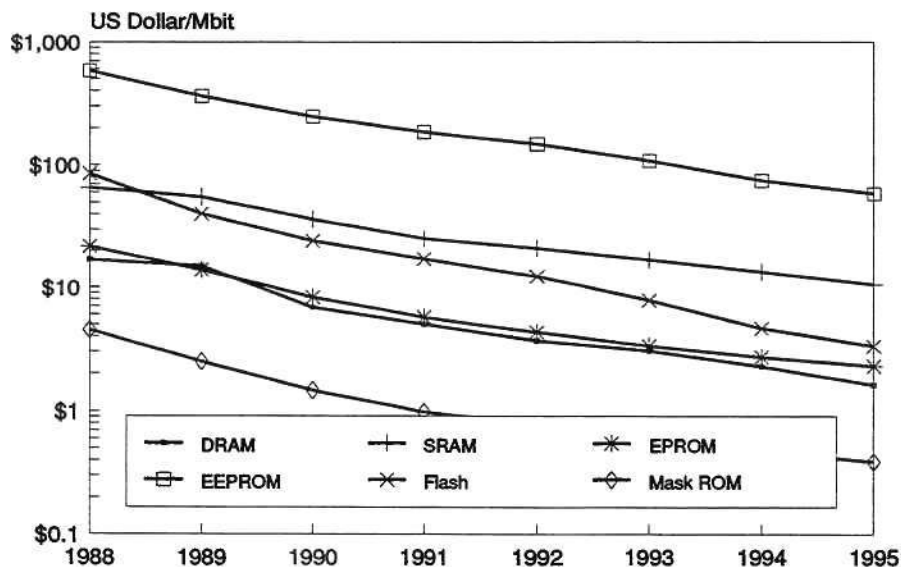
Source: Dataquest

## EUROPEAN MOS MEMORY CONSUMPTION (Bit CONSUMPTION)



Source: Dataquest

## EUROPEAN MOS MEMORY PRICE/Mbit (AVERAGED ACROSS ALL DENSITIES)



Source: Dataquest

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## FLASH MEMORY PRODUCT ANNOUNCEMENTS

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	1M	2M	4M	8M	16M
Intel	4/89	6/90	1/92	4/92	4/93
AMD	9/90	4/91		1/93	9/93
Toshiba	11/90		9/91		6/93
Hitachi	9/90		3/92		
Atmel	9/90				
Samsung				3/93	
SGS-Thomson	1/92		9/93		3/93
WSI					
SEEQ	6/89		6/93		
Mitsubishi	9/90		1/93		8/93
Catalyst	3/91				

Source: Dataquest

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## FLASH MEMORY PRODUCT ANNOUNCEMENTS

---

	1M	2M	4M	8M	16M
NEC	1/91		3/92		6/93
Fujitsu	1/93		6/93		12/93
Texas Inst.	1/91		1/93		1/95
NMB				1/95	1/95
Cypress	9/92		3/93		9/93
Sharp				1/95	3/95
Vitellic			9/93		
Hualon			9/93		
Macronix					9/95
Oki			3/93		3/94
TSMC				3/93	1/94

Source: Dataquest

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## EUROPEAN SEMICONDUCTOR MARKET

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(Millions of ECU)

	1991	1992	% AGR	1996	% CAGR
MOS					
Memory	1,787	2,000	11.9	3,584	14.9
Microcomponent	1,701	1,929	13.4	3,167	13.2
Logic	1,366	1,463	7.1	2,455	12.4

Source: Dataquest

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## AGENDA

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- European market share
- European market analysis
  - Products and applications
- Vendor analysis
- European market analysis
  - Regions
- Closing remarks

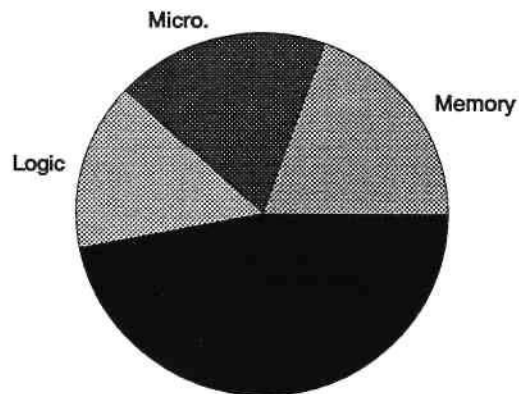
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## FORECAST ANALYSIS

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- Products
- Applications
- Countries

### EUROPEAN SEMICONDUCTOR MARKET PRODUCT SHARE



1991 Product Share

Source: Dataquest



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## EUROPEAN SEMICONDUCTOR MARKET

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(Millions of ECU)

	1991	1992	% AGR	1996	% CAGR
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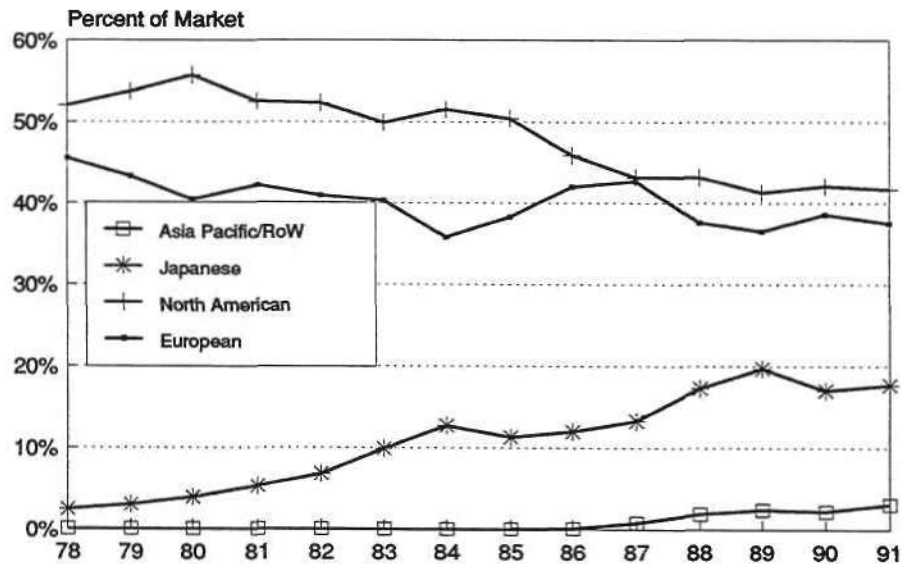
## PRELIMINARY EUROPEAN MARKET SHARE RANKINGS 1991

(Millions of US Dollars)

1990 Rank	1991 Rank	Name	1991 Revenue	91/90 % Growth
1	1	Philips	1,172	1.5
2	2	Siemens	958	-0.6
3	3	SGS-Thomson	887	-2.3
4	4	Motorola	770	0.7
6	5	Intel	760	22.2
5	6	Texas Instruments	629	-1.3
7	7	Toshiba	509	3.9
8	8	NEC	452	8.4
9	9	National Semiconductor	408	0.0
10	10	Hitachi	318	16.5

Source: Dataquest

## PRELIMINARY EUROPEAN MARKET SHARE BY SUPPLIER BASE REGION



Source: Dataquest

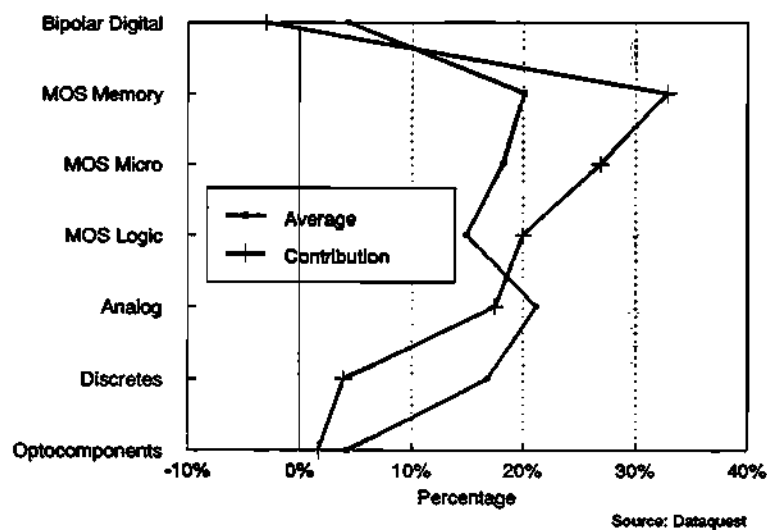
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## AGENDA

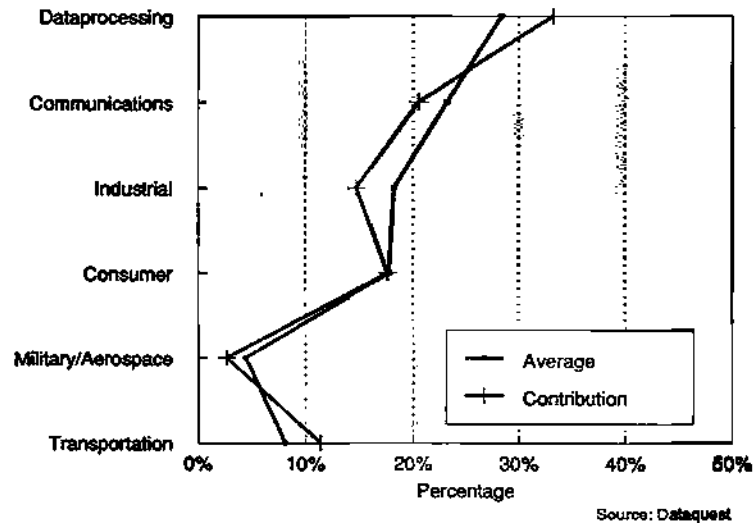
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- European market share
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### PORTFOLIO ANALYSIS EUROPEAN PRODUCT SPLIT



## PORTFOLIO ANALYSIS EUROPEAN APPLICATIONS SPLIT



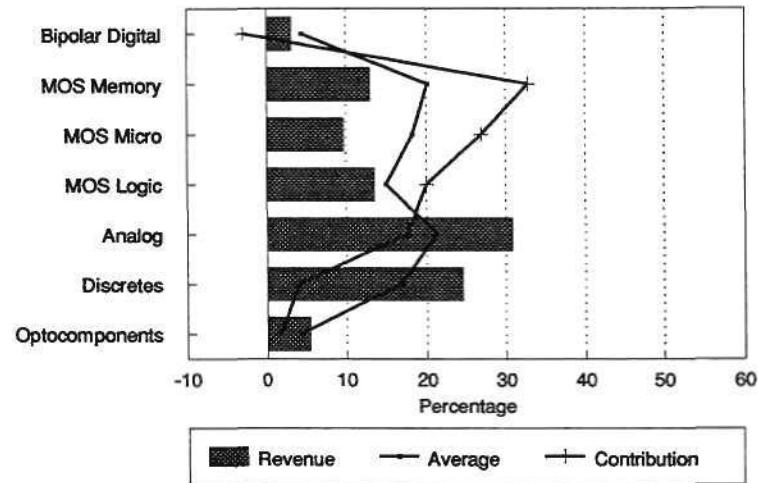

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## MARKET SHARE ANALYSIS

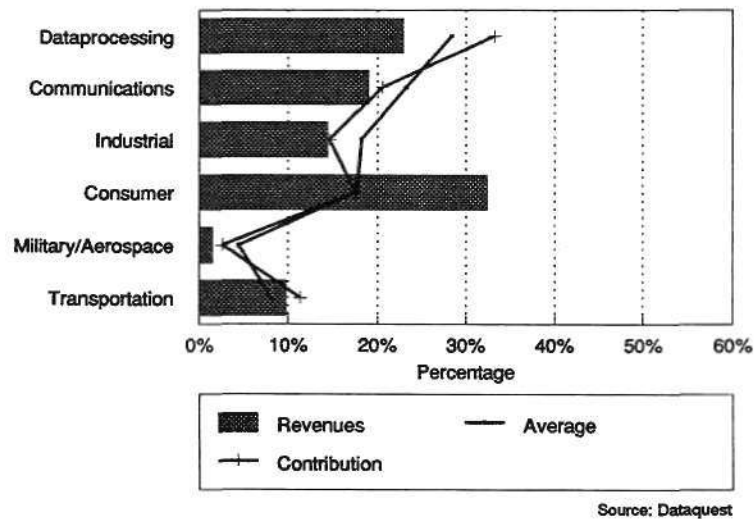
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- Europeans: Philips, Siemens, SGS-Thomson
- United States: Motorola, Intel, Texas Instruments
- Japanese: Toshiba, NEC, Hitachi

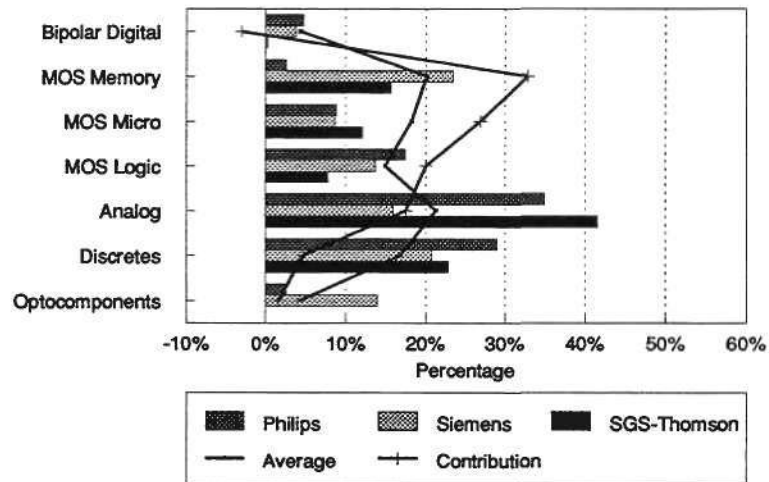
## EUROPEAN COMPANIES PORTFOLIO ANALYSIS EUROPEAN PRODUCT SPLIT



## EUROPEAN COMPANIES PORTFOLIO ANALYSIS EUROPEAN APPLICATIONS SPLIT

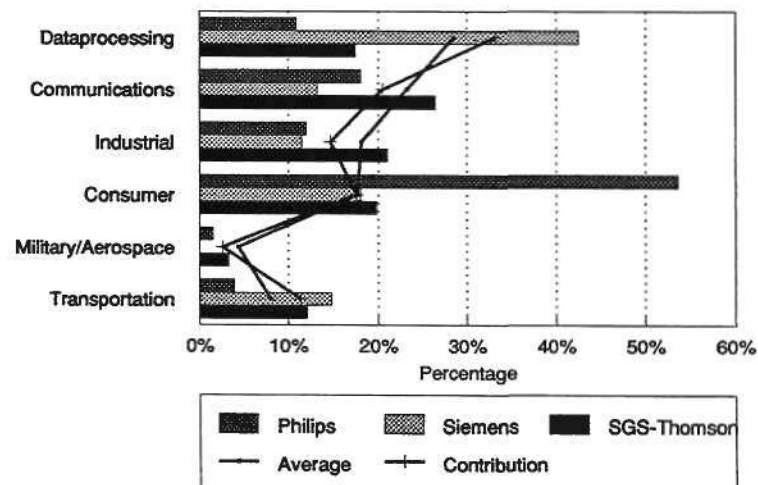


## EUROPEAN COMPANIES PORTFOLIO ANALYSIS EUROPEAN PRODUCT SPLIT



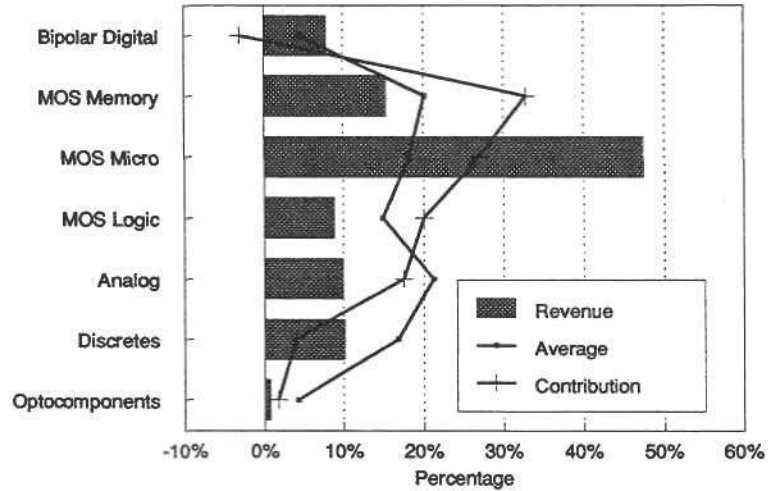
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## EUROPEAN COMPANIES PORTFOLIO ANALYSIS EUROPEAN APPLICATIONS SPLIT



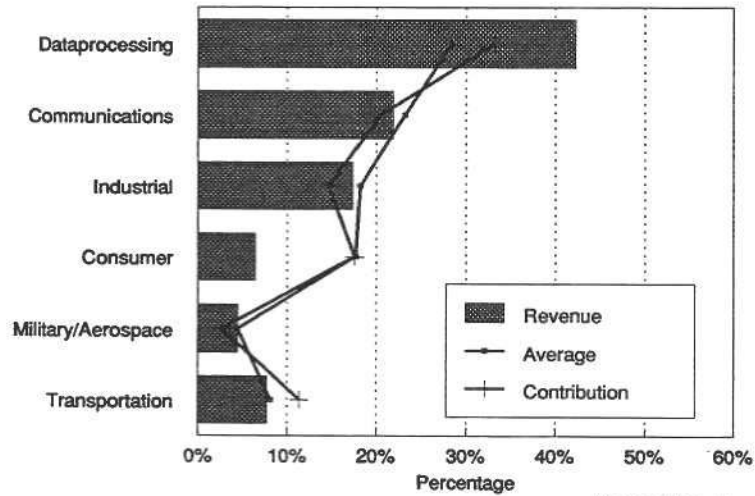
Source: Dataquest

## US COMPANIES PORTFOLIO ANALYSIS EUROPEAN PRODUCT SPLIT



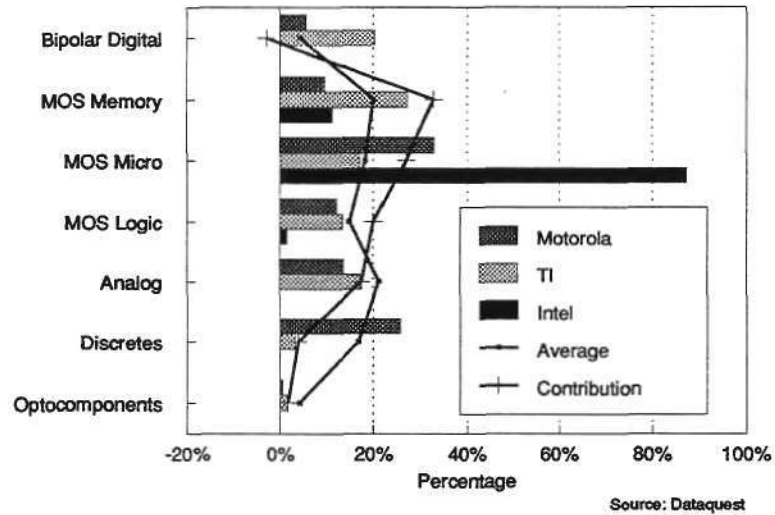
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## US COMPANIES PORTFOLIO ANALYSIS EUROPEAN APPLICATIONS SPLIT

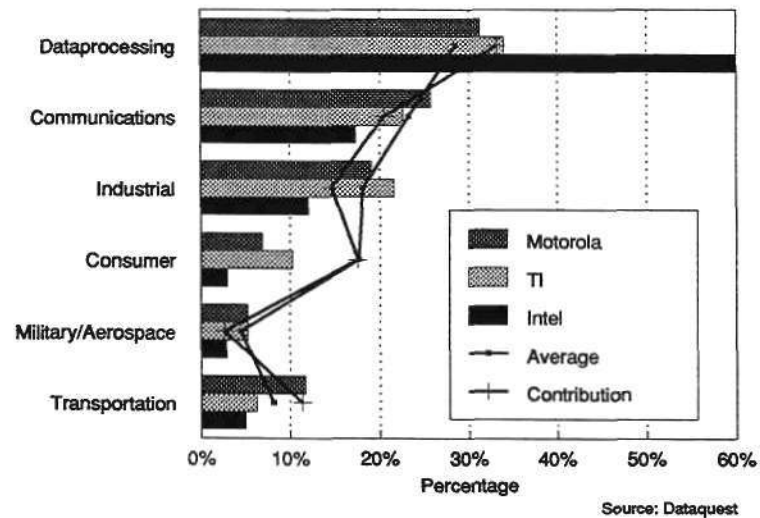


Source: Dataquest

## US COMPANIES PORTFOLIO ANALYSIS EUROPEAN PRODUCT SPLIT

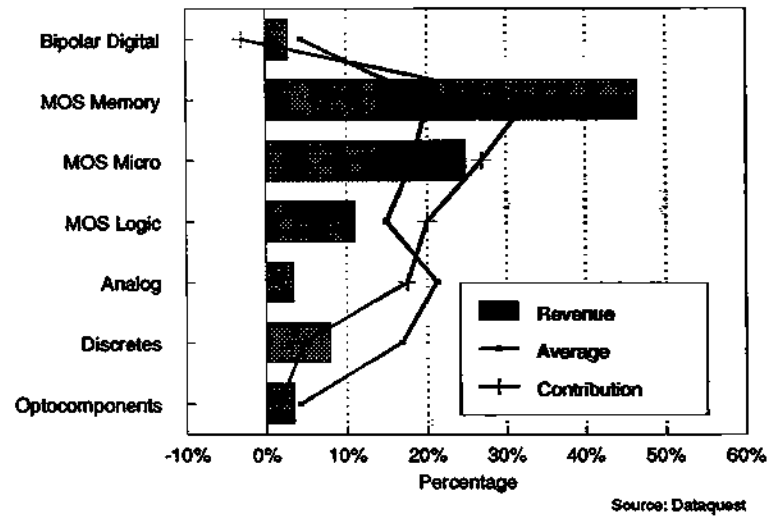


## US COMPANIES PORTFOLIO ANALYSIS EUROPEAN APPLICATIONS SPLIT

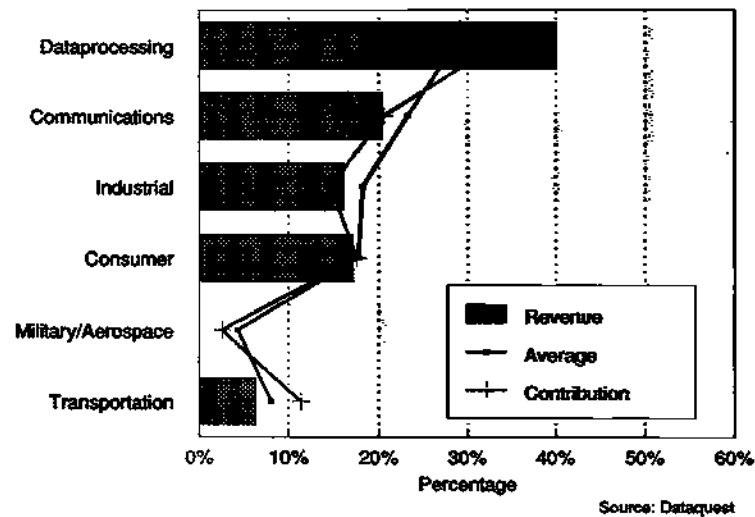




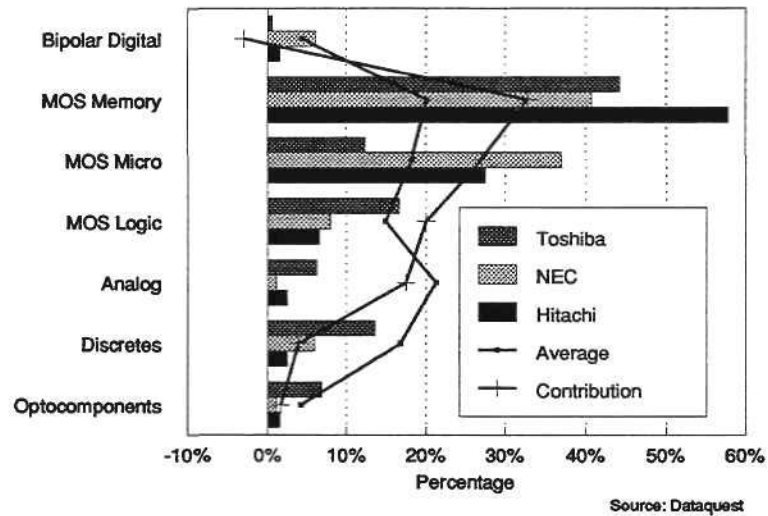
## JAPANESE COMPANIES PORTFOLIO ANALYSIS EUROPEAN PRODUCT SPLIT



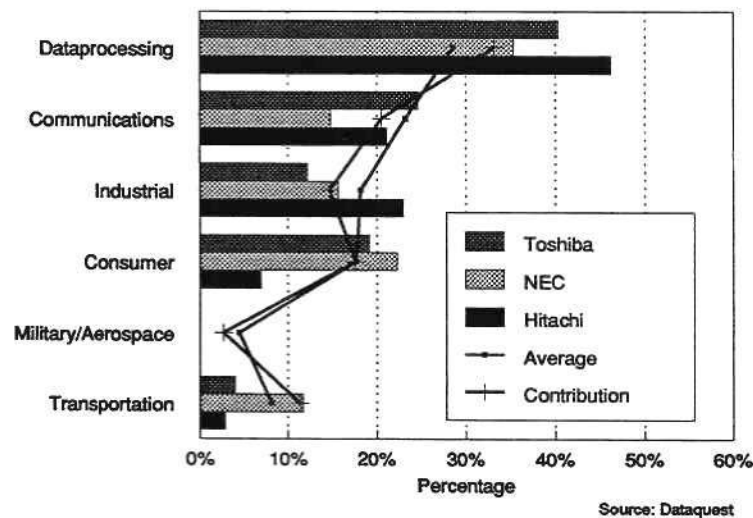
## JAPANESE COMPANIES PORTFOLIO ANALYSIS EUROPEAN APPLICATIONS SPLIT



## JAPANESE COMPANIES PORTFOLIO ANALYSIS EUROPEAN PRODUCT SPLIT



## JAPANESE COMPANIES PORTFOLIO ANALYSIS EUROPEAN APPLICATIONS SPLIT



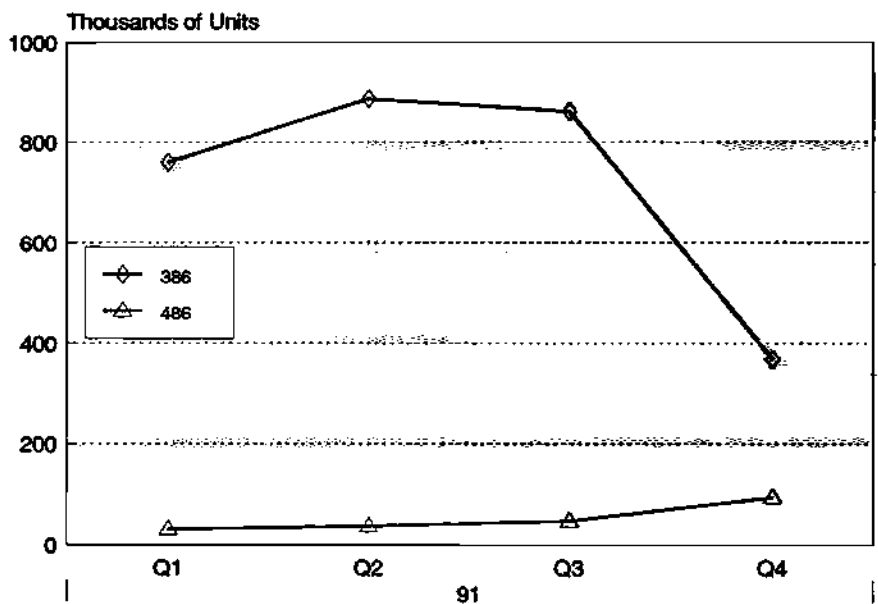
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## PRODUCTS - MICROCOMPONENT

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- Microprocessor strengthened
  - Processor mix moved upmarket

### EUROPEAN MICROCOMPONENT MARKET



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## PRODUCTS - MICROCOMPONENT

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- Microprocessor strengthened
  - Processor mix moved upmarket
- Microcontroller
  - Weak consumer market
  - GSM delays for DSP products
  - ISDN slower than expected
  - Transport segment slow
- Microperipheral
  - Significant price declines
  - Stronger competition than anticipated

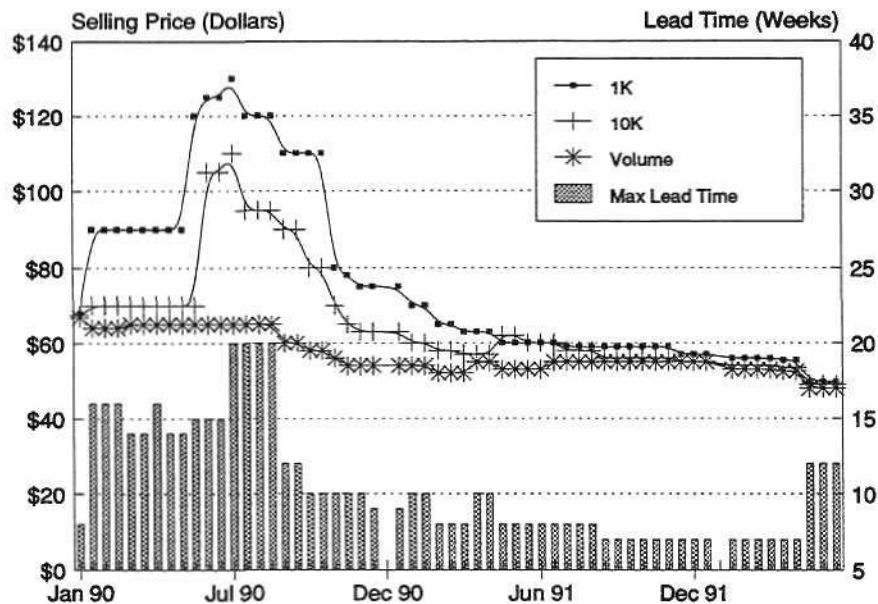
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## PRODUCTS - MICROCOMPONENT

---

- Competition enters microprocessors
  - AMD, Chips & Tech, Cyrix, Texas, ST
  - Intel responding well
  - Consumer marketing comes to processors

## INTEL 386SX PRICING



Source: Dataquest

## PRODUCTS - MICROCOMPONENT

- Competition enters microprocessors
  - AMD, Chips & Tech, Cyrix, Texas, ST
  - Intel responding well
  - Consumer marketing comes to processors
- RISC
  - Step improvement in performance
  - ACE consortium weakening
  - ARM achieving success
  - IBM endorsing the transputer

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## EUROPEAN SEMICONDUCTOR MARKET

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(Millions of ECU)

	1991	1992	% AGR	1996	% CAGR
MOS					
Memory	1,787	2,000	11.9	3,584	14.9
Microcomponent	1,701	1,929	13.4	3,167	13.2
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Source: Dataquest

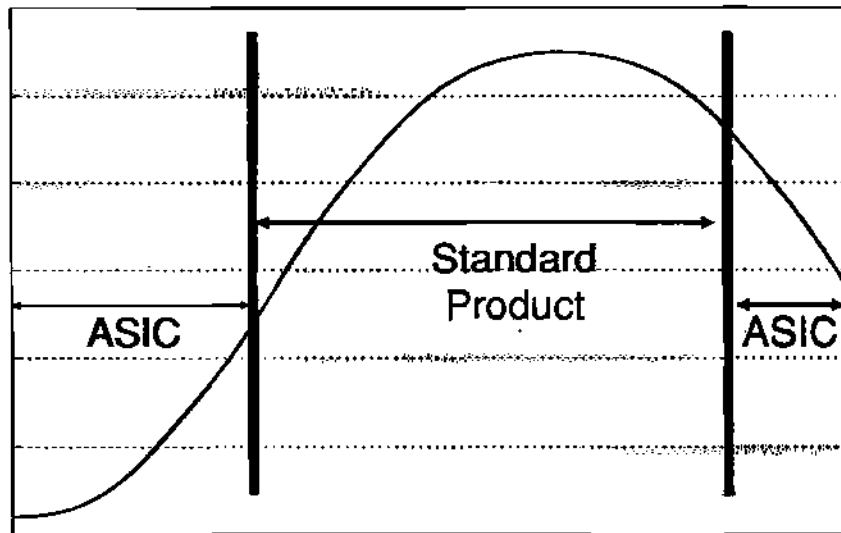
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## PRODUCTS - LOGIC

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- Emphasis moving to standard products  
- ASIC is the loser here

## PRODUCT CYCLE TIMES



Product Lifetime

Source: Dataquest

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## PRODUCTS - LOGIC

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- Emphasis moving to standard products  
- ASIC is the loser here
- Fierce competition in GSM, HDTV, data compression, will axe chip prices
- General purpose logic will move to CMOS and BiCMOS
- Bipolar still has a place in high-speed applications

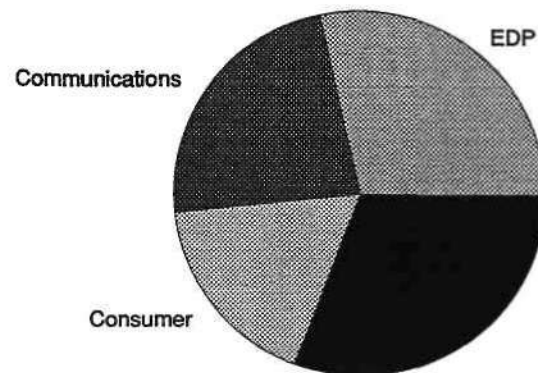
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## FORECAST ANALYSIS

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- Products
- Applications
- Countries

### EUROPEAN SEMICONDUCTOR MARKET APPLICATIONS SHARE



1991 Applications Share

Source: Dataquest



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## EUROPEAN SEMICONDUCTOR MARKET

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(Millions of ECU)

	1991	1992	% AGR	1996	% CAGR
EDP	2,594	2,837	9.4	4,392	11.1
Communications	2,123	2,240	5.5	3,225	8.7
Consumer	1,613	1,695	5.1	2,561	9.7

Source: Dataquest

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### APPLICATIONS - EDP

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- High growth again  
- PC manufacture returns to Europe
- Mainframe and workstation manufacture in France and Italy rises
- Longer-term multimedia will be the application driver

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## APPLICATIONS - COMMUNICATIONS

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- Europe's greatest strength
- Internal consumption:
  - Digital communications
  - Mobile and cordless
  - Infrastructure in East Europe
- External exports:
  - Exchanges
  - Mobile handsets
- World's top hardware suppliers are European

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## APPLICATIONS - CONSUMER

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- Short-term demand weak
  - Threat of recession in most countries
  - Excess inventory of all consumer goods
  - Olympics may not help
- Longer-term outlook is better
  - DCC and minidisk to stimulate demand
  - Consumer multimedia
  - HDTV: let's wait and see

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## AGENDA

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- European market share
- European market analysis
  - Products and applications
- Vendor analysis
- European market analysis
  - Regions
- Closing remarks

---

## INVESTMENT

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- Investment grew from \$5.1 billion to \$14.4 billion from 1986 to 1991
- Reason: investment boom in Japan
- Result: excess capacity
- Evidence:
  - Memory prices
  - Japanese profit margins
  - Increase in foundry activity
  - Increased fab closures/delays

---

### DELAYED 200 mm FAB PLANS IN JAPAN

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COMPANY	PRODUCTS	FAB TYPE
Fujitsu	16Mb DRAM	Production
Hitachi	4Mb/16Mb DRAM	Production
KTI	ASIC	Production
Matsushita	16Mb DRAM	R&D
Matsushita	16Mb/64Mb DRAM	Production
NEC	16Mb DRAM, MPU	Production
NEC	4Mb/16Mb DRAM, EPROM	Production
NKK	4Mb SRAM, ASIC, MPU	Pilot
Oki	16Mb DRAM	Production
Sanyo	16Mb DRAM	Production
Sharp	4Mb DRAM, ROM	Production
Toshiba	16Mb DRAM	Pilot

---

### WORLDWIDE FORECAST OF PRODUCTION, CAPITAL SPENDING AND WAFER FAB EQUIPMENT

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(Millions of Dollars)

	1991	1992	AGR	1995	CAGR 95/90
Production	69,231	78,769	14%	110,352	11.9%
Capital Spending	14,372	13,970	-3%	19,090	8.8%
Fab Equipment	6,026	5,568	-8%	8,883	8.7%

Source: Dataquest

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## INVESTMENT

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- Slowdown in Japanese foreign investment
- Slowdown in transfer of capital
- Migration from commodity to value-added products
- Spectre of increased trade friction
- Pervasiveness of semiconductors will restore balance

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## AGENDA

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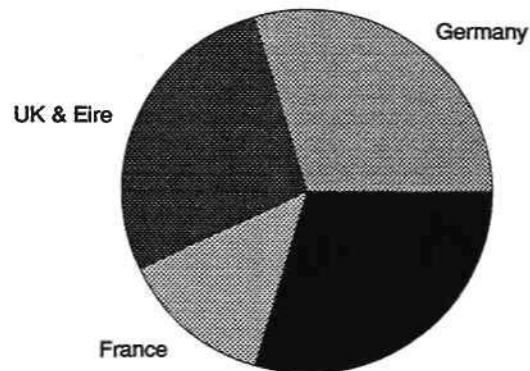
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## AGENDA

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- European market share
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### EUROPEAN SEMICONDUCTOR MARKET REGIONAL SHARE



1991 Regions Share

Source: Dataquest

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## EUROPEAN SEMICONDUCTOR MARKET CONSUMPTION FORECAST

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(Millions of ECU)

Country	1991	1992	AGR 92/91	1996	CAGR 96/91
France	1,228	1,275	3.8%	1,844	8.5%
United Kingdom & Ireland	2,405	2,669	11.0%	4,310	12.4%
Germany	2,770	2,878	3.9%	4,294	9.2%

Source: Dataquest

---

### COUNTRIES - GERMANY

---

- Short-term demand weak
  - Cost of reunification is high
  - Excess consumer inventories
  - Automotive market is soft
- Positive factors are:
  - Telecoms business is strong
  - Industrial production is stable
  - PC manufacture rising
- Longer-term outlook good - due to size
- Attraction for foreign investment - medium

---

## COUNTRIES - UK & EIRE

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- High investment by multinationals
  - Strong manufacturing economy
  - Design wins are outside Europe however
- PC manufacture is concentrated here
- Longer-term outlook good
  - Due to foreign investment
- Attraction for foreign investment - good

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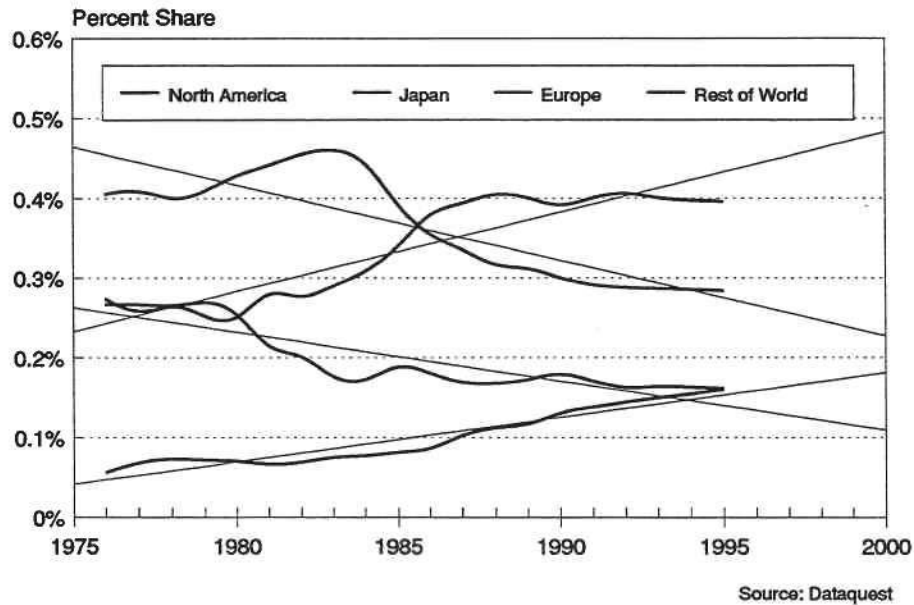
## COUNTRIES - FRANCE

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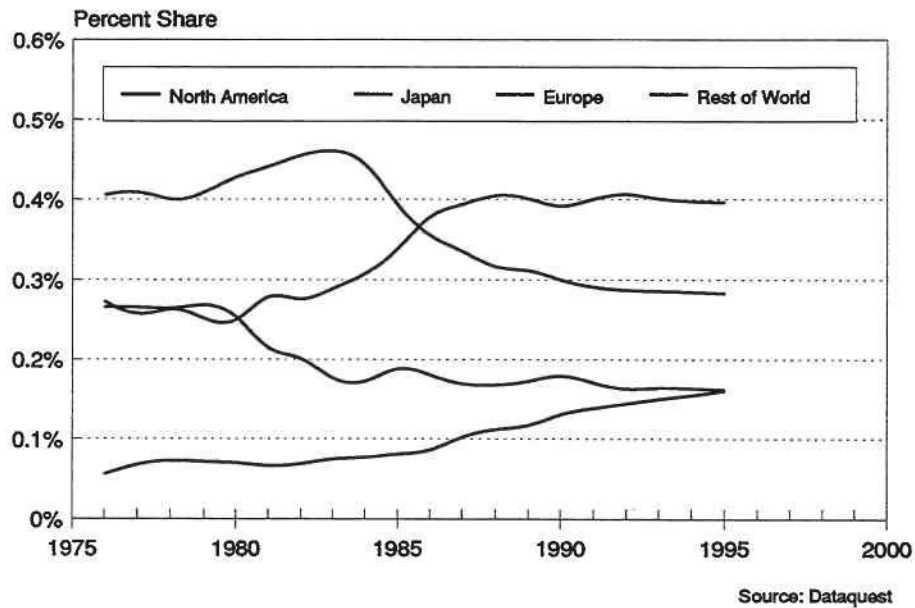
- Country close to recession
- Local manufacture moving outside Europe
- Good telecoms business
  - Alcatel No.1 telecoms manufacturer
- Attraction for foreign investment - poor

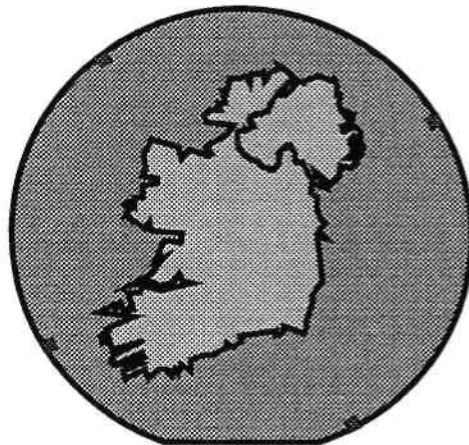


## WORLDWIDE SEMICONDUCTOR FORECAST MARKET SHARE BY WORLD REGION



## WORLDWIDE SEMICONDUCTOR FORECAST MARKET SHARE BY WORLD REGION





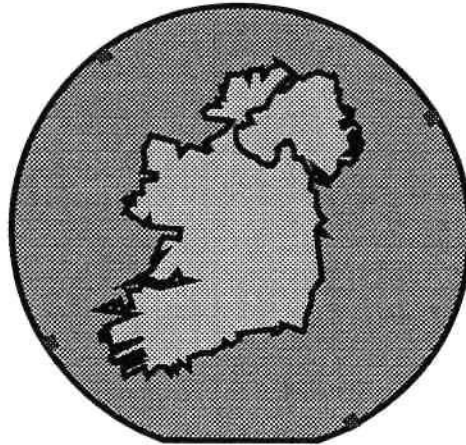
## **RESULTS OF THE 1991 EUROPEAN PROCUREMENT SURVEY**

***Bipin Parmar***

Group Director European Semiconductors  
and Conference Chairman  
Dataquest Europe Limited

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## INVESTING IN ELECTRONICS

***Dan Flinter***

Executive Director  
Industrial Development Authority of Ireland

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## INVESTING IN ELECTRONICS



Dan Flinter  
Executive Director  
Industrial Development  
Authority of Ireland

Mr. Flinter is Executive Director of the Industrial Development Authority of Ireland (IDA) with responsibility for overseas investment. Prior to this he was appointed to the IDA Board as Executive Director with responsibility for organization services and regional development. He has also been Planning Manager, Manager for Information Technology and Senior Economist. He joined IDA as a researcher in the planning division. Mr. Flinter graduated from University College Dublin with a Master's degree in Economics.

Dataquest Europe Limited  
**EUROPEAN SEMICONDUCTOR INDUSTRY CONFERENCE**  
June 3-5, 1992  
Dublin, Ireland

**SPEECH**  
**BY DAN FLINTER AT**  
**DATAQUEST CONFERENCE**  
**3 June 1992**

**INTRODUCTION:**

Many of the papers presented at this Conference over the next two days will be from representatives of international companies who are involved in the development, production and marketing of electronic components; software, etc. Although IDA has been in the electronics business since the 1970's our participation in the industry is from a different perspective than most of yours.

Ireland is a player in the electronics sector because it offers a competitive mix of skills, costs and financial advantages. The industry is important to us because it is one which can best meet our economic objectives. It is a sector which has grown at a remarkable pace in the eighties and further growth seems assured. Latest estimates suggest that the value of world electronics output in 1990 was \$750 billion, a figure set to rise by close to 40% to \$998 billion by 1995.

Our macro economic objective is to facilitate economic growth and job creation. As executives this translates into a simply stated business objective which is to win business investment decisions for Ireland. Our business objective is to be a significant player i.e. to win real market share in the mobile investment business in the various markets we operate in.

From an operational level, our participation in the electronics industry means we have to know our market; who the key players in the industry are; how Ireland can help them to achieve growth in profitability and gain a higher level of market share.

We have been involved in key decisions taken by major companies and observed the process of change in the industry over the past 20 years.

We have observed and experienced the evolution of the industry and the responses made by companies to these changes. We have also seen the responses that various Governments have made to these changes.

I would like here today to **share some of our experiences** with you and our view as to where the electronics industry is headed.

### **EVOLUTION OF THE ELECTRONICS INDUSTRY:**

Electronics is one of the most important sectors of the Irish economy today. Twenty years ago it barely existed, with a handful of companies employing less than 2% of our industrial workforce and generating 6% of Ireland's industrial exports. Today, there are 200 companies in the sector employing almost 10% of the industrial workforce and accounting for almost 30% of industrial exports. On a capita basis, Ireland is now the most significant exporter of hardware and software products in Europe.

The industry in Ireland evolved relatively recently. In the early seventies, companies such as General Electric, Data Products and Westinghouse invested in Ireland.

They did so because Ireland offers lower manufacturing costs and lower corporate tax rates and their Irish operations were focussed on producing cost sensitive, commodity products.

When Digital arrived in 1974 to make computers for the European market, it was justifiably seen as a major coup. The infrastructure to support a vibrant electronics sector at that time however did not exist. All the country had to offer was its people. For many years Digital flew in parts from the US to be assembled in their Irish facility.

Today, most of the first wave of electronics companies are still operating in Ireland, but their operations are totally transformed. For example, in Dundalk, Harris Semiconductor (formerly General Electric) only makes one product family - but all the product design and development work takes place there. Recently Data Products was acquired by Hitachi and soon it will start making a range of DIY tools in its Irish factory.

A similar transformation occurred for example, in Telectron, bought by the US giant A T & T as its first manufacturing investment outside its home market. Telectron was a domestic manufacturing company in the telecommunications business, selling about 5% of its output overseas and the balance to the Irish P & T. Under AT & T's ownership the Irish plant has operated its own Computer Aided Design Team, controls marketing of products in the Middle East and Africa, and is almost 100% an export company.

The focus on developing the educational infrastructure in Ireland, has played a crucial role in this transformation. The establishment of a network of technical colleges and universities, with their focus on computer science, microelectronics and other business disciplines, provided the quality of skills required by the rapidly changing sector to develop and extend their activities in Ireland and to attract new employers.

By the end of the 1970's electronics companies in Ireland found themselves in a more attractive, less barren environment, with the development of the Irish subsupply base. As we gained a reputation for the quality and flexibility of our people, we began to win more investment and the early eighties saw a surge in our market share and an evolution in the kinds of projects locating in Ireland to include more complex products and more integrated manufacturing.

US companies lead the way with a range of investments

- high end dataprocessing companies like Stratus & Teradata.
- Companies like Dell and Quantum in the high value cost sensitive PC and disc drive business.
- Intel's new microprocessor facility in Dublin which will be a \$500 million world class sub micron fab processing 8" wafers.
- Analog Devices now employ over 700 people in Ireland of whom more than 60 are involved in new product development.



- General Semiconductor is expanding its TVS product development and fabrication activity here.
- Motorola has selected Ireland as the European site for paging and two way radio products.
- Most recently highly successful datacommunications companies like 3Com and Cabletron are establishing their European manufacturing base.

### **Software:**

Growth in the European software industry is running at 20% a year in some segments, particularly packaged software, and Ireland is well positioned to enjoy the benefits of this growth through the presence here of such US based world market leaders as Microsoft, Borland, Claris and Lotus.

Dublin is now regarded as the software capital of Europe, engaged in sophisticated product development as well as localisation of software for European markets and duplication and packaging. Ireland is where Motorola develops software for digital cellular communications, IBM has a 150 person software development laboratory, and Philips has a combined IC design and software laboratory employing about 100 engineers. The software sector accounts for 20% of the total number employed in the Irish electronics sector and we are confident that this will grow even further.

Ireland has also been selected by many Japanese companies.

There are two good reasons for putting Japanese and other Far Eastern electronics companies high on our list of target firms: they are an increasingly important force in the marketplace and they are often the quality standard setters in the industry. If Irish suppliers can work to the tolerances and overall quality standards set by the Japanese they can supply anyone.

In 1989, Ireland attracted Alps Electric, Ohshima, Fujitsu Isotec and Brother Industries to establish Irish operations - the two latter companies making sub-assemblies for plants located elsewhere in Europe. Many of the Japanese investments located elsewhere in Europe fall into this final assembly category - but, significantly, all of the 22 Japanese plants located in Ireland are genuine manufacturing operations in their own right, employing high levels of skills and expertise. IDA's strategy for the Japanese market is to position Ireland as the parts supply centre of Europe.

The recent announcement by Matsushita-Kotobuki Electronics Industries (MKE) of Japan, a company which is synonymous with the household name of "Panasonic" and Quantum Corporation of California who have come together to build one of the most advanced automated clean room assembly facilities in the world. MKE will produce disc drives in generic form which will then be customised in a separate manufacturing facility by Quantum Corporation.

In the electronics industry, as in other sectors, the concept of "critical mass" can be important. The strategy adopted by the IDA has been to identify those industries and operations which can contribute to the overall development of the sector, improving the infrastructure for existing and other new companies.

The recent successful pursuit of disk drive manufacturers is an example of this approach. Ireland targeted the top four disk drive manufacturers in the world and has persuaded three of them that we are the best base for planned European manufacturing facilities.

Because disk drive manufacture is recognised to be a highly cost sensitive industry the value of capturing these firms has an important demonstration effect for other manufacturers planning European investment. But equally important is that disk drives are a key component for computer manufacturers.

We are optimistic, and there are already signs that our optimism is justified, that many personal computer manufacturers will see considerable benefit in locating their operations close to the source of key components, like disk drives.

In today's environment, we have to be very aware of the cost sensitivity of potential projects. The employment potential of the market of mobile investment is like a pyramid, at the top of which are highly sophisticated projects at the leading edge of research and development providing good opportunities for graduates.

Because of the availability of such skills in Ireland and our competitive unit costs, we consistently have an edge over competitors for such projects. Typically however these projects are not very large employers.

At the other end of the scale are high-volume manufacturing and assembly operations using low skill levels, but employing thousands of people. Because Irish labour costs while competitive in European terms are higher compared to less developed countries which have a surplus of low skill labour, these are projects which Ireland is less likely to win - even if it were socially and politically acceptable to pursue such projects.

Our constant challenge is to determine the cut off point in the middle of that pyramid above which projects are securable and below which they are unobtainable because of wage rate differentials.

### **Employment potential-electronics investments**

#### **R & D**

**Low volume,  
high value products**

**Cut off point  
for Ireland  
(moves with costs)**

**High volume,  
medium value products**

**High volume,  
low value products**

**Employment**

### **What lessons have we learned in our business?**

In my view the electronics industry has over the past twenty years been an extraordinary example of how the "laws" of competitive advantage have in many instances been rewritten. The significance of the developments is the speed at which these changes have come about. Technology is clearly essential to competitive advantage now but will not necessarily deliver markets and profitability. Highly efficient manufacturing with effective low unit costs are crucial but not necessarily the final determinant. Quality, previously considered a guarantee of success now is a bench mark which a company must achieve before its customers, especially industrial customers, will even consider making a purchase.

Distance from the market and lost time in terms of the length of the supply chain and the attendant working capital costs are becoming of major significance. The much abused term of globalisation is increasingly real and is being constantly redefined. International companies constantly are seeking to achieve the optimum from a combination of alternative but compatible strategies.

There is clearly no one single solution. But companies in the industry must have:-

- shorter delivery times to customers
- a responsive manufacturing capability
- cost efficient component suppliers
- access to technology

All of these strategies have to be implemented in the context of geographical locations which are consistent with and supportive of the business needs of companies.

Ireland's own business strategy in terms of winning new investments from this sector has as I have already mentioned changed radically over the past twenty years:-

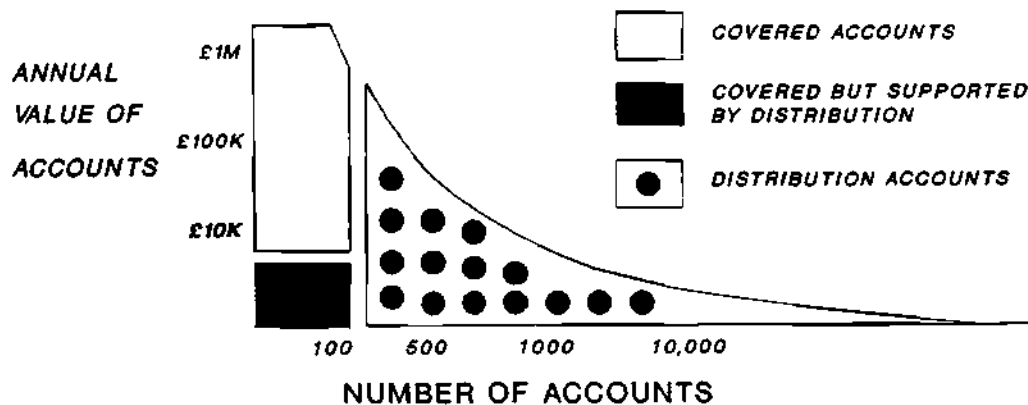
- Late sixties, Ireland focussed exclusively on attracting investment from the manufacturing sector, particularly the electronics & healthcare sectors. We were the first country in Europe to use fiscal incentives to attract investment. Other Development Agencies entered the market and began to compete directly with us for projects. To survive in the market place, it was necessary for us to become a competitive location for other value added industries such as product design, software development and production, technical market support, direct marketing and product repair.
- Improvements in the third level education system and our telecommunications system opened up the potential for new activities to be carried out in Ireland. For example, the software industry. The initial focus was on software development in hardware companies but the emphasis quickly changed to independent software houses. IDA was the first European development agency to enter this market and as a result quickly gained market share.

- Another area was the data processing sector. Today there are six American companies processing claims in Ireland including Mass Mutual; Cigna and Metropolitan Life.
- The next phase in our development strategy was launched by the Government in the late eighties with the decision to establish the International Financial Services Centre in the nearby docks area in Dublin. Today over 190 institutions from all over the world have been licensed to establish in this Centre and already 130 of these are trading.
- Understand the new business opportunities and entering these markets before our competitors do, as we have done in the software industry and more recently the telemarketing area.

We are genuinely proud of our overseas clients and the significant contribution they make to the Irish economy.

Ends

## DISTRIBUTION'S ROLE.



The major semiconductor manufacturers supplying the European market are focusing more attention on their "key" accounts and expanding their distribution coverage - more accounts, not more distributors.

Gary Kibblewhite.



## European Distribution Trends.

- Distribution today serves over 30% of total component demand (by value) and over 98% (by number of customers).
- Substantial changes occurring.
- In the 80's UK groups dominated the acquisition scene, Lex, Farnell, Memec, Electrocomponents, Electron-House.
- In the 90's it is now continental European and US companies that are acquiring.

Gary Kibblewhite.

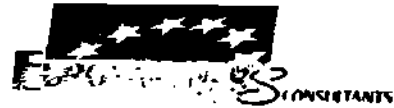




# CHANGE, CHANGE, AND MORE CHANGE !

What is driving it ?

Gary Kibblewhite.



- Poor profitability of both distributors and manufacturers.
- Repositioning of major semiconductor suppliers and distributors.
- Mergers and acquisitions.
- Formation of the Single Market.
- Logistics.
- Increased technical content of semiconductors.
- Electronic trading.

Gary Kibblewhite



## The Profitability/Size Equation.

Just because you are a global player does it mean you are necessarily profitable ?

Some major players ranked by market capitalisation:-

Electrocomponents	(UK)	\$1043 million
Avnet	(US)	\$ 892 million
Farnell	(UK)	\$ 749 million
Arrow	(US)	\$ 378 million
Diploma	(UK)	\$ 332 million

## How Have These Major Players Performed Over The Last Three Years.

(Source: Matheson Securities).

### ELECTROCOMPONENTS.

Sales growth • +11.2%  
Net asset growth • +32%  
Profit before tax  
growth • +6%

ROCE • 47%  
Operating margin • 14%  
Working capital/sales • 3.3X

### ARROW ELECTRONICS.

Sales growth • +20%  
Net asset growth • 0%  
Profit before tax  
growth • +19%

ROCE • 16%  
Operating margin • 4%  
Working capital/sales • 4X

# How Have These Major Players Performed Over The Last Three Years. (continued)

(Source: Matheson Securities).

## AVNET.

Sales growth ▪ 1.4%  
Net asset growth ▪ Nil

Profit before tax  
growth ▪ +5.7%

ROCE ▪ 12.5%  
Operating margin ▪ 5.5% and  
rising.  
Working capital/sales ▪ 2X

## FARNELL ELECTRONIC COMPONENTS (Pre ESD acquisition).

Sales growth ▪ 8%  
Net asset growth ▪ 0%  
Profit before tax  
growth ▪ 12%

ROCE ▪ 29.5% (Group)  
Operating margin ▪ 23%  
Working capital/sales ▪ 1.7X

## Component Distributors Are Polarising

### Catalogue Distributors.

#### Examples:

#### FEATURES.

FARNELL

ESD

RS

NEWARK



Generally profitable above  
the industry norm.

Growing by both Greenfield  
start-up and acquisition.

Moving into new markets.

## Component Distributors Are Polarising

Broad Liners.

Examples:

AVNET

ARROW

LEX

TEKELEK



### FEATURES.

Having a tough time on the profit front.

Major players in the "buy or be bought" scene.

Developing worldwide businesses.

## Component Distributors Are Polarising

Niche Players

Examples:

MEMEC  
(Raab Karcher)

ACAL



### FEATURES.

Generally profitable in excess of industry norm.

Steady growth.

Limited geographic expansion.

## Mergers And Acquisitions

- Lex sell European and North American Distribution activities to Arrow.
- Northern Telecom sell ESD to Farnell.
- Diploma sells Access to Avnet.
- Arrow buy stake in Silverstar/Lasi/Celdis.
- MMD buy Rapid Recall.
- Elbatex buy Jermyn France and Germany.
- And more and more .....

## Some Single Market Implications:-

- Service Differentiators.
- Cross-boarder dealing.
- Ship and Debit vs commodity.

# LOGISTICS

The arrival of "integrated operators" in Europe, eg UPS.

Huge cost variations with "traditional" services:-

eg. A 3 kg shipment from Manchester to Munich costs

- \* \$192 if sent as a single IATA shipment.
  - \* \$138 if sent as a consolidated shipment (approx)
  - \* \$53 if sent via an "integrator" door-to-door service.
- and ... much less for a comparable distance shipment in the USA, so there is still scope for big cost reductions.

Controlled 24, 48, or 72 hour services by either air or ground.

Value added taxes still a problem - who collects them ?

Integrated operators will also offer service of collecting the cash by the end of this year.

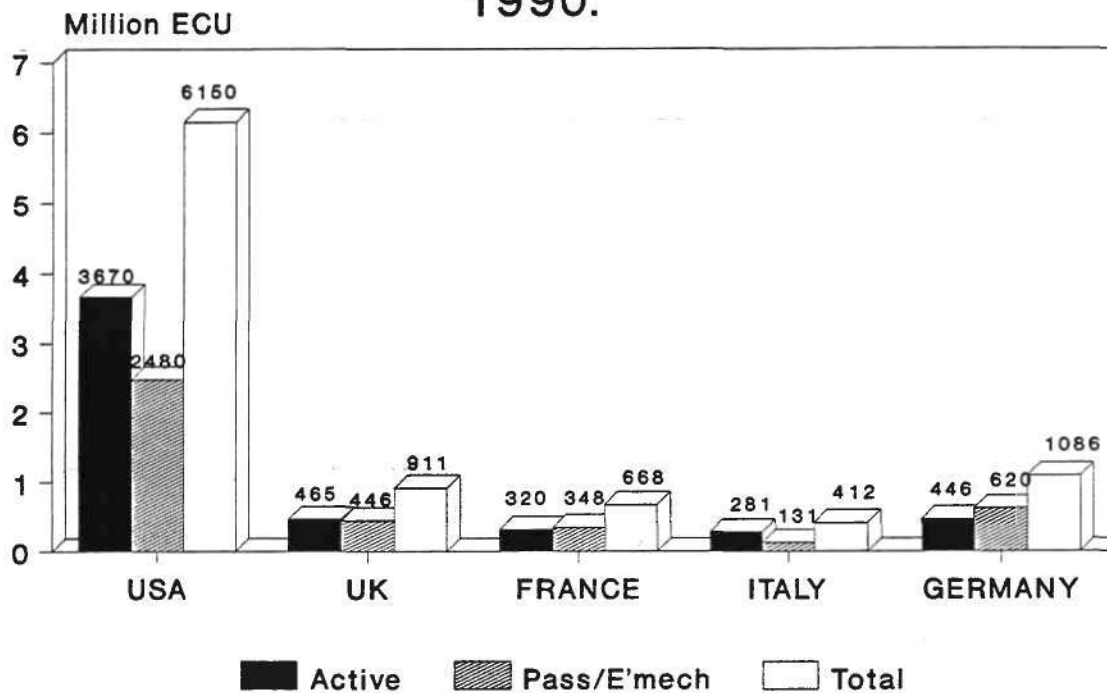
# ELECTRONIC TRADING

- \* Emergence of Edifice (within Edifact) as an international standard.
- \* Simple "EDI" now just a small part of an electronic trading environment which now includes:-
  - \* On-line databases/order status.
  - \* Bulletin boards.
  - \* Inventory visibility programmes.
  - \* E-mail.

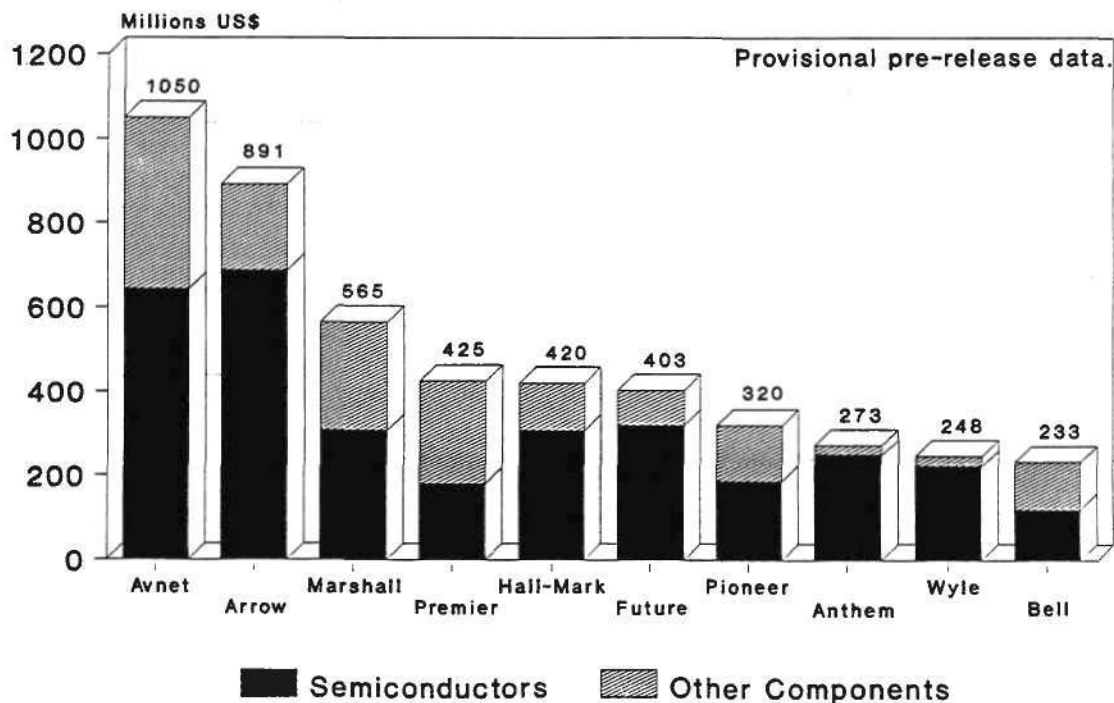
as well as the "traditional EDI" functions relating to standard business forms:-

- \* Invoices - Acknowledgements - Orders - etc. etc.

## Distribution Total Available Market USA vs Major European Country Market. 1990.

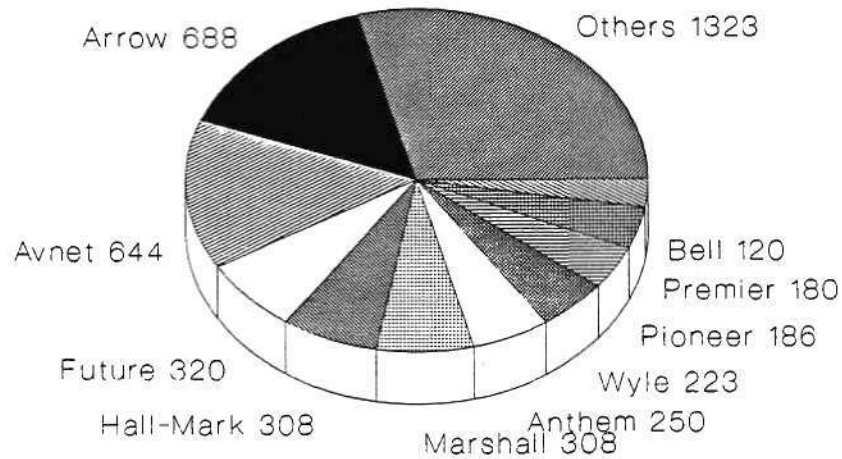


## Electronic Component Distribution USA 1991 - Sales of Top 10 Groups

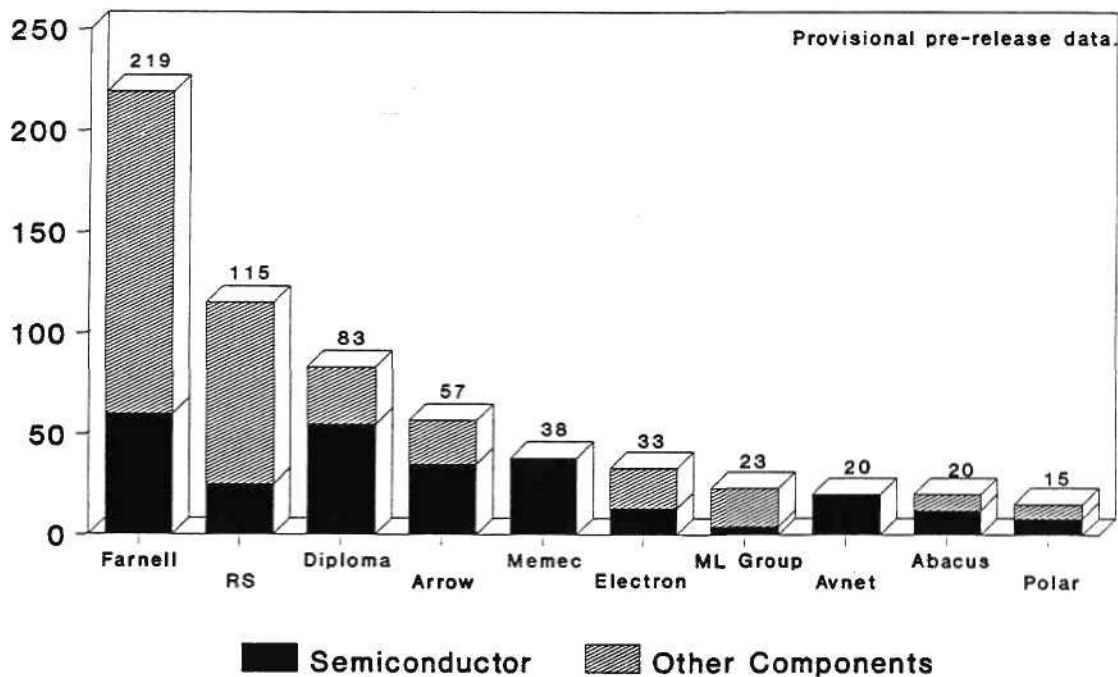


# Semiconductor Distribution USA 1991 - Total Market \$4550 Million

Provisional pre-release data.



# Total Component Distribution U.K. - 1991 Sales of Top 10 Groups.

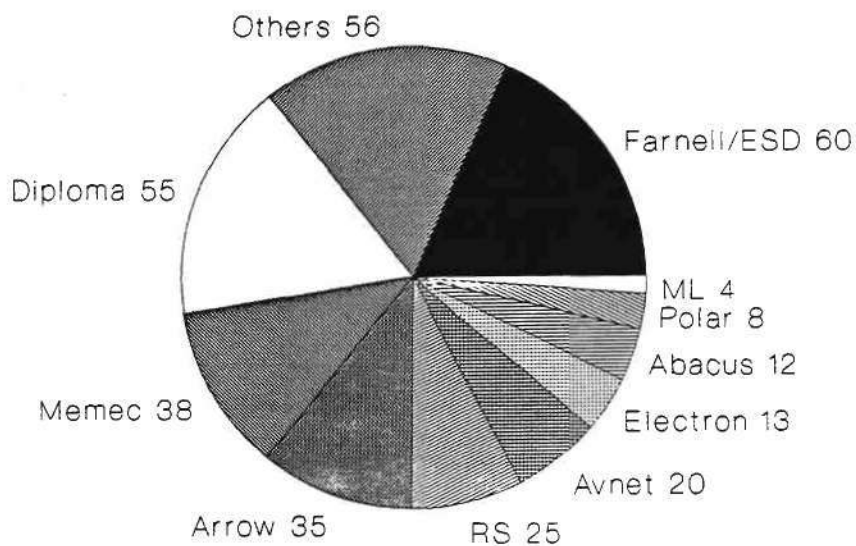




# Semiconductor Distribution

## U.K. 1991 - Total market £326 million.

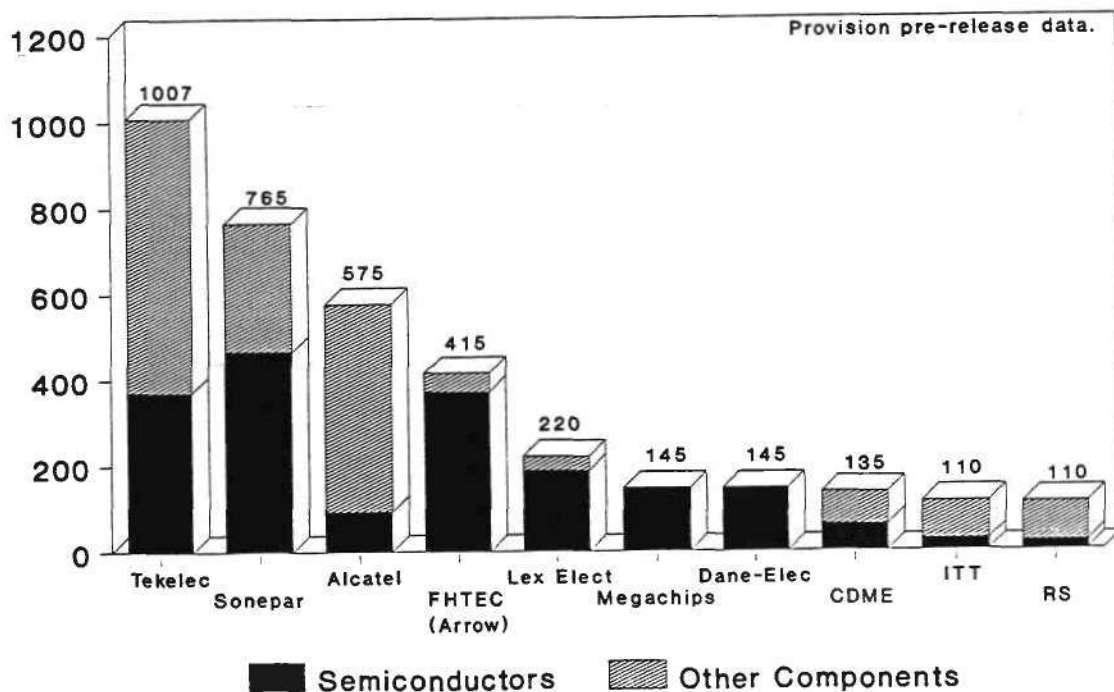
Provisional pre-release data.



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# Total Component Distribution

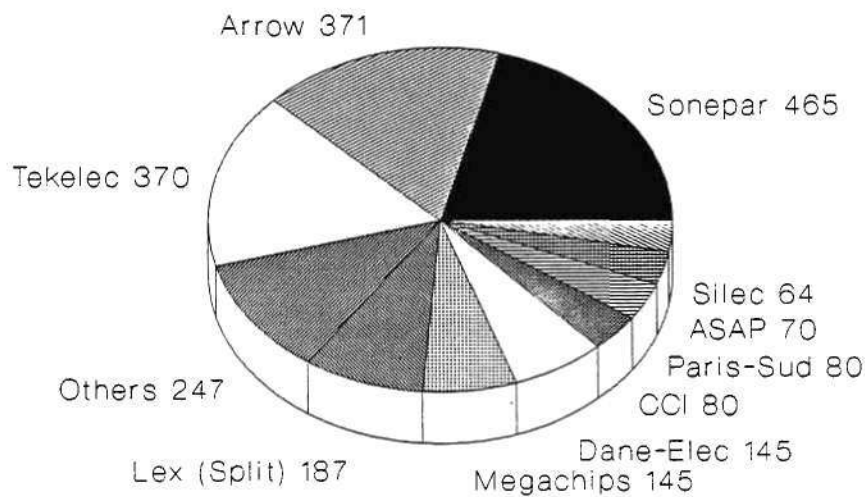
## France - 1991 Sales of Top 10 Groups



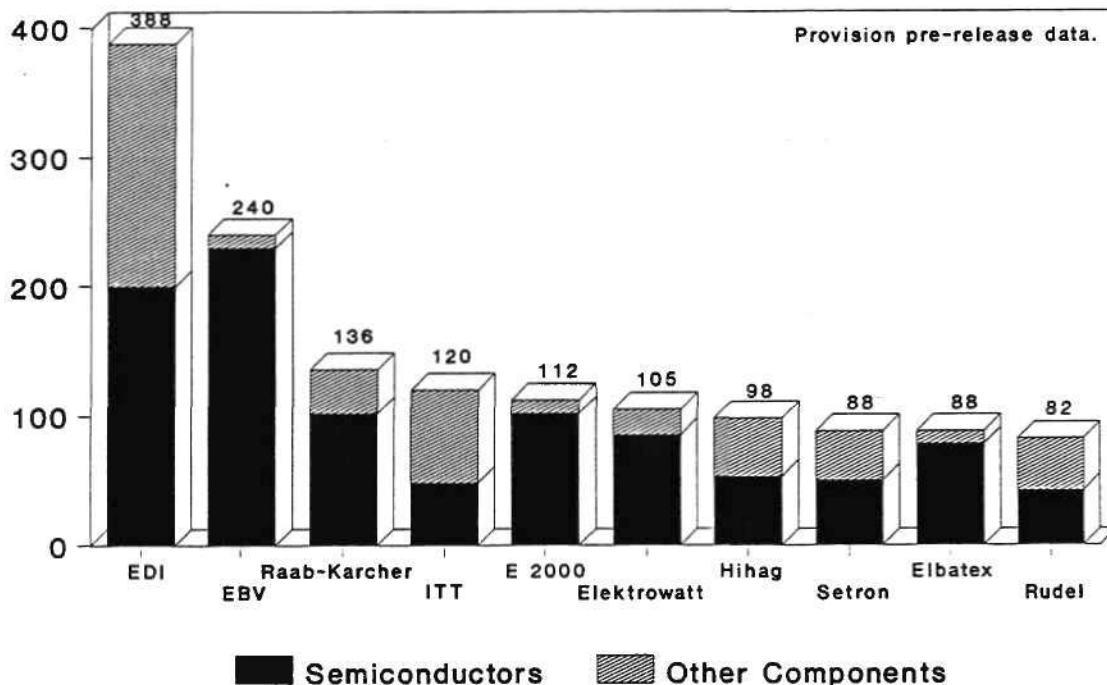
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# Semiconductor Distribution France 1991 - Total Market 2224m f.f

Provisional pre-release data.

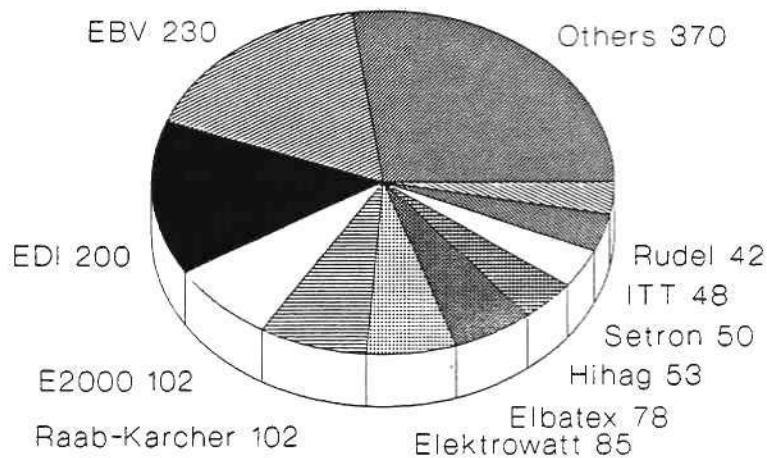


# Electronic Component Distribution Germany 1991 - Sales of top 10 Groups.

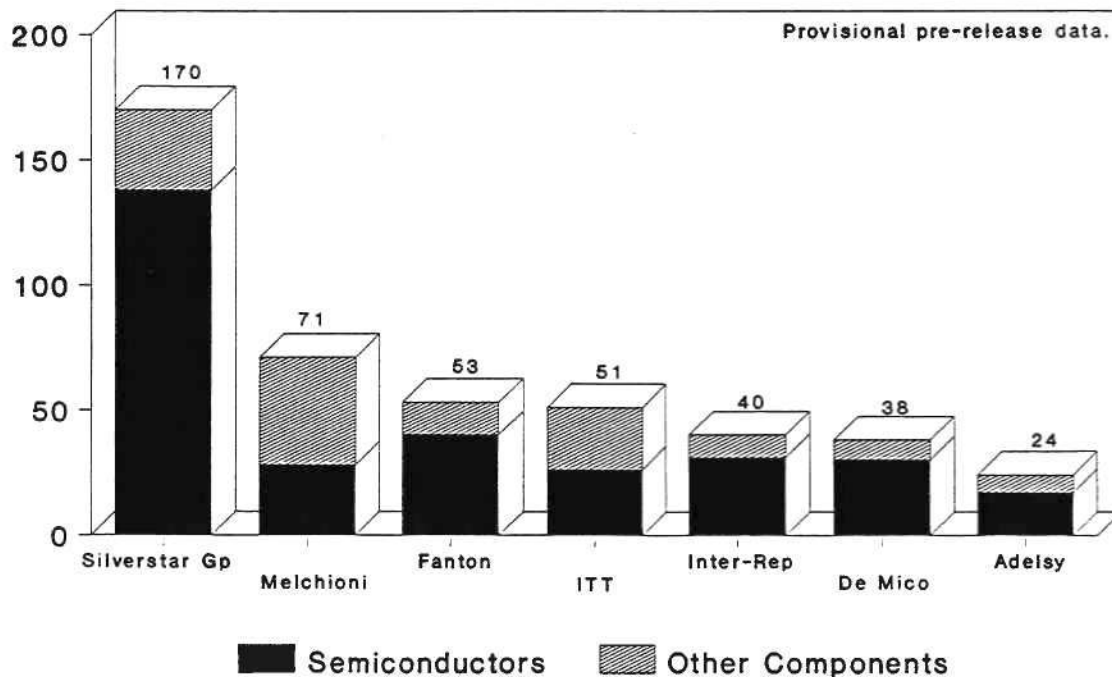


## Semiconductor Distribution Market Germany 1991 - Total Market 1360m DM.

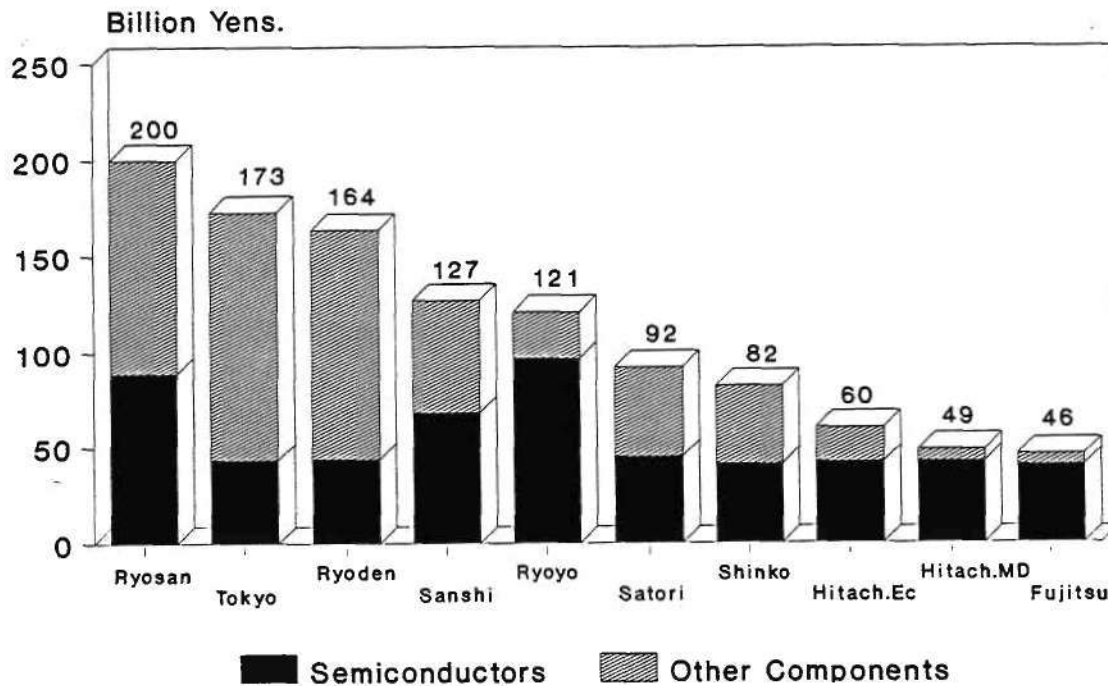
Provisional pre-release data.



## Electronic Component Distribution Italy 1991 - Sales of Top 7 Groups

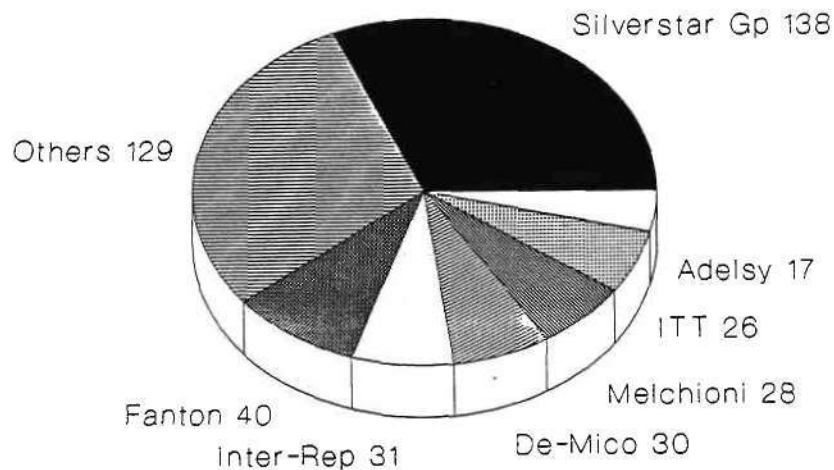


## Electronic Component Distribution Japan 1990 - Sales Of Top 10 Disti.



## Semiconductor Distribution Italy 1991 - Total Market 439 b.lira.

Provision pre-release data





## **SEMICONDUCTOR DISTRIBUTION IN THE '90s**

***Gary Kibblewhite***  
Managing Director  
Europartners Consultancy

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## **SEMICONDUCTOR DISTRIBUTION IN THE '90s**

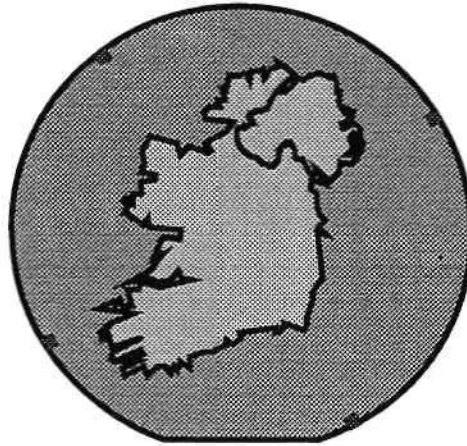


Gary Kibblewhite  
Managing Director  
Europartners Consultancy

Mr. Kibblewhite is Managing Director of Europartners Consultancy with partners throughout Europe and associates in the United States and Japan. In addition he is a consultant for Dataquest Europe Ltd., Chairman of the Association of Franchised Distributors of Electronic Components in the United Kingdom, and the first Chairman for the newly formed International Distribution of Electronics Association. He is also the European partner for Fleck International, the major US-based connector market research organization, and a Director of the Abacus Distribution Group. Mr. Kibblewhite has been in senior positions in the electronic components industry in Europe for over 30 years, and has been awarded the Institute of Directors' Diploma in Company Direction.

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**This presentation was not available  
at the time of publication**



## STRATEGIC END-USER TRENDS

***Bipin Parmar***

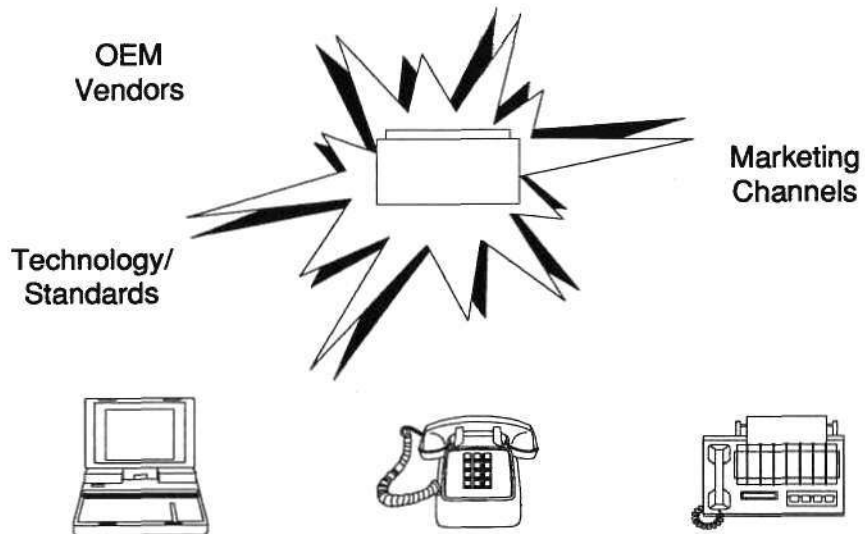
Group Director European Semiconductors  
and Conference Chairman  
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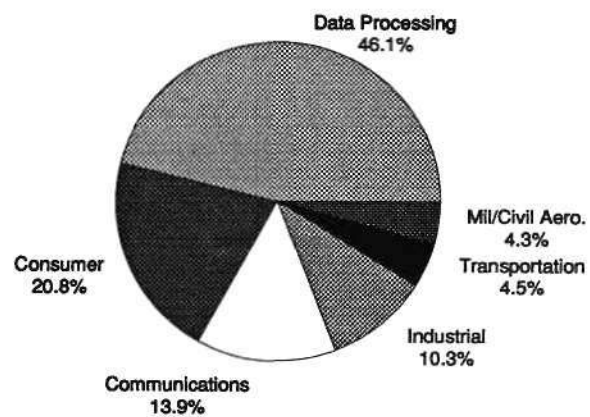
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## END-USER STRATEGIC TRENDS

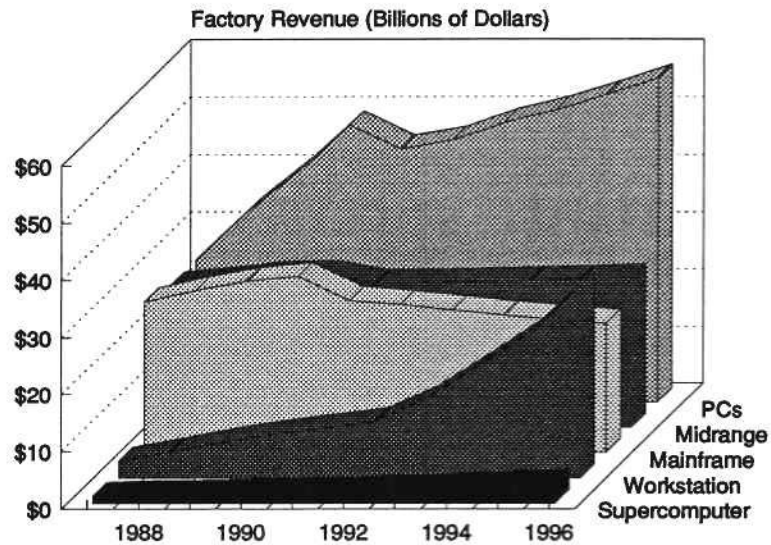


## WORLDWIDE SEMICONDUCTOR CONSUMPTION BY APPLICATION SEGMENT



Source: Dataquest

## WORLDWIDE COMPUTER SYSTEMS PRODUCT SEGMENTATION



Source: Dataquest

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## TOP SEMICONDUCTOR USERS IN EUROPE

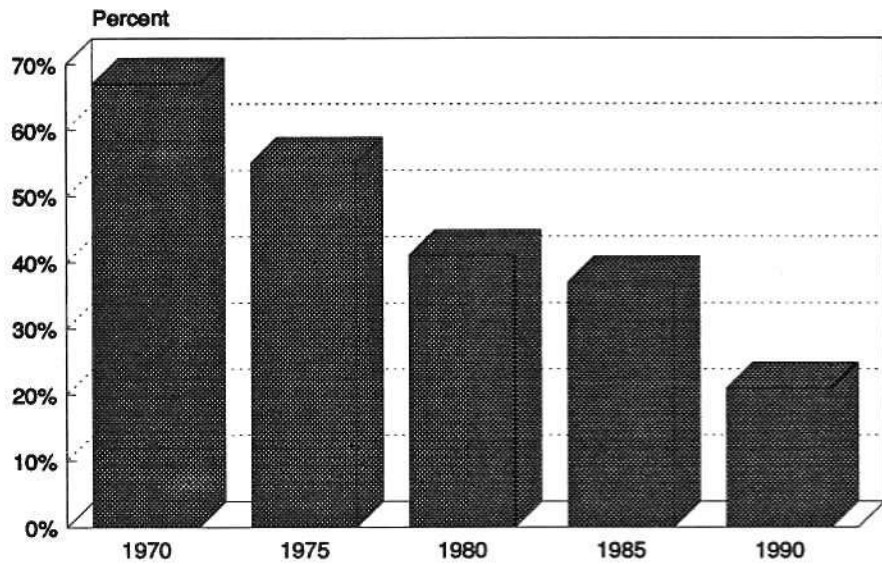
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(1991 Estimates)

1. IBM
2. Siemens
3. Philips
4. Bosch
5. Alcatel
6. Olivetti
7. Grundig
8. Nokia
9. Matsushita
10. Ericsson

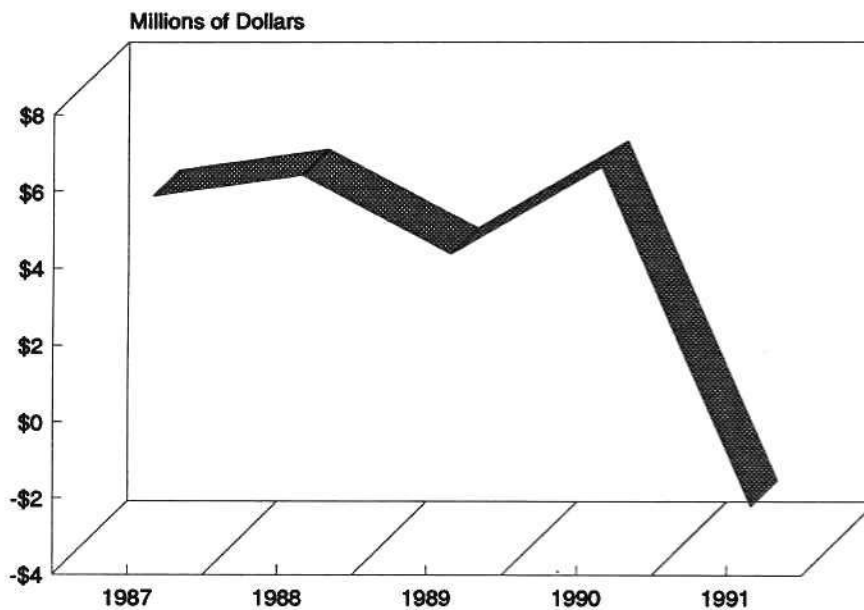
Top 50 are available in your ESAM binders

## IBM MARKET SHARE OF COMPUTER SYSTEMS WORLDWIDE



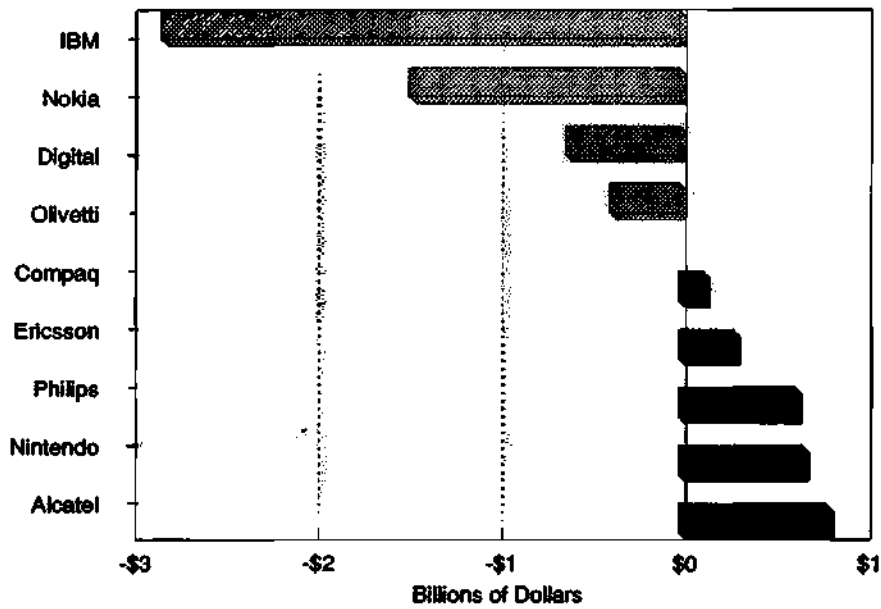
Source: Dataquest

## IBM NET EARNINGS



Source: Dataquest

## 1991 SELECTED COMPANIES PROFIT MARGINS



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## TOP EFFECTIVE PC MANUFACTURERS IN EUROPE

---

1. IBM
2. Olivetti
3. Apple
4. Bull
5. Commodore
6. Siemens Nixdorf
7. Victor
8. Tulip
9. Acorn
10. Nokia Data Systems

## UNIT PC MARKET SHARE BY MAIN MARKETS

### UNITED KINGDOM

1. Commodore
2. IBM
3. Compaq
4. Atari
5. Apple

### GERMANY

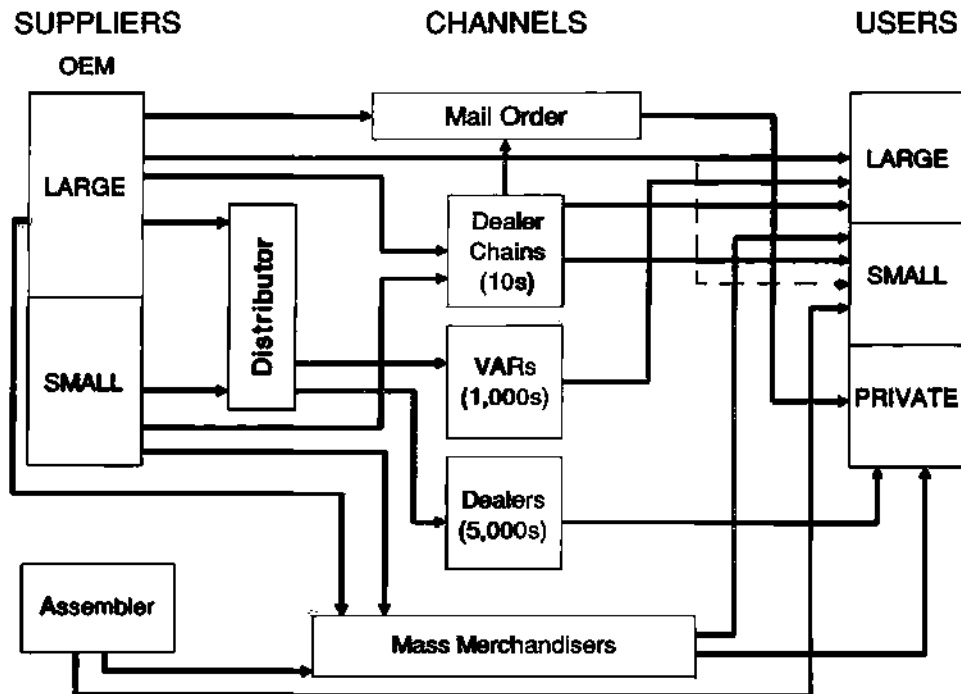
1. Commodore
2. Vobis
3. IBM
4. Atari
5. Siemens-Nixdorf

### FRANCE

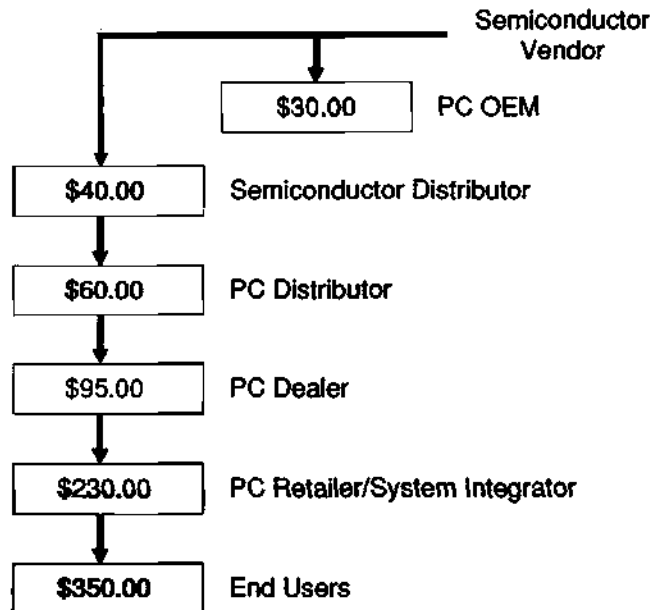
1. IBM
2. Apple
3. Compaq
4. Commodore
5. Atari

### ITALY

1. Olivetti
2. IBM
3. Commodore
4. Apple
5. Zenith Data Systems



## 1MBx9 SIMM (MEMORY MODULE)



## THE BIRTH OF A NEW SET OF CUSTOMERS

### UNITED KINGDOM

1. Computercenter
2. Dixons
3. Centre File
4. Specialist Computers
5. Businessland UK

### FRANCE

1. Agena
2. ISTA
3. Random
4. Asystel Conseil et Service
5. ECS Diffusion

### GERMANY

1. Component Computer Gruppe
2. Computerland Deutschland
3. Taylorix
4. House of Computers
5. Metro

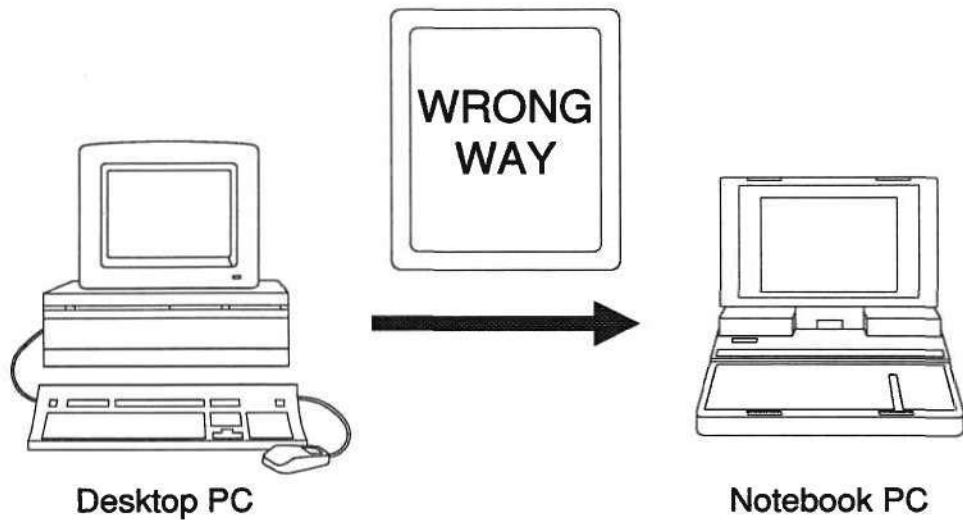
### ITALY

1. Metos
2. Asystel Sirio
3. TC Sistema
4. Winline
5. Systex Informatica

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## Downsizing

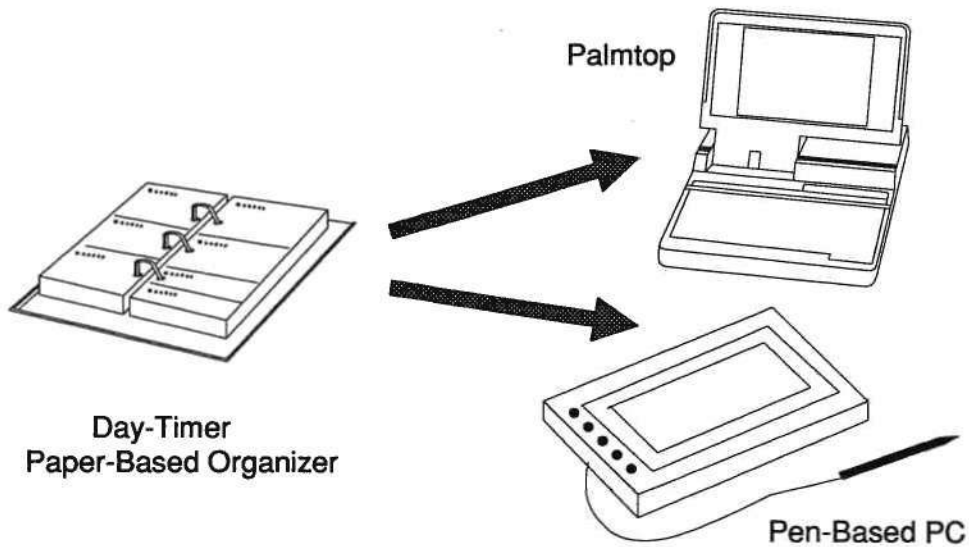
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## Emulation of Function

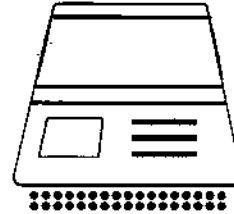
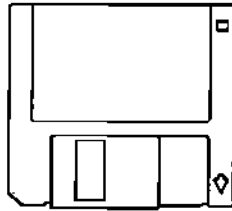
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## THE COST OF USING INFORMATION

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	Cost		Cost
Floppy:	\$1	Memory Card:	\$300
Notebook:	\$3,000	Palmtop:	\$600
Total	\$3,001	Total	\$900

---

**The Floppy Is More Expensive!**

---

## PC CARDS



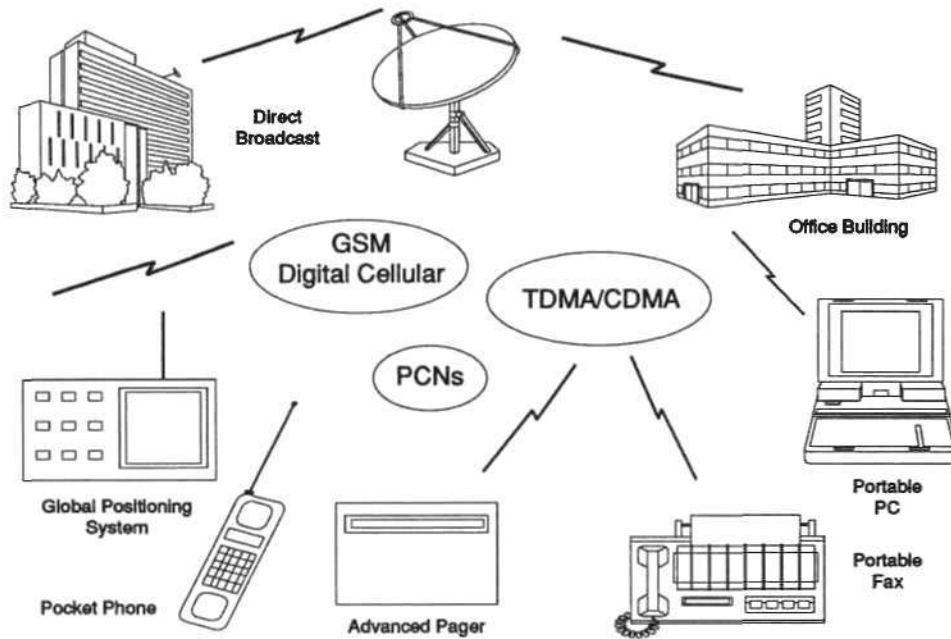
10% to 15% Margin



System  
Integrator/Retailer



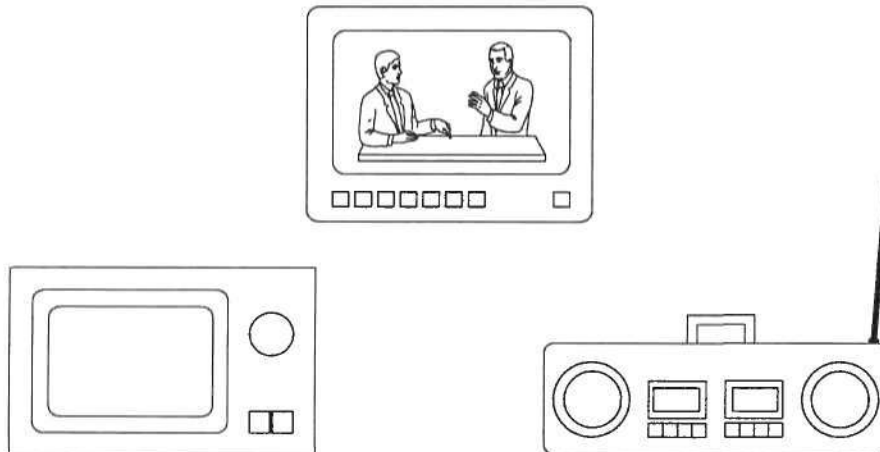
## GOING WIRELESS (AND DIGITAL)



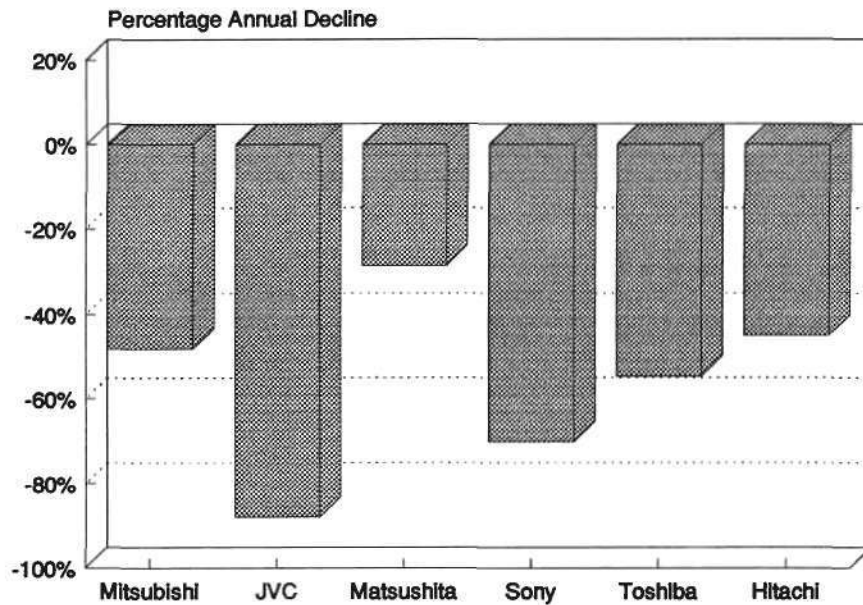
---

## CONSUMER ELECTRONICS

---



## 1990-1991 CONSUMER PROFIT DECLINES



Source: Yomiuri-Shimbun

---

## TOP 5 BANKS

---

(by Capital)

1980

1. Crédit Agricole (France)
2. National Westminster (UK)
3. Barclays (UK)
4. Bank America (US)
5. Citicorp (US)

1990

1. Somitomo (Japan)
2. Dai-ichi Kangyo (Japan)
3. Fuji (Japan)
4. Sanawa (Japan)
5. Union Bank of Switzerland

Source: The Banker

---

## JAPANESE BANKS FACE \$9,635M LOSS

---

### Bank Losses on Securities (\$M)

Sanawa Bank	1,077
Industrial Bank of Japan	732
Fuji Bank	716
Sumitomo Bank	655
Tokai Bank	629
Sakura Bank	586
Diawa Bank	540
Dai-ichi Bank	535

Source: Financial Times

---

## TRENDS IN JAPANESE COMPANIES

---

- Squeeze for higher returns
- Less frequent product cycles
- Slowdown on foreign investments
- Retrench to core products
- Alliances within Japan

---

## THE BIRTH OF EUROPEAN ZIABATSU/KEIRETSU

---

(Banks/Industrial/Electronics/Construction/Services)

Daimler-Benz

Siemens

Alcatel

Thomson

Bosch

Philips

France Telecom

---

## POSSIBLE STRATEGIES FOR OEMs

---

- Outsource manufacturing
- Concentrate on channels/mail order/  
mass merchandisers
- Application-specific PCs, PBX, telephones
- Retrench to core activities
- Software and professional services

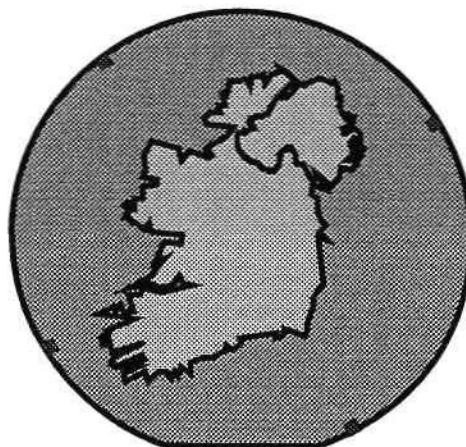
---

## STRATEGIES OF SEMICONDUCTOR VENDORS

---

- Continuously monitor customers' strategic directions
- High-growth areas may not return the best margins
- Create new organizations to address/develop new customers
- Subcontract for customer product development
- Enter the service business: training, consultancy, standards setting

X

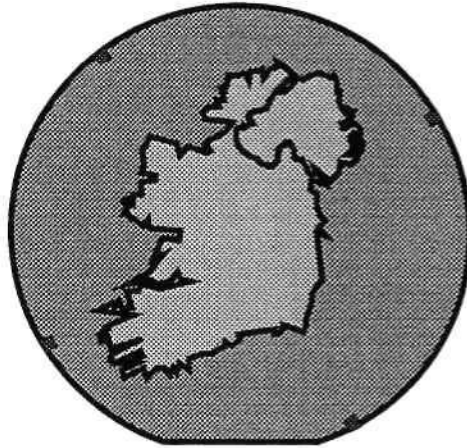


## **EMERGING APPLICATIONS AND TECHNOLOGIES: INTRODUCTION**

***Byron Harding***  
Industry Analyst  
European Semiconductor Group  
Dataquest Europe Limited

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## PC CARDS

***John Reimer***

Chairman and President

Personal Computer Memory Card International Association

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## PC CARDS



John Reimer  
Chairman and President  
Personal Computer Memory  
Card International Association

Mr. Reimer is Vice President of Marketing for SunDisk Corporation, a start-up company based in Santa Clara, California, which specializes in flash memory technology and systems. He joined SunDisk from Fujitsu Microelectronics, where he managed the IC Memory Card business unit. Mr. Reimer pioneered the formation of the Personal Computer Memory Card International Association (PCMIA) and is currently Chairman and President of the organization. Prior to this he managed Fujitsu's Microcomputer and Communication Products group before starting the IC Memory Card business unit in 1989. Prior to Fujitsu, he held various engineering and management positions in Texas Instruments. Mr. Reimer has a BSEE from the University of Illinois, United States.

Dataquest Europe Limited  
**EUROPEAN SEMICONDUCTOR INDUSTRY CONFERENCE**  
June 3-5, 1992  
Dublin, Ireland

# PCMCIA INDUSTRY FORUM

Mobile Computing Opportunities



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## PCMCIA INDUSTRY FORUM

### Mobile Computing Opportunities Sparked by PC Cards

**John Reimer**

SunDisk Corporation

PCMCIA President & Chairman

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**PCMCIA INDUSTRY FORUM**  
*Mobile Computing Opportunities*

---

PCMCIA INDUSTRY FORUM



**Objectives**

- ▼ **Market Demands**
- ▼ **Motivation for PC Cards**
- ▼ **Market Opportunities**
- ▼ **PCMCIA Accomplishments**
- ▼ **PCMCIA Future Direction**

3

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PCMCIA INDUSTRY FORUM



***Mobiles are Experiencing Explosive Growth***

- ▼ **1 in 3 Computers Sold Worldwide in 1995 will be Mobile**

Source: Forrester Research

4

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PCMCIA INDUSTRY FORUM



## ***Today's Mobile Computer User Critical Buying Factors***

- ▼ Physical Size
- ▼ Weight
- ▼ Battery Run-Time
- ▼ Display Quality
- ▼ Application Compatibility
- ▼ Keyboard
- ▼ CPU Performance
- ▼ Communications Capability
- ▼ Cost

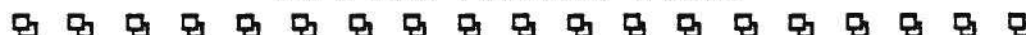
Source: Venture Development Corporation

5

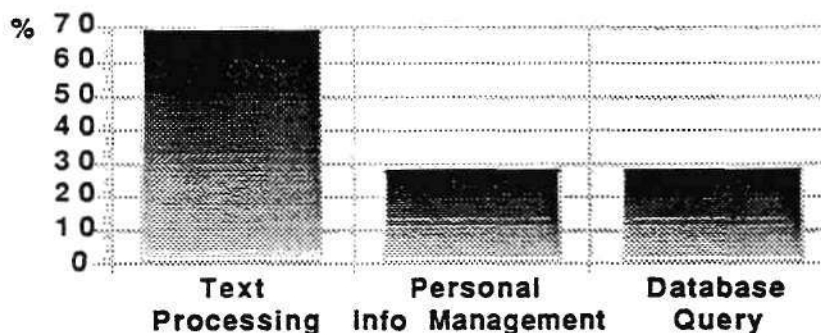
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## ***Most Important Applications for a Mobile Computer***



Note: Percentage Totals Over 100% Due to Multiple Responses

Source: Venture Development Corporation

6

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## PCMCIA INDUSTRY FORUM

Mobile Computing Opportunities

### PCMCIA INDUSTRY FORUM



## **Impact of Solid-State Storage**

- ▼ **A New Generation of Mobile Computers Will Use PC Cards to Better Meet End User's Critical Buying Factors**
- ▼ **First Generation PC Card Products Have Been Introduced**

7

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### PCMCIA INDUSTRY FORUM



## **Next Generation PC Card Products**

- ▼ **Pen-Based Products**
  - Ruggedness
  - High Capacity Removable Media
  - Low Power Consumption
  - Size
  - Weight



8

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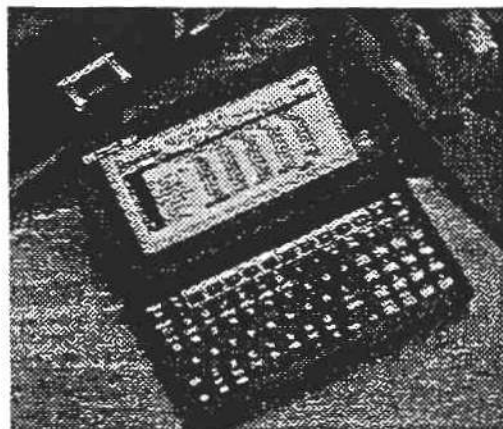
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## Next Generation PC Card Products

### ▼ Palmtop Computers

- Size
- Low Power
- High Capacity Removable Media
- Weight
- Ruggedness



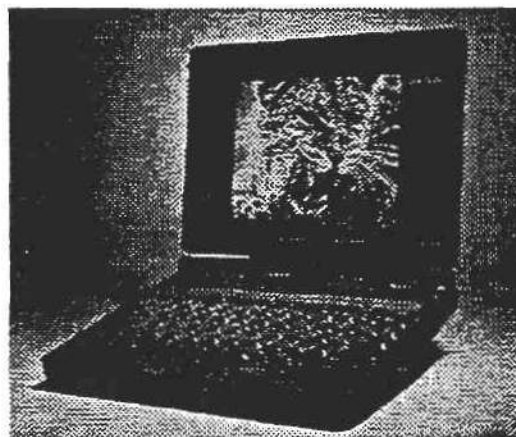
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## Next Generation PC Card Products

### ▼ Sub-Notebook

- Size
- Low Power
- OS Compatibility
- Ruggedness
- Weight
- High Capacity Removable Media



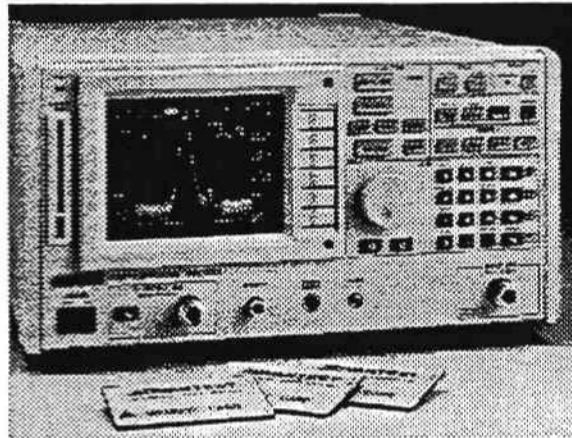
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## **Next Generation PC Card Products**

### ▼ **Application Specific Computers**

- Removability
- Size
- Weight
- Low Power



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## **Notebook Market**

### ▼ **Sub-Notebook**

- Mobility
- Connectivity

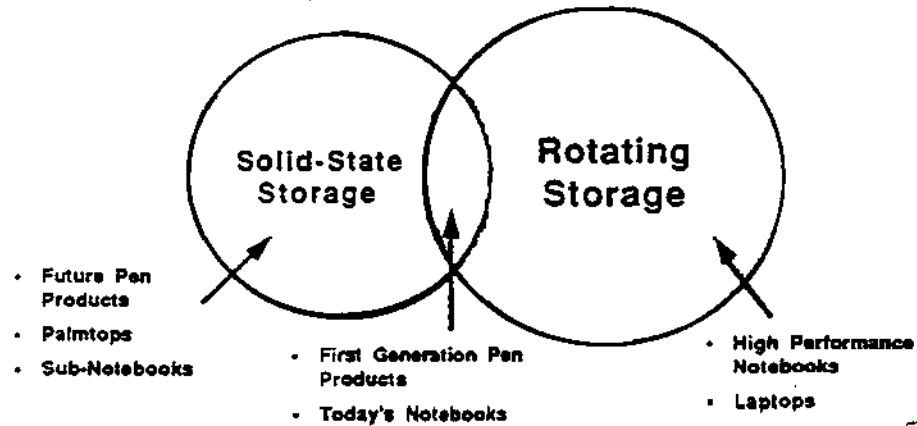
### ▼ **Notebook**

- Performance
- Maximum Storage Capacity



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## **Solid-State Storage will Coexist with Rotating Storage**



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## **Standards Accelerate Adoption of New Technologies**

- ▼ Reduce Risk
- ▼ Increase Component Supply base
- ▼ Lower Cost
- ▼ Increase Market Size





## PCMCIA INDUSTRY FORUM

Mobile Computing Opportunities

### PCMCIA INDUSTRY FORUM



## **PCMCIA 2.0 Release**

*"Mobile Computing Market Opportunities Sparked  
by Solid State PC Cards"*

- ▼ **September 16, 1991**
- ▼ **Key Industry Leaders  
Gave Vision for the  
Future**
- ▼ **Over 200 Attendees  
(30 Press)**



### PCMCIA INDUSTRY FORUM



## **Opportunities Created By PC Cards - Hardware Companies**

- ▼ **Unprecedented Mobility**
- ▼ **New Classes of Mobile Computer  
Enabled**
  - Palmtop, Pen-Based, Sub-Notebook
  - Imaging Systems
  - Application Specific



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**Opportunities Created By PC Cards  
- Hardware Companies (Continued)**

▼ **Supporting Hardware**

- Reader/Writers
- Programmers
- Test Equipment
- Data loggers



PCMCIA INDUSTRY FORUM



**Opportunities Created By PC Cards  
- Software Companies**

- ▼ **New Class of Applications for  
Mobile Users**
- ▼ **Early Market Entry Critical to  
Secure Market Position**



## PCMCIA INDUSTRY FORUM

Mobile Computing Opportunities

### PCMCIA INDUSTRY FORUM



## **Opportunities Created By PC Cards - End Users**

- ▼ **The Functionality of Next Generation Mobile Computers Combined with New Applications, Will give their Users a Competitive Advantage**

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### PCMCIA INDUSTRY FORUM



## **Future Direction**

- ▼ **Continue to be Market Driven**
  - Identify and Respond to New Marketing Needs
  - Respond to Activity in Communications Area
- ▼ **Focus on Educating Software Developers**
- ▼ **Focus on Educating Users**

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**PCMCIA INDUSTRY FORUM**  
*Marketing Overview*

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**PCMCIA INDUSTRY FORUM**

**PCMCIA Marketing  
Overview**

**Kathy Kriner**

Memory Card Systems & Design

PCMCIA Marketing Committee Chairman

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*Marketing Overview*

**PCMCIA INDUSTRY FORUM**



**Objectives**

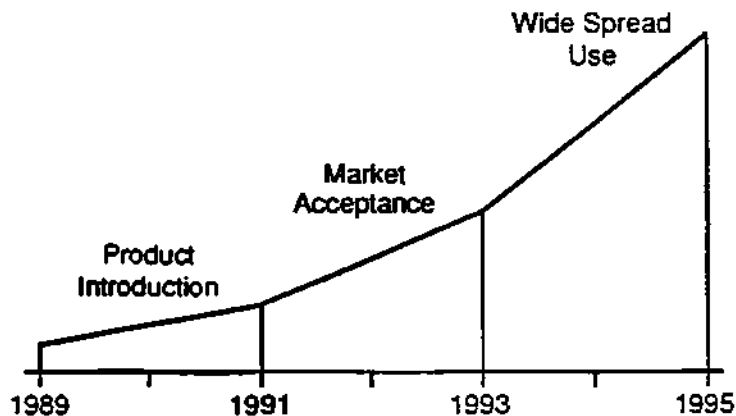
- ▼ **Indicate Size of the Current Market**
- ▼ **Provide Exposure to Variety of Application Areas**
- ▼ **Review Factors Effecting Growth**
- ▼ **Accomplishments**
- ▼ **Future Tasks**



**PCMCIA INDUSTRY FORUM**



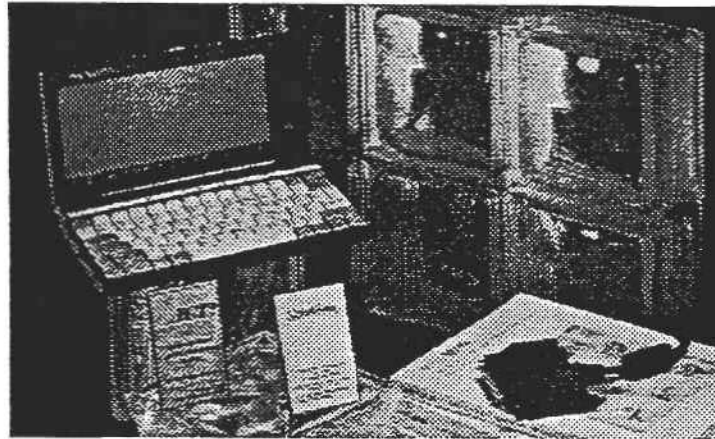
**PC Card Market Trend**



# PCMCIA INDUSTRY FORUM

## Marketing Overview

### PCMCIA INDUSTRY FORUM

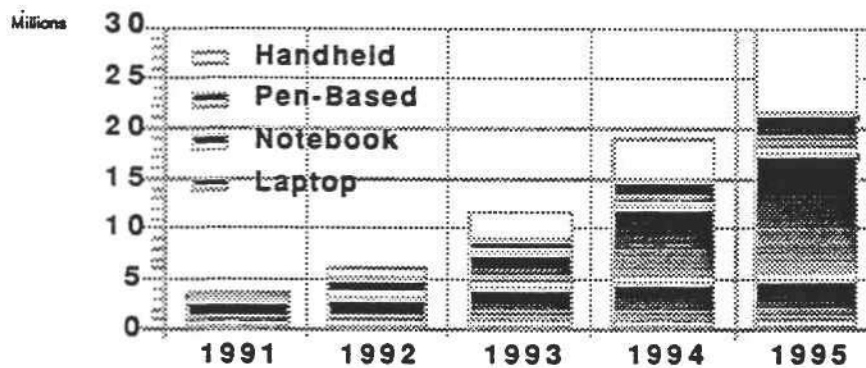


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### PCMCIA INDUSTRY FORUM

## Worldwide Portable PC Forecast



Source: Dataquest January 1992

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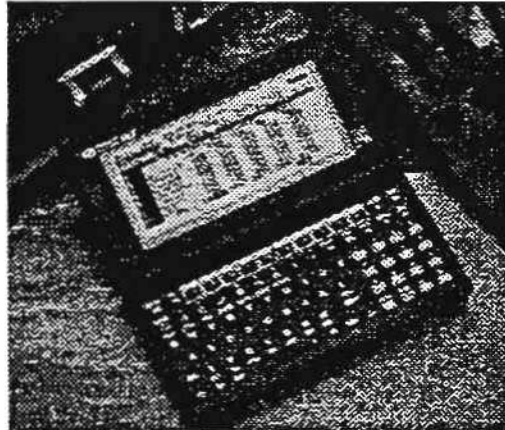
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**Example: HP**



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**Example: SCM**



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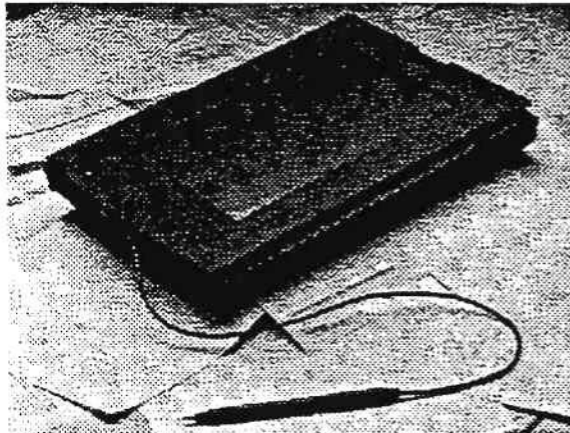


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Marketing Overview

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**Example: Grid**



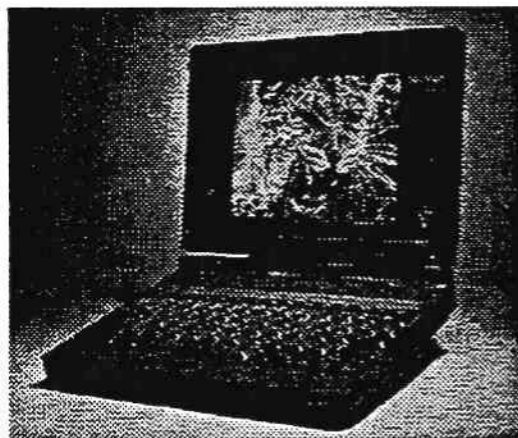
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**Example: Sharp Notebook**



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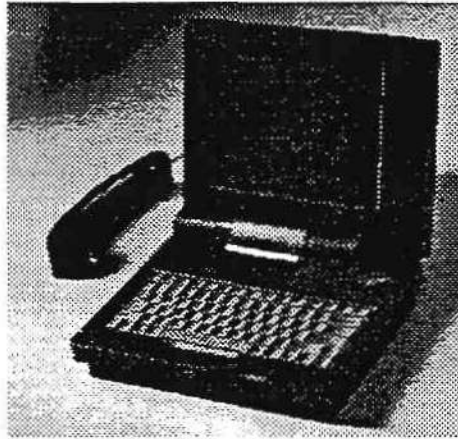
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**Example: IBM PCradio**



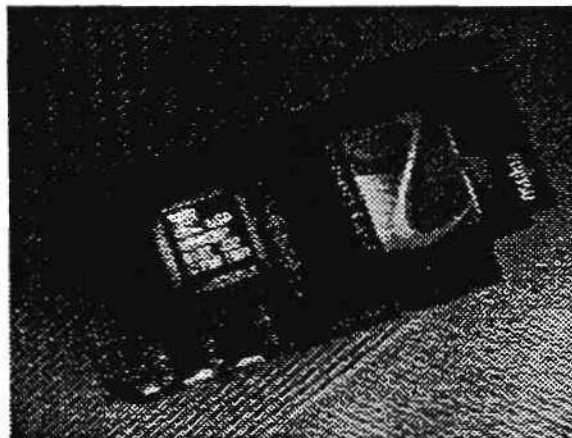
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**Fujitsu MB86301**



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**Databook Programmer**



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□ □ □ □ □ □ □ □ □ □ □ □ □ □ □ □ □ □ □ □

**Adtron Programmer**



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*Marketing Overview*

PCMCIA INDUSTRY FORUM



***Environments and Application Areas***

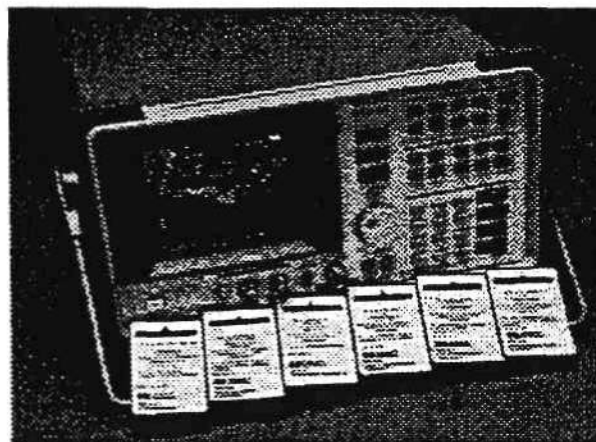
- ▼ **PC Market**
- ▼ **System Design and Prototyping**
- ▼ **Manufacturing/Industrial**
  - Test Equipment
  - Industrial Control Systems
  - Robotics
- ▼ **Commercial Retail**
  - Office Automation
  - Digitized Music
  - Multimedia Systems
  - Data Applications



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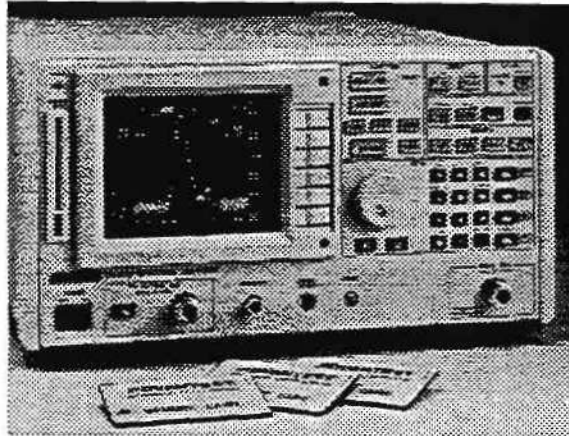
***HP Spectrum Analyzer***



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**Advantest Spectrum Analyzer**



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**MIDI**



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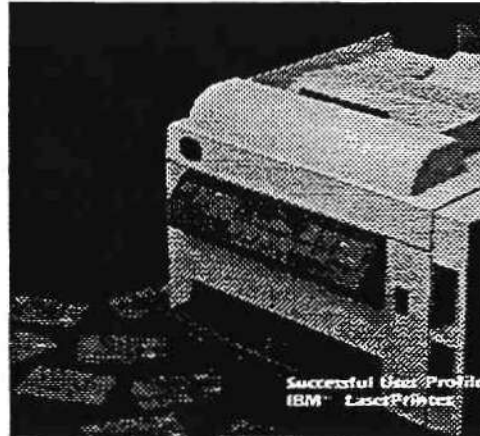


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*Marketing Overview*

PCMCIA INDUSTRY FORUM



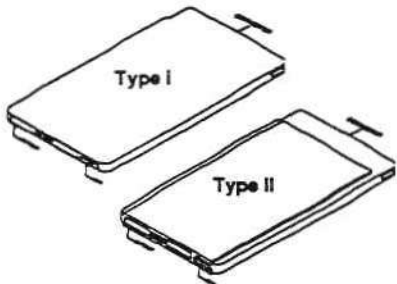
**IBM Laser Printer**



PCMCIA INDUSTRY FORUM



**Standard Card Configurations**

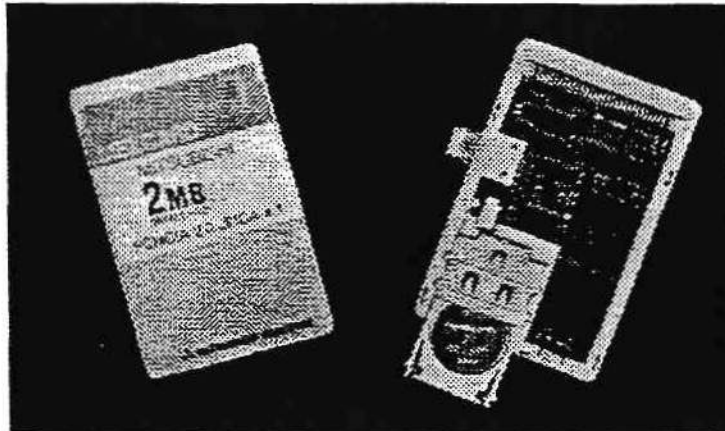
Standard Card Configurations	Implementations	
Type I and II Cards 	Memory PC Cards	I/O PC Cards
	SRAM ROM EPROM EERPOM FLASH	AIMS Solid-State Mass Storage Fax/Modem



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Marketing Overview

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**Mitsubishi Cards**



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**MIPs Cards**



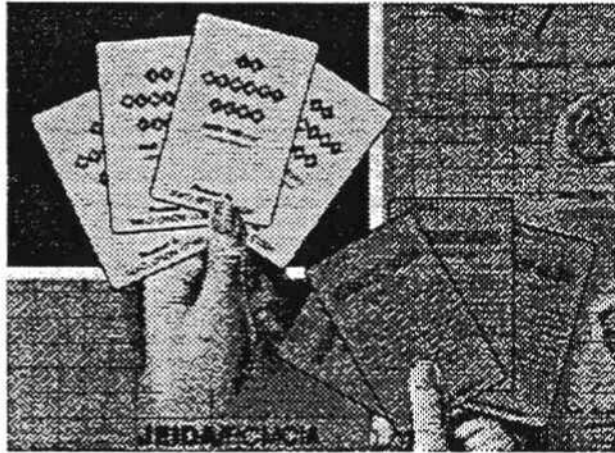
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**Epson Cards**

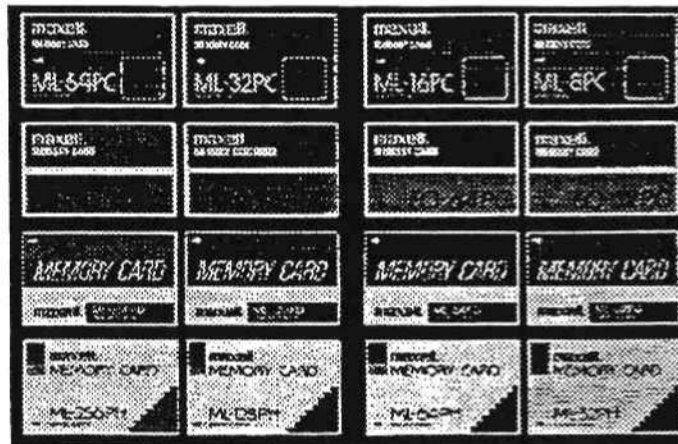


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**Maxell Cards**



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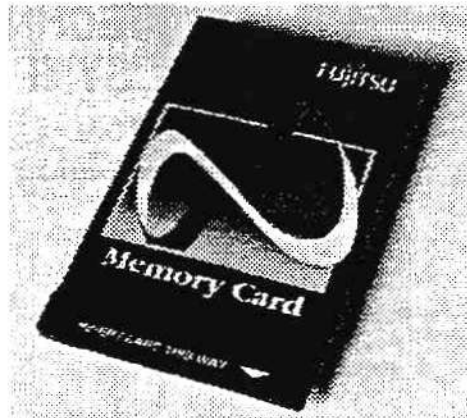


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**Fujitsu Cards**



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**Micron Cards**



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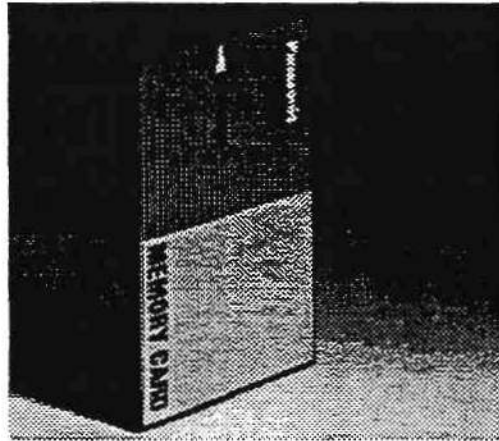




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**Panasonic Cards**

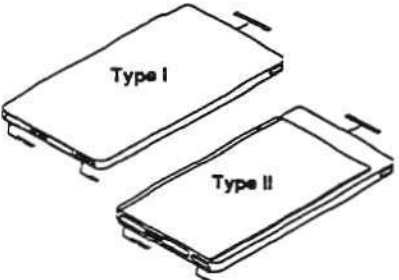


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**Standard Card Configurations**

Standard Card Configurations	Implementations	
	Memory PC Cards	I/O PC Cards
Type I and II Cards 	SRAM ROM EPROM EERPOM FLASH	AIMS Solid-State Mass Storage Fax/Modem

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Intel EXCA Card



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Sundisk Card



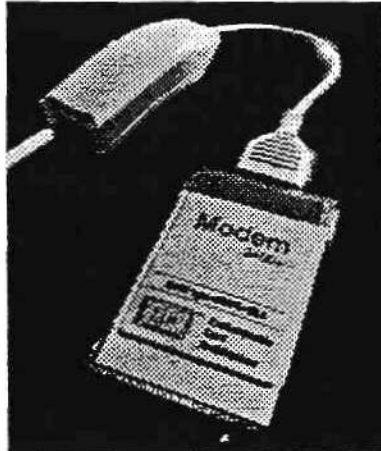
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## **Intel Modem Card**



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## **Market Growth Factors**

- ▼ **Benefits of the Technology**
- ▼ **Development of Standards**
- ▼ **Expansion of Applications**

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# PCMCIA INDUSTRY FORUM

## Marketing Overview

### PCMCIA INDUSTRY FORUM



## Laptop Computer World Market Forecast

CPU Type	1989	1990	1991	1992	1993	1994	1990 - 1994 Compounded Growth Rate
8088 / 86	658	504	499	364	194	82	-36.45%
80286	677	898	581	474	254	0	-100.00%
80386SX	60	257	782	1215	997	457	15.43%
80386DX	46	80	180	292	1191	2285	131.26%
80486	0	0	0	0	14	61	—
TOTAL	1141	1739	2042	2345	2650	2885	14.46%

K Units

Source: Dataquest, October 1990

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### PCMCIA INDUSTRY FORUM



## Selectronics Bible



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## Marketing Overview

## PCMCIA INDUSTRY FORUM



## Selectronics Encyclopedia



**PCMCIA INDUSTRY FORUM**



## Environments and Application Areas

### ▼ PC Market

## ▼ System Design and Prototyping

▼ **Manufacturing/Industrial**

- Test Equipment
- Industrial Control Systems
- Robotics

### ▼ Commercial Retail

- Office Automation
- Digitized Music
- Multimedia Systems
- Data Applications



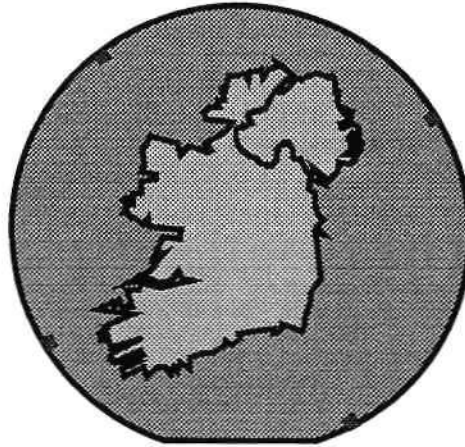
PCMCIA INDUSTRY FORUM



**Future Tasks**

- ▼ **Continue to Promote PC Card Technology**
  - Symposium
  - Trade Show Participation
  - Press Relations
- ▼ **Provide a Strong Marketing Orientation**
- ▼ **Develop "Sales Collateral"**
  - Research and Survey Work





## PERSONAL COMMUNICATIONS

***Dean Eyers***  
Industry Analyst  
European Telecommunications Group  
Dataquest Europe Limited

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Roussel House, Broadwater Park, Denham, Uxbridge, Middx UB9 5HP / 0895 835050 / Tlx 266195 / Fax 0895 835260

## PERSONAL COMMUNICATIONS



Dean Eyers  
Industry Analyst  
European Telecommunications Group  
Dataquest Europe Limited

Mr. Eyers is an Industry Analyst for Dataquest's European Telecommunications Group (ETG) and is located in Denham, England. He is responsible for research in the mobile communications area. Prior to joining Dataquest, Mr. Eyers worked in market research, following a Business Management course at Sunderland Polytechnic Business School. Mr. Eyers received a B.Sc. honours degree in Psychology from the University of Newcastle upon Tyne.

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**EUROPEAN SEMICONDUCTOR INDUSTRY CONFERENCE**  
June 3-5, 1992  
Dublin, Ireland



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## PERSONAL COMMUNICATIONS IN EUROPE

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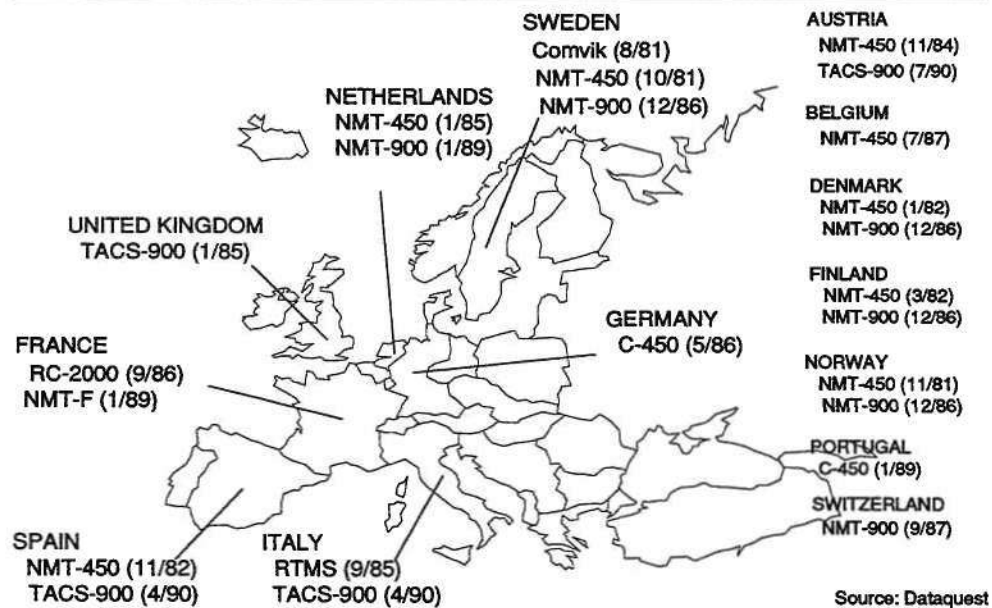
### AGENDA

- Analog Cellular
- GSM Digital Cellular
- DCS 1800
- Digital Cordless Telephony

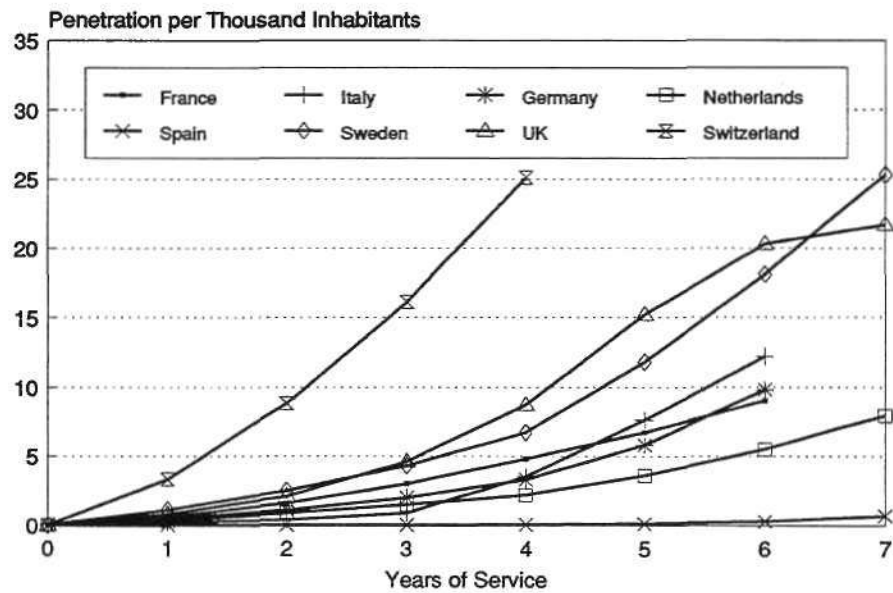
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### ANALOG CELLULAR SYSTEMS IMPLEMENTATION BY COUNTRY

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## PENETRATION BY MAJOR COUNTRY BY YEAR



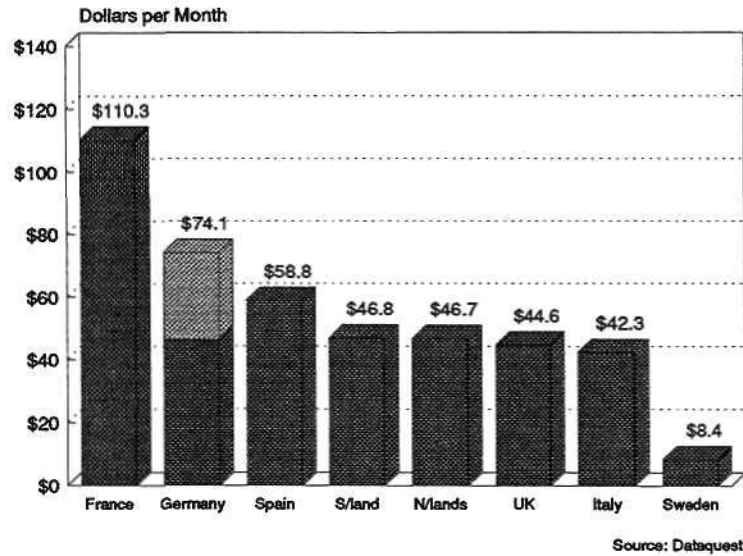
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## KEY FACTORS IN CELLULAR MARKETS

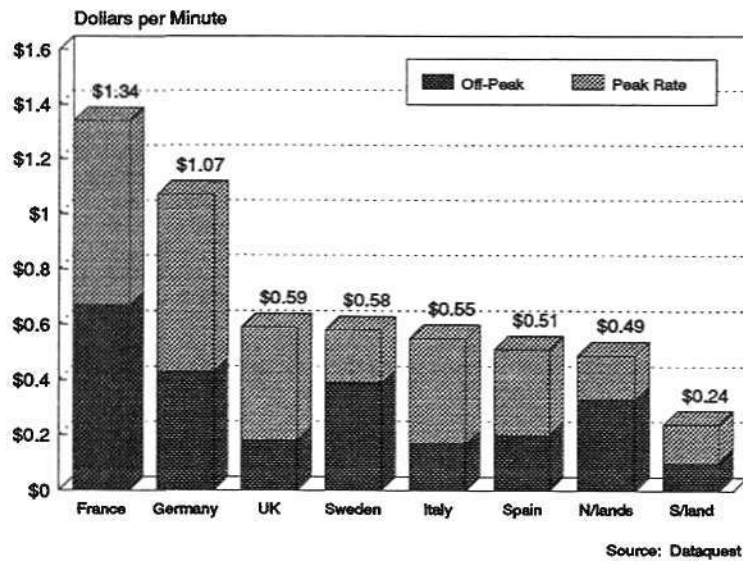
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- Pricing
  - Equipment
  - Tariffs
- Coverage
- Capacity
- Service/quality
- Equipment features/availability
- Demographics/economics

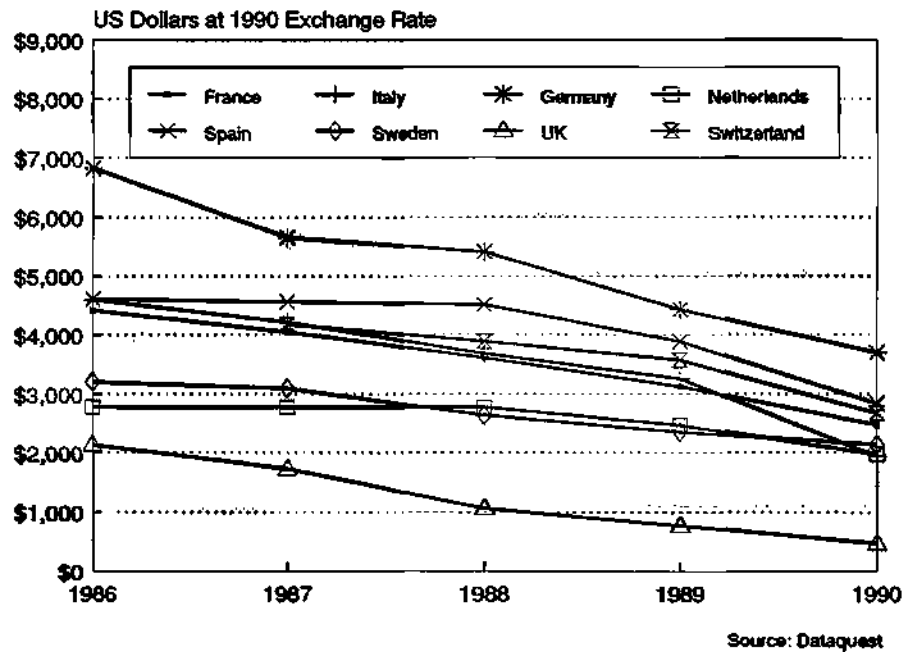
## EUROPEAN CELLULAR SUBSCRIPTION FEES



## EUROPEAN CELLULAR CALL CHARGES



## CELLULAR TELEPHONES - END-USER PRICES



## ANALOG CELLULAR MARKET TRENDS

- Still predominantly business market
- Recession leading to slowdown
- Interim analog networks supporting growth
- Capacity available on many systems
- New tariff packages in Nordic countries

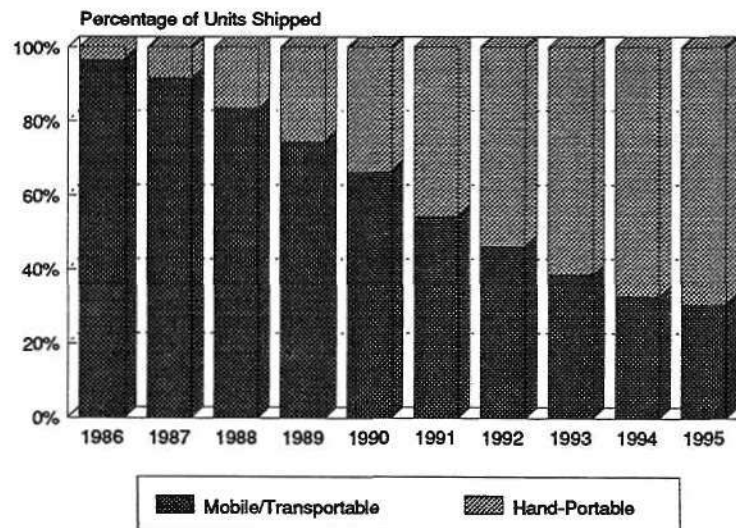
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## ANALOG CELLULAR MARKET TRENDS

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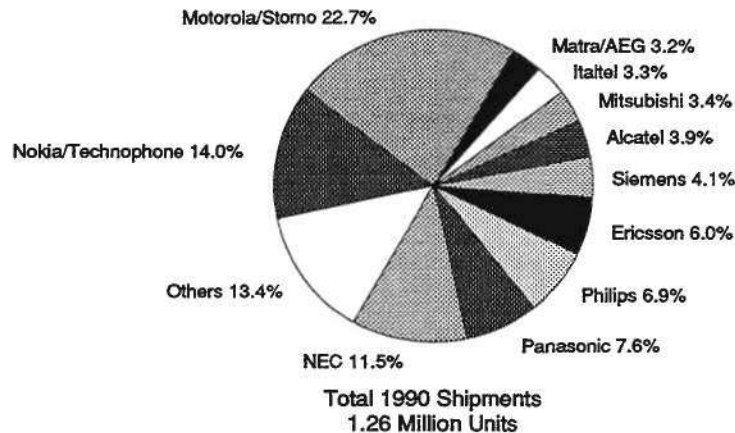
- Strongest growth in hand-portable sector
- Major players cover Europe
- Many early specialists acquired
- Some new entrants

## EUROPEAN ANALOG CELLULAR SHIPMENTS



Source: Dataquest

## EUROPEAN CELLULAR TELEPHONE MARKET



Source: Dataquest

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### ANALOG CELLULAR LIMITATIONS

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- Spectrum availability limits capacity
- Economies of scale for infrastructure and terminal suppliers limited by fragmented market
- Tariffs and terminal prices relatively high
- Scope for further growth is generally limited to business users
- Congestion in areas of high-user density
- Potential new competitors deterred from entry

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## REASONS FOR GSM

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- Realization of spectrum limitation
- Harmonized system in all CEPT countries
- Digital Technology
- Gives Europe a leading edge

---

## KEY FACTORS FOR GSM - PRICING

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### Handsets

- Components more expensive
- Heavy cost of research & development
- Economies of scale potentially greater
- Greater competition

Initially higher price than analog, significant erosion once critical market size attained

---

## KEY FACTORS FOR GSM - PRICING

---

### Service Tariffs

- Competing operators
  - Existing operators want smooth migration
  - New operators want fast growth, max. ROI
- Service providers in major territories
- Greater competition for infrastructure supply
- Innately higher spectrum efficiency
- Ultimately, lower cost per subscriber

Tariffs/package price to drop with competition

---

## KEY FACTORS FOR GSM

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Coverage - Initially limited compared to analog

Capacity - More spectrum available - EC directive  
- More spectrum efficient

Quality - Better speech quality, more reliable

Features - More sophisticated services available  
- Product differentiation stimulated by competition



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## DELAYS IN GSM

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- Specifications set late, incomplete
  - Still changing
  - Some features delayed until phase II
  - Ongoing problems with type approval
- Operators still have capacity on analog networks
- Inter-country roaming arrangements to be agreed
- Second operators licensed late, more to come

Market development largely dependent on level of support from operators and manufacturers

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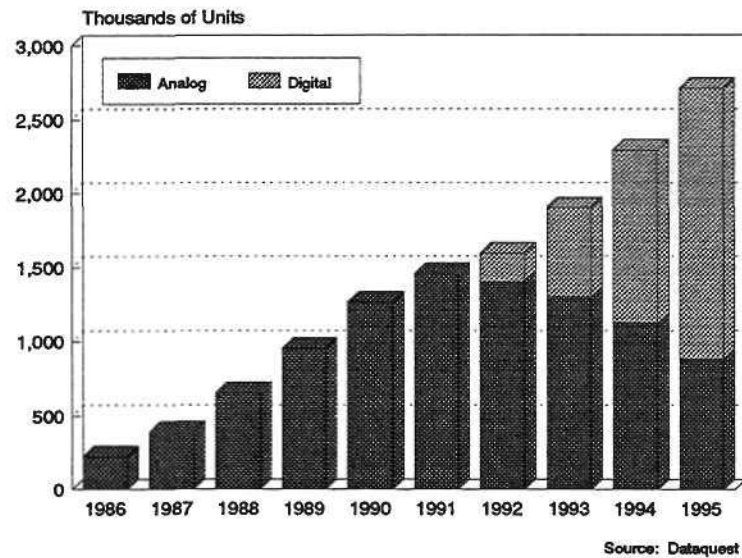
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## GSM - MARKET PROSPECTS

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- GSM has slipped but not fallen
- Growth will begin in earnest next year, driven by majors with unexploited potential - Germany and France
- Competition will be fierce - expect second wave of terminal suppliers during 1993
- GSM terminal shipments to overtake combined analog in 1994/5
- Terminal market to grow to \$2.3 billion by 1995

## EUROPEAN CELLULAR SHIPMENTS



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## DCS 1800 IN EUROPE

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- PCN concepts of UK's DTI
- GSM specification at 1.8 GHz
- Microcellular applications
- Three licenses in UK - down to two
- License to be issued in Germany

---

## DCS 1800 IN EUROPE

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- Main advantage over GSM is extra capacity
- Disadvantage is network investment
- PSTN competition demands political will and long-term investment
- Possible application in underdeveloped territories
- Western Europe - focus is mobility

---

## DIGITAL CORDLESS TELEPHONY

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- Two major standards:
  - DECT
  - CT2/CAI
- Three major applications:
  - Office System - cordless PBX platform
  - Telepoint - portable PSTN access service
  - Residential - home base station
- Possible future applications:
  - Local loop - Telepoint to the home
  - Personal Communications Network

---

## TELEPOINT STATUS IN EUROPE

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- UK failure - not a valid test
- Services to launch this year in France, Netherlands and UK - others watching
- Success will depend on positioning and operator support in national market
- Critical mass of business terminals would provide major boost
- CT2 still has window of opportunity

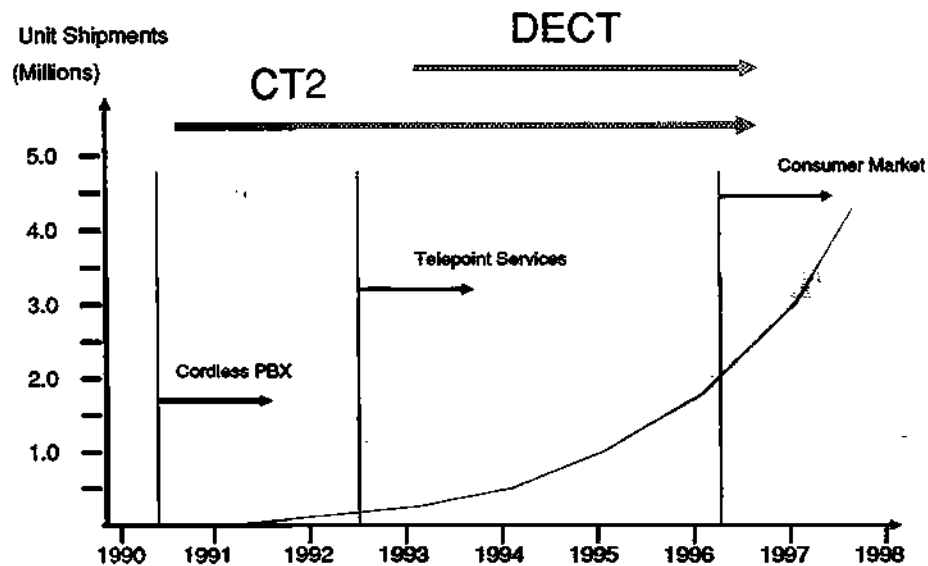
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## CORDLESS PBX ENVIRONMENT

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- Products must meet general price/feature criteria
- Competition between standards and with analog cordless alternative
- Standards/approvals bodies play key role
- Telepoint may be a differentiator
- Related technologies may influence market

## EUROPEAN DIGITAL CORDLESS TELEPHONY (TECHNOLOGY APPLICATION TRENDS)



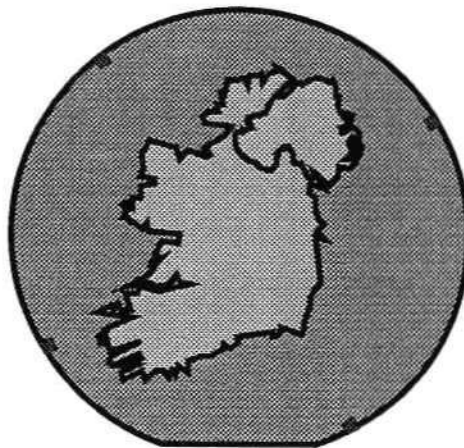
Source: Dataquest

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## PERSONAL COMMUNICATIONS IN EUROPE

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- A pan-European market
- Technologies in competition
- A realistic dream?
- Leading the world



## VIDEOPHONES

***Jeffrey Goldberg***  
Industry Analyst  
European Document Management Group  
Dataquest Europe Limited

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## VIDEOPHONES



Jeffrey Goldberg  
Industry Analyst  
European Document  
Management Group  
Dataquest Europe Limited

Mr. Goldberg is an Industry Analyst for Dataquest's European Document Management Group (EDMG) specializing in facsimile and software related to document management technology. He has more than 10 years' experience in the microcomputer industry, most recently working for Psion plc as a Senior Software Engineer managing the development of the MC600 notebook computer. Prior to this, he worked for Borland International in the United Kingdom, Denmark and the United States as European Development Manager for Future Development, focusing on products such as SideKick Plus and SideKick for Presentation Manager. Mr. Goldberg received a B.Sc. in Electrical and Electronic Engineering from City University, London.

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June 3-5, 1992  
Dublin, Ireland

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## WHAT IS VIDEO TELEPHONY?

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- Videophones
- PC Videophones
- Video Conferencing

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## WHO WANTS IT?

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- 60 percent of message = non verbal
- Phone familiar object
- Video obvious extension
- Clear cost savings



---

## TECHNOLOGY

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- Why does it not exist today?
- Bandwidth, Bandwidth...
- Image compression

---

## STANDARDS

---

- Why important?
- CCITT H.261
- Problems...

---

## ANALOG versus DIGITAL

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- ISDN or PSTN
- Coverage
- Cost
- Quality

---

## WHAT'S INSIDE THE BOX?

---

- Camera (CCD)
- LCD and drivers
- Keyboard/mini display
- CPU
- Audio codec
- Video codec
- ISDN interface/PSTN modem

---

## H.261 VIDEO CODEC

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- DCT
- Motion estimation and compensation
- Quantization
- Loop filtering
- Variable length coding/decoding

---

## QUALITY

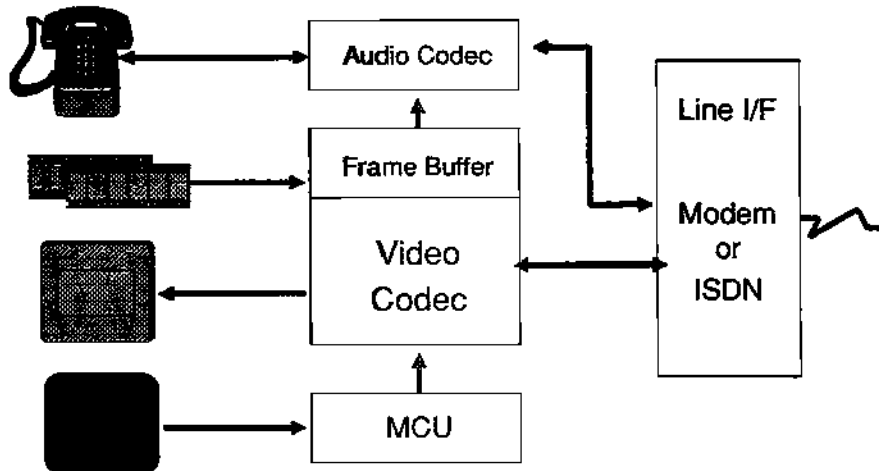
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- VGA (640 pixels by 480 lines)
- CIF (352 pixels by 288 lines)
- QCIF (176 pixels by 144 lines)
- Analog (128 pixels by 96 lines)

---

## A VIDEOPHONE IS...

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## DATAQUEST VIEW OF THE VIDEOPHONE MARKET

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- Similar to facsimile
- Slow to start until price/quality acceptable
- Strong growth
- 1995-2000 timeframe
- Potential of vast market

---

## IMPLEMENTATION OF VIDEO CODEC

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- 16-bit DSPs (TI 320C30)
- Hardwired ICs
- Peripheral chips also required

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## KEY PLAYERS

---

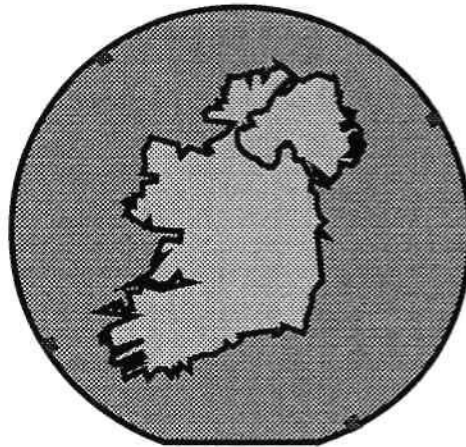
- Hitachi
- BT (and partners)
- CL/IIT
- PictureTel/Intel
- GEC-Marconi (and partners)
- AT&T

---

## DATAQUEST VIEW OF THE VIDEOPHONE MARKET

---

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## **FLASH MEMORY REVOLUTIONIZES PORTABLE COMPUTING**

***Anthony G. Barre***  
Director of Strategic Planning  
Memory Components Division  
Intel Corporation

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## **FLASH MEMORY REVOLUTIONIZES PORTABLE COMPUTING**



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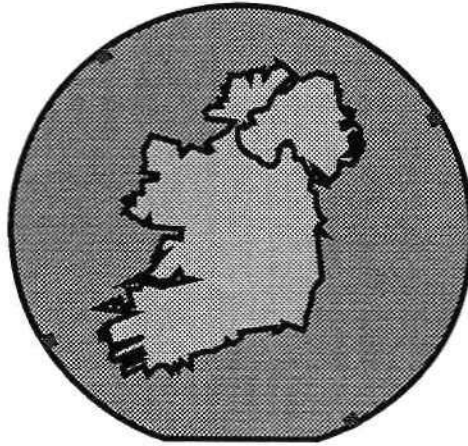
Mr. Barre is based in Folsom, California, and directs all of the strategic planning for Intel's Flash-based components, cards, systems and software. Prior to this assignment, he served in several general management and marketing roles in Intel's Microprocessor and Memory Business units. Mr. Barre gained a Masters degree in Engineering Science at the California Institute of Technology and a B.Sc. degree in Engineering from the United States Military Academy at West Point, New York.

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**This presentation was not available  
at the time of publication**

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## **FUZZY LOGIC**

***Professor A. J. van der Wal***  
Manager  
European Technical Centre  
Omron Electronics Europe BV

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## FUZZY LOGIC



Professor A. J. van der Wal  
Manager  
European Technical Centre  
Omron Electronics Europe BV

Mr. van der Wal is Manager of the European Technical Centre (ETC) of Omron Electronics Europe BV in the Netherlands. This R&D centre is active in developing fuzzy logic applications and consulting in the area of fuzzy technology. Prior to this he was an advisor with this company and a consultant with Berenschot Informatica. He was a professor of physics at Eindhoven University. His research involved user-friendly interfaces, fast data acquisition and real-time data analysis, distributed processing, neural networks and expert systems. Mr. van der Wal worked in industrial research with Philips NatLab and in the medium energy facility of SIN. He studied Physics at the University of Utrecht and received a Ph.D. in Solid-State Physics.

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# FUZZY LOGIC:

A quantitative way to model qualitative information

Ariën J. van der Wal  
Omron Electronics Europe  
R&D Centre

Session:  
New Technologies

European Semiconductor  
Conference  
June 4, 1992 Dublin  
Dataquest

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## Agenda

- Fuzzy Logic Basics
- Merits of Fuzzy Logic
- Application areas
- Example: Fuzzy Control
- How Fuzzy Logic can be implemented in products

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## Why Fuzzy Logic ?

# Precision is costly

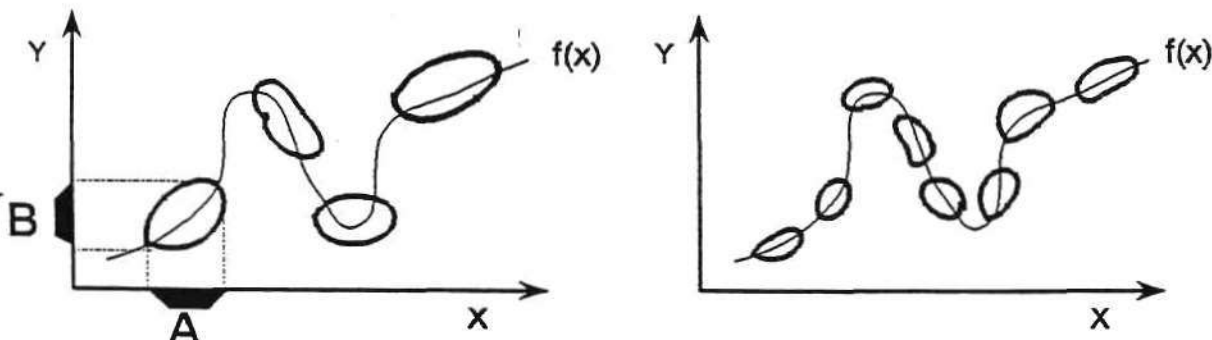
- Uncertainty is inherent to physical observations (Heisenberg)
- Tradeoff between accuracy and
  - Complexity
  - Computability
  - Significance (Zadeh)
- "So far as the laws of mathematics refer to reality, they are not certain. And so far as they are certain, they do not refer to reality"

Albert Einstein

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## Approximation of functions



A model-free estimator based on fuzzy coverings  
Finer covering → Better approximation

"Rule"  $\equiv$  Association (A,B)

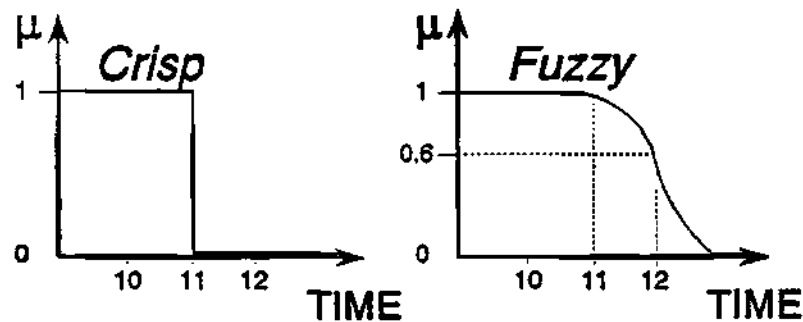
$A \subset X \quad B \subset Y \Rightarrow \text{Patch } (A \times B) \text{ in state space}$

IF X is A THEN Y is B  $\Rightarrow$  Rule

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## Fuzzy set theory introduces "Elasticity of meaning"



CHECKOUT TIME IS 11 A.M.

The meaning of '11 a.m.' is context dependent.

$\mu_{11 \text{ am}}$  (hour) = membership function

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## FUZZY and OMRON

Fuzzy is one of the basic technologies at OMRON

OMRON's Corporate Philosophy

Future Vision

*To the machine  
the work of the  
machine*

*To man the thrill  
of further creation*

*Human  
Friendly  
Technology*

*Optimized Society  
(2006 ..)*

*Best man -  
machine relationships  
Human based sense  
of values*

Fuzzy Technology

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## Fuzzy Technology: Omron's View

1. A paradigm to utilize fuzziness as valuable information
2. A methodology for modeling and utilizing human knowledge and senses

Human-friendly machines

Higher level of automation

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## Taxonomy of model-free estimators

Representation			
<i>Symbolic</i>	<i>Numerical</i>		
AI EXPERT SYSTEMS	FUZZY SYSTEMS	Structured	Type of knowledge
	NEURAL SYSTEMS		
		Unstructured	

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## Chronology

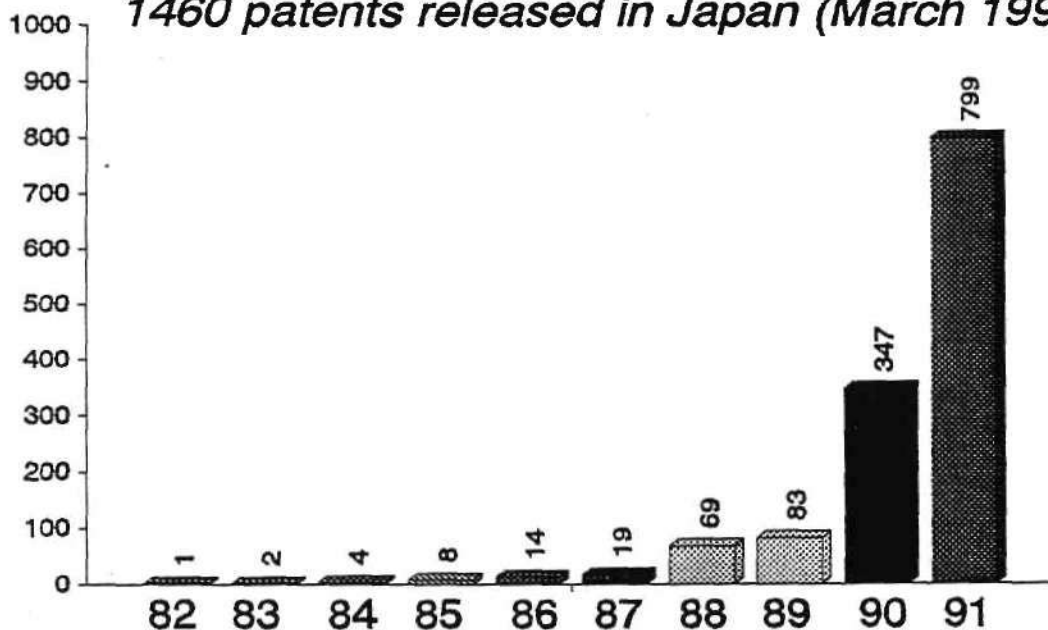
- 1983 Began fuzzy technology research
- 1984 Submitted the first patent on fuzzy logic
- 1987 Presented OMRON's fuzzy controller at the 2nd IFSA, initiated the "fuzzy boom"
- 1988 Marketed worlds first super-high speed FUZZY controller, FZ-1000
- 1989 Established Fuzzy Technology Business Promotion Center  
Welcomed Prof. Zadeh to OMRON as senior adviser
- 1992 Complete serie of FUZZY (co)processors: FP1000, FP3000, FP5000, FP7000  
Fuzzy Inference Board FB-30AT for PC  
Fuzzy Unit for PLC C200H-FZ001  
Total number of patents applied reached 1460

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## Number of Fuzzy patents

*1460 patents released in Japan (March 1992)*



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## Merits of Fuzzy technology

### User-oriented Features:

- Reduction of overshoot
- Reduction of settling time
- Multiple objective control possible
- Accurately following setpoint changes
- Feature extraction
- Reduction of maintenance
- Reduction of power consumption
- User-friendly man-machine interface
- Reduction of error ratio

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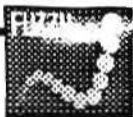


## Merits of Fuzzy technology

### Developer - oriented Features

- Short development time
- Easy to cover a complete multiple input domain
- Straightforward to include operator experience
- Trade-off between different design characteristics is possible
- Hybrid control possible
- Strong interpolative properties
- Same rule base can be used for wide range of model parameters

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## Application areas of Fuzzy Technology

- Expert Systems
- Control
- Data analysis and pattern recognition

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## Application examples of Fuzzy Logic

- Expert systems for medical diagnoses, scheduling and control, sales, economics, marketing research and stock performance prediction.
- Automotive systems for automatic transmission control, fuel injection, active suspension control and anti-skid braking (ASB).
- Control systems for consumer electronics products: still video and camcorders, airconditioners, microwave ovens.

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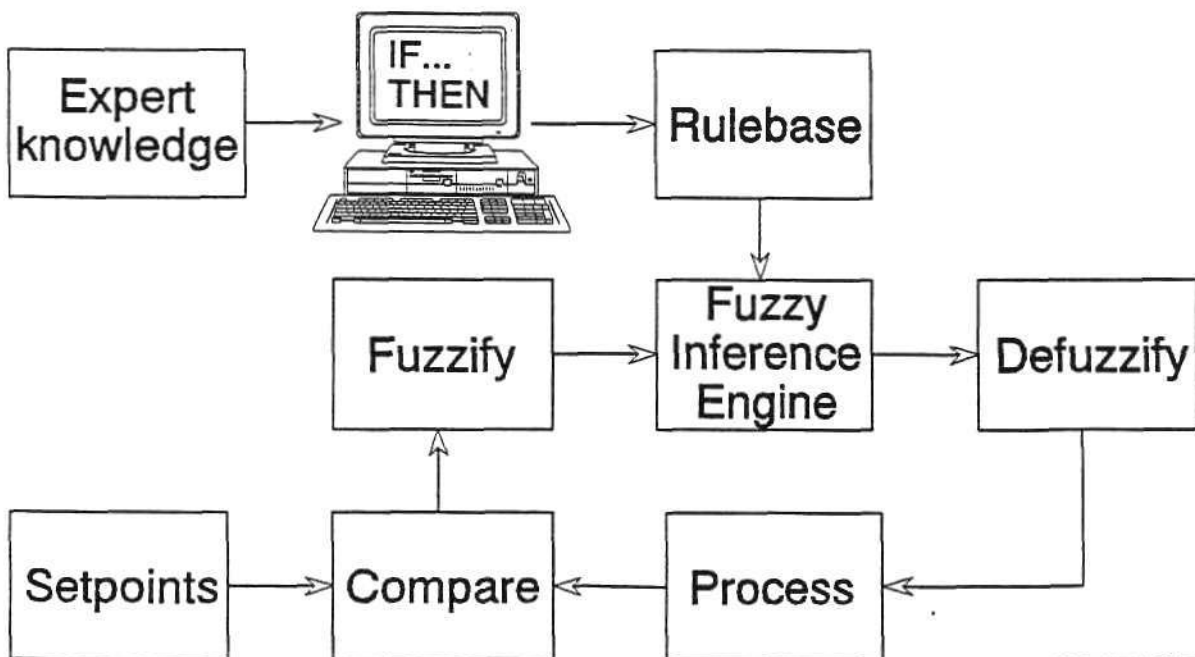
## Application examples of Fuzzy Logic

- Industrial systems for elevator, rail system, robot and motor control.
- Industrial manufacturing, process industry and environmental processing.
- Pattern recognition systems, e.g. access control and security systems and smart sensors.

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## Structure of a Fuzzy controller

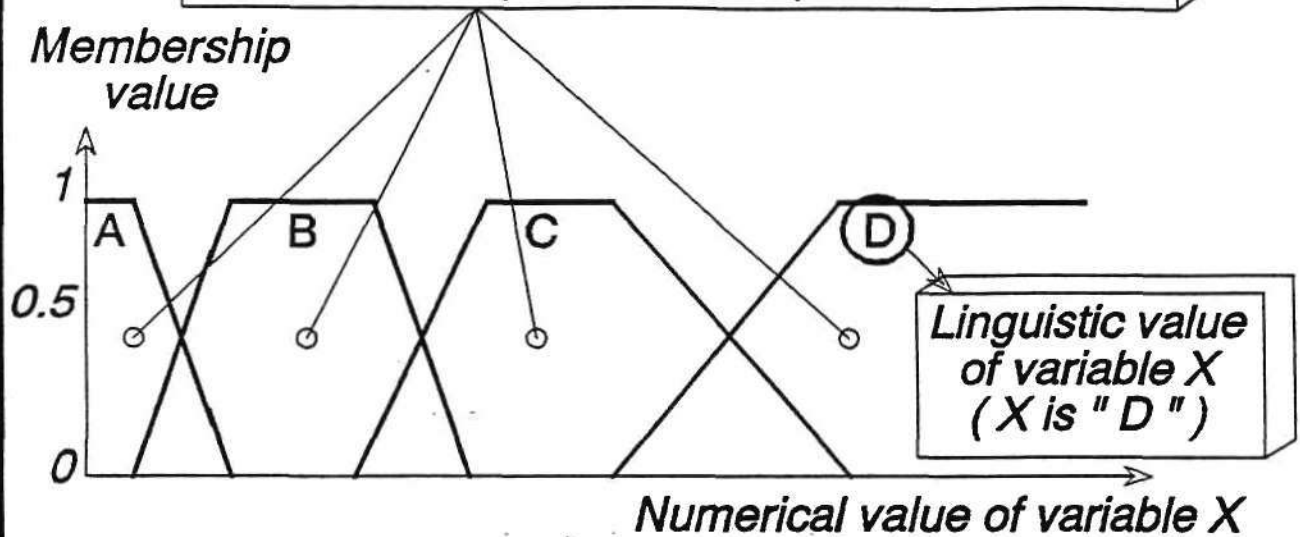


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## Fuzzification of variables

*Membership functions for different linguistic classifications (A, B, C and D) of the variable X*



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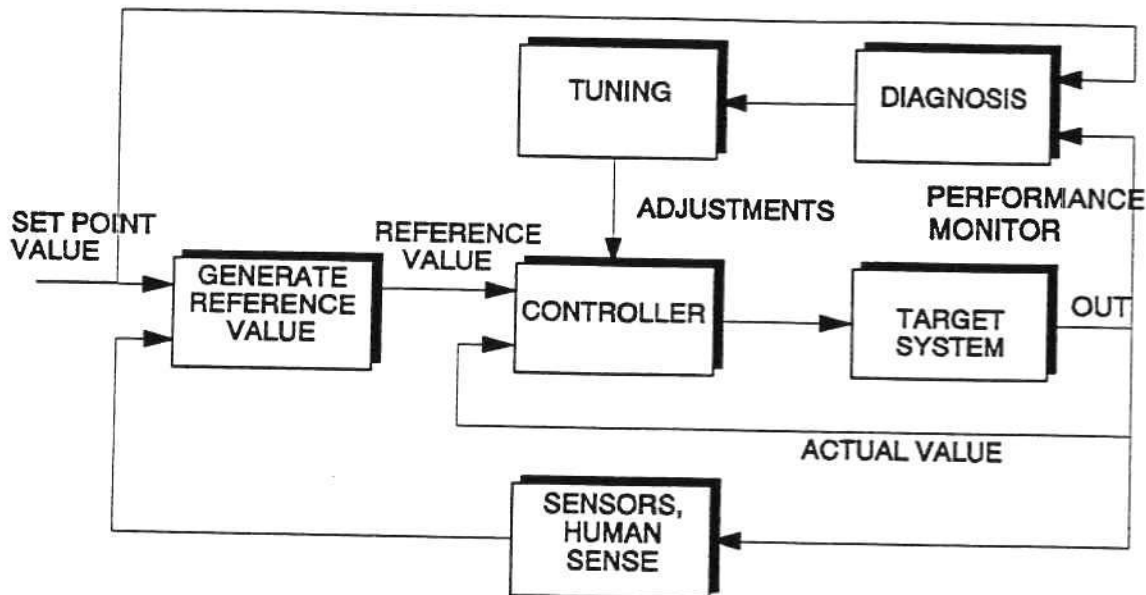
## Fuzzy control $\Leftrightarrow$ Conventional control

- Conventional controllers rely strongly on a good mathematical model description of the process
- Conventional methods of control have come to rely exclusively on linear mathematical control methods
- Strong dependence on changes in workpoint and on parameter scaling

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## Where to employ Fuzzy Logic

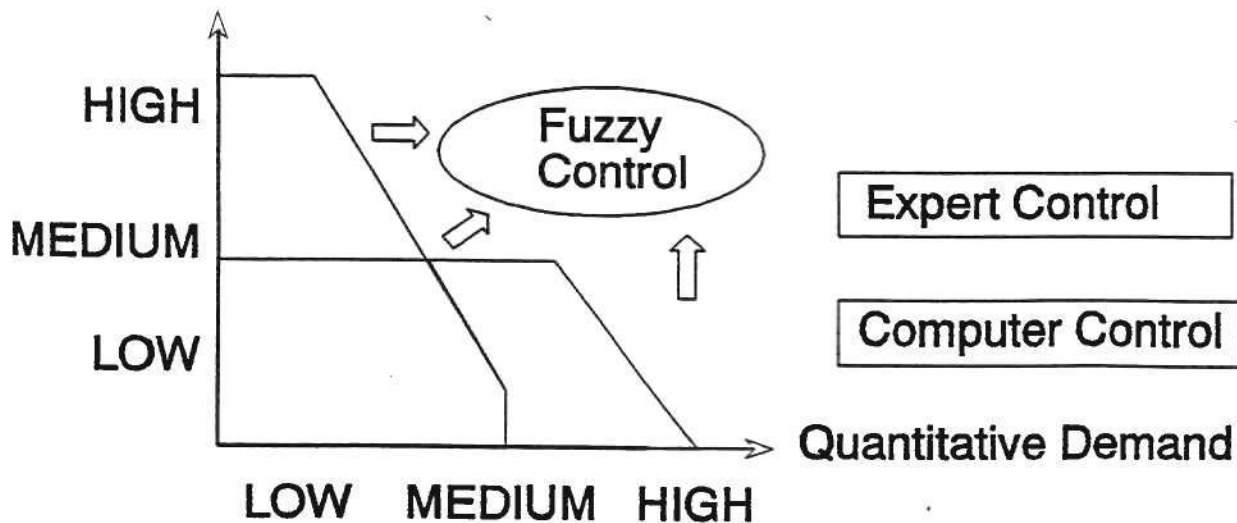


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## Quantitative/Qualitative demand

Qualitative Demand



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## OMRON Fuzzy Products

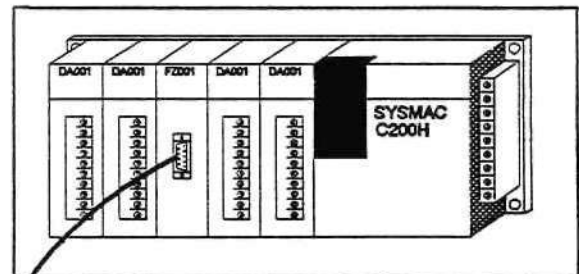
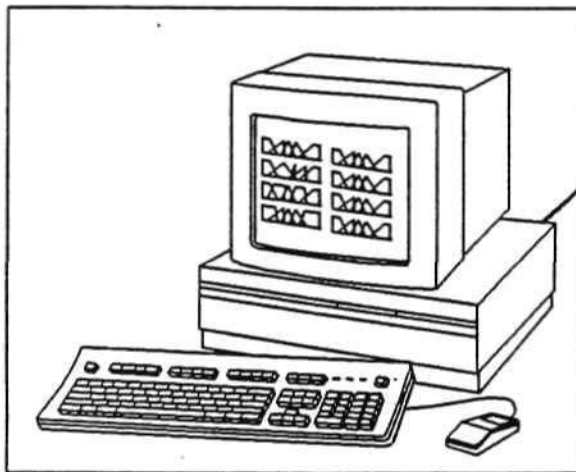
1. Fuzzy Processors: FP 1000, FP 3000, FP 5000
2. Software Development Tools: FS 10-AT, FS 50-AT
3. Fuzzy Inference Board: FB 30-AT
4. Programmable Fuzzy Logic Controller: C200H-FZ001
5. Fuzzy Temperature Controller: E5AF
6. Consultancy in Applications of Fuzzy Logic Technology e.g. in Factory Automation

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## FZ001 - Sysmate FSS

### Fuzzy Support Software

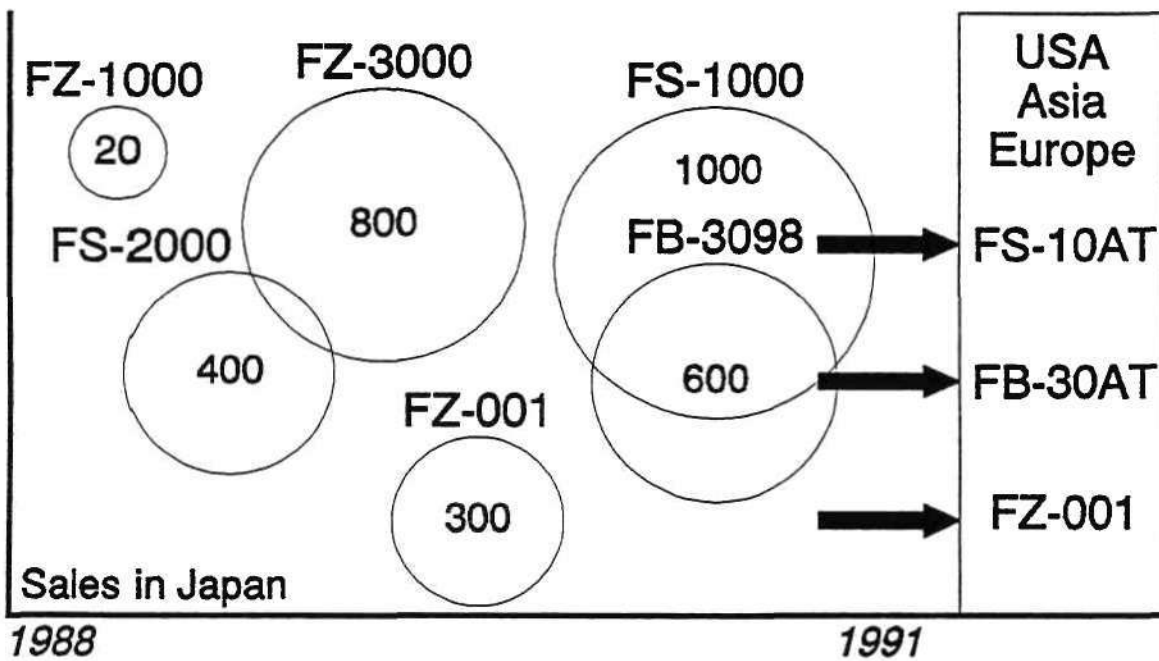


- Creation of rules / MF's
- Rule consistency check
- File load/save on disk
- Documentation printout
- Up-/download FZ001 data
- I/O + Inference monitoring
- Save log file for analysis

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## OMRON dominates Fuzzy Tools



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## **PRODUCTS MARKETS ANALYSIS—LOGIC: INTRODUCTION**

***Mike Glennon***  
Senior Industry Analyst  
European Semiconductor Group  
Dataquest Europe Limited

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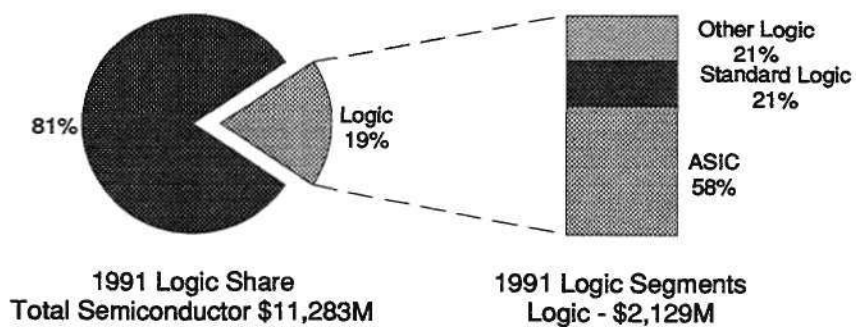
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## PRODUCTS MARKET ANALYSIS - LOGIC

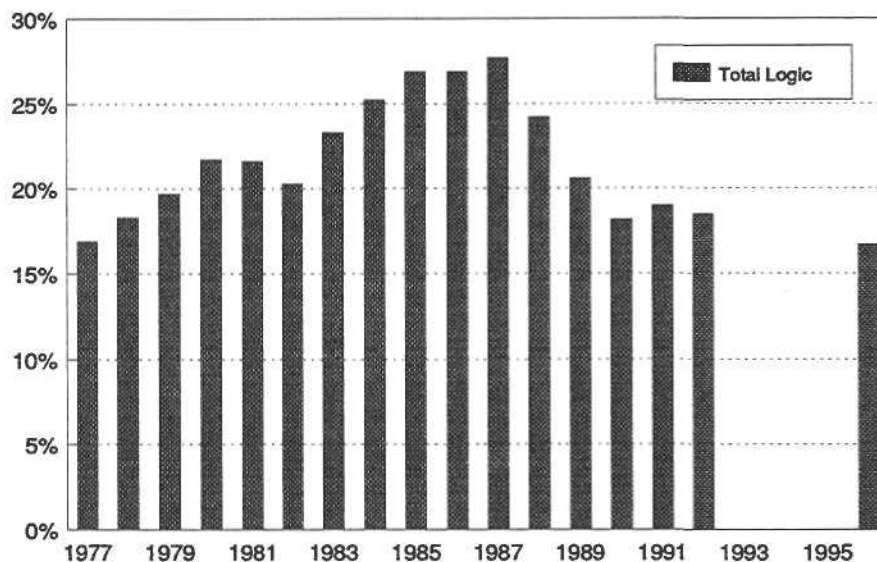
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- Logic market trends and analysis
- Is standard logic dead?
- Future trends in general purpose logic

### EUROPEAN LOGIC MARKET SHARE OF SEMICONDUCTOR MARKET

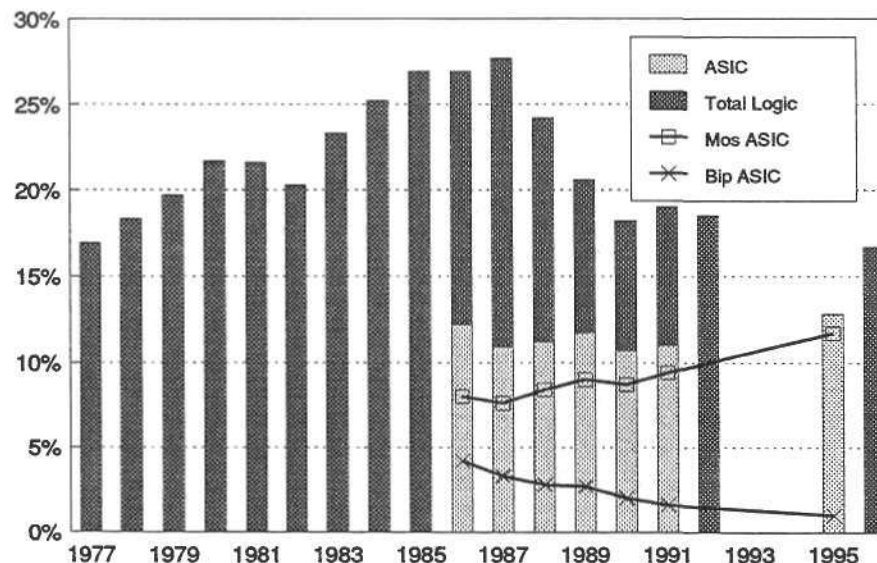


## EUROPEAN LOGIC MARKET SHARE OF TOTAL SEMICONDUCTOR



Source: Dataquest (June 1992)

## EUROPEAN LOGIC MARKET SHARE OF TOTAL SEMICONDUCTOR

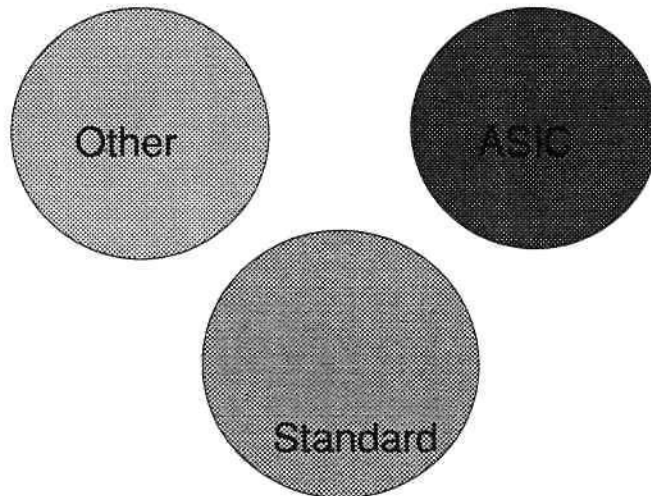


Source: Dataquest (June 1992)

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## PRODUCTS - LOGIC

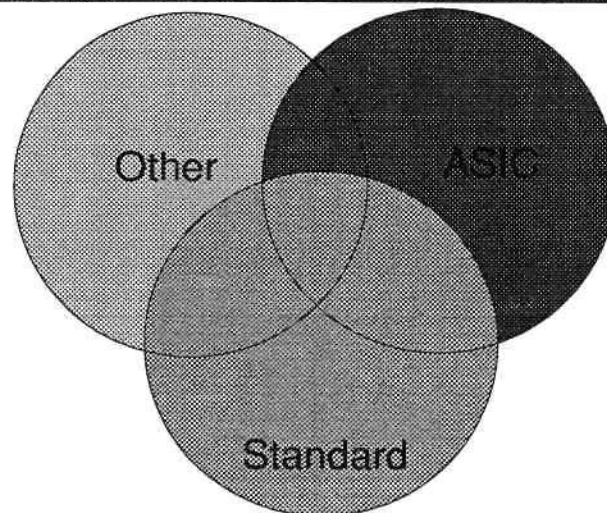
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## PRODUCTS - LOGIC

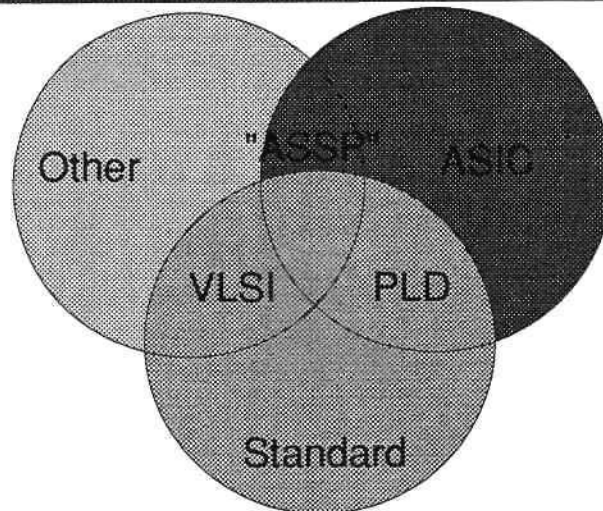
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## PRODUCTS - LOGIC

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## LOGIC OVERLAP PRODUCTS

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- "ASSP" (Application Specific Standard Product)
  - PC chip sets
  - GSM chip sets
  - Image compression chip sets
- VLSI
  - Disk controllers
  - LAN products
- PLD products
  - Field programmable gate arrays
  - PLD/PLA products

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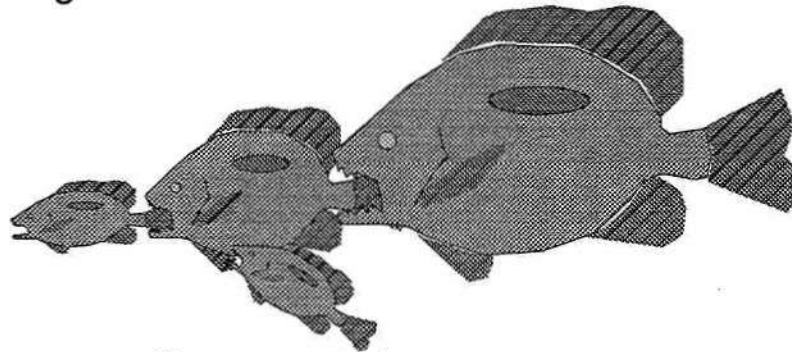
## LOGIC MARKET CANNIBALIZATION

---

Standard  
Logic

ASIC

Other Logic



Programmable  
Logic

Source: Dataquest  
June 1992



## **IS STANDARD LOGIC DEAD?**

***Glenn Louch***

Director

Standard Products Division  
National Semiconductor Europe

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## IS STANDARD LOGIC DEAD?



Glenn Louch  
Director  
Standard Products Division  
National Semiconductor Europe

Mr. Louch is Director of the European Standard Products Division of National Semiconductor Europe covering logic, programmable logic, interface and MOS memory. He is based at the headquarters in Swindon, England. Mr. Louch has held management positions in both the United Kingdom and Germany. Prior to joining National Semiconductor Mr. Louch held a number of sales and sales management positions in distribution. He completed an electronic engineering apprenticeship with the Schlumberger group in Farnborough, England.

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# IS LOGIC DEAD?

## AGENDA

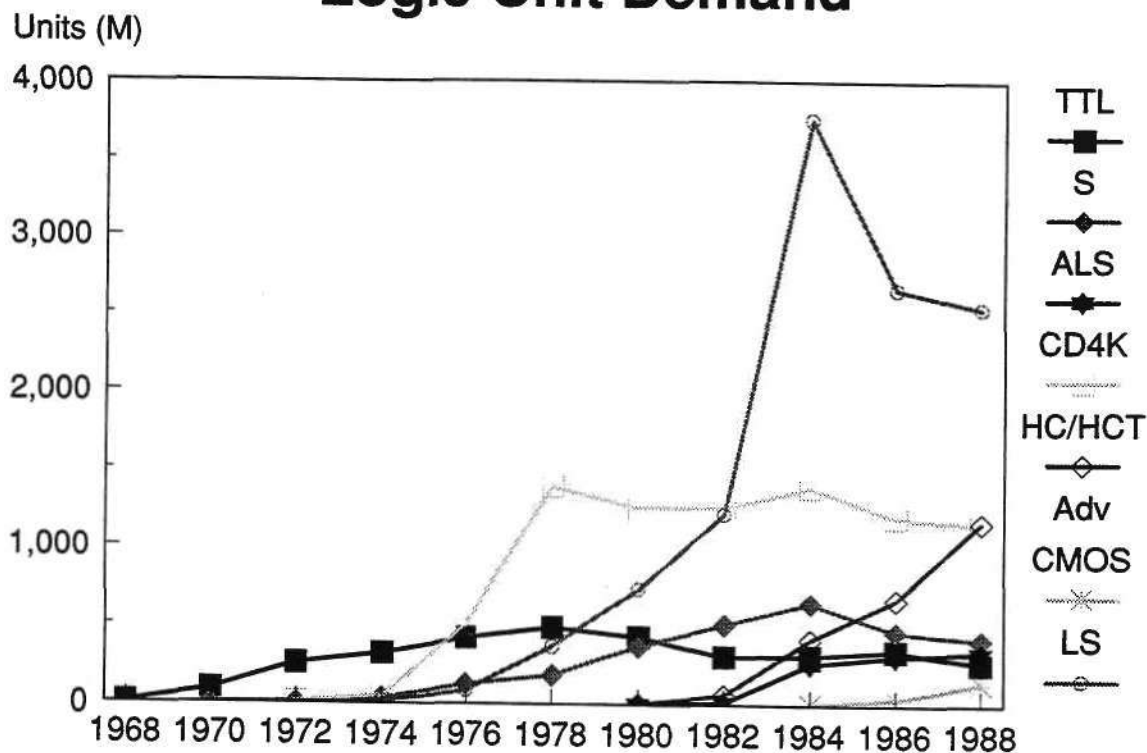
- 1967 - 1988 THE GLORY YEARS
- TO USE OR NOT TO USE?
- 1988 - 1992 ADAPTING TO SURVIVE
- THE ELDER STATESMAN
- THE NEXT FEW YEARS
- THE VERDICT - DEAD OR ALIVE?



# AGENDA

- 1967 - 1988 THE GLORY YEARS
- TO USE OR NOT TO USE?
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## Logic Unit Demand



## European TAM (M\$)

### Logic / PLD / ASIC

	1987	1988	1989	1990	1991	1992
CMOS Logic	229	287	263	230	224	232
BIPOLAR Logic	410	394	282	248	239	197
TOTAL Logic	639	681	545	478	463	429
PLD	82	118	127	150	191	264
ASIC	792	982	1182	1344	1465	1779

Source: Dataquest prelim May 92

## AGENDA

- 1967 - 1988 THE GLORY YEARS
- TO USE OR NOT TO USE?
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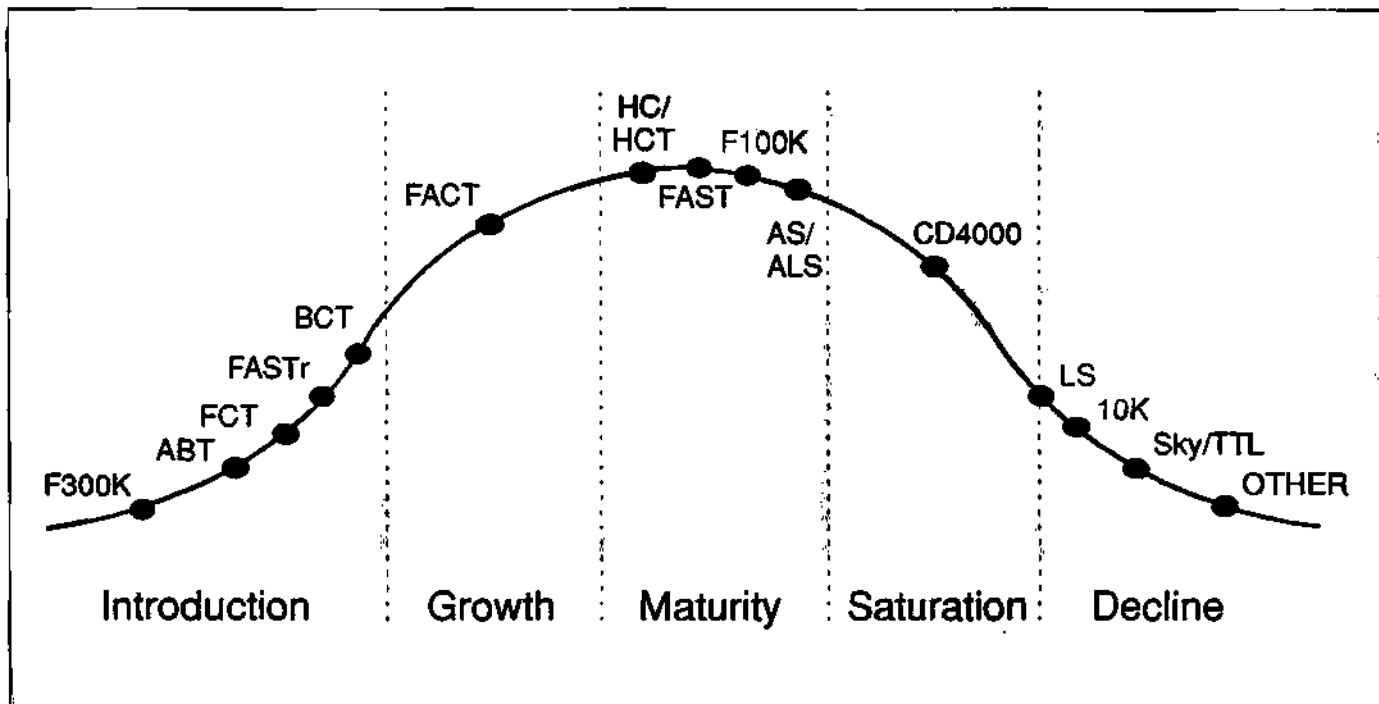
# Common Reasons to Use Logic

- It's the standard we are used to.
- Good designs last a long time ~ upgrades are "fine-tuned".
- System only has a low gate count.
- "Glue" for ASIC, PLD and other VLSI solutions.
- Time to market, multi-sourced, low risk.
- Translation - TTL / ECL ~ 5v / 3v.

## AGENDA

- 1967 - 1988 THE GLORY YEARS
- TO USE OR NOT TO USE?
- 1988 - 1992 ADAPTING TO SURVIVE
- THE ELDER STATESMAN
- THE NEXT FEW YEARS
- THE VERDICT - DEAD OR ALIVE?

# Product Life Cycle



## AGENDA

- 1967 - 1988 THE GLORY YEARS
- TO USE OR NOT TO USE?
- 1988 - 1992 ADAPTING TO SURVIVE
- THE ELDER STATESMAN
- THE NEXT FEW YEARS
- THE VERDICT - DEAD OR ALIVE?

# Logic ~ The Influencing Factors

- Cost Control
- Test Equipment & Methodology
- Supply & Demand Management
- EDI
- JTAG
- Cycletime
- Design Friendly specifications
- Design Modelling
- Packaging

## AGENDA

- 1967 - 1988 THE GLORY YEARS
- TO USE OR NOT TO USE?
- 1988 - 1992 ADAPTING TO SURVIVE
- THE ELDER STATESMAN
- THE NEXT FEW YEARS
- THE VERDICT - DEAD OR ALIVE?

# AGENDA

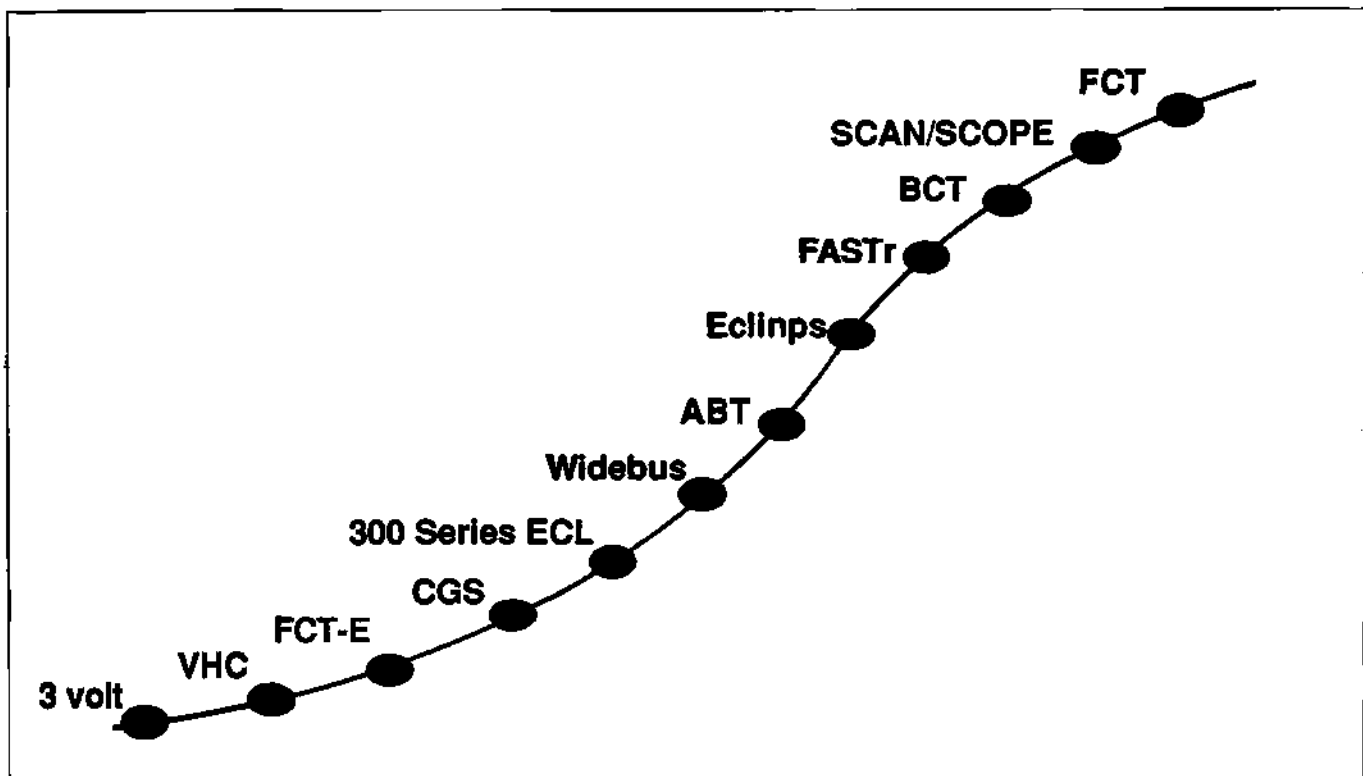
- 1967 - 1988 THE GLORY YEARS
- TO USE OR NOT TO USE?
- 1988 - 1992 ADAPTING TO SURVIVE
- THE ELDER STATESMAN
- THE NEXT FEW YEARS
- THE VERDICT - DEAD OR ALIVE?

## Logic European TAM

	1987	1988	1989	1990	1991	1992	1993	1994	1995	1996	CAGR 90-95
Total Logic	639	681	545	478	463	429	415	388	345	347	-5.6%
Bipolar Std Logic	410	394	282	248	239	197	167	148	122	112	-14.1%
TTL	362	347	246	217	210	172	145	126	101	92	-15.2%
LS	228	217	152	135	107	85	69	57	43	39	-18.3%
Standard	17	14	8	6	6	5	4	3	2	2	-19.7%
ALS	33	32	25	22	36	29	23	19	16	14	-17.2%
FAST	55	56	43	38	45	40	38	37	32	30	-7.8%
AS	13	14	10	9	9	8	7	7	6	5	-11.1%
S	16	14	8	7	7	5	4	3	2	2	-22.2%
ECL/Other	49	48	36	30	29	25	22	22	21	20	-7.2%
CMOS Std Logic	229	287	263	230	224	232	248	240	223	235	1.0%
4000/74C	120	129	100	79	71	62	62	50	36	34	-13.7%
HC/HCT	100	134	127	109	113	119	124	118	102	101	-2.2%
AC/ACT	8	22	33	38	20	38	45	51	60	70	18.5%
BC/BCT	1	2	3	4	10	13	17	21	25	30	24.6%

Source: Dataquest Prelim

## INTRODUCTION PHASE



## AGENDA

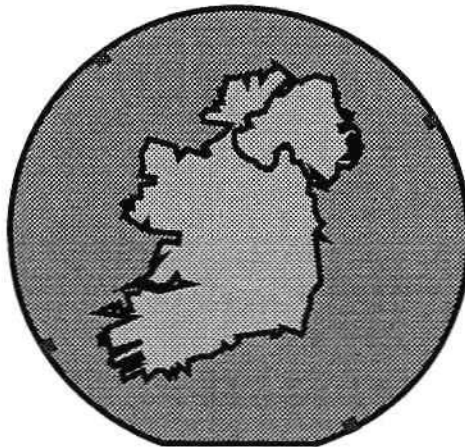
- 1967 - 1988 THE GLORY YEARS
- TO USE OR NOT TO USE?
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- THE ELDER STATESMAN
- THE NEXT FEW YEARS
- THE VERDICT - DEAD OR ALIVE?

# The Verdict

*" Reports of my death are grossly  
exaggerated "*

Mark Twain





## **FUTURE TRENDS IN GENERAL PURPOSE LOGIC**

***Peter Dennstedt***  
Manager  
European General Purpose Logic  
Texas Instruments Europe

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## **FUTURE TRENDS IN GENERAL PURPOSE LOGIC**



Peter Dennstedt  
Manager  
European General Purpose Logic  
Texas Instruments Europe

Mr. Dennstedt is Manager of Texas Instruments' (TI's) European General Purpose Logic Business facility. He is based in Freising, Germany at TI's German subsidiary and is responsible for the company's European general purpose logic business which also includes a major part of TI's design, engineering and characterization for Advanced Logic Products for worldwide sales. Mr. Dennstedt received an Industrial Engineering degree 1973 in Munich, Germany.

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June 3-5, 1992  
Dublin, Ireland

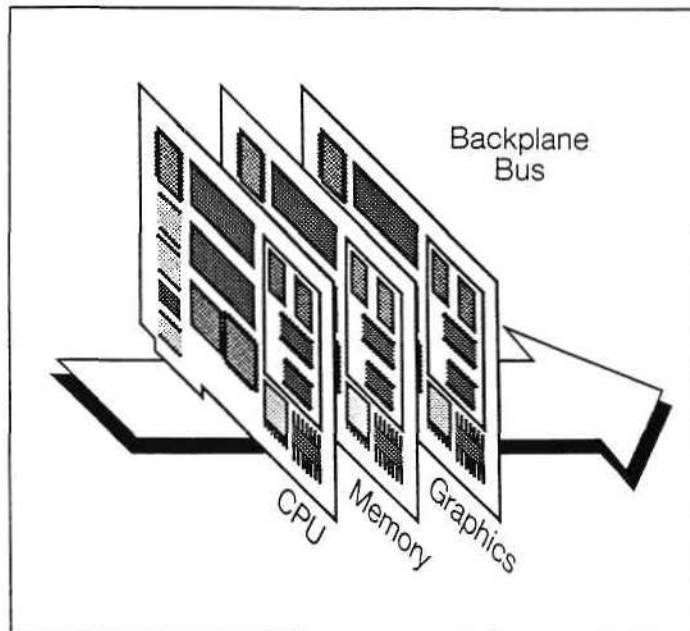
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## THE COMPUTER SYSTEM TRENDS

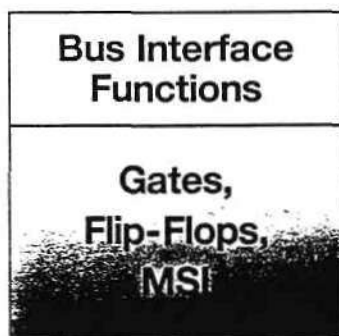
### ● System Trends

- Higher complexity
- Increased speed
- Wider architecture
- Higher density
- Minimum power consumption

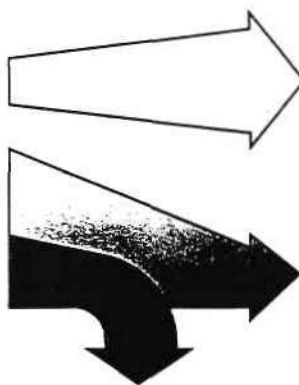
Will drive a continuous high demand for advanced general purpose bus drivers



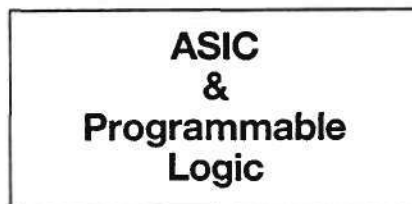
## GENERAL PURPOSE LOGIC TRANSITION



1985



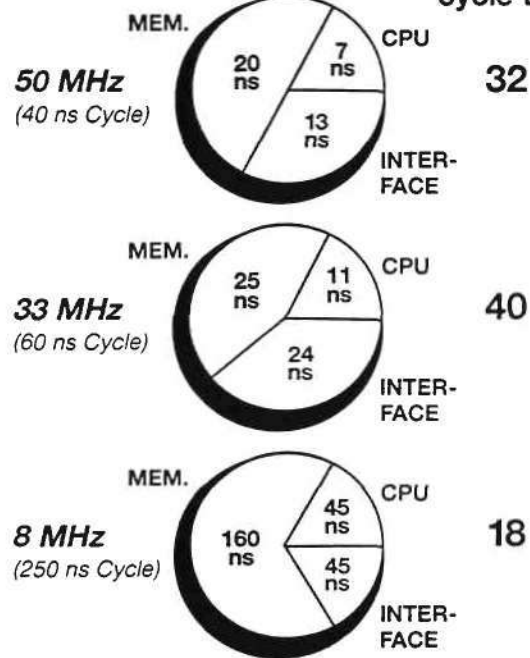
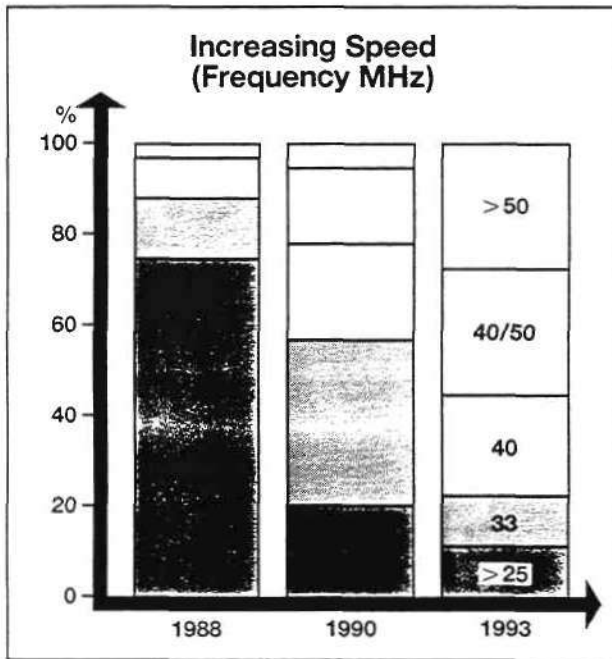
Gates, Counters,  
Flip-Flops & Registers, ...



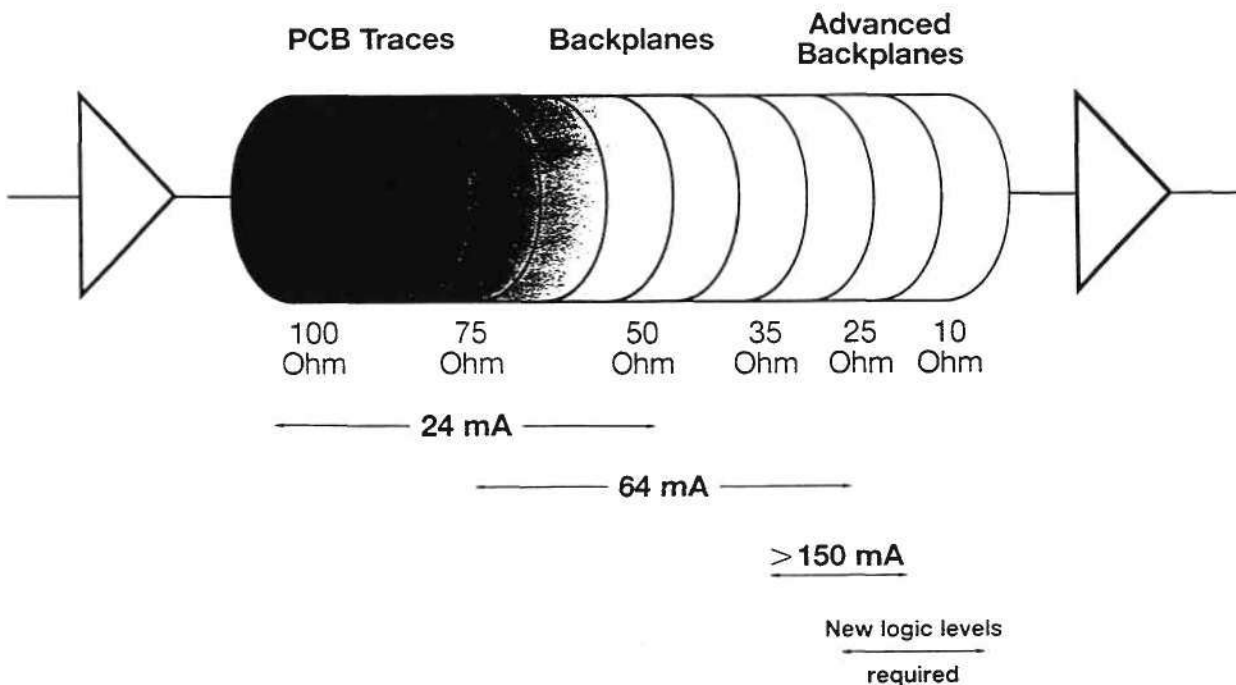
1995



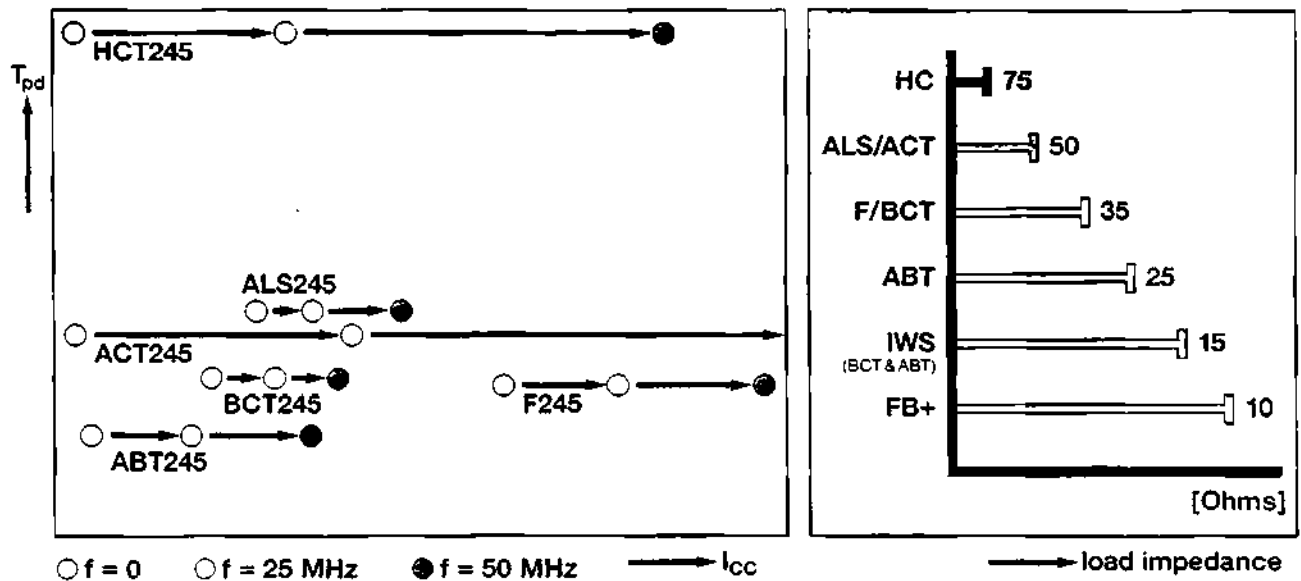
## TECHNOLOGY NEEDS



## DRIVE CAPABILITY



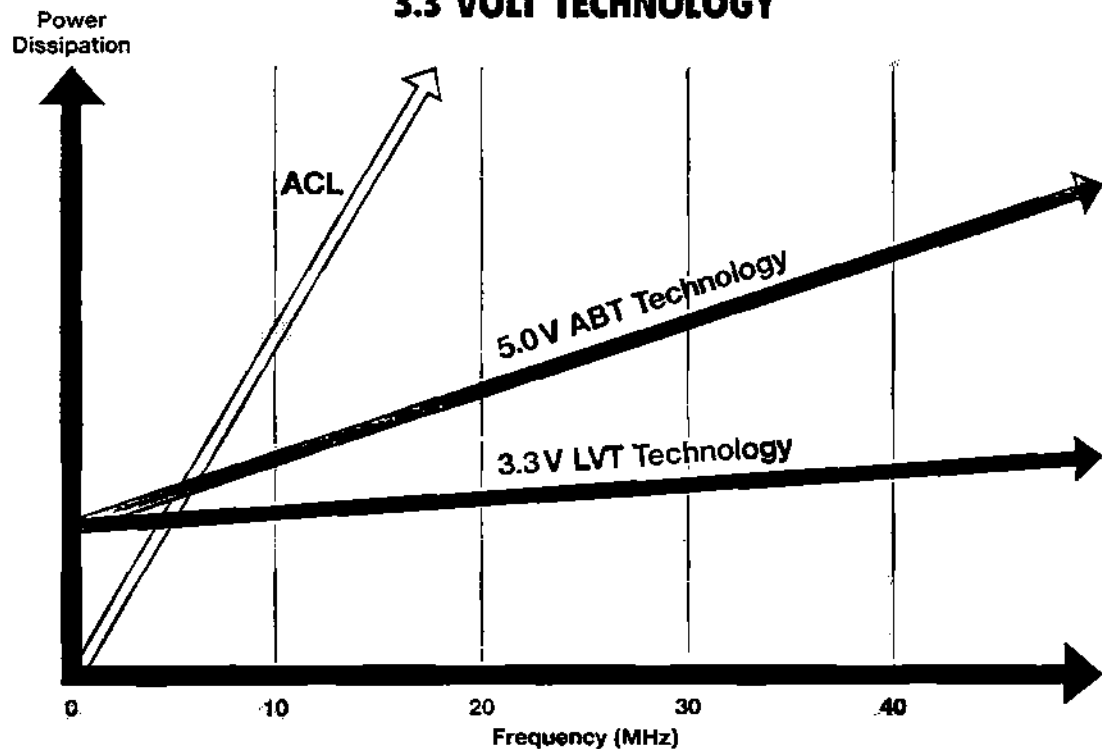
## TECHNOLOGY COMPARISON: SPEED & DRIVE



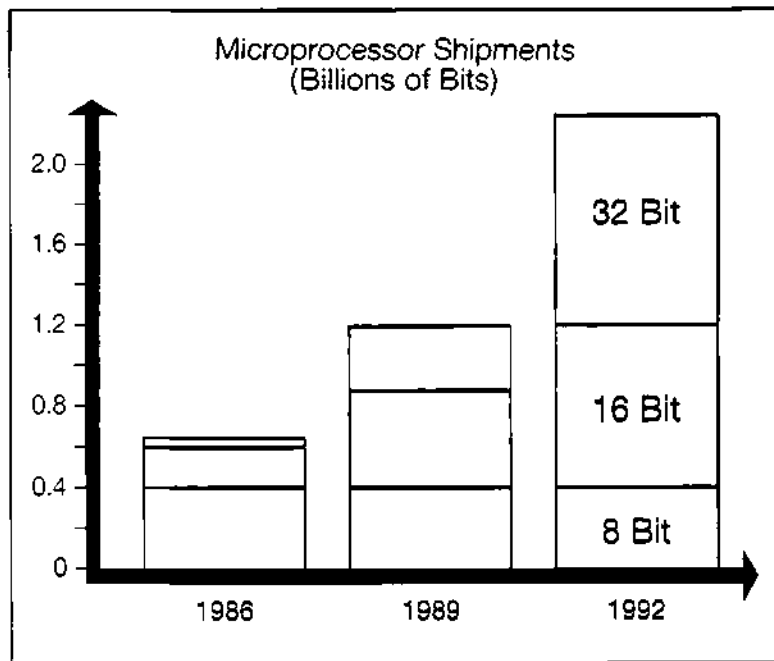
Ti offers 8-bit bus functions in BCT, ACL, and ABT, 16-bit functions in ACL and ABT, and 32-bit functions in ABT technologies



## 3.3 VOLT TECHNOLOGY



## DESIGN TRENDS TOWARDS WIDER BUS WIDTH



Required  
pincount for  
single package solution

80-120

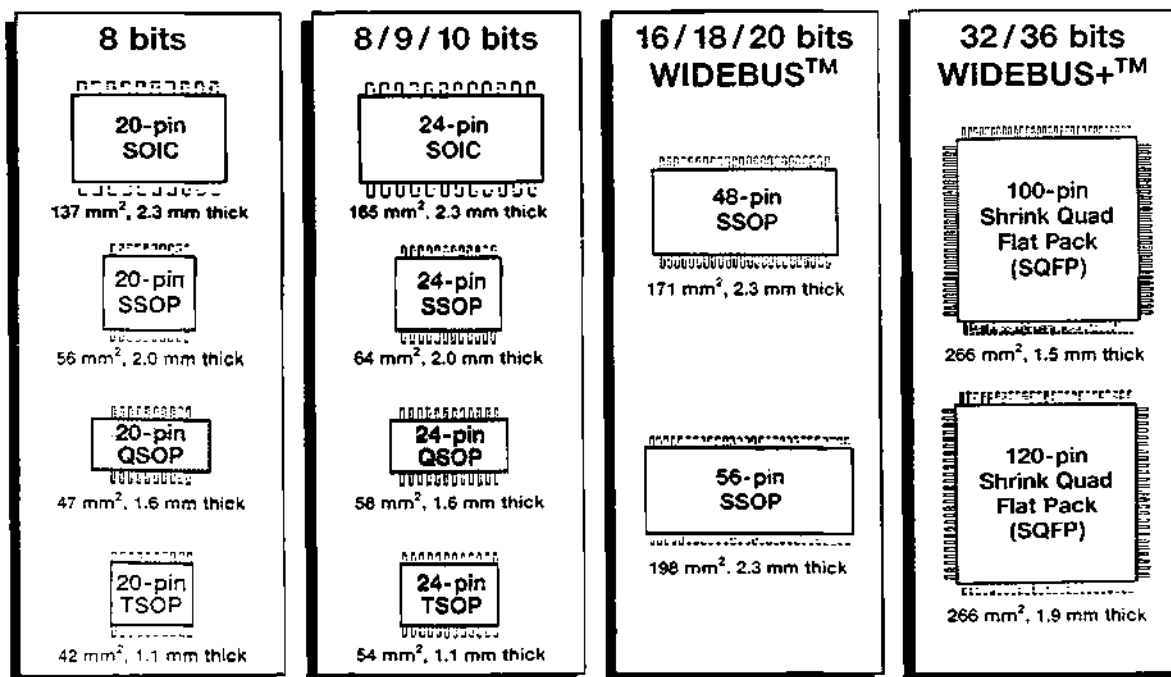
48-56

20-24

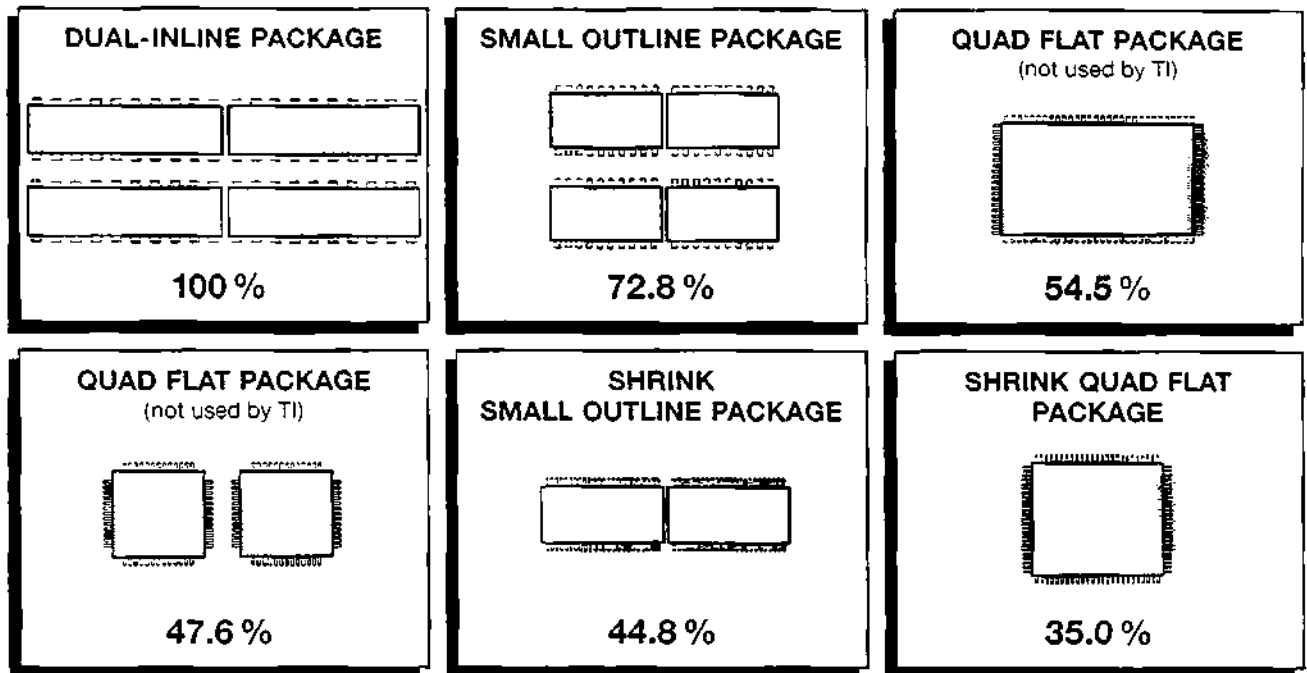
Beyond 1992: Emergence of 64-bit and 128-bit architectures



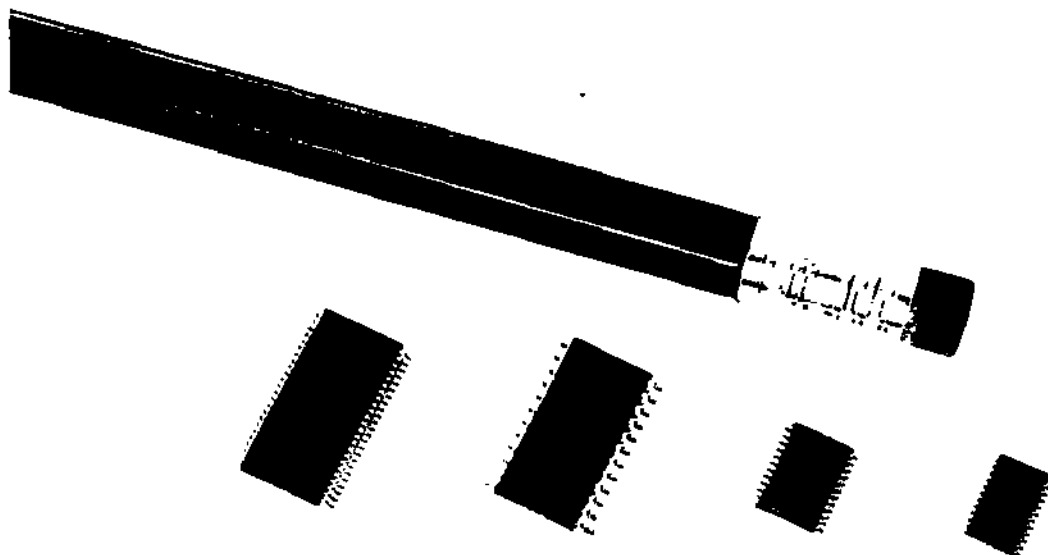
## ADVANCED BUS INTERFACE PACKAGING



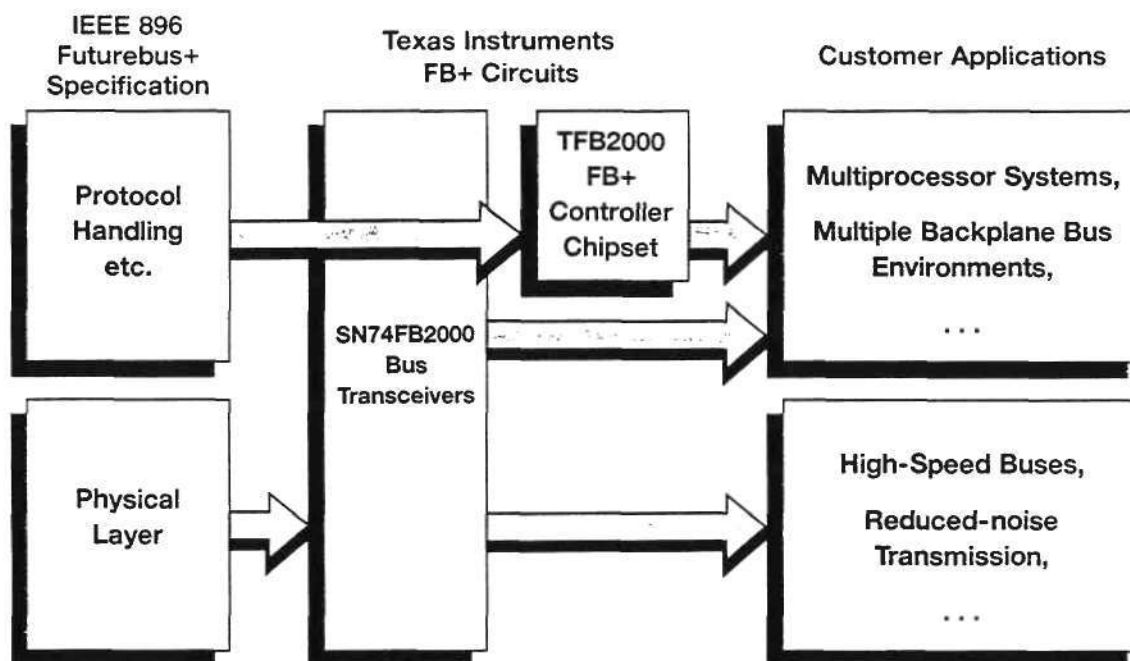
## 32-BIT BUS INTERFACE BOARD AREA COMPARISON



Comparison ignores space required for connecting lines



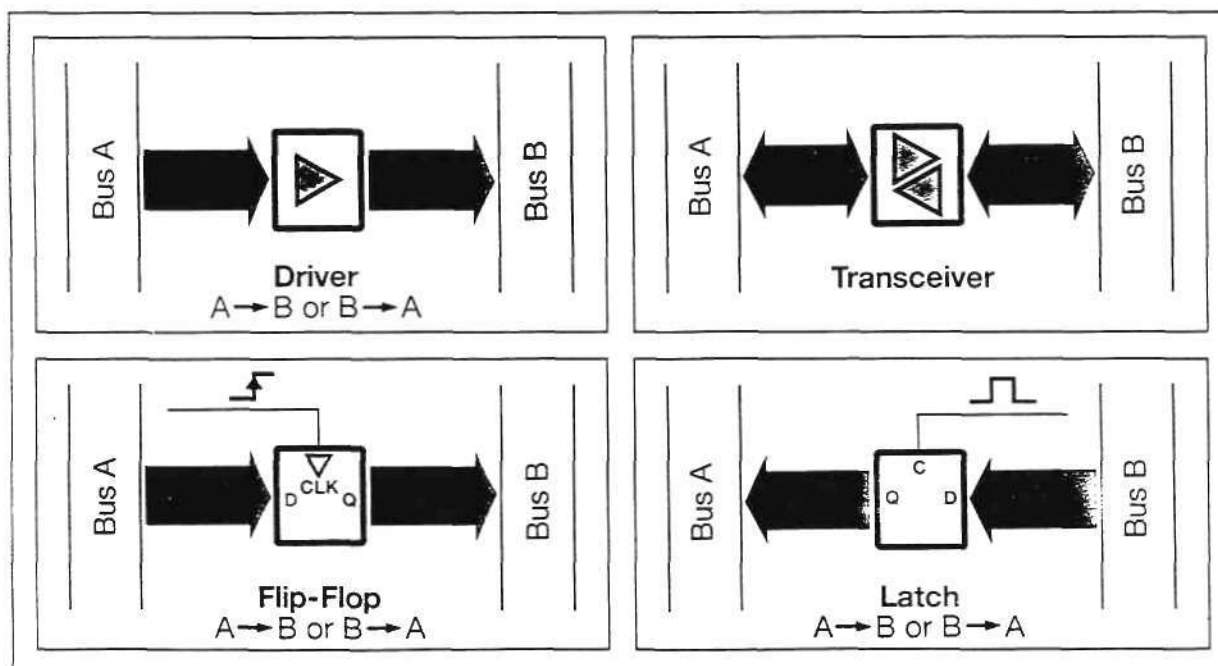
## FB+: WIDENING THE SPEED BOTTLENECK



TI supports both the hardware and the protocol standard of Futurebus+



## THE 'UNIVERSAL BUS TRANSCEIVER' CONCEPT



18- and 36-bit UBT's available in Advanced BiCMOS





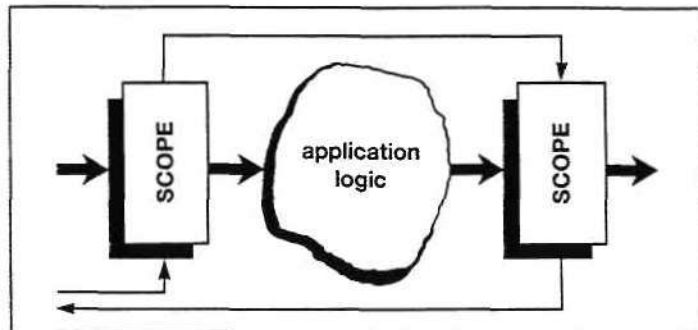
## BUS DRIVERS INCORPORATE TESTABILITY

Growing system density and complexity lead to a lack of physical access.  
Costs for detecting and identifying faults increase.

IEEE1149.1 (JTAG) boundary scan reduces test costs and adds flexibility.

**More than 30 TI SCOPE bus driver products support the IEEE1149.1 standard:**

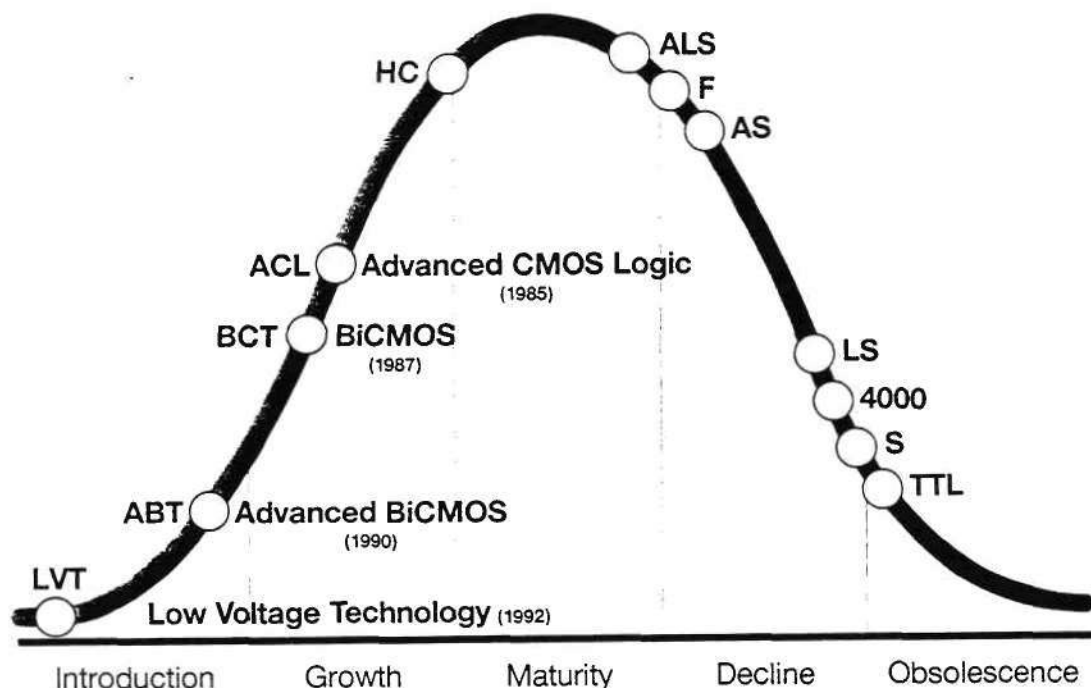
- 8-bit bus drivers / transceivers / flip-flops / latches / registered transceivers
- 16-bit WIDEBUS transceivers / registered transceivers / universal bus transceivers
- 32-bit WIDEBUS+ transceivers / registered transceivers / universal bus transceivers



SCOPE, WIDEBUS, and WIDEBUS+ are trademarks of Texas Instruments Incorporated.



## GROWING AND MATURING TECHNOLOGIES



## ADVANCED BUS INTERFACE LOGIC MADE FOR COMPUTERS

**PC, Workstation, Mini, Mainframe**

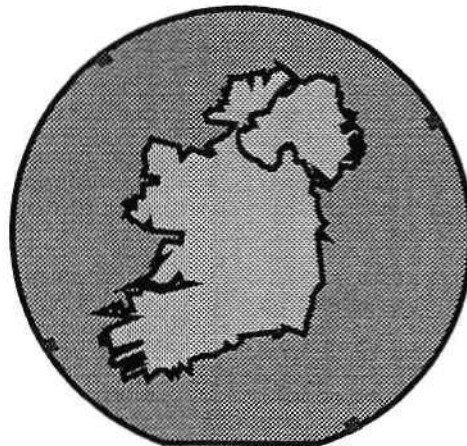
ACL logic, BiCMOS drivers, BiCMOS IWS drivers,  
MOS memory drivers, clock drivers, Bus Termination Arrays, . . .



### ... FINDS APPLICATIONS IN TELECOM, AUTOMOTIVE, INDUSTRY & CONSUMER

PABX:	ACL Widebus, ABT drivers, BiCMOS drivers Bus Termination Arrays
Cellular radio base station:	IWS drivers, BiCMOS drivers
Security phone handset:	SSOP-packaged ACL logic
Car phone:	ACL Widebus
Automotive motor control:	ABT drivers
Train communication link:	ABT drivers, ABT Widebus
Identification / access control:	BiCMOS drivers, Bus Termination Arrays
Textile machine control:	JTAG octals & controllers, ABT drivers
High-Definition TV:	Bus Termination Arrays





## **PANEL SESSION 1: EVOLUTION OF SEMICONDUCTOR PROCUREMENT**

***Chaired by Mark Giudici***  
Dataquest Incorporated

***John Hudson***  
Apple Computer Ltd.

***Keith Williams***  
Avnet EMG

***Earl Kitchen***  
GEC Plessey Telecoms

***Klaus Wangerin***  
Sony Europa GmbH

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## **EVOLUTION OF SEMICONDUCTOR PROCUREMENT**



Mark Giudici  
Director and Principal Analyst  
Semiconductor Procurement Service  
Dataquest Incorporated

Mr. Giudici is Director and Principal Analyst, Semiconductor Procurement Service for Dataquest Incorporated. He is responsible for tracking and analysing emerging semiconductor procurement issues and trends. He also covers regional semiconductor prices and cost modeling issues. In addition, he has participated in various custom research projects involving procurement needs and regional price differentials. Prior to joining Dataquest, Mr. Giudici spent eight years in both the computer and semiconductor industries, where he held a variety of financial and marketing positions. Most recently, he was Product Marketing Engineer with Gould-American Microsystems, where he was responsible for cost modeling and marketing semicustom and foundry-custom semiconductor components. Mr. Giudici graduated from California State University, Chico with a BS in Business Administration, and from the University of Oregon with an MBA in Business Management.

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# Evolution of Semiconductor Procurement

from  
Order Placers  
to  
Supply Base Managers

---

## SEMICONDUCTOR PROCUREMENT

---

Past focus on:

- Price
- Price
- Price



Supplier

Buyer

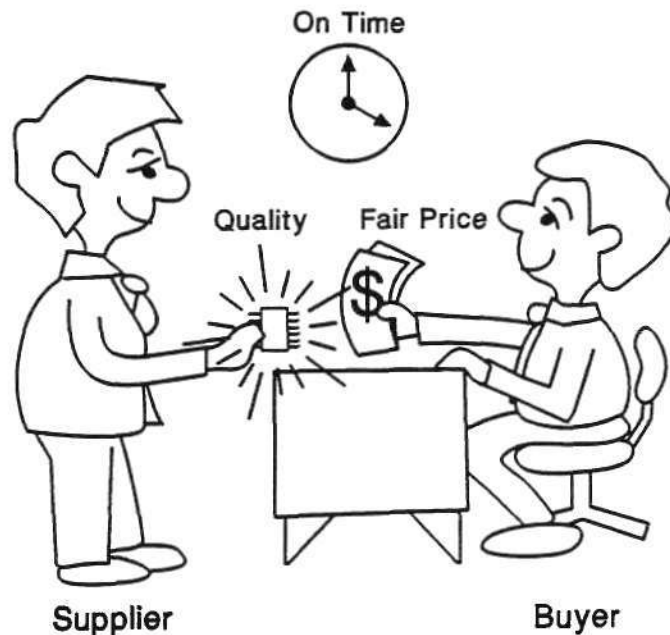
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## SEMICONDUCTOR PROCUREMENT

---

Current/future focus on:

- Quality
- Delivery
- Price



---

## SEMICONDUCTOR PROCUREMENT

---

### Issues

#### European Rank

1. On-time delivery
2. Quality/reliability
3. (Cost of) ownership
4. Pricing
5. Vendor base relationships

#### Worldwide Rank

1. Pricing
2. Quality/reliability
3. On-time delivery
4. Availability
5. Cost control

---

## **SEMICONDUCTOR PROCUREMENT**

---

- Evolving from an afterthought  
(i.e., place the order at the lowest price)
- Becoming (is) an integral part of product design/manufacturing decision:
  - Supplier qualification
  - Delivery coordination with inventory levels
  - Contractual pricing
- Procurement focus due to:
  - Integration trends
  - Supplier reduction trend
  - Shorter time to market/life cycles of products

## **EVOLUTION OF SEMICONDUCTOR PROCUREMENT**



**John Hudson**  
European Regional Supply  
Base Manager  
Apple Computer Ltd.

Mr. Hudson is the European Regional Supply Base Manager for memory, microprocessor and microcontroller components. He is based at Apple Computer Ltd., where he is responsible for the development and implementation of semiconductor sourcing strategies in conjunction with the Worldwide Apple Semiconductor Team. Prior to this, Mr. Hudson was Commodity Manager for Memory and Microcontrollers for Western Digital Corporation in Irvine, California. He has also held component and vendor quality engineering roles for various companies including Western Digital, CPT and Digital Equipment Corporation. Mr. Hudson holds a B.Sc. degree in Electronic Engineering from the University of Limerick, Ireland.

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## ***Charter***

**"Never Fail to Deliver High Quality,  
Cost Effective Personal Computing products  
when our Customers want them. "**

**By building on our capabilities of:**

- **Demand Driven Manufacturing**
- **Flexibility / Speed of Execution**
- **Customisation & Configuration**
- **Service**
- **People**

## **APPLE MANUFACTURING CORK**

🍏 **Start-Up October 1980 - IDA Factory 40K Sq. Ft.**

🍏 **Site now 340K Sq Ft with 1000 employees**

🍏 **\$90 M invested to date**

🍏 **Process**

**PCB Assy**

**Final Assy Test**

**Configuration & Pack**

**European Service Centre**

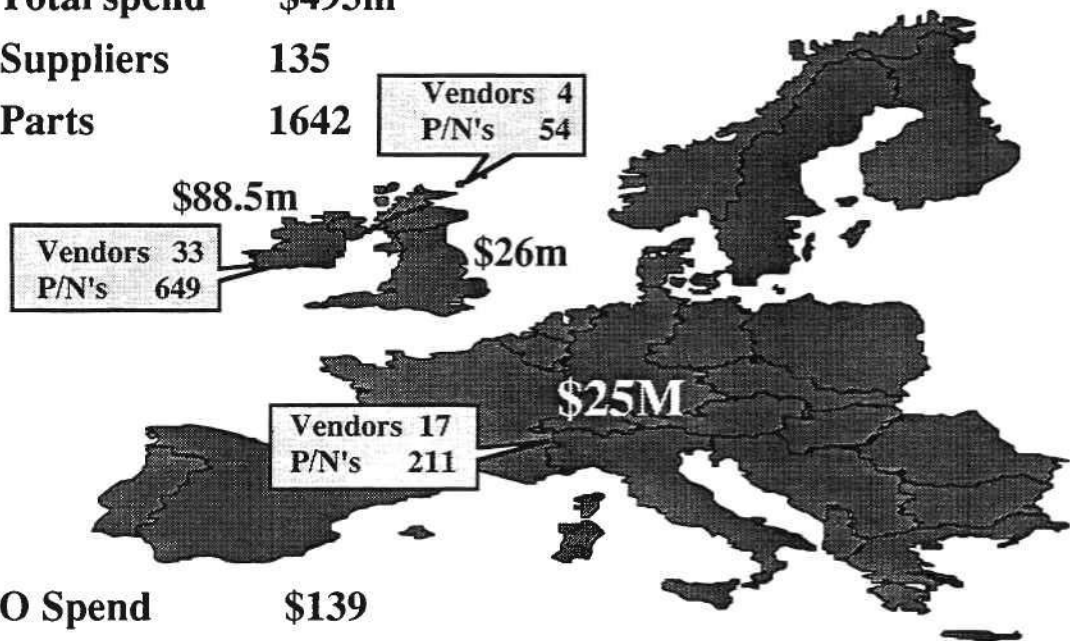
🍏 **ISO90002**

# CORK 1991 EUROPEAN ACTIVITY

Cork Total spend \$493m

Total Suppliers 135

Total Parts 1642



EURO Spend \$139

US Spend \$118

FAR EAST Spend \$236

## WHAT IS UNIQUE ABOUT SEMICONDUCTORS?

### TECHNOLOGY DRIVER

- Wide Technology Spectrum
- Limited supply base across technologies
- Heavy use of subcontract ie Design House/Fab/Assy
- Long process cycles

### MARKET DRIVEN COMMODITY

- Difficult cost models
- "Butterfly" effect e.g. Windows accelerator cards and VRAM

# WHAT IS UNIQUE ABOUT SEMICONDUCTORS?

## SHORT PART and TECHNOLOGY LIFE CYCLES

- Complex Qualification Cycles : Spec, Application, Mfg Process - No History
- Critical dependency on cross-functional effectiveness
- Supplier and User communications

## GEOPOLITICAL FACTORS

- Regional Protectionism i.e. Tariffs
- WW Producers remote from Design Centers

## TRADITIONAL PURCHASING

- Lowest P.O. Price
- Freight Costs
- Forecasts and Request Date
- Credit Terms
- Procure against AVL
- Operationally Focussed

## SUPPLY BASE MANAGEMENT

- Lowest Cost of Ownership
- Local Hub Inventory
- Duty, Tariff, and Currency Mgmt
- Sole sourced strategic relationships
- Exec & Eng. Linkages with Snr Mgmt
- WW Mfg. requires WW Account Mgmt.
- Regional Offsets: Buy where we sell

# ***HOW DOES APPLE ADDRESS THESE ISSUES?***

---

## ***COMMODITY TEAMS***

***"MULTIFUNCTIONAL TEAM WITH FULL OWNERSHIP  
AND RESPONSIBILITY FOR THE MANAGEMENT AND  
IMPLEMENTATION OF ALL ISSUES AND PLANS  
CONCERNING A PARTICULAR GROUP OF PARTS"***

**SUPPLIER ENGINEERING**

DPM and Reliability Improvement  
Supplier audits and technical feedback  
Apple Process Qualification of new parts  
Regional Technical Interface to Suppliers

**CONTRACT BUYER**

Contract Negotiation  
Cost Negotiation and Business Allocation  
Regional Business Interface to Suppliers

**OPERATION SPECIALIST**

Implement MRP  
Ensure allocation plan  
Site Metrics

**SUPPLIER MANAGEMENT WW  
NOT  
WW SUPPLIER MANAGEMENT**

CENTRALISED HIERARCHICAL MGMT  
MARKET INFO HAS CORPORATE BIAS  
STRATEGIC AND TACTICAL CONFLICTS



GLOBAL MEMBERS  
RECOGNITION OF REGIONAL MARKET  
INFORMATION GATHERING NETWORK  
UNDISTORTED MARKET INTELLIGENCE TECHNICAL  
AND COMMERCIAL SKILL SETS

## SEMICONDUCTOR GLOBAL TEAM

- Strategic commodity along with Display Tech and Mass Storage
- Headquartered in proximity to Design Community made up of regionally located members
- Regional members are global team headcount *NOT* Site Headcount - clear accountability
- Regional Experts with strong ties to local manufacturing

## CUPERTINO

RAM SBM  
ROM SBM  
ASIC SBM  
MICROS SBM  
COMPONENT ENG X 3

### CORK

1 BIZ  
1 TECH/BIZ

### FREMONT

1 TECH

### SINGAPORE

1 TECH/BIZ

### FOUNTAIN

1 TECH/BIZ

# MAP - ing the Future at Apple

- ☞ Overview & Outlook
- ☞ Sourcing
- ☞ Technology Trends
- ☞ Quality
- ☞ Recommendations
- ☞ Leverage
- ☞ Pricing
- ☞ Regional Offsets
- ☞ Capacity

## Material Acquisition Plan

🍏 APPLE COMPUTER LTD

DATAQUEST 4th June '9

### *STRATEGIC ALLIANCES*

- 🍏 IBM AND APPLE FORM ALLIANCE ON RISC
- 🍏 MOTOROLA - MICROPROCESSORS AND MEMORY
- 🍏 APPLE SOLE SOURCES PSRAM FROM HITACHI FOR POWERBOOK!!
- 🍏 SONY SUPPLIES APPLE POWERBOOK 100
- 🍏 SHARP - CODEVELOPMENT PIPS

🍏 APPLE COMPUTER LTD

DATAQUEST 4th June '9

# ***APPLE INVESTMENT IN SUPPLIER RELATIONS***

## **SUPPLIER CERTIFICATION PROGRAM**

**BUSINESS AND QUALITY DEV. PROGRAM WITH KEY SUPPLIERS  
(54 SUPPLIERS)**

## **EDI**

**16 ACTIVE TRADING PARTNERS  
UTILISING EDIFACT AS STD  
30% OF PO VOL is EDI -> 70% by OCT**

***....means long term relationships***



## **EVOLUTION OF SEMICONDUCTOR PROCUREMENT**



Keith Williams  
European Managing Director  
Avnet EMG

Mr. Williams is the European Managing Director of Avnet EMG: the world's largest distributor of electronic components in 1991. He has spent 22 years in the semiconductor industry. He was the Founder and Managing Director of the Access Group, a start up specialist semiconductor distributor. Mr. Williams also managed the semiconductor business of ITT Electronic Services and has experience of product marketing, production planning and field sales with Texas Instruments. He graduated from Imperial College, London with an honours degree in Physics and Mathematics.

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## THE CUSTOMER REQUIREMENTS IN THE 1990s

- The prime objectives
- The need for global procurement
- Customers are reading the same books
- Increased strategic flexibility
- Improved quality
- Improved technological support
- Customer coverage
- Long term partnerships

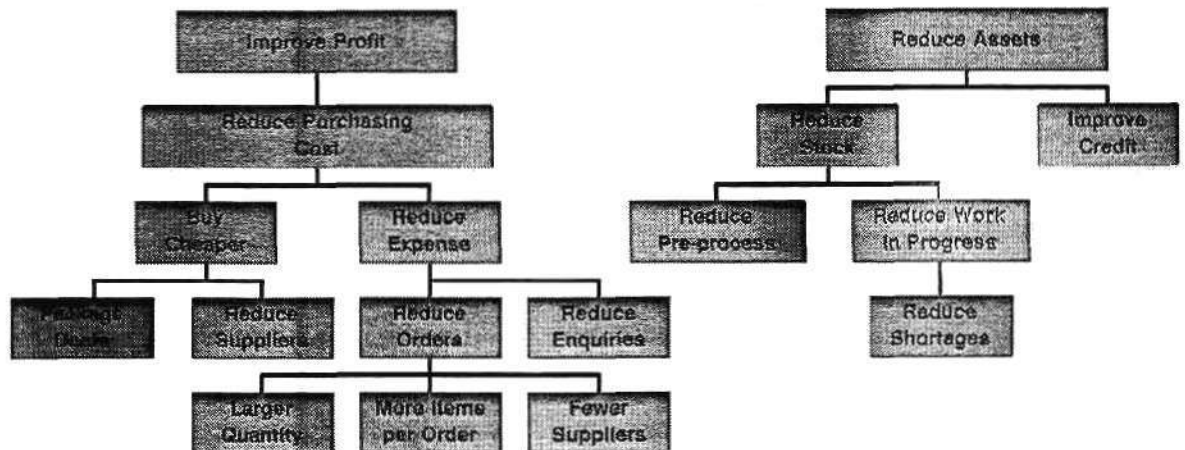


THE CHANGING ROLE OF DISTRIBUTION IN EUROPE



**AVNET**

## THE CUSTOMERS PRIME PROFIT OBJECTIVES



The use of distribution improves the customers return on capital employed



THE CHANGING ROLE OF DISTRIBUTION IN EUROPE



**AVNET**

## THE NEED FOR GLOBAL PROCUREMENT

- Competitive need for world class quality
- Continuous need for cost reductions
- Total cost of ownership is becoming the primary vendor measurement
- Companies with local technical and commercial resources backed by worldwide resources are perceived to be capable of reducing the cost of ownership
- Aggressive global sourcing strategies
- Global need to capitalise on technology and economic conditions in developing regions of Europe and ROW
- Access to worldwide inventories - e.g., Avnet EMG has more inventory than the whole of UK distribution



THE CHANGING ROLE OF DISTRIBUTION IN EUROPE



**AVNET**

## CUSTOMERS ARE READING THE SAME BOOKS

- Focus your factories
- Simplify your process
- Design for manufacturing
- Reduce your supplier base
- Reduce "overhead"
- Partnership with customers and suppliers
- Eliminate non-value activities



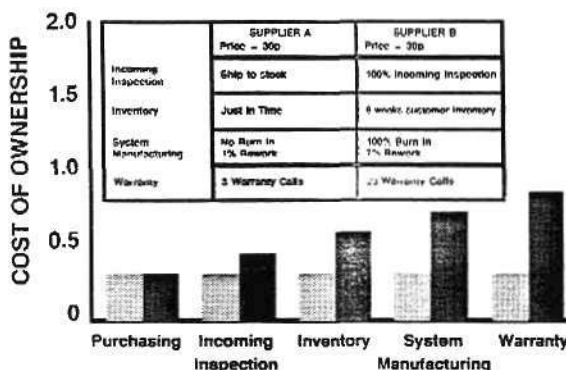
THE CHANGING ROLE OF DISTRIBUTION IN EUROPE



**AVNET**

## REDUCED COST OF OWNERSHIP

- Including the cost of quality, the cost of ownership can be up to 4 times the purchase price
- Management practices traditionally do not differentiate between a \$0.010 resistor and a \$500 MPU
- A \$1.0 film resistor purchase costs 75 cents to manage
- Stock room activities have been estimated at 60% of non-value added costs
- Traditionally there are about 29 steps to purchase a 1 cent resistor
- The distributor needs to be a more cost effective materials handler than the customer



### Key Issues

- Only those distributors with the financial resource, critical mass and vision will be involved in the range of value added services so key to low cost of ownership



THE CHANGING ROLE OF DISTRIBUTION IN EUROPE



**AVNET**

## INCREASED STRATEGIC FLEXIBILITY

*Strategic Flexibility is a Way of Customers*

- Gaining a competitive edge
- Increasing profits
- Increasing market share
- Increasing quality

"You gain Strategic Flexibility when you consciously look at each process and increase the number of alternatives you have to perform the operation of your business"



### Key Issues

- The key requirement to gain strategic flexibility is for the customer to focus on his core business using the value added services of the progressive distributor



THE CHANGING ROLE OF DISTRIBUTION IN EUROPE



**AVNET**

## INCREASED STRATEGIC FLEXIBILITY

Value Added Service Enables  
Flexibility by Offering:

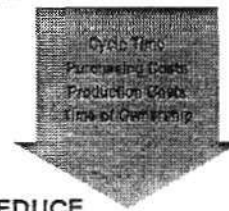
- Reduced lead time and cycle time
- Lower cost of procurement
- Improved operational flow
- Improved inventory turns
- High customer return  
on capital employed
- Highest quality components
- \$1.2 billion in assets that can be leveraged  
(e.g., Avnet)

Benefits of Strategic Flexibility  
in Manufacturing

INCREASE



REDUCE



THE CHANGING ROLE OF DISTRIBUTION IN EUROPE



**AVNET**

## QUALITY

- The competitive need for world class quality
- Quality is one of the essential requirements of the 1990s
- Product handling is a key element of TQC
  - the need for rail quantities and sealed boxes
- With electrical quality generally under control,  
non electrical quality is now the major focus
- EDI will be essential to reduce errors
- Traceability will be essential
- Distribution will be judged on zero error goals  
to a +/- 1 day shipment window

Key Issues

- Customer approved TQM practices in distribution  
will be essential for the quality conscious customer



THE CHANGING ROLE OF DISTRIBUTION IN EUROPE



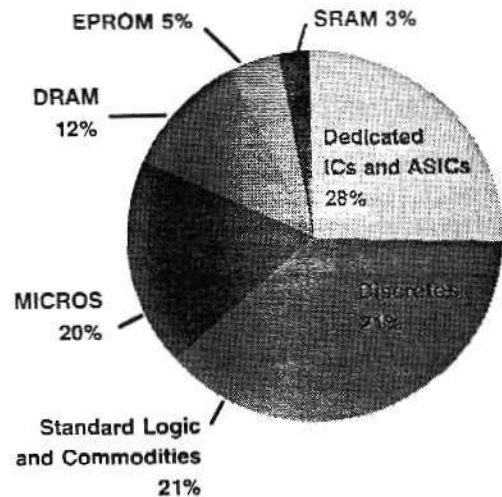
**AVNET**

## TECHNOLOGICAL SUPPORT

- The rate of change to VLSI is increasing
- Life cycles are reducing
- The fastest growing sectors will be MPU, ASIC, dedicated ICs and memory
- The component sell is increasingly becoming the system sell
- The customer requires strategic specialist assistance at the front end for processors and specialist assistance at the back end for interconnect and passive
- The distributor will increasingly need to understand the sector needs as well as the product features

### Key Issues

- The purveyor of stocked standard parts has a reducing presence in an ever increasing technological market place



THE CHANGING ROLE OF DISTRIBUTION IN EUROPE



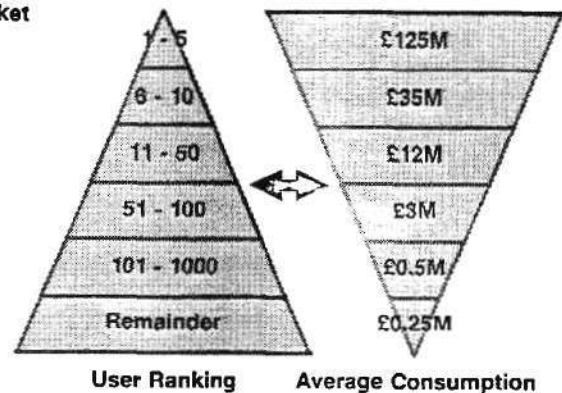
**AVNET**

## CUSTOMER COVERAGE

- The top 5 customers represent 20% of the market
- The bottom 49,000 customers represent 40% of the market
- Direct manufacturer coverage will increasingly be strategic and not volume dependant
- For 99% of the customers, distributor coverage is the only option
- Distribution must develop as well as service demand throughout the pyramid

### Key Issues

- Distribution will increase its market share as technical support, value added services and emphasis on cost of ownership increases



THE CHANGING ROLE OF DISTRIBUTION IN EUROPE



**AVNET**



## LONG TERM PARTNERSHIPS

- Local distribution will increasingly lose franchises to the Global and European Groups
- Distribution will be characterised by an increasing number of mergers and acquisitions
- The customer must develop long term partnerships with distributors and manufacturers alike
- Partnerships must be sought within the spirit of mutual trust
- Will distribution be characterised by a small number of Global Groups plus local niche specialists?
- Only distributors with an acceptable ROTC through the cycle will survive

### *The Key Issues*

- The customer must select tomorrow's distributors and manufacturers



THE CHANGING POLE OF DISTRIBUTION IN EUROPE



**AVNET**

## THE ADVANTAGES OF THE GLOBAL DISTRIBUTOR

- The high probability of franchise retention vs the local distributor
- The size and depth of available global inventories
- The inevitable reduction in cost of ownership as a result of economies of scale
- The benefits of global partnering to global customers
- The effort and resources capable of being directed towards "Total Quality"
- The ability to plan long term



THE CHANGING POLE OF DISTRIBUTION IN EUROPE



**AVNET**

## **EVOLUTION OF SEMICONDUCTOR PROCUREMENT**



Earl Kitchen  
Purchasing Manager  
GEC Plessey Telecoms

Mr. Kitchen is Purchasing Manager of GPT's largest division, Telephone Switching Group, at its headquarters in Liverpool, England. He is responsible for all procurement matters in relation to System X, intelligent networks, mobility and voice applications. Mr. Kitchen has been involved in the procurement function for almost 30 years, during which time he worked for Plessey, ITT (STC) and GPT. He received an M.Sc. degree in the Faculty of Management Sciences from Manchester University.

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**EUROPEAN SEMICONDUCTOR INDUSTRY CONFERENCE**  
June 3-5, 1992  
Dublin, Ireland

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## **"THE PROCUREMENT EVOLUTION IN TELECOMMUNICATIONS"**

- **The changing market place**
- **The changing buyer - supplier relationship**
- **Competitive advantage through the value-chain**
- **The change process in buyer-supplier relationships**
- **Creating the right conditions for buyers-suppliers**
- **Implications for suppliers**
- **Win-win relationships**

## **THE CHANGING MARKET PLACE**

- **Internationalisation of Telecom**
- **Industry restructuring**
- **Price erosion**
- **Technological advances**
- **Government legislation**
- **International trade policies**
- **Customer support**
- **Software content increasing**

# THE CHANGING BUYER/SUPPLIER RELATIONSHIP



**1960s/70s  
Adversarial**

**BUYING AT THE  
LOWEST PRICES**

**Them vs Us  
Many Sources  
Large Stocks**



**1980s  
Partnership**



**Partnerships  
Source Rationalisation  
Low Stocks**



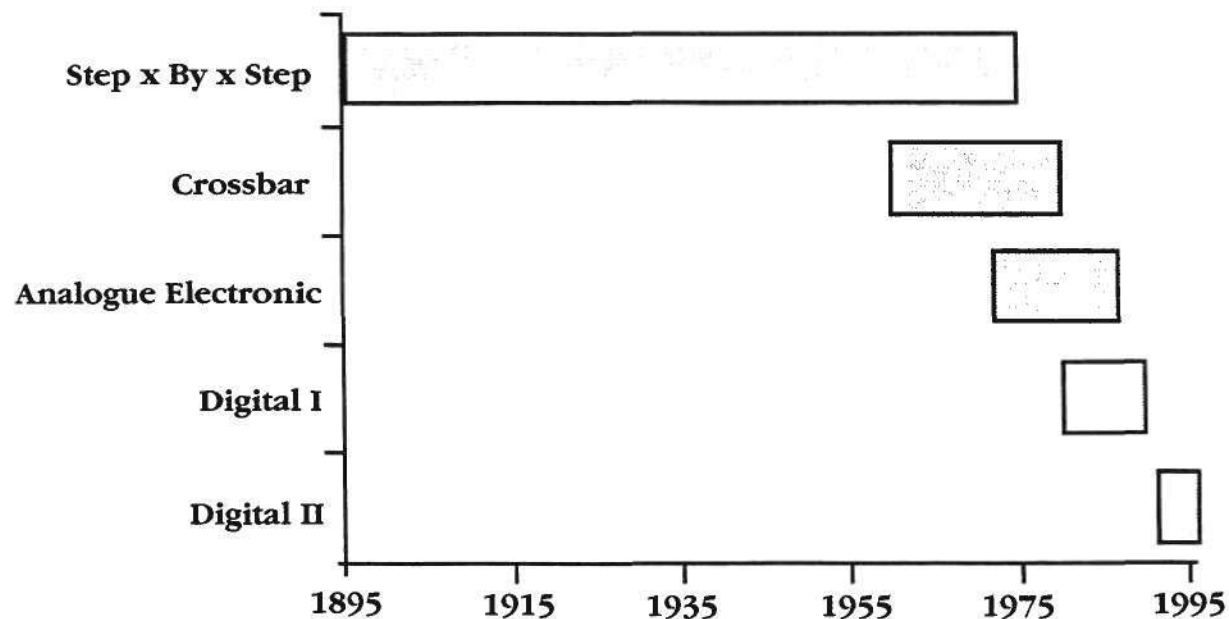
**1990s  
Searching/Balanced**

**INTERDEPENDENCE**

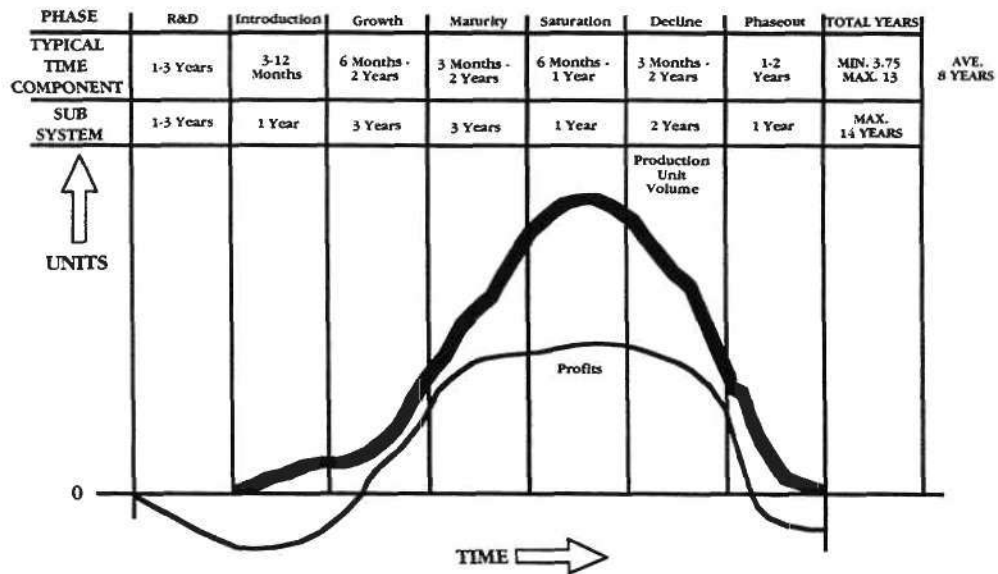
**Win-Win Relationships  
Change  
Market Complexities**

## PUBLIC SWITCHING PRODUCT LIFE CYCLES

**EQUIPMENT TYPES**

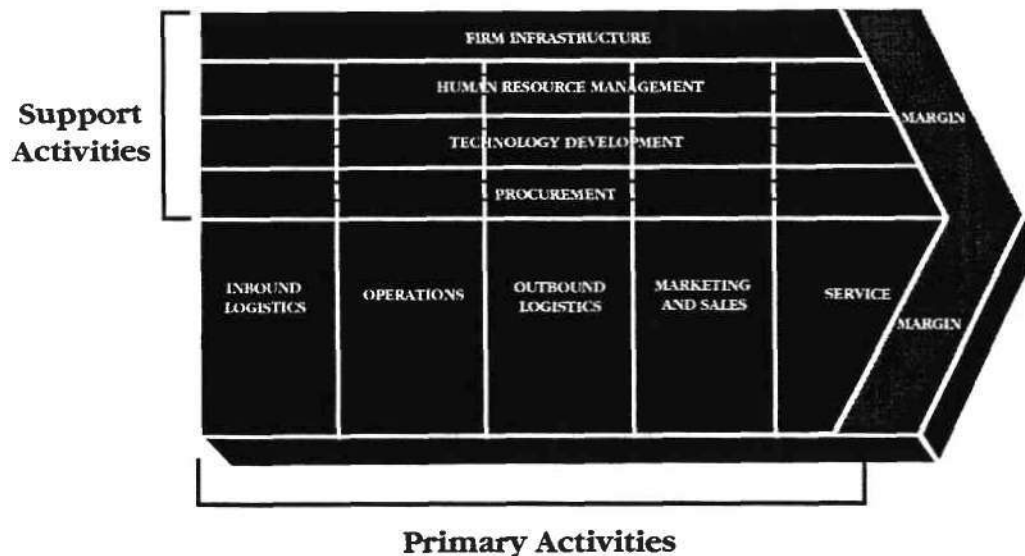


## TYPICAL INTEGRATED CIRCUIT LIFE CYCLE VERSUS TELECOMMUNICATION SUB SYSTEM



Source : Dataquest

## COMPETITIVE ADVANTAGES THROUGH THE VALUE CHAIN

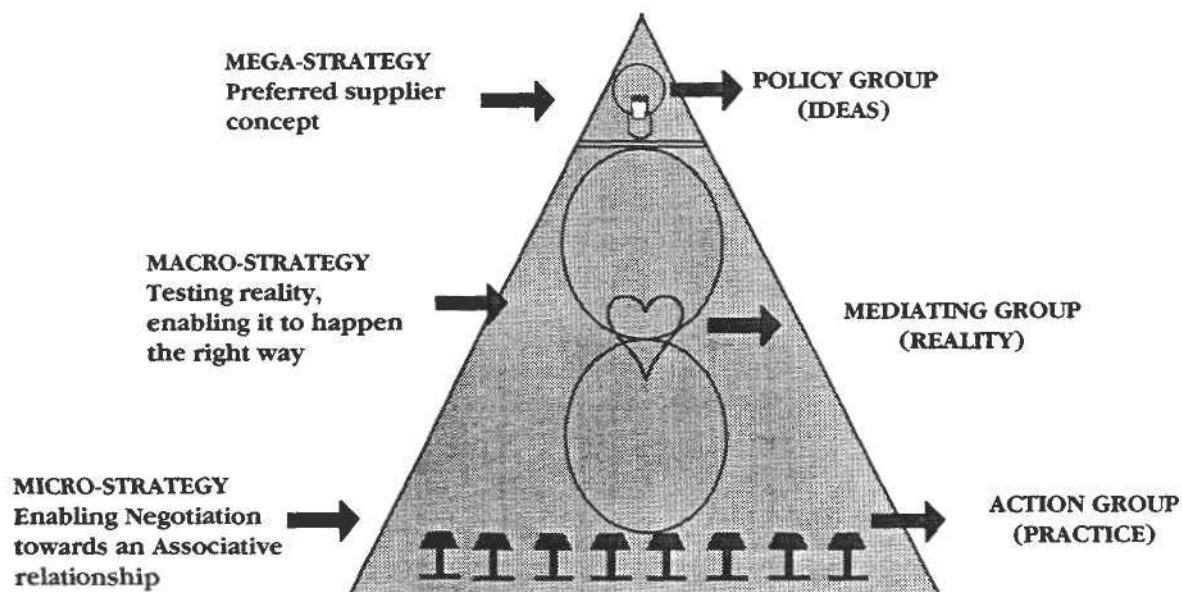


Source : Michael E. Porter (Competitive Advantage)

## CREATING THE RIGHT CONDITIONS FOR BUYERS

- Vision
- Ethics
- Resources
- Appraisal

## THE CHANGE PROCESS IN BUYER-SUPPLIER RELATIONSHIPS



## **CREATING THE RIGHT CONDITIONS FOR SUPPLIERS**

- **Early involvement**
- **Trust**
- **Solving problems together**
- **Fairness**
- **Keeping key players informed**
- **Develop opportunities together**

## **IMPLICATIONS FOR SUPPLIERS**

- **Fewer**
- **Larger**
- **Market driven**
- **Committed to continuous improvement**
- **Improved time to market**
- **Reduced lead times**
- **Sharing of risks**
- **Electronic trading**

## **WIN - WIN RELATIONSHIPS**

- **Regular senior executive meetings**
- **Consistent communication**
- **Integration of interfacing disciplines**
- **Ongoing audit process**

## **EVOLUTION OF SEMICONDUCTOR PROCUREMENT**



Klaus Wangerin  
Director  
European Procurement  
Sony Europa GmbH

Mr. Wangerin is Director of European Procurement for Sony Europa GmbH. He has spent many years in various responsible positions in Germany's consumer products electronics industry. Mr. Wangerin was General Manager Materials Division for Sony Wega Produktions GmbH. Prior to this he worked for Sony Europe and was responsible for all European procurement activities. Mr. Wangerin graduated as an Industrial Manager.

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Ladies and Gentlemen,

First of all I'd like to express my sincere appreciation for having the chance to speak to such a distinguished audience about some of the key issues facing a European consumer products manufacturer with a Japanese background, and I understand this role as an honour for our corporation recognizing our enormous efforts towards localization.

Thanks again to the organizer "Dataquest".

Sony has a history of more than 30 years in Europe and meanwhile 18 years have passed since Sony began to produce TV-sets in the United Kingdom. Sony has now got 15 production sites in Europe employing more than 8.000 people.

Time has passed and perhaps just a few people will remember that our European manufacturing operation started with almost all parts shipped from Japan but consistent with the decision of our chairman Mr. Akio Morita to work towards the global localization concept

*"Where we sell, we have to produce  
where we produce, we have to buy  
where we buy, we have to research."*

we are proud of our overall achievement in increasing the degree of local content in the various product lines and the high percentage of parts locally procured.

But material categories can differ and since today's subject is the "semiconductor", I think I should first present some slides to explain our demand in general and in Europe especially . They will explain with a brief overview the development of our usage by volume and semiconductor categories compared to the situation in Sony Japan. Regarding these slides I would briefly like to mention that the consumer hardware we are manufacturing in Europe consists of TV-sets, home- and personal-video units and audio products like compact disc player, car-radios and some hifi-units, not to forget loudspeaker boxes.

Slides	-	Sony demand total
	-	Sony demand by categories
	-	Sony demand Europe
	-	Sony demand Europe by categories



You may understand that I cannot show the split among the different vendors which are attracting us with their devices but if you buy and open our products you can easily see that we are sourcing parts for our production in Europe not only from Japan of course, but also a lot from the USA and Europe.

However, with my responsibility for European Procurement and strengthening localization I am still not satisfied with European semiconductors for use in producing products in Sony EC plants and there is certainly a large opportunity for doing more. The reason why that has not happened yet and why again it will take some time is difficult to explain but it has something to do with the keynotes we were asked to give to this conference.

In my opinion there are several fundamental reasons:

### 1) History

Nobody can deny that the sales forces of the European semiconductor industry have explored the potential Japanese procurement market rather late and have underestimated the obstacles to enter a market as a newcomer considering the needs of excellent products and with the concept to fulfill the cultural different requirements of that market.

I have now worked for about 25 years in the European/German electronics consumer market and I have not forgotten what tough work it was for Japanese sales engineers to develop an interest for their products in the European market in the mid-sixties but they have not given up and they have learnt the lesson that a newcomer has to be better in all aspects than an existing local source - European manufacturers must now learn this same lesson!

### 2) Communication

Apart from a few commodities the decision to integrate a new semiconductor in a new chassis- or set-design starts at a very early design-in-stage. Our members in research and engineering - whether located in Japan or in Europe - have to feel completely certain which products and which vendor will enable them to fulfill their requirements for an innovative, cost conscious and very reliable concept.

This feeling certainly is supported by good or bad experiences (trust and confidence), knowledge of the market, internal statistics about vendor rating and constant communication with

the partners of the semiconductor market. Communication is a matter of common understanding and that includes the key factor of language.

For some product lines we have already localized our engineering departments and here it can be proved the share of European semiconductors are the highest. But unfortunately for me in case of other product lines there is no urgent need to move these engineering activities to Europe. The reason is either that there is no advanced technology available in Europe - just think of personal video - or that Europe's industry has stopped the development and manufacture of certain products in Europe - if you think of several audio products. Which means in our case vendors have to look for a way how to awake our users interest. Believe me this will only happen if communication takes place at the source and unfortunately for you that means for various products - Japan -.

Another criteria in regard of communication should be that parts suppliers shall make effort to establish longterm relationship with their customers. The relationship will bring about open mind friendship between supplier and customer beyond company manners and the supplier will be able to get future information about products development and other useful information.

If a supplier wants to establish the relationship with a customer, he should consider multi-relations. The meaning is that the business talk used to include complicated factors for achieving the result. Sometimes the matter of engineering or top decision as for instance investment should be discussed in business talk.

Additionally it is to say that if the supplier has as a communication channel only the salesperson, he better should take a time for organizing communication channels between executive and executive or engineer and engineer to be able to understand all aspects of a longterm relationship.

Both parties should spent a lot of time for communicating what they think or what they want, even though the salesperson could arrange opportunity for discussion. And if the supplier has managed to arrange communication channel on each other's management level the supplier can easily respond quickly through the suitable channel.

### 3) Technology

I have already mentioned technology as a reason for not rushing set-engineering into Europe. Moreover in semiconductor technology we will find maybe another reason why European semiconductors participate below our target level in our demand calculation. We in Sony believe that the final customers, the consumers, are extremely interested in buying small and light-weight consumer products which they can carry, that are robust and reliable, but by no means cost more than they are used to paying for less compact products. I do not want to list all of Sony's inventions in this regard which have created new markets, but this was only possible with the strong support of our vendors towards miniaturization. Sony has set benchmarks but we are sure that we still have not reached the end of the road. And as usual these innovative tiny component devices soon will become standard, a reason why we want to know from our vendor candidates what product strategies they have in mind. Most of our concern is IC package. According to the result of our survey, 93 % of Japanese semiconductor users have headaches of finding suitable tiny and thin IC package as like VSOP and VQFP in foreign semiconductor's line up, even if user can find suitable function of chip.

European semiconductor manufacturers do not seem to intend to develop devices in miniaturized packages because of not so strong market demand in Europe. We hope that European semiconductor manufacturers become aware that miniaturization technology is a fruitful apple tree.

Another concern of us are the low power consumption chips. As customer of WALKMAN knows, consumer products operate on a battery of 1,5 volt but we do not know foreign semiconductor manufacturers who are able to design 1,5 V operation CMOS chips. Japanese semiconductor user of consumer products are looking for good capable partner of foreign semiconductor manufacturers, which means only vendors who are able to support us in our requirement for innovation can actually become key-vendors, being involved at the earliest stage in the development of new products. The next slides may underline the direction we are marching towards package design.

Slides:                      Package design

#### 4) Customer satisfaction

For our semiconductor demand there exists a significant number of companies who want to supply us with their devices. Sometimes it is very hard to make the correct decision but one factor can be counted as the key for the vendor selection:

##### Customer satisfaction

We in Sony see it as our external as well as internal duty to manage our tasks towards 100 % customer satisfaction. Everybody is a customer but in turn has a customer too. To be satisfied is one issue, but to satisfy a customer is even more difficult and if you think of all the necessary factors for 100 % customer satisfaction you will come to a long check-list.

I have already outlined some of these requirements. One is communication and this includes more European design-in centres in the semiconductor branch with Japanese speaking members in Japan. Another is technology in products and packaging but we should not forget quality as well.

Quality is one of our major sales arguments. As you may understand the miniaturization and complexity of the sets does not allow repairs anymore. So far the quality of the devices is a key factor in our vendor-selection. I don't want to go into details but frankly speaking there exists a big gap between the different global semiconductor markets.

And as you know, the Japanese user looking for good partner as a supplier who can quick respond for urgent trouble. Most foreign semiconductor manufacturers have a business contract with Japanese traders but if trouble occurs on production line at user's site, the trader must take care of the user's trouble.

But due to lack of communication between trader and semiconductor manufacturers or technical capability of the trader, sometimes we have frustration that is caused by slow response. Foreign semiconductor manufacturers should feel much more responsible for traders training.

There are many more points that are necessary for complete customer satisfaction. Let me just mention on-time delivery, cost performance, response time, participation in improvement programmes or involvement in environmental issues such as recycling.

A final issue I'd like to add. Business can be a matter of a big contract which involves all legal, technical and commercial affairs and sometimes vendors want to start business on the base of such a contract including a promise for long-term relationship.

But is not customer satisfaction a better base for doing business? A customer who is satisfied will use this experience as a foundation to build business relationships.

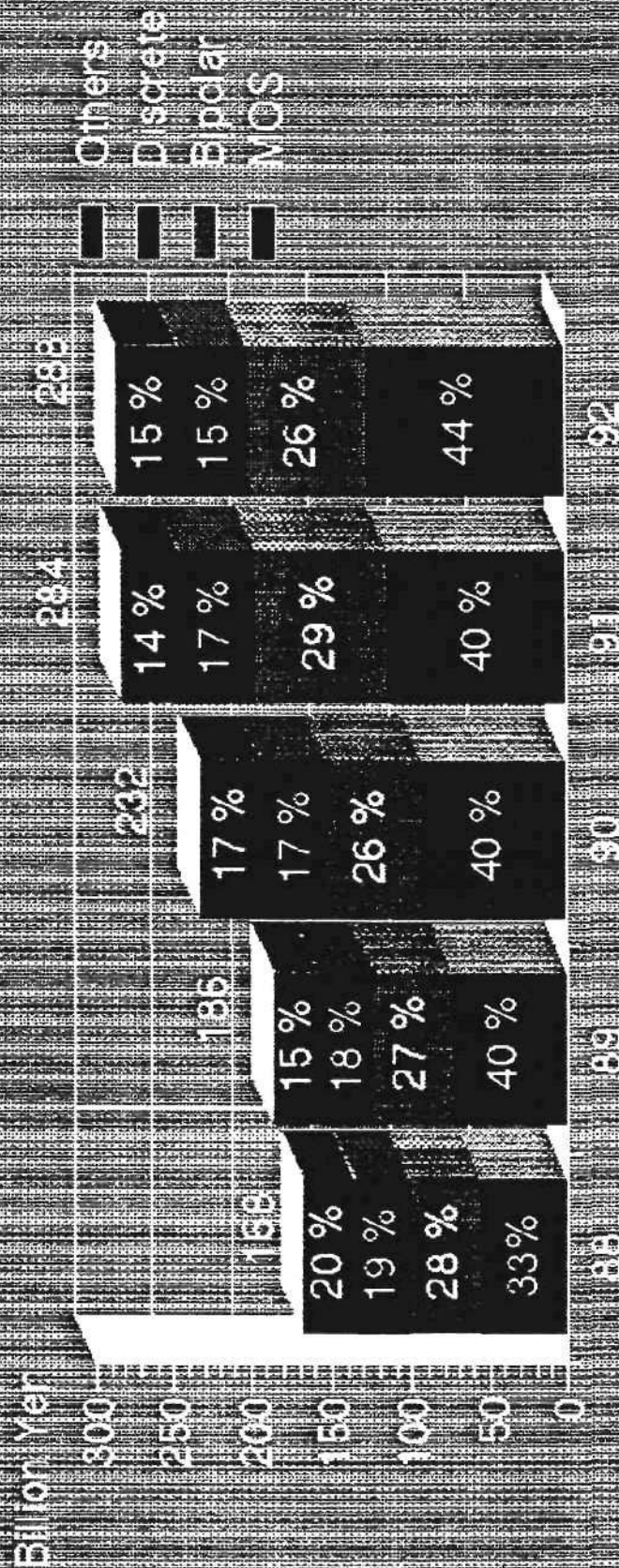
The Japanese electronics industry has furnished a requirement list for foreign semiconductor manufacturers which should be considered as a minimum requirement to satisfy Japanese set-makers. Let me present this chart as a summary of the arguments needed for achieving customer satisfaction.

Slide	Requirement list
-------	------------------

This chart is fully in line with our European opinions and let me close my speech with the hope that the European semiconductor industry with all of its products and operations will become so attractive that Sony will be forced to integrate more European semiconductors into its products. Not only in consumer products for the European market but in its products for the other global markets as well.

Thank you for your attention.

# ESTIMATE SEMICONDUCTOR TOTAL CONSUMPTION IN SONY WORLDWIDE





# COMPARISON TOTAL CONSUMPTION WORLD vs. SONY

SONY: 284 BIO YEN

Source: 1991 WSTS

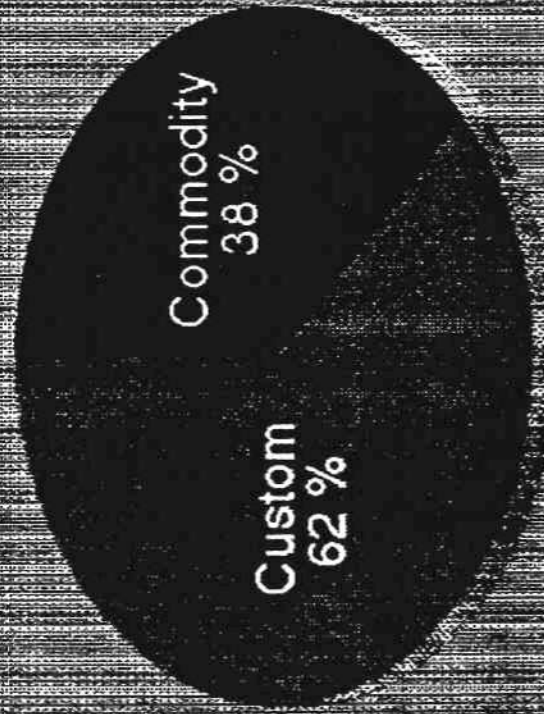
4 %

WORLD: 7.200 BIO YEN

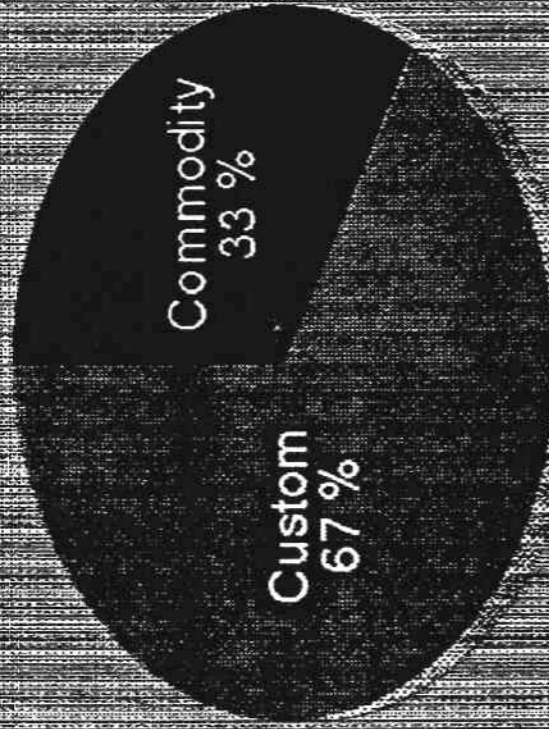
SONY

CUSTOM/COMMODITY RATIO OF TOTAL  
SEMICONDUCTOR CONSUMPTION IN SONY

FY 88



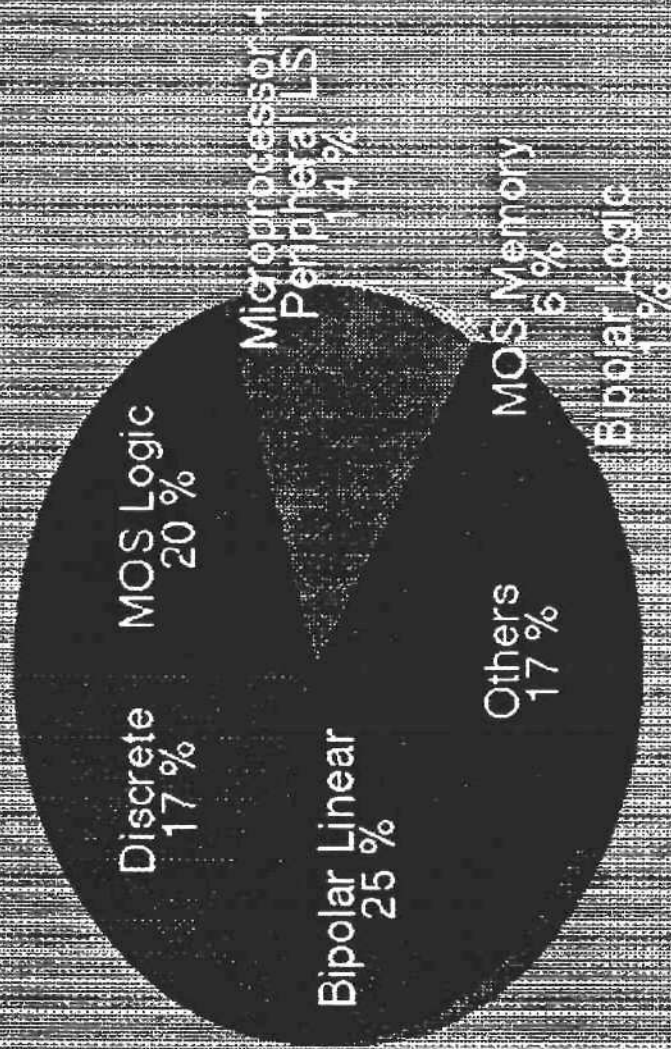
FY 91





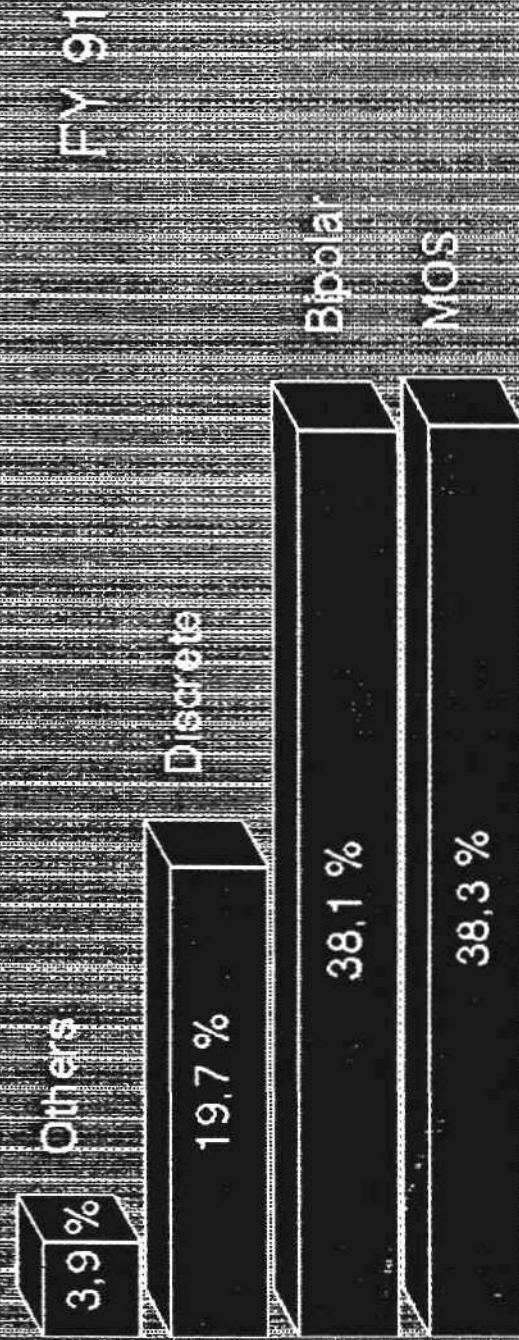
# SEMICONDUCTOR TOTAL CONSUMPTION IN SONY JAPAN BY CATEGORY

FY 90



SONY

# SONY EUROPE SEMICONDUCTOR CONSUMPTION





# SEMICONDUCTOR TOTAL CONSUMPTION BY CATEGORY IN SONY EUROPE

FY 91

Bipolar Logic  
2.5 %

Others  
3.9 %

MOS Memory  
0.5 %

Microprocessor+  
Peripheral LS  
11.9 %

Bipolar Linear  
35.6 %

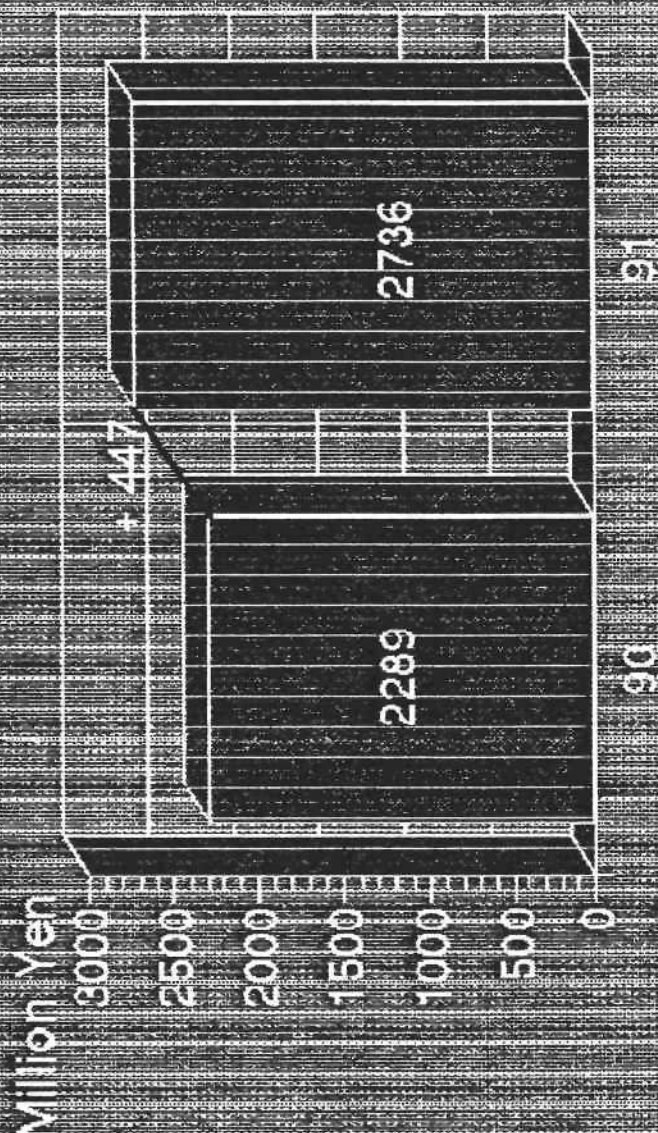
MOS Logic  
25.9 %

Discrete  
19.7 %

SONY



# EUROPEAN SEMICONDUCTOR SUPPLIES TO SONY JAPAN



SONY



TREND

- Quad Flat Plastic Package for Surface Mount (QFP-type)

QFP



VQFP

1.27 mm - 0.65 mm



0.5 mm

lead pitch

SONY



# TREND

• Small Outline Plastic Package for Surface Mount (SOP-type)

SOP

SSOP

1.27 mm

0.65 mm

lead pitch



## TO ACHIEVE THE HIGH-DENSITY MOUNTING

- Change to small and low-profile devices
- shrink SOP from 1.27 mm lead pitch to SSOP with 0.65 mm
- fine pitch QFP (1.27 - 0.65 mm) lead pitch to 0.5 mm, next target may be 0.3 mm in lead pitch
- 1608 package for small signal transistors
- 1712 package (2012 eq.) diode
- 1005 type package is under development



# TO ACHIEVE THE HIGH-DENSITY MOUNTING

---

- Improved heat-resistant package of IC's
- Free from heat-destruction in reflow soldering
- reflow soldering is applied two times (or more) for double sided assembly



# TO ACHIEVE THE HIGH-DENSITY MOUNTING

- Surface of P.C.B. shall be filled by components
- precision form of components give space-saving between device to device
- multi-layer P.C.B. is applied to minimize surface wiring
- SMD small size connector is used

## TREND

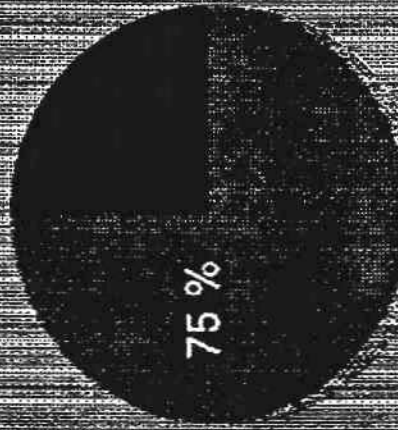
- Surface Mount Type Parts Quantity Ratio in Sony Products



1988



1990



1993  
(Estimation)

Japanese trend for reference: 58 %



# TECHNICAL SPECIFICATION FOR PRECISE PACKAGE

---

- Heat proofing plastic mold materials
- High reliability chips
- Precise arrangement of package lead
- Solderable lead plating



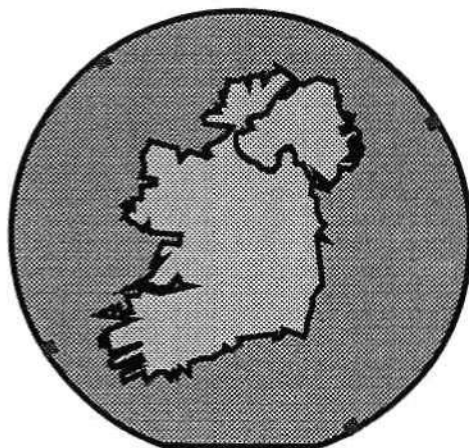
## WHAT FACTORS WERE OBSTACLE TO ADOPT FOREIGN SEMICONDUCTORS?

- Electric specifications of the semiconductor chip were satisfactory but suitable package was not existing 93 %
- Electric specifications were not satisfactory 33 %
- Electric specifications and package were satisfactory but leads arrangement and other quality control factors were not satisfactory 27 %
- Satisfied package was existing but electric specifications were not satisfactory 20 %



# REQUIREMENTS - PROPOSALS FROM USER'S POINT OF VIEW

- Establish Local Design Centres
- Build trust between users and suppliers
- Speed up processing of quality control problems
- Provide proper training for distributors
- Develop surface-mount devices
- Improve responsiveness to user's flexible production plans



## **PANEL SESSION 2: SEMICONDUCTOR MANUFACTURING IN EUROPE**

***Chaired by Bipin Parmar***  
Dataquest Europe Limited

***Thomas E. Hartman***  
Intel Corporation

***George Bennett***  
Motorola Semiconductors Ltd.

***Larry Murtagh***  
NEC Semiconductors Ireland Ltd.

***Laurent Bosson***  
SGS-Thomson

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## SEMICONDUCTOR MANUFACTURING IN EUROPE



Thomas E. Hartman  
General Manager  
Ireland Components Manufacturing  
Intel Corporation

Mr. Hartman is currently General Manager, Ireland Components Manufacturing for Intel Corporation. He has been in the semiconductor field since 1959 in various capacities ranging from R&D to wafer fab plant management. With Texas Instruments he started up the company's first Japanese wafer fab. Mr. Hartman then joined Intel where he has been involved with nine fab start-ups over the last 17 years.

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at the time of publication**



## SEMICONDUCTOR MANUFACTURING IN EUROPE



George Bennett  
Vice President and General Manager  
MOS Memory and Microprocessor  
Division (Europe)  
Motorola Ltd.

Mr. Bennett joined Motorola in 1979. He held various management positions in the wafer fabrication area before being appointed General Manager, East Kilbride, Scotland in 1988. In the same year he was appointed Vice President and General Manager, MOS Memory and Microprocessor division of the European Semiconductor Group. Prior to this he held various positions within Ferranti, Glasgow University and Logitech, and ran his own manufacturing business. Mr. Bennett gained a B.Sc. in Applied Physics from Heriot-Watt University and then graduated from Glasgow University in 1969 with a Ph.D in Electronics and Electrical Engineering.

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## SEMICONDUCTOR MANUFACTURING IN EUROPE



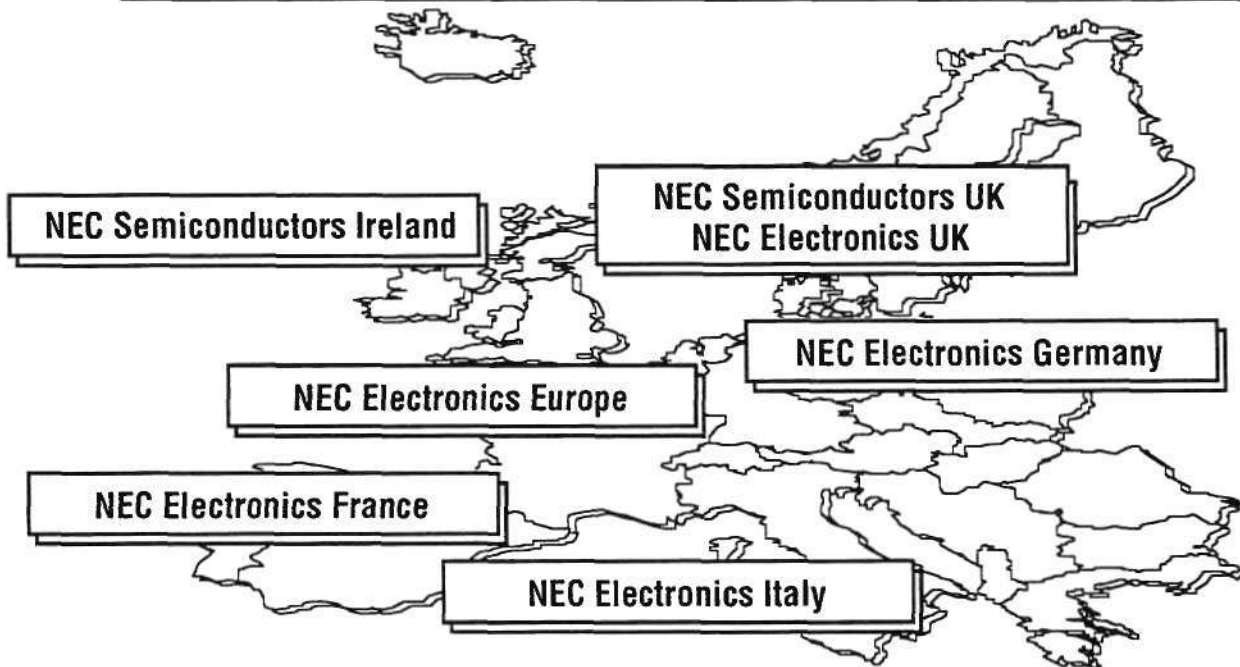
Larry Murtagh  
Managing Director  
NEC Semiconductors Ireland Ltd.

Mr. Murtagh is Managing Director of NEC's Semiconductor manufacturing facility located in Co. Meath, Ireland. His company is responsible for assembly and test of memory, micro-processor and application-specific integrated circuits for the European market. Before joining NEC, Mr. Murtagh was Managing Director of Ecco Ltd., the European subsidiary of General Electric (USA) Semiconductors. Mr. Murtagh received a B.Sc. degree in Chemistry at University College, Galway, Ireland.

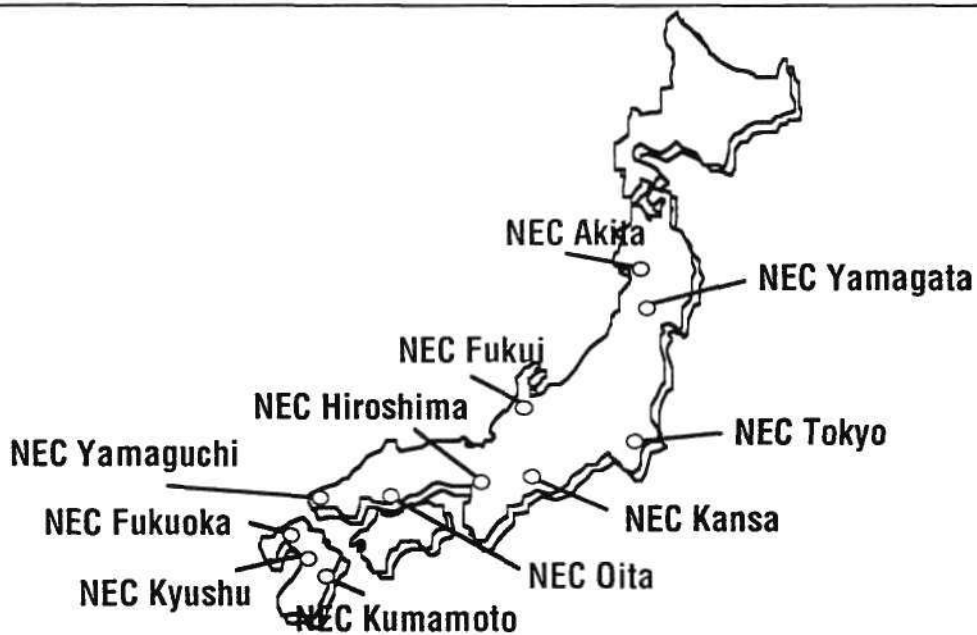
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## NEC Europe

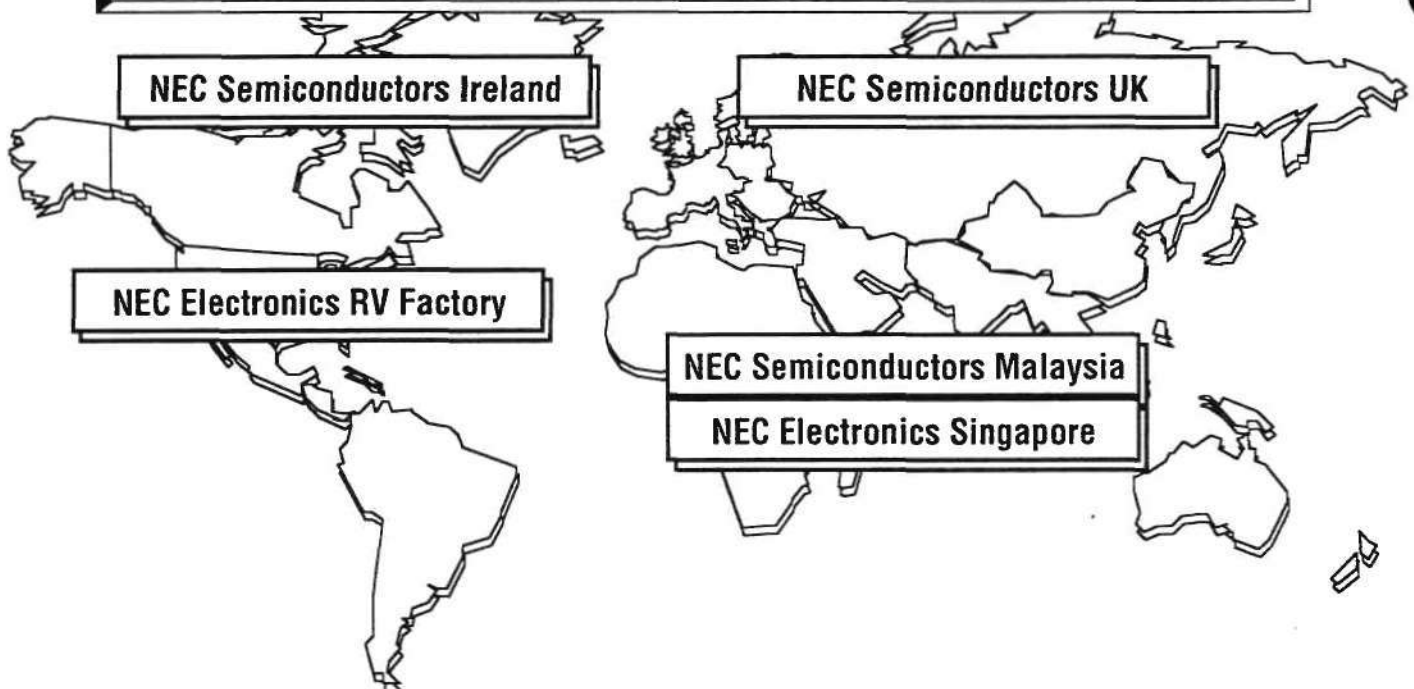


## NEC Semiconductor Manufacturing Japan



**NEC**

## **NEC Semiconductor Manufacturing World Wide**



## **Issues**

- 1. Why Do You Think Manufacturing Semiconductors in Europe is More Expensive than Other Parts of the World?**
- 2. Why is it Important to Manufacture in Europe if it is More Costly Here?**
- 3. Is it Viable to Expect a European Plant to be Constructed to Supply Just Local Market Needs or Must it supply Products for Worldwide Consumption?**
- 4. Do You Think there are Factors that Lead to a European Plant Being More Inefficient than Elsewhere, eg Training Skills, Supplies, Local Government?**
- 5. How Do You Think Government Policies Effect Manufacturing in Europe? Which Policies Help and Which Hinder?**

## Semiconductor Manufacturing in Europe More Expensive?

Cost	Japan	Europe
Land	Higher	Lower
Building / Servces	Higher	Lower
Equipment	Lower	Higher

Total Startup Cost Compared to Japan = Marginally Higher

## European Semiconductor Manufacturing

- Start up *Cost* of a European Wafer Fab is Slightly Higher than in Japan
- Offset by *Benefits* from European Wafer Fabrication

## **European Semiconductor Manufacturing**

### ***NEC Policy:***

**Production Inside Market to Support  
European Customer Needs**

## **European Semiconductor Manufacturing**

### **Benefits:**

- **Service / Flexibility for Customer Satisfaction**
- **Improved Logistics and Communication**
- **Positive Trade and Technology Balance**
- **Key Element of European Business Structure**

## NEC's European Business Development

1st Stage '72

Direct  
Export

2nd Stage '73 - '74

Sales Through  
Subsidiaries

3rd Stage '74 - '86

Assembly  
Overseas

4th Stage '87

Integrated  
European  
Production

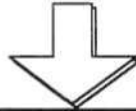
## Basic Policy of NEC's Globalisation

1. Production within the Market to Support Regional Needs
2. Affiliates to be Placed in the Most Suitable Locations
3. Inter Regional Cooperation on Specific Products



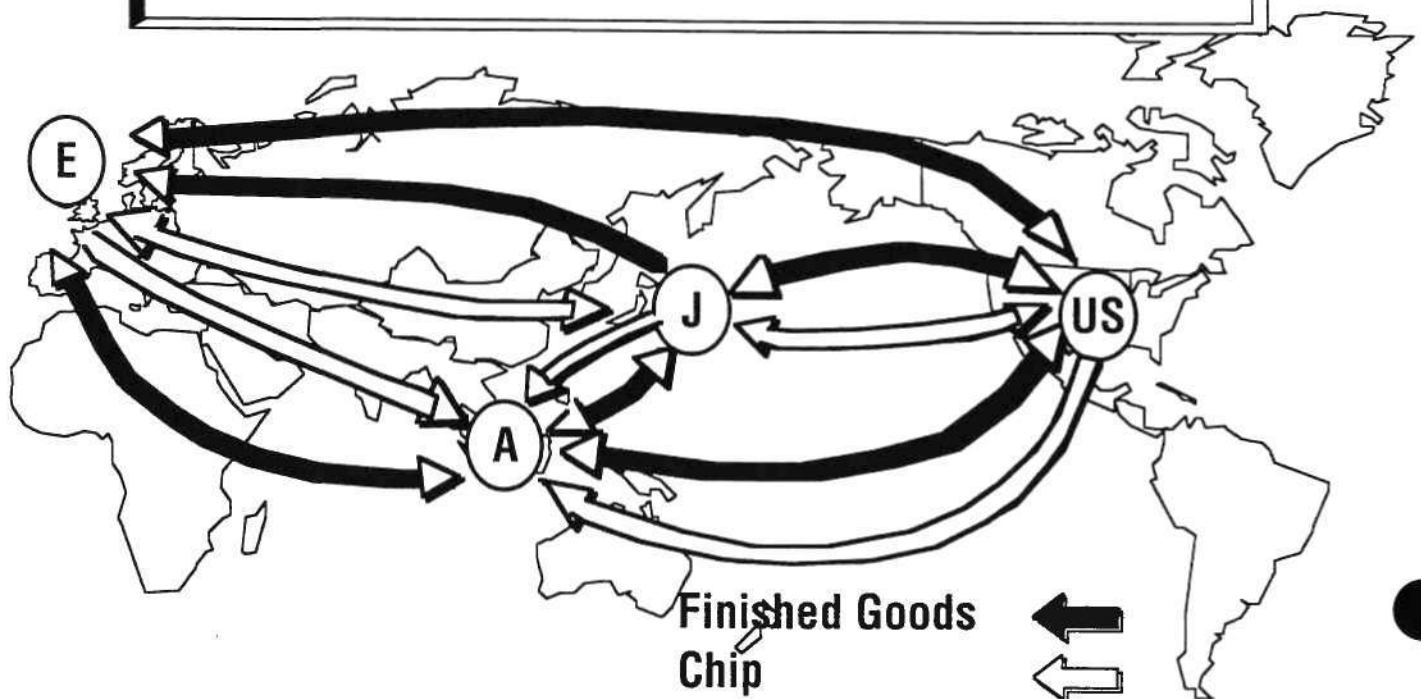
## Philosophy for Manufacturing

- Use of the Most Advanced Equipment World Wide
- Production of Various Products to Support the Market
- Worldwide Production / Information Network



## Establishment of World Wide Integrated Manufacturing

## Global Logistics Semiconductors



## **European Manufacturing Environment**

- **Education / Training Positive**
- **Local Governments Supportive**
- **Main Problem is Absence of Major European Semiconductor Equipment Vendors**
- **Import of Equipment from Japan / USA is Expensive**
- **Import Duty on Equipment by European Governments Further Increases Cost**

## **Government Policies**

### ***Positive:***

- **Local Investment Incentives**
- **Capital Allowances**
- **Local Content**

### ***Negative:***

- **Import Duty on Semiconductor Equipment**

## **European Semiconductor Manufacturing**

### ***Summary:***

- **Wafer Fabrication Manufacturing Cost is Similar to Japan**
- **Local Manufacturing Improves Customer Satisfaction and Service**
- **NEC's Semiconductor Business is Committed to Worldwide "Globalisation" Concept**

***NEC***

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## SEMICONDUCTOR MANUFACTURING IN EUROPE



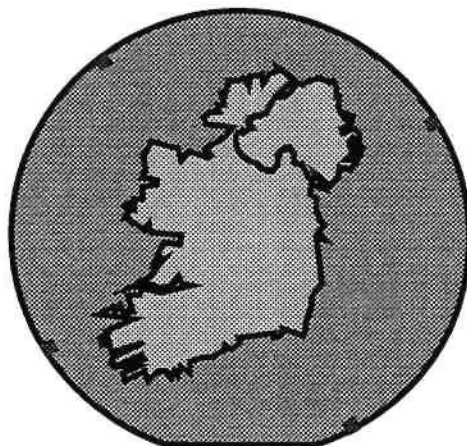
Laurent Bosson  
Corporate Vice President  
Manufacturing  
SGS-Thomson

Mr. Bosson is Corporate Vice President, Director of Central Manufacturing and Director of VLSI fabs for SGS-Thomson. He was also appointed President of SGS-Thomson Microelectronics US earlier this year. Prior to this he was General Manager of the Rennes facility for SGS Microelettronica, later SGS-Thomson Microelectronics Group. Before this Mr. Bosson held various positions in the components branch of Thomson CSF responsible for maintenance, engineering manufacturing and business administration. He graduated from the University of Dijon, France with a degree in Chemistry and Physics.

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## **EXECUTIVE ISSUES: THE SEMICONDUCTOR INDUSTRY INTRODUCTION**

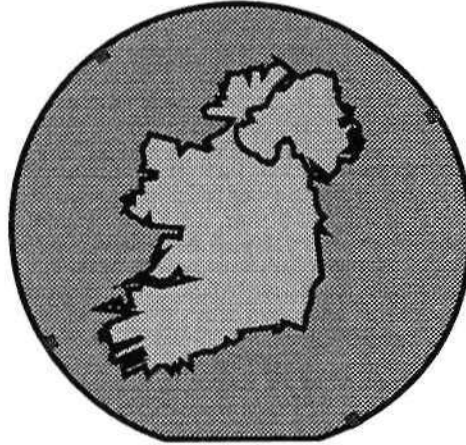
***Jim Eastlake***

Senior Industry Analyst and Manager  
European Semiconductor Group  
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## **FUTURE TRENDS IN LCD MARKETS AND TECHNOLOGIES**

***Isamu Washizuka***  
Corporate Director  
Sharp Electronics Europe GmbH

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## **FUTURE TRENDS IN LCD MARKETS AND TECHNOLOGIES**



Isamu Washizuka  
Corporate Director  
Sharp Electronics GmbH

Mr. Washizuka is Corporate Director of Sharp Electronics GmbH. He is also General Manager of the LCD Group. Mr. Washizuka has held many managerial roles within different divisions. He is a senior member of the IEEE and a member of the Institute of Electronics, Information and Communication Engineers. Mr. Washizuka graduated from Osaka Prefecture University, Japan.

Dataquest Europe Limited  
**EUROPEAN SEMICONDUCTOR INDUSTRY CONFERENCE**  
June 3-5, 1992  
Dublin, Ireland

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## **PROMISING FUTURE OF LCD ( 1 )**

**LCD WHOSE INITIAL APPLICATIONS WERE SMALL NUMERIC DISPLAYS FOR CALCULATORS AND WATCHES HAS BEEN QUICKLY EXPANDING ITS APPLICATIONS.**

**THANKS TO ITS DISPLAY QUALITY AND LOW POWER CONSUMPTION, WHICH DIFFERENTIATES LCD FROM OTHER FLAT DISPLAYS, LCD HAS MADE CONSIDERABLE CONTRIBUTION TO CREAT ENTIRELY NEW MARKETS FOR PORTABLE EQUIPMENT SUCH AS PORTABLE WORD PROCESSORS, PERSONAL COMPUTERS(PC),INCLUDING NOTE BOOK PC.**

**LCD IS REGARDED, THEREFORE,"THE" FLAT DISPLAY HAVING THE HIGHEST COST-PERFORMANCE AND IS EXPLODING ITS APPLICATIONS IN THE FOLLOWING FOUR AREAS**

**SHARP**

- 1. VISUAL APPLICATION /OA DISPLAY ( DIRECT VIEW DISPLAY, LCD PROJECTORS, VIRTUAL REALITY, ETC. )**
- 2. NEW INFORMATION DISPLAY DEVICES SERVING AS INTELLIGENT ELECTRONIC WRITING PAPER (PROVIDING INTERACTIVE RELATION BETWEEN HUMAN AND MACHINE, BETWEEN MACHINES, AND BETWEEN MACHINE AND NATURE)**
- 3. INTERIOR AND EXTERIOR APPLICATIONS (APPLICATIONS UTILIZING THE MOLECULAR ORIENTATION CONTROL FUNCTION IN ADDITION TO DISPLAY)**
- 4. SUBSTITUTE FOR CRT TO SOLVE THE PROBLEM ( MAINLY 14" OR SMALLER CRTS FOR DIRECT VIEW LCD)**

**SHARP**

## **PROMISING FUTURE OF LCD ( 2 )**

**THE EVER GROWING NEEDS FOR COLOR DISPLAYS CREATE NEW APPLICATIONS OF COLOR LCDS, EXPANDING TFT-LCD APPLICATIONS BECAUSE OF ITS MULTI-MEDIA DISPLAY CAPABILITY.**

**SHARP**

## **PROMISING FUTURE OF LCD ( 3 )**

### **○ CONTRIBUTION TO HIGHLY INFORMATION-ORIENTED SOCIETY**

**AS SHOWN BELOW, LCD IS NOT ONLY USED IN SPECIAL AREA BUT ALSO IN PRODUCTS AND EQUIPMENT FAMILIAR TO ORDINARY PEOPLE. WITH THE TECHNOLOGICAL ADVANCEMENT, LCD WILL COME CLOSER AND CLOSER TO HUMAN, SERVING AS BETTER INTERFACE BETWEEN HUMAN AND INFORMATION MEDIA**

#### **[ OA/OA EQUIPMENT ]**

**SPACE & ENERGY SAVING WITH AMENITY**

#### **[ HOME/PERSONAL EQUIPMENT ]**

**BETTER ACCESS TO INFORMATION "ANYWHERE, ANYTIME"**

**EXAMPLE: PORTABLE PLAYBACK TERMINAL SUCH AS**

**CAMCODER, CD-ROM, CD-I, PALMTOP (PC)**

**HYPER ELECTRONIC ORGANIZER**

**[ AUTOMOBILE ] NAVIGATION-SYSTEM (GPS DISPLAY)**

**[ PUBLIC TRANSPORTATION ] IN-TRAIN ENTERTAINMENT  
INFORMATION PANEL**

**SHARP**

## **New Creative Products**

**LCD HAS GREAT POTENTIALITY TO CREATE NEW MARKETS FOR FINISHED PRODUCTS SINCE LAST YEAR, WHICH CRT COULD NOT REALIZE WITH CONVENTIONAL TECHNOLOGIES, AS SHOWN IN THE FOLLOWING PAGES.**

**SHARP**

- 1. THE 32-BIT COLOR NOTEBOOK PERSONAL COMPUTER EMPLOYING THE 8.4" TFT COLOR LCD CAN DISPLAY THE DELICATE COLOR TONES WHICH ARE NECESSARY FOR COLOR GRAPHICS. THE COLOR NOTEBOOK PERSONAL COMPUTERS ARE INCREASING RAPIDLY.**

**SHARP**

2. UNTIL LAST YEAR MOST OF THE COLOR LAP-TOP PERSONAL COMPUTERS COMMERCIALY AVAILABLE HAD VGA DISPLAY (640 X RGB X 480 PIXEL MODE) WITH 512COLORS. IN THIS YEAR THE MULTI-MEDIA LCD CAPABLE OF DISPLAYING 260,000 COLORS OR 16,700,000 COLORS HAS BEEN BEGINNING TO BE USED.
3. PEN-INPUT OR PEN-BASED PALMTOP PC / NOTEBOOK PC HAVE BEEN INTRODUCED, OFFERING EASY INTERACTIVE FUNCTIONS.

— SHARP —

4. "WALL- HUNG TV " INCORPORATING 8.6" TFT COLOR LCD IS GETTING POPULAR IN THE MARKET.
5. WIDE SCREEN LCD PROJECTION HDTV WITH 16:9 ASPECT RATIO HAS BEEN MARKETED.

— SHARP —

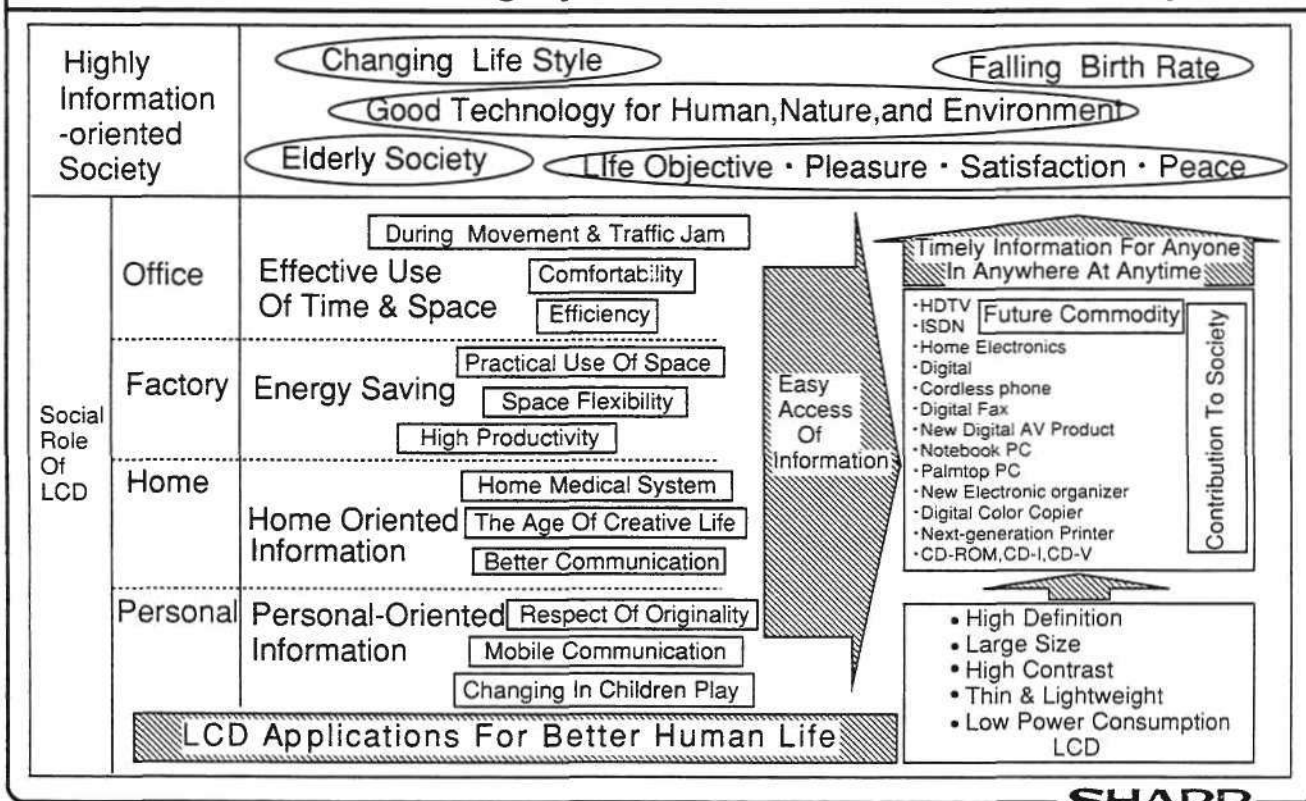
## Application Of LCD(STN,MIM,TFT)

Application			Simple Matrix	Active Matrix	
			STN	TFT	MIM
Small And Middle Size	B / W	Pocket Calculator And Auxiliary Display Of Information Machine	◎	△	△
		Palm-top PC	◎	△	○
		New Electronics System Passport	◎	△	○
		Digital Cordless telephone	◎	△	△
	Color	TV game	◎	△	○
		TV Telephon	○	◎	◎
		Portable TV	△	◎	○
		Home Electronics	△	◎	○
		Digital Copy machine	△	◎	△
		View Finder	○	◎	○
		Camera with VTR Monitor	△	◎	○
		CD-ROM,CD-I,CDV	△	◎	○
		Seat Vision	△	◎	○
		LC D Projection	△	◎	△
		Navigation System	△	◎	○
	B / W	Lap-top PC	◎	△	○
		Note Book PC	◎	△	○
		Word Processor	◎	△	△
		Work Station	◎	△	○
		Digital Fax	◎	△	△
		Next generation Printer	○	△	○
	Color	Lap-top PC	○	◎	○
		Note Book PC	○	◎	○
		Work Station	○	◎	○
		Machine for ISDN	△	◎	○
		New Digital AV	△	◎	○
		Wall Hung TV	△	◎	○
		HDTV	△	◎	△

◎: Excellent   ○: Good   △: Fair

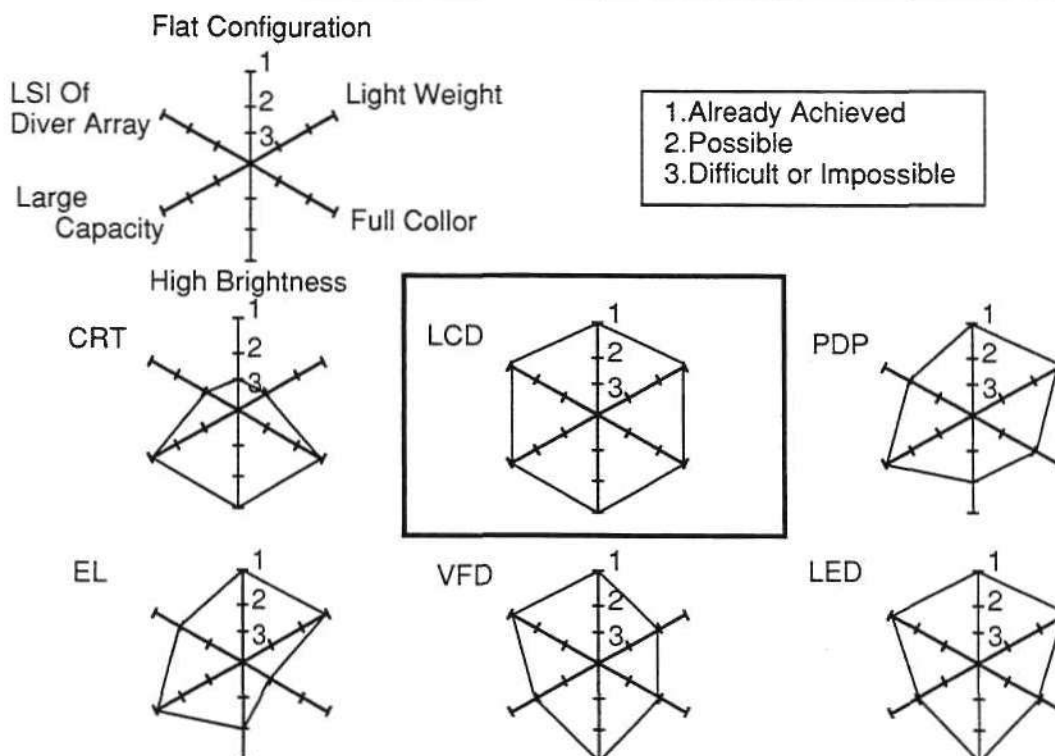
**SHARP**

# LCD's Role In Highly Information-oriented Society



SHARP

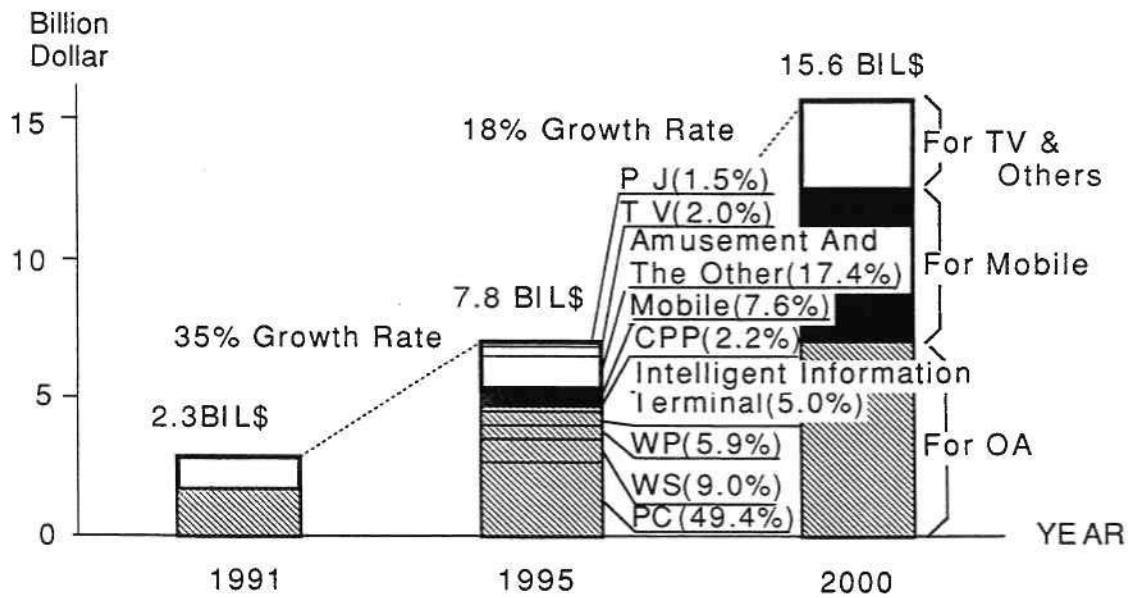
## Comparison Of Display Technology



SHARP



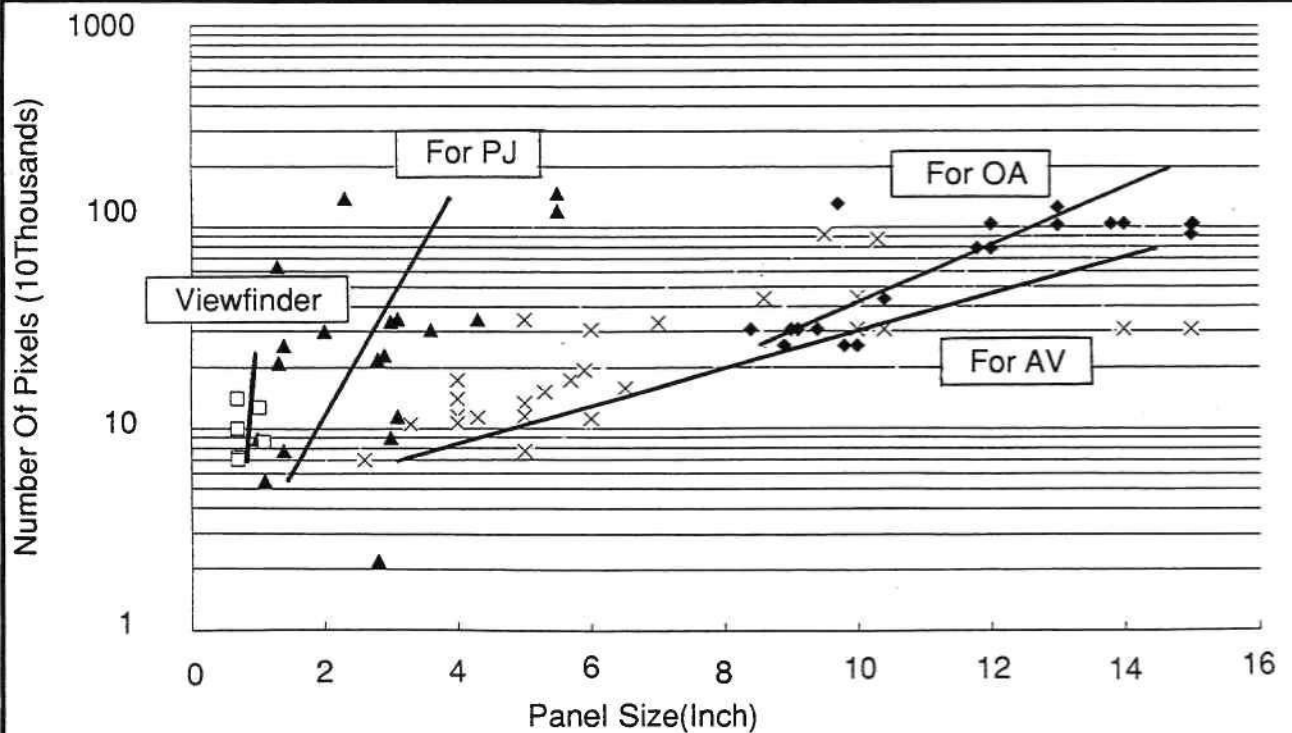
## Market Forecast Of LCD



Ref: Nomura Research Ins. / Sharp

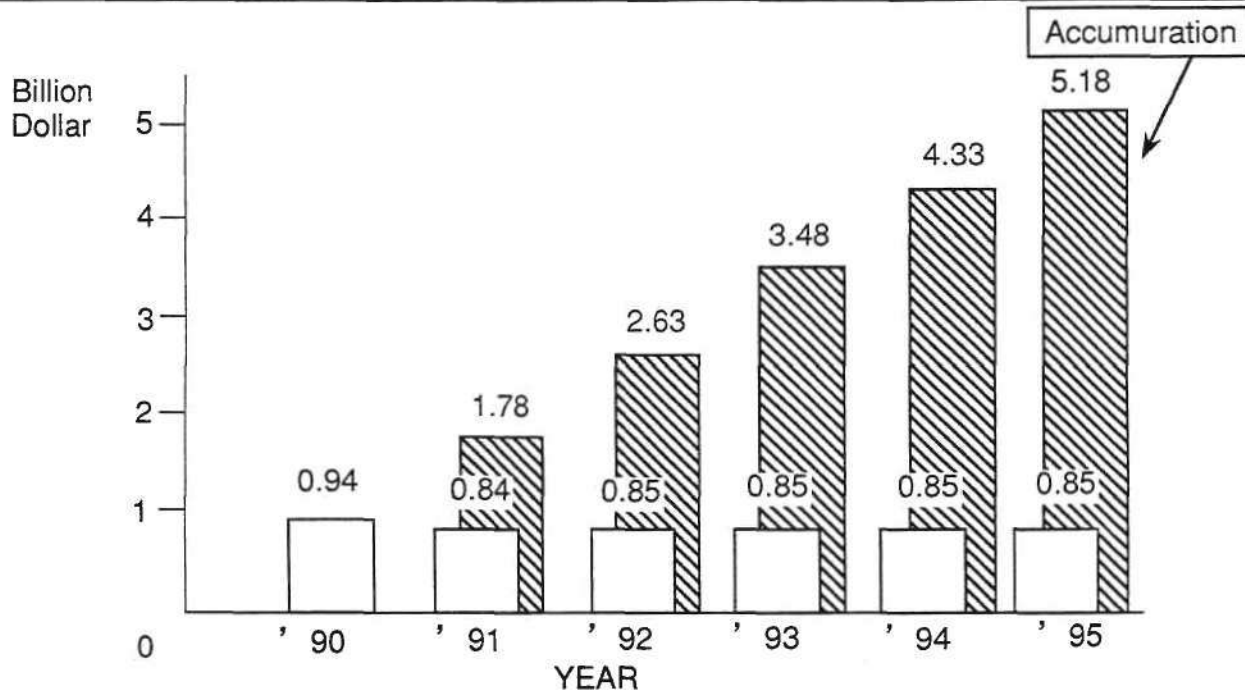
**SHARP**

## Size vs Pixel Of Active Matrix LCD



**SHARP**

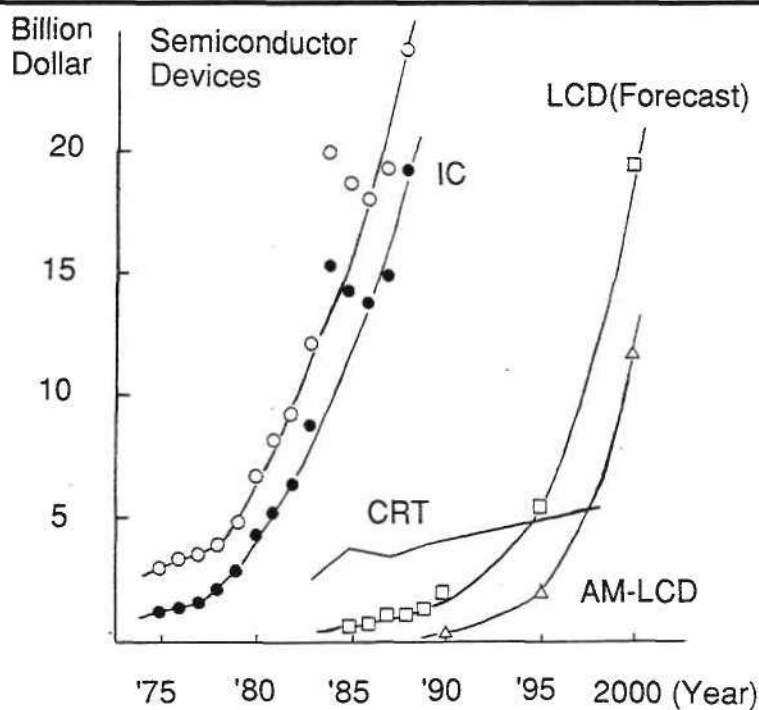
## Forecast For Capital Investment By LCD Panel Manufacturers



Ref. : Nikkei BP Flat panel Display '92 , /Sharp

**SHARP**

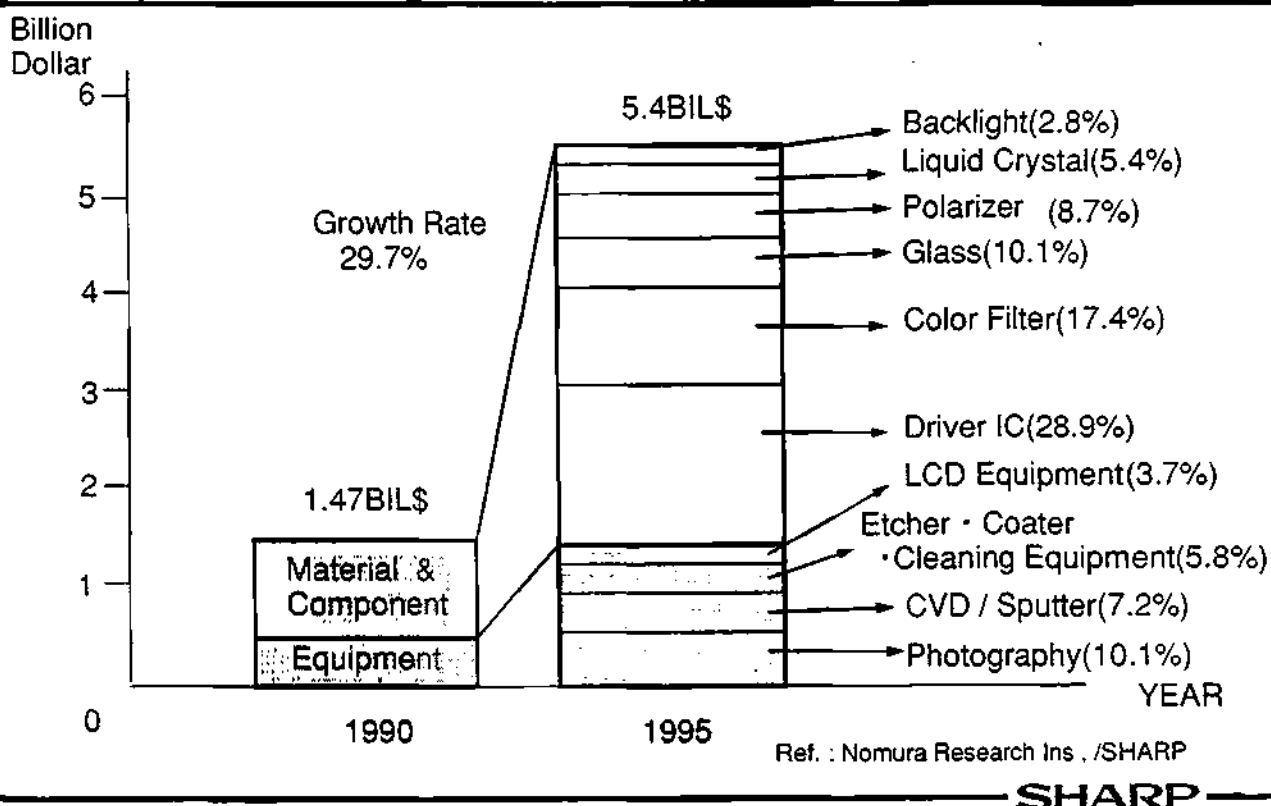
## Market Forecast For Semiconductor And LCD



(Ref.: Nomura Research Institute)

**SHARP**

## Worldwide Market Forecast Of LCD Peripheral Industries



**SHARP**

## RECENT TREND OF TFT PRODUCTION FACILITIES, EQUIPMENT AND PERIPHERAL MATERIALS

IN ADDITION TO THE IMPROVEMENT OF THROUGHPUT, THE EQUIPMENT PROCESS MARGIN, STABLE OPERATION AND RESOURCE SAVING ARE IMPORTANT FACTORS.

AT PRESENT, THE BATCH PROCESSING EQUIPMENT IS MAINLY USED. THE NEW TREND IN THE INDUSTRY IS SHIFTING TO THE APPLICATION OF SINGLE PLATE PROCESS. THE THIN FILM FORMING EQUIPMENT FOR "UNIFORM FILM QUALITY" AND "REMARKABLY REDUCED PARTICLES" HAS BEEN ANNOUNCED.

FURTHER IMPROVEMENT FOR SAVING SPACE AND INTEGRATION OF MULTIPLE PRODUCTION PROCESSES TO IN-LINE SINGLE PLATE PRODUCTION SYSTEM ARE THE PROBLEMS TO BE SOLVED.

**SHARP**

# Technological Trend Of TFT Process Equipment

TFT process	Present	Future & Equipment Manufacturers
<div> <div>Film Deposition</div> <div>P-CVD</div> <div>Sputter</div> <div>Patterning</div> <div>Resist Coat</div> <div>Exposure</div> <div>Develop</div> <div>Etching</div> <div>Cleaning</div> </div>	<b>1. P-CVD/Sputter</b> <div> <div>① In-Line Vertical Two Side Batch Deposition System(with tray)</div> <div>② Film Uniformity(<math>\pm 15\%</math>)</div> <div>③ Eliminate Particle</div> <div>④ Foot Print / Throughput</div> </div>	
	<div> <div>• AMAT • Kokusai Electric • Anelva • ULVAC etc.</div> <div> <div>⇒ Multi Chamber Single Plate (Trayless)Deposition System</div> <div>⇒ <math>\pm &lt; 5\%</math></div> <div>⇒ Inprocess Plasma Cleaning</div> <div>⇒ 1.5~2.0 Ratio</div> </div> </div>	
	<b>2. Patterning</b> <div> <div>① Reduction Of Photo Resist Consumption</div> <div>② Stepping Exposure System ( Boundary Problem Grey Scale Shift)</div> </div>	
	<div> <div>• D.N.S • Nikon • Canon etc.</div> <div> <div>⇒ Roll Coater</div> <div>⇒ Improvement Of Alignment Accuracy / In Large Shot Size</div> </div> </div>	
	<b>3. Etching · Cleaning</b> <div> <div>• Plasma System · Tokyo Electron • Anelva • Shibaura • AMAT etc.</div> </div>	
	<div> <div>① Wet Etching</div> <div>② Batch Clean System (With Cassette)</div> </div>	
	<div> <div>⇒ Single Plate Dry Etching (RIE/Plasma Mode)</div> <div>⇒ Single Plate Cleaning Process (Megasonic · Brush · Water Jet Dry Cleaning)</div> </div>	

SHARP

THE FOLLOWING TWO TYPES OF INSPECTION EQUIPMENT HAVE BEEN REMARKABLY IMPROVED.

1. EQUIPMENT TO INSPECT ALL TFT ARRAYS QUICKLY AND AUTOMATICALLY WITH HIGH SENSITIVITY WITHOUT CONTACT.
2. INSPECTING EQUIPMENT TO DETECT DEFECTS AS PHYSICAL PATTERN FAULTS AND INDICATES THEM BY PICTURE PROCESSING TECHNOLOGY .

SHARP

## Technological Trend Of TFT Inspection Equipment

Process	Item	Technology & Manufacturers
	<ul style="list-style-type: none"> <li>• Pinhole</li> <li>• Particle</li> <li>• Pattern</li> </ul>	<b>Optical Method</b> <ul style="list-style-type: none"> <li>• Lasertec      High Speed Periodic Pattern Comparison</li> <li>• KLA ACROTEC      High Speed Periodic Pattern Comparison</li> <li>• Orbot      Check &amp; Reference Comparison Design Rule</li> <li>• Insystems      Holographic Inspection</li> </ul>
	<ul style="list-style-type: none"> <li>• Panel Image Quality</li> <li>• Point Defect</li> <li>• Line Defect</li> <li>• S-G Short</li> </ul>	<b>Electro-Optical Method</b> <ul style="list-style-type: none"> <li>• Photon Dynamics      Measurement Of Pixel Potential Using Pockels Effect</li> </ul>
	<ul style="list-style-type: none"> <li>• Display Quality</li> </ul>	<b>Electrical Method</b> <ul style="list-style-type: none"> <li>• GenRad      Transfer Admittance Method</li> <li>• IBM      Charge Sensing</li> </ul>

**SHARP**

**THE PERIPHERAL MATERIALS HAVE BEEN REMARKABLY IMPROVED AS A RESULT OF ;**

- 1. IMPROVEMENT OF IN SPECTRAL CHARACTERISTICS, CHEMICAL AND THERMAL STABILITY OF COLOR FILTER**
- 2. REDUCTION OF POWER CONSUMPTION, THICKNESS AND WEIGHT OF BACKLIGHT**
- 3. REDUCTION OF SIZE OF DRIVER LSI**
- 4. REDUCTION OF DRIVE VOLTAGE**
- 5. APPLICATION OF MULTI-GRADATION DIGITAL DISPLAY SUITED FOR LARGE AND HIGH DEFINITION TFT-LCD.**

**SHARP**

## Technological Trend Of Color Filter

Materials	Coloring Method & Subject	Manufacturers
<b>Dye</b> [Excellent In Spectrum Characteristic] Application : TFT-LCD For AV	<b>Dyeing Type [ Photolithography ]</b> • Uniformity Of Coating / Dyeing • Chemical & Thermal Stability	Toppan Printing Dainippon Printing Micro Engineering Shintron Kyodo Printing
<b>Pigment</b> [Excellent In Optical & Thermal Stability] Application : TFT-LCD For OA / PJ	<b>Dispersion [ Photolithography ]</b> • Color Matching <b>Dispersion [ Print ]</b> • Resolution • Pitch • Leveling <b>Electro Deposition [Photolithography]</b>	Hitachi Casio Sanyo Seiko Epson Kyocera etc.

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## Technological Trend Of Peripheral Materials

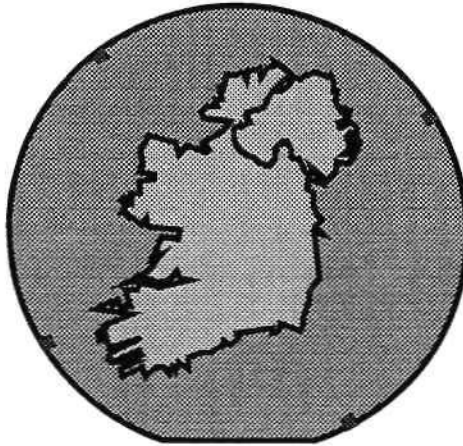
Peripheral Components	Materials	Problems	Manufacturers
<b>Backlight</b> (Fluorescent Lamp) Direct light Edge light	CCFT HCFT(High Brightness) CCFT(Bend) CCFT(Flat )	Low Power Consumption (12W⇒4W) High Brightness Long Life Thin / Lightweight	Harison , Stanley Panasonic GE Sylvania Toshiba etc.
Optical Guide Unit	Acrylic Board Reflected Board Magnified Board	With Polarizer Low Cost Lightweight Small Size & Thin (<5.0mm)	Meitaku Tama etc.
Polarizer	Non-glare Hard-coat	High Durability	Nitto Denko Sanritz, Cayapora Fuji Photo Film etc.
Reterdation	Reterdation Film		
Non-Reflected Coat	Non-Reflected Cr Anti Reflection Treatment Anti Glare Treatment	Appearance Of Surface Control Of Anti Glare Improvement Of Visibility High Durability	Sumitomo Chemical Three-M etc.

**SHARP**

**Technological Trend Of Driver LSI  
For Large Size & High Definition TFT-LCD**

Development	Subject	Present	⇄ Future
Small Size	Shrinking Of Chip Size Slim Chip Fine Output Pin	37mm <sup>2</sup> (7.4×5mm) Width 10mm 120	⇄ 26mm <sup>2</sup> (15.0×1.7mm) ⇄ Width 5mm ⇄ 240
Low Power Consumption	Low Voltage Drive System (Source Driver)	Analog 13V Digital 5V	⇄ 6V ⇄ 3V
For Large Size & High Resolution	Grey Scale Drive System High Speed Frequency (Source Driver)	16 Grey Scale Analog(Non-Interlace) Analog 7.5MHz Digital 15MHz	⇄ 256 Grey Scale ⇄ Digital(Multi-Media) ⇄ 10MHz (3-Phase Clock) ⇄ 30MHz
Others	Low Output Impedance Minimum Output Deviation EMI Reduction		

**SHARP**



## **ACHIEVING CRITICAL MASS THROUGH INDUSTRIAL COOPERATION**

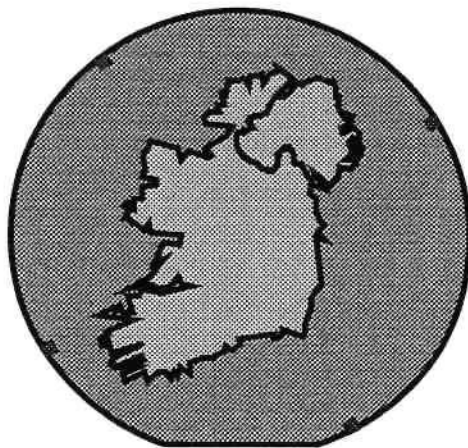
***Giulio Cesare Grata***  
Director of Microelectronics DGXIII  
European Commission

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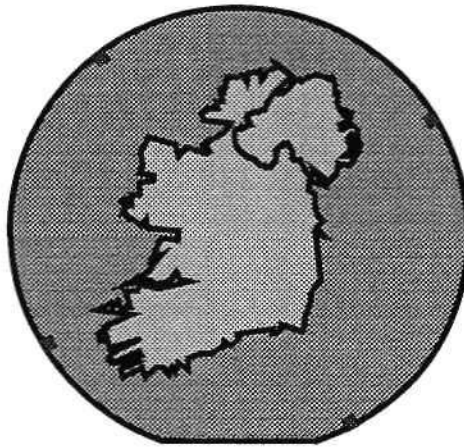
## INTRODUCTION

***Bipin Parmar***

Group Director European Semiconductors  
and Conference Chairman  
Dataquest Europe Limited

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## **HORIZONTAL INTEGRATION IN EUROPE**

***Guy Dumas***

Matra-MHS Honorary President  
Representative of the Telefunken  
Electronic Group for European Affairs

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## **HORIZONTAL INTEGRATION IN EUROPE**



Guy Dumas  
Matra-MHS Honorary President  
Representative of the Telefunken  
Electronic Group for European Affairs

Mr. Dumas is Honorary President of Matra-MHS and a representative of the Telefunken Electronic Group for European Affairs. In 1983 he was appointed Chairman and Chief Executive Officer of Matra-MHS. Prior to this he was Managing Director of the semiconductor division of Thomson-CSF, and before this Technical Director, then Managing Director, and later Chairman of the Board with Silec Semiconductor. Mr. Dumas studied Electrical Engineering at the Ecole Supérieure d'Electricité and graduated from Ecole Normale Supérieure with a doctorate in Physics.

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**EUROPEAN SEMICONDUCTOR INDUSTRY CONFERENCE**  
June 3-5, 1992  
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**Eleventh annual European Semiconductor**  
**Industry Conference 3rd - 5th June 1992**

**Guy DUMAS**

**Slide 1. Horizontal integration in Europe.**

Horizontal integration is a concept that has been broadly debated in Europe and elsewhere in the world. It has been also debated in the USA on the purpose of the SEMATECH venture that certainly has some horizontal integration features.

**Slide 2. Definition.**

The debate is mostly centered around the supposed lesser efficiency of precompetitive cooperative development compared to virtue of vertical integration. After all, it is often said that the Japanese semiconductor vendors leadership is partly due to sound vertical integration. To clarify my purpose, let me say my company is very much involved with both concepts. I believe foolish to oppose one concept to the other, when, in fact, they gain from each other. However the dispute exists, and arise because for the last two decades, Europe has been losing ground in the electronic business and corrective actions are taken to steer away from this trend.

**Slide 3. Semiconductor Worldwide Market.**

You may see on the screen over 30 years of semiconductor business history. Since 1959 until now the market has grown about 100 fold. In 59, with around 750 millions dollars, the worldwide market was not even the size of the 1991 Belgium market. Such a growth indicates the pervasive power of silicon! Pervasiveness that has definitively modified our way of working, entertaining, communicating, thinking and what so ever... Faxes, copying machines, mobile telephone, video recorder/players, Digital records etc etc, the list is endless of product that would not exist without IC's.

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#### Slide 4. **Main Events.**

All this, because of successive improvements, inventions, that were geared to produce more while spending less per unit. Devices were, generation after generation more and more complex although their costs went on a negative slope. It is amazing to realize there is a very small 30 years span between the transistor radios of the late 50's (Germanium transistors, they were) and the recently published pictures of a 15 billions years old event. I will not resist to say that between those two outcomes that I just mentionned, there has been the BIG BANG OF SILICON. Mind you, this is not finished, for the industrial society is still surfing on the ripples of that big bang.

#### Slide 5. **Semiconductor Company Market Share.**

Proceeding to scrutinize the past, we may see that, when it comes to surfing the silicon wave, some people seem more talented than others. The integrated circuit was invented in the US, and still the worldwide market share of American companies went from over 50 % in the late 70's, down toward the 30 % region in our days. European companies had close to 20 % of the world market in the past, but are down now to under 10 %. I certainly do not want to add to vague Japan bashing, however market shares lost by the US and Europe were mostly taken up by Japanese companies.

# **Slide 6. European Market Split**

Let's set apart the performances of American companies and take a closer look at the European market. In 1979 European companies were holding around 45 % of their home market, while the Japanese companies were owning 3 % of this European market. In 1990, the market share of European companies was down to around 35 %, and the Japanese companies share climbed to 20 %. In this part of the world where Free Trade was invented (remember Adam SMITH), those figures should not raise any objection... Except that the future economic growth of Europe is more and more dependant on silicon.

# **Slide 7. Share of Value added in European Industries.**

You may see on that transparency, that the experts estimate that by 1995, in Europe, the electronic industry, compared to other manufacturing segments, should be the one that will have the largest added value share. I would like, here, to quote my esteemed colleague Mr Pascale PISTORIO, from ST, who recently said in an address to the press, Quote "No advanced industrial society can exist without controlled access to an advanced electronic industry, which in turn cannot exist without controlled access to an advanced microelectronic industry." End of quote.

## Slide 8. Reasons of Decline.

Of course, there are plenty of reasons for the lost of worldwide market share from US and European companies. I think those that spelled out here have some value. The hermiticity of the Japanese market does not help, indeed. But European and American companies may also be directly responsible for the lost ground. There is the "Quarter Syndrom" coming from the belief that shareholders expect ever increasing profit. So when bad times come, to keep the profit at an acceptable level, you cut in R&D spendings. Although the quarter syndrom is said to typically American, the Europeans are far from immune to it. On top of it, in Europe, we have nationalism, which brought market fragmentation. Markets that were too small to support the large investments required in semiconductors. And finally the Cost of Capital was damaging. Interest rates that were, in the 80's, much higher in Europe and in the US than they were in Japan.

## Slide 9. Escalating Cost.

Talking about capital, you may see on the screen the historical cost of a fully equipped clean room for volume production. In the late 70's the cost came to 70 Millions Dollars, while in 1990 it is about 5 times higher. Product development has followed the same slope, except that it's still more dramatic. One estimates that to develop (product and process) a 256 K SRAM the expenses were in the 100 Millions Dollars range. Only two generation later (1 Mbit, then 4 Mbit), the R&D cost of the 4 Mbit SRAM is estimated at 400 Millions Dollars. And I am hearing of 850 millions Dollars for the 16 Mbits... Total investment, fab room plus product/process development, would then come close to 1.5 Billion Dollars. Now, let's remember that the largest European semiconductor company has a yearly revenue in 3 billions Dollars range... So European companies do have a very simple choice: Either they cooperate or they disappear...



Slide 10. **J E S S I Joint European Submicron Silicon.**

The Joint European Submicron Silicon, JESSI, is a cooperative R & D program that spans over 7 years. Its stated objective is to advance Europe position in the information technology in the crucial submicron silicon sector by improving cooperation between various european industries and research institutes. JESSI aims are the improvements of Horizontal AND vertical cooperations. Initial phase ended on December 31st, 1991 and proved that cooperation could be extremely productive even though initiation this cooperative process took time and efforts.

Slide 11. **Start-up Phase.**

The expenses incurred over the two years of the start up phase came up to 460 Millions ECU (one ECU is worth about 1.23 Dollar) and represented over 3000 men years of engineers and scientists. On top of those listed on the screen and that are specific to silicon process technology. Achievements were made on production lithography equipment, CAD tools for automatic design and on hardware description language synthesis. That may not sound like major achievements, although they are, but anyway everybody understand that they are part of the electronic food chain, which Europe needs to restore to a competitive stage.

Slide 12. **Main Phase.**

The main phase started on January 1st of this year and will extend to 1997. The budget allocated for 1992 amounts to 430 Millions ECU that are distributed over a number of projects that encompass applications in the fields of High definition T.V, digital audio broadcasting, broadband telecommunication, cellular mobil telephone, and electronic system for automobile safety. The total program aims to develop application specific chips sets in the relevant state-of-the-art silicon technology.

### Slide 13. **Project Organization.**

Using the experience drawn from the start up phase, a new organization has been devised for the main phase program. Projects that relate to the same field of application are gathered in a cluster. Each cluster has a flagship project that is helped and supported by all other linked projects. The goal of this organization is to achieve a better focus on the core theme and thus improve overall efficiency. This type of organization is, obviously, a form of horizontal integration. I have taken here the example of competitive CMOS manufacturing cluster.

### Slide 14. **Project Matrix.**

Horizontal integration implies that every project has partners working together. I have put on the screen the matrix of the participating nations in all the projects. For instance, you can see from the transparency that Belgium companies are cooperating with British companies on a total of 10 projects, or that France and Italy have 15 projects in common. Since there are more than two partners on any given project, the view here does not tell how many they are. However the projection says that 13 countries are joining their efforts towards the same goal.

A giant company such as IBM is joining in an advanced lithography project and 200 mm wafer engineering project in both Germany and France.

### Slide 15. **The European Players.**

As previously stated, all these projects for different applications aim at promoting the development of submicron silicon technology. It is, therefore, only natural that all the European semiconductor manufacturers cooperate in the field of process technology. Today there are seven European companies. Two small ones, are somehow linked to more powerful manufacturers, ES2 with PHILIPS and MIETEC/ALCATEL with SGS/THOMSON. The other five companies are: PHILIPS, SIEMENS, SGS/THOMSON (ST), GEC/PLESSEY (GPS) and MEG. (TELEFUNKEN Electronic - MHS).

Slide 16.    **M E G   -   The Company.**

MEG is certainly not a name with which you are familiar, yet. In fact it is not quite real. It will be legally incorporated sometime mid year, and will be immediately active since its members are already very effective in the market. MEG will start its existence with revenue exceeding the Billion Dollars mark, which is rather a good background for a start-up company !

Slide 17.    **M E G   &   J E S S I**

Through one or the other of the smaller companies that make MEG, the corporation participates in many JESSI projects. In the CMOS logic cluster, and particularly in the joint logic project where 0.5 micron digital CMOS will be soon produced. MEG also participates in the tools and methods for high reliability products, in support tools for design automation, and last but not least in the Manufacturing Science & Technology (MST) linked with the Flexible automated wafer fab project (FAW). Recently Professor Dr Ingrid Hartmut WEULE, from the board of DAIMLER BENZ, emphasized the support this latter project will receive from the whole corporation for addressing the significant number of application specific products dedicated to the Group needs.

Slide 18.    **Strategic Applications.**

That cannot be a surprise considering that the Automotive, as well as the Aerospace part of the Corporation need the previously mentioned controlled access to advanced semiconductor technology. Only speaking about the automobile and forgetting the aircraft for the lack of time, just bear with me in reading some of the applications where top notch silicon will be mandatory. Ignition - pollution free emission, clutch management, tire pressure sensor, active damper and level control Etc, etc.

Slide 19. **JESSI Program.**

I feel that the true conclusion of this presentation is to put on the screen the summary of the JESSI program. Obviously there are obstacles and difficulties. Technical difficulties and political difficulties. However the program moves on. The 0.7 micron digital CMOS is a reality that came through thanks to this very program. First structure of the 0.3 micron technology have been completed at the research level. Everyday see some sort of progress in one field or another. Europe is on the move, European electronic is back.

Thank you very much.

# HORIZONTAL INTEGRATION IN EUROPE

92 06 / DC 1

Members of TELEFUNKEN electronic Group  
TELEFUNKEN electronic, EUROSEL electronic, SILICONIX electronic, M99 electronic

## *Horizontal integration in Europe*

### DEFINITION

#### HORIZONTAL INTEGRATION

- Cooperative development works on a particular technical field

#### VERTICAL INTEGRATION

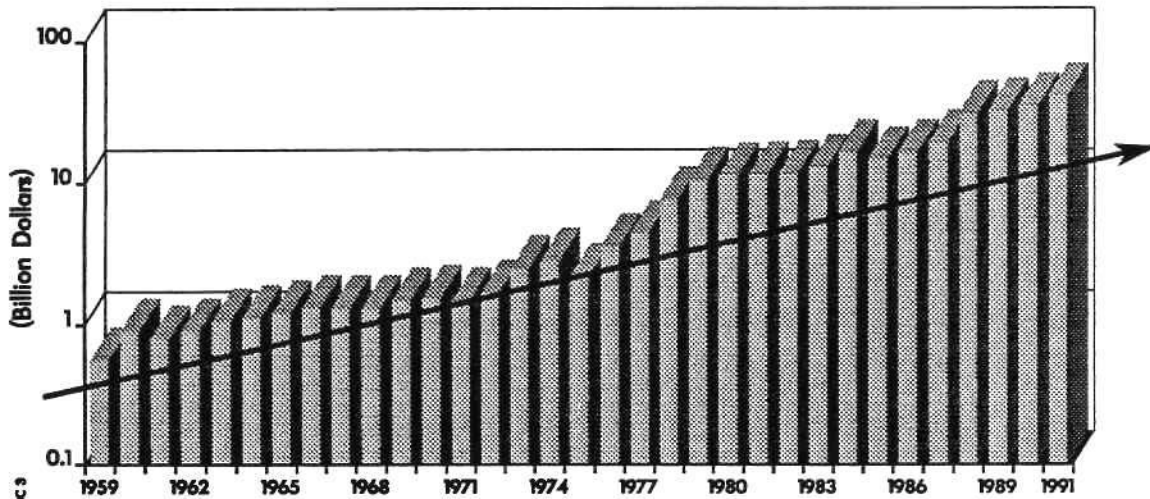
- Brings together all manufacturing aspects of a range of products

92 06 / DC 2

Members of TELEFUNKEN electronic Group  
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## Horizontal integration in Europe

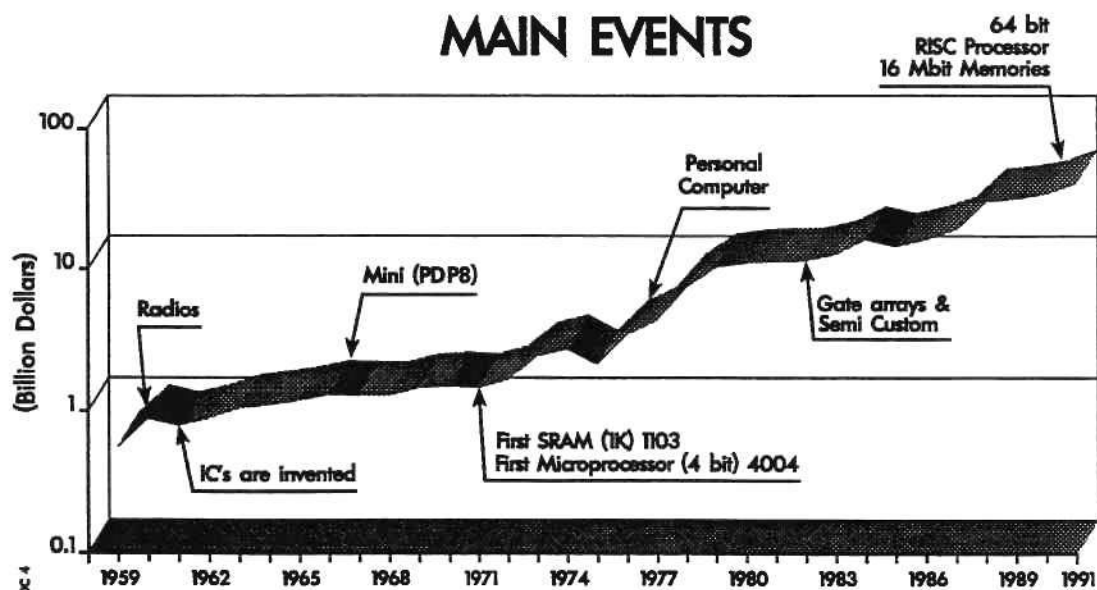
### SEMICONDUCTOR WORLDWIDE MARKET



Members of TELEFUNKEN electronic Group  
TELEFUNKEN electronic, EUROSEL electronic, SILICONIX electronic, MIB electronic

## Horizontal integration in Europe

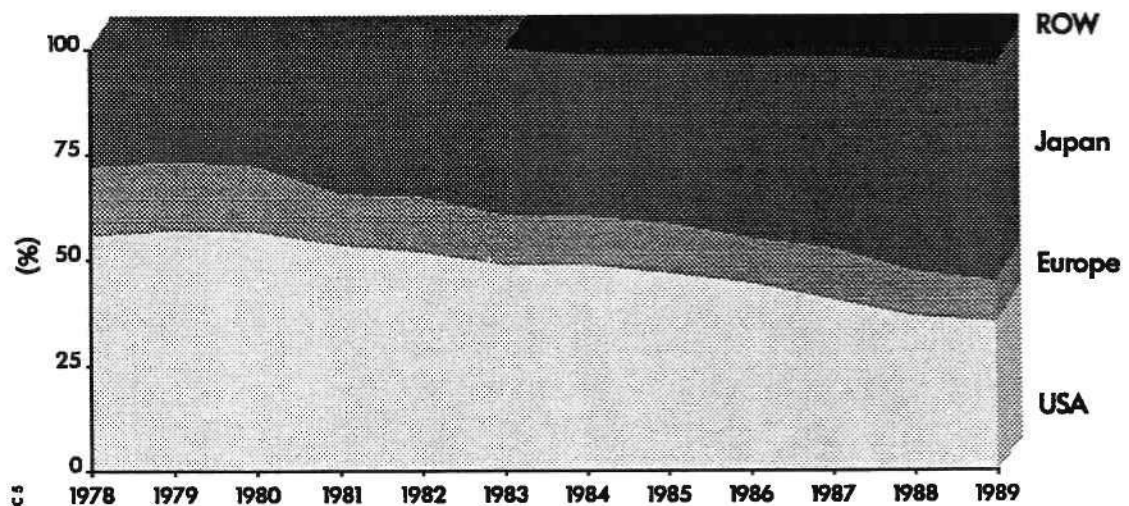
### MAIN EVENTS



Members of TELEFUNKEN electronic Group  
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## Horizontal integration in Europe

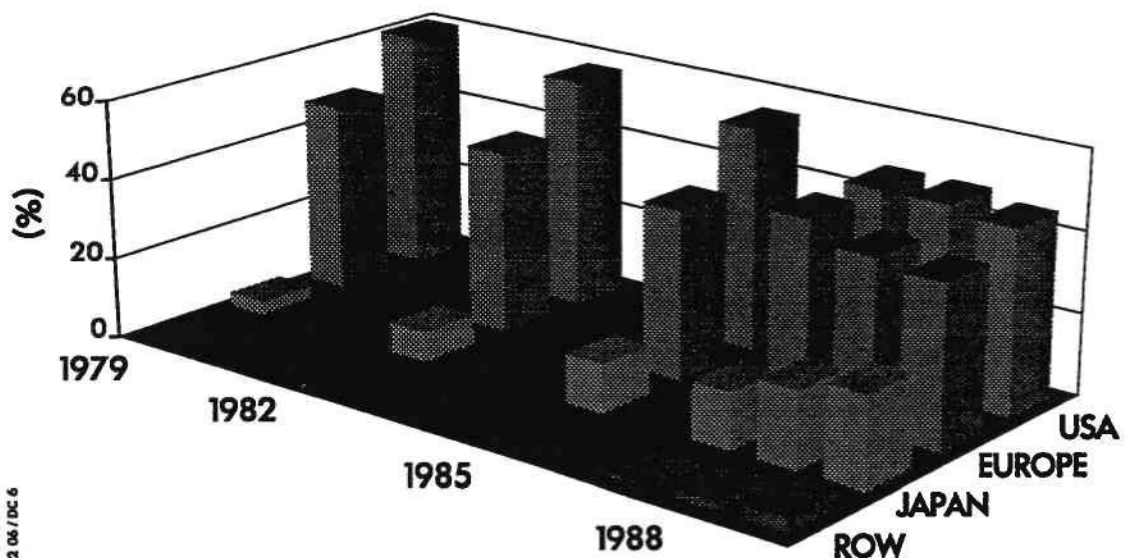
### SEMICONDUCTOR COMPANY MARKET SHARE



92 06 / DC 5  
Members of TELEFUNKEN electronic Group  
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## Horizontal integration in Europe

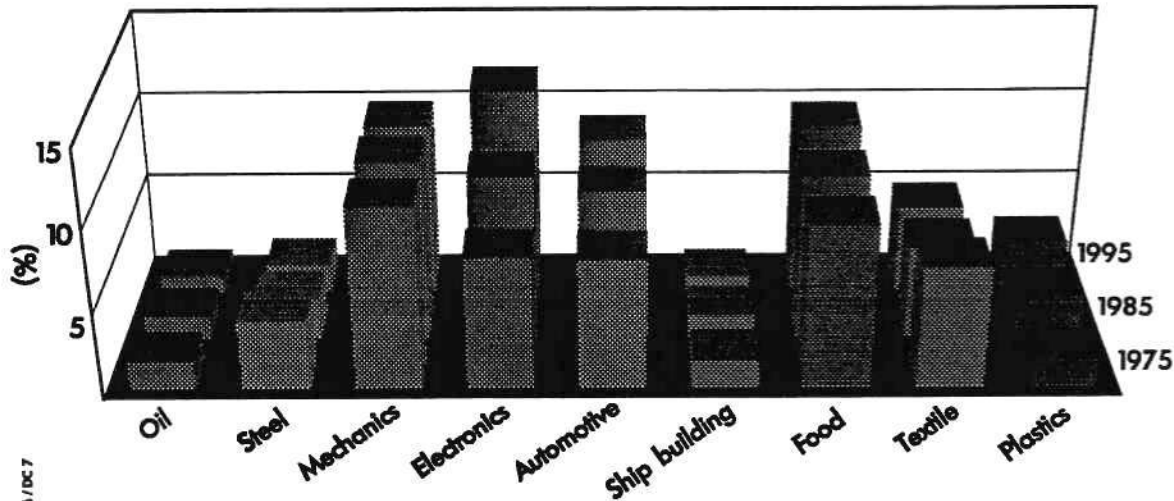
### EUROPEAN MARKET SPLIT



92 06 / DC 6  
Members of TELEFUNKEN electronic Group  
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## Horizontal integration in Europe

### SHARE OF VALUE ADDED IN EUROPEAN INDUSTRIES



92 06 / DC 7

Members of TELEFUNKEN electronic Group  
TELEFUNKEN electronic, EUROTEL electronic, SILICONIX electronic, MHS electronic

## Horizontal integration in Europe

### REASONS OF DECLINE

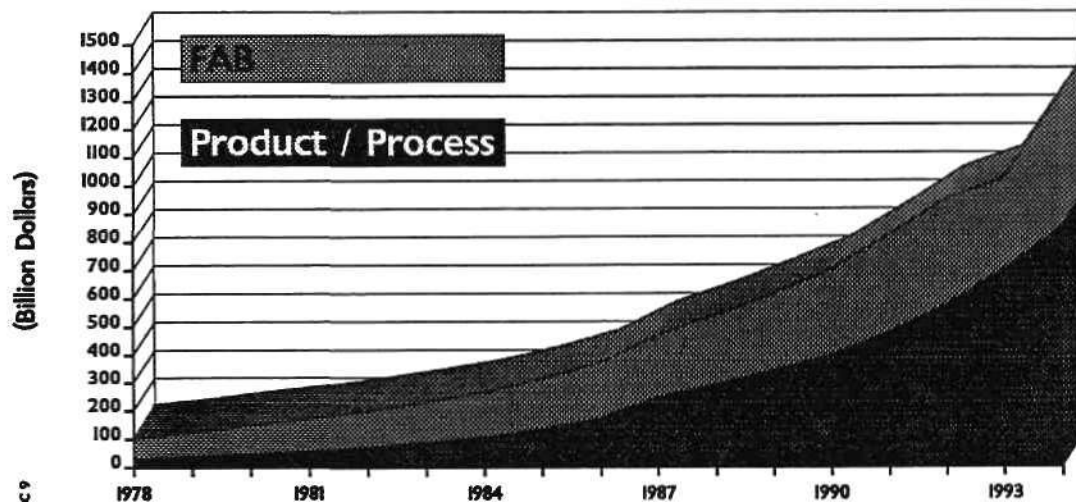
- Japanese market tightly closed
- Quarter syndrom in USA
- Market fragmentation in Europe
- Cost of Capital

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Members of TELEFUNKEN electronic Group  
TELEFUNKEN electronic, EUROTEL electronic, SILICONIX electronic, MHS electronic



## ESCALATING COST



92 06 / DC 9

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## JOINT EUROPEAN SUBMICRON SILICON

### Organize cooperative development projects

- 1990 / 1991 : Start-up phase
- 1992 / 1996 : Main phase

### Objectives

- Reduce market fragmentation
- Increase transnational cooperation
- Integrate relevant sectors of the industry

92 06 / DC 10

Members of TELEFUNKEN electronic Group  
TELEFUNKEN electronic, EUROSEL electronic, SILICONIX electronic, MMS electronic

## START-UP PHASE

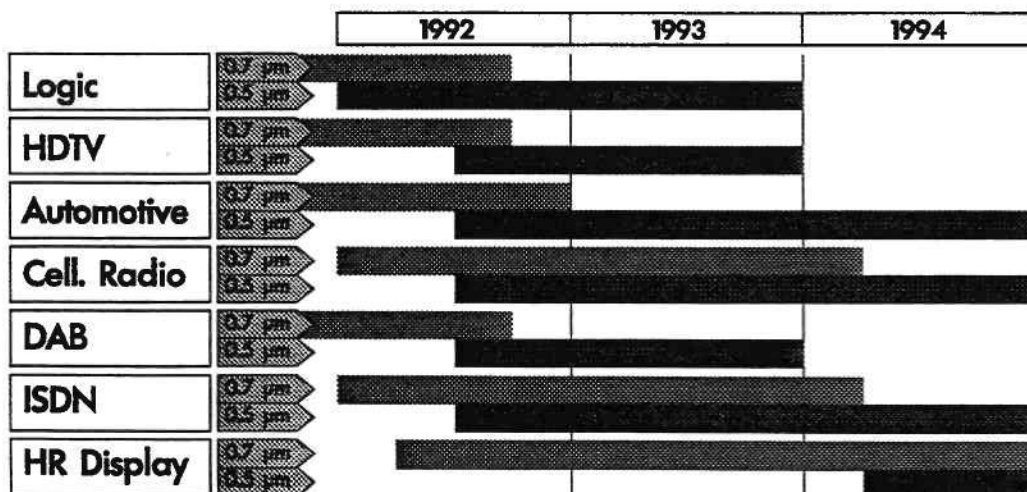
- Complete on December 31st, 1991
- Expenses of 460 Millions ECU & 3000 men years
- Achievements (Silicon)
  - 16 Mbit SRAM / 16 Mbit EPROM
  - 0.7 micron CMOS digital circuits
  - Structures of the 0.3 micron CMOS technology

92 06 / DC 11

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## MAIN PHASE



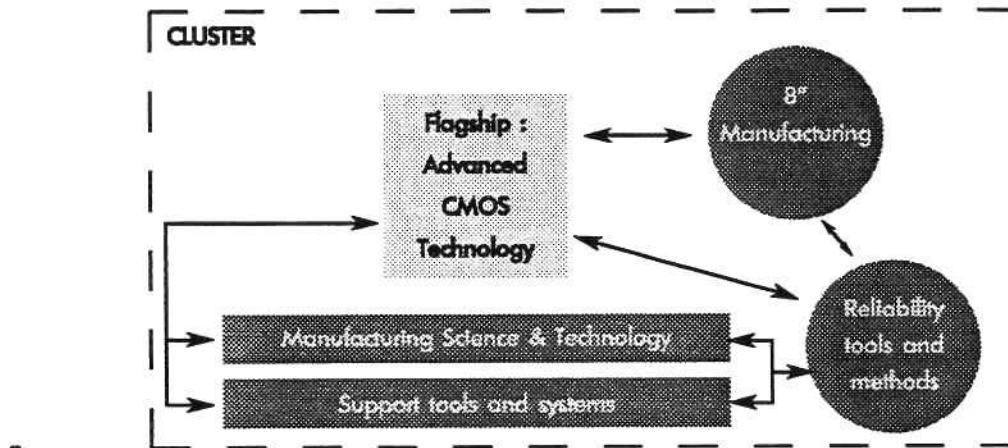
92 06 / DC 12

Members of TELEFUNKEN electronic Group

TELEFUNKEN electronic, EUROSEL electronic, SILICONIX electronic, MMS electronic

## PROJECT ORGANIZATION

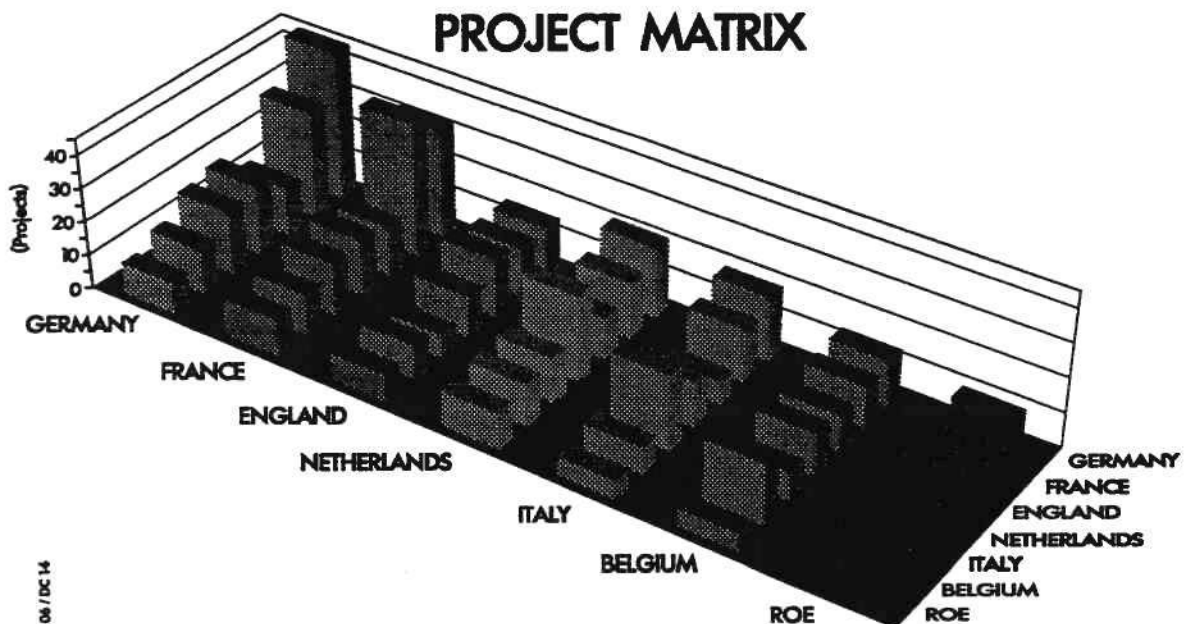
Example of cluster : Competitive CMOS manufacturing



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## PROJECT MATRIX



92 06 / DC 14

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## THE EUROPEAN PLAYERS

### TWO SMALL

- ES2 → tied to PHILIPS
- MIETEC / ALCATEL → tied to SGS / THOMSON

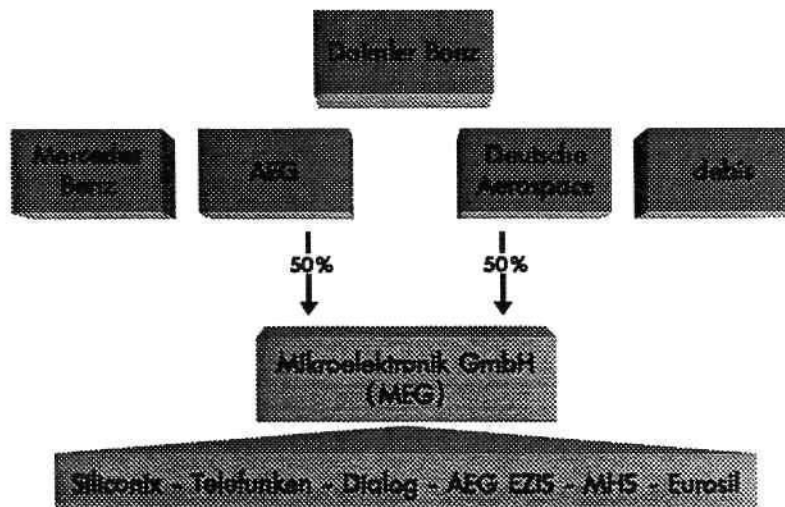
### FIVE MAJOR

- PHILIPS
- SGS / THOMSON
- SIEMENS
- GEC / PLESSEY
- MEG

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## MEG - THE COMPANY



92 06 / DC 16

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## MEG & JESSI

### MEG PROJECT PARTICIPATION

- CMOS logic cluster
- Tools and methods for high reliability
- Manufacturing science & technology (FAW)
- Support tools & systems

92 06 / DC 07

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## STRATEGIC APPLICATIONS

### UNDER THE HOOD

- Ignition - Pollution free emission
- Clutch management
- Tire pressure - Damper & Level control
- Multiplexed data bus

### CABIN

- Seat and mirror memories
- Rain sensor
- Air bag
- Infrared cabin surveillance
- Radars (anti-collision, rear warning, blind spot ...)

92 06 / DC 18

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## JESSI PROGRAM

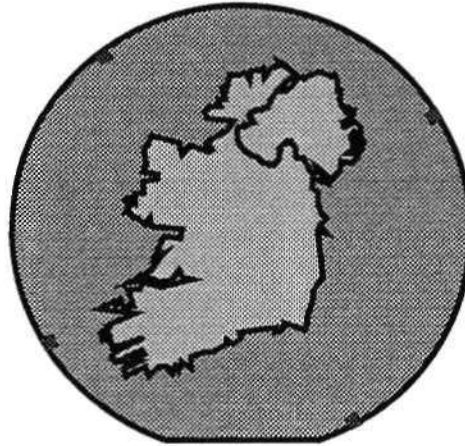
1990	1991	1992	1993	1994	1995	1996
------	------	------	------	------	------	------

**CMOS**

0.7 micron	0.5 micron	0.3 micron
------------	------------	------------

**OPTIONS**

1 micron	0.7 micron	0.5 micron
----------	------------	------------



## RIDING THE SECOND WAVE IN EUROPE

***Hans Geyer***  
Director and General Manager  
Intel Europe

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## **RIDING THE SECOND WAVE IN EUROPE**



**Hans Geyer**  
Director and General Manager  
Intel Europe

Mr. Geyer is Director and General Manager for Intel Europe. He joined Intel in April 1980 and has since held various managerial positions and has a wealth of experience in computer architecture, technical marketing, microprocessors and peripheral controllers and components. Prior to joining Intel, he was involved in hardware and software development for intelligent and point-of-sales terminals at Siemens AG, Germany. Mr. Geyer studied Computer Science and Mathematics at the Technical University of Munich, holds a Masters Degree (Diplom-Informatiker) in Computer Science and is an INSEAD alumni.

**Dataquest Europe Limited**  
**EUROPEAN SEMICONDUCTOR INDUSTRY CONFERENCE**  
June 3-5, 1992  
Dublin, Ireland

Dataquest Europe Limited, a company of The Dun & Bradstreet Corporation  
Roussel House, Broadwater Park, Denham, Uxbridge, Middx UB9 5HP / 0895 835050 / Tlx 266195 / Fax 0895 835260



# **Riding The Second Wave - In Europe**

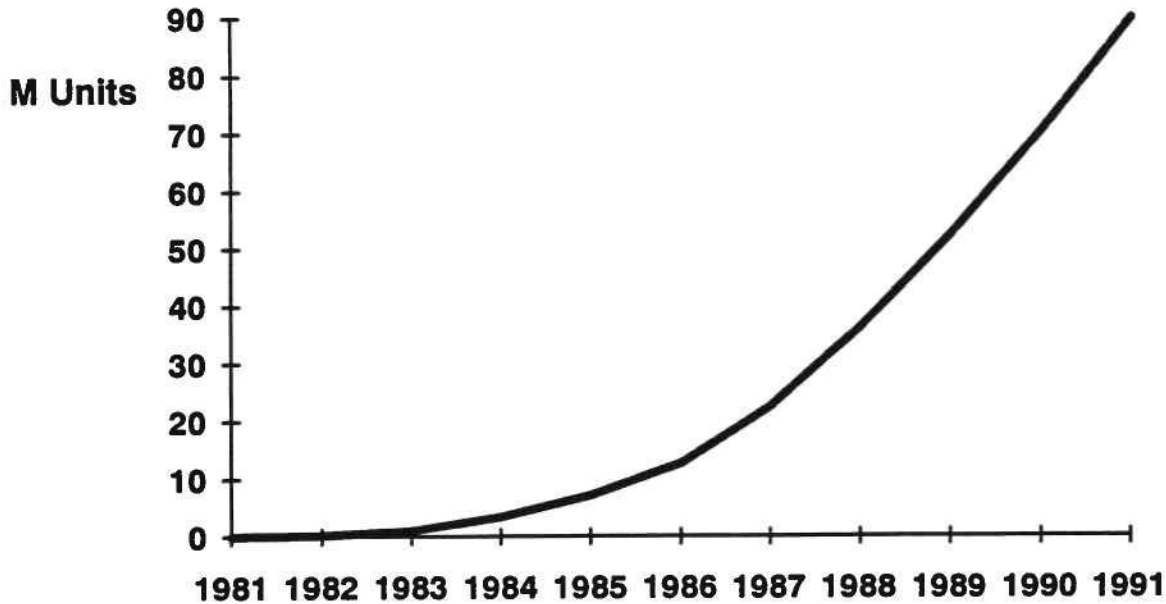
**Hans Geyer**

**Director and General Manager, Intel Europe**  
**Dataquest European Semiconductor Conference**  
**June 5, 1992**

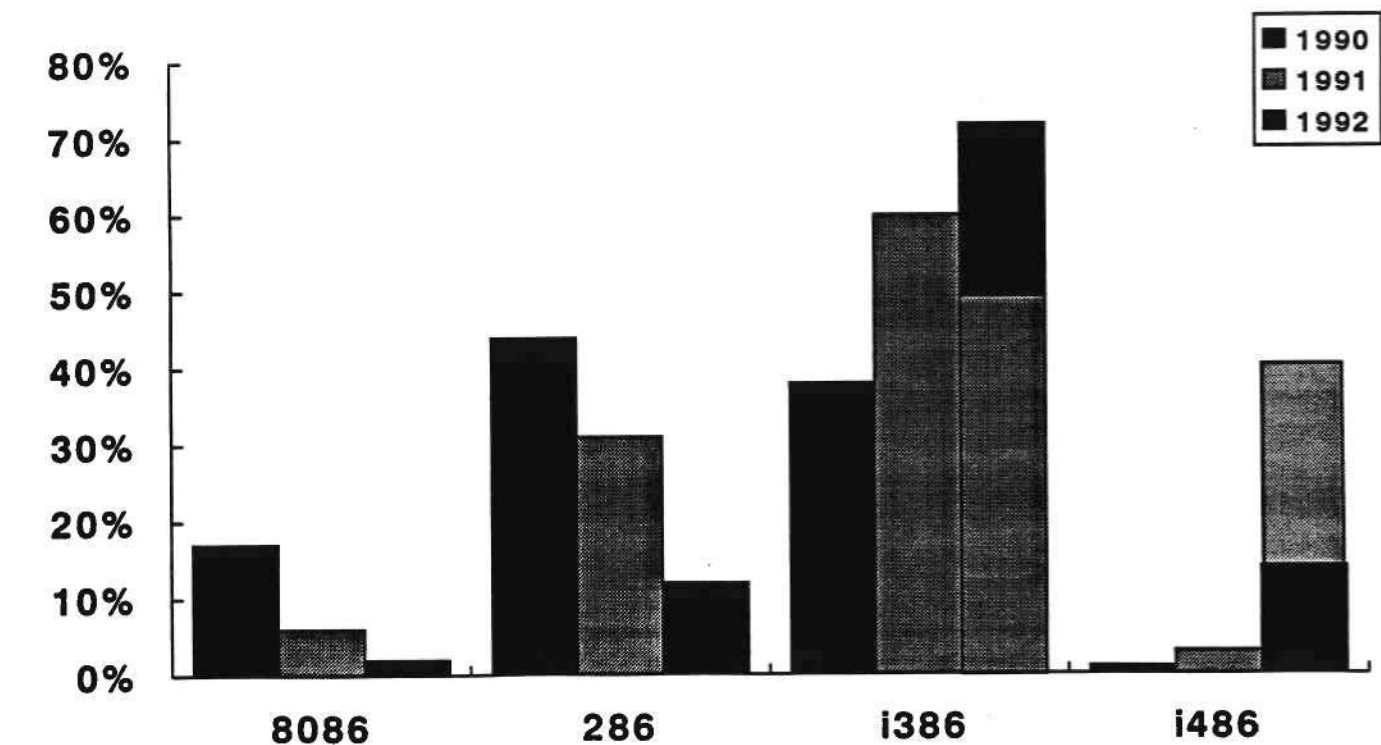
## **Agenda**

-  ● **PC Market**
- **Move To The Second Wave**
- **European Procurement Trends**
- **Future Of Business Computing**
- **Manufacturing In Europe**

# Worldwide Installed Base of X86-Based PCs



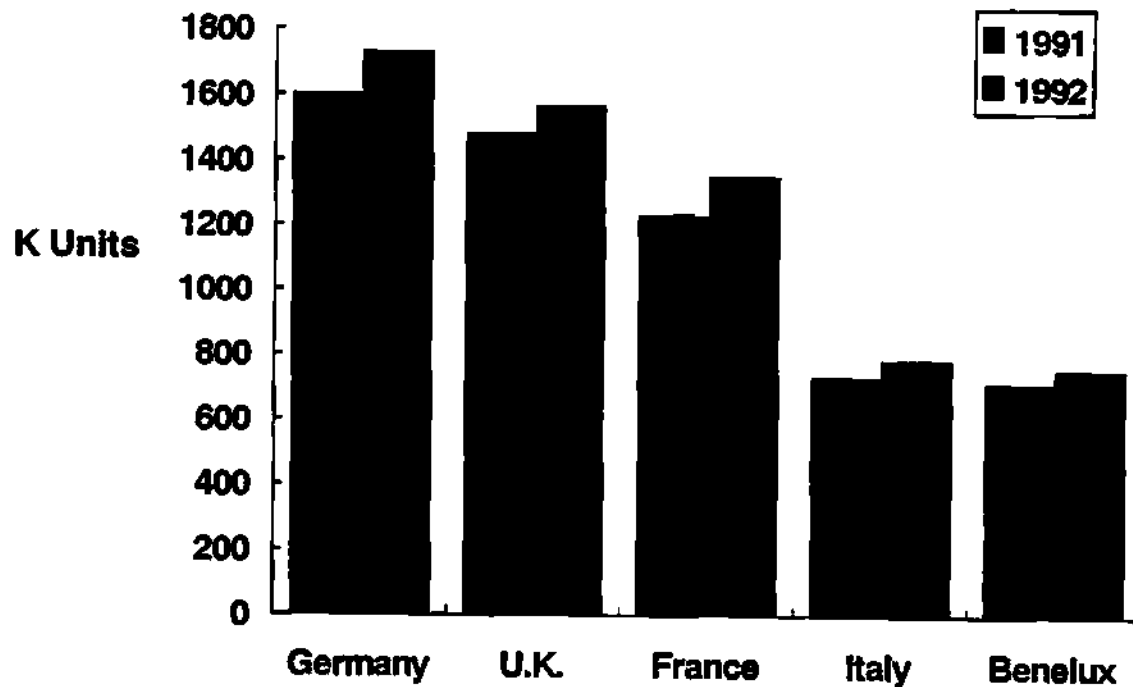
## Total European PC Shipments



Source: Intel and Dataquest

# European PC Market By Country

## X86 Architecture



## Agenda

- PC Market
- ➔ ● Move To The Second Wave
- European Procurement Trends
- Future Of Business Computing
- Manufacturing In Europe

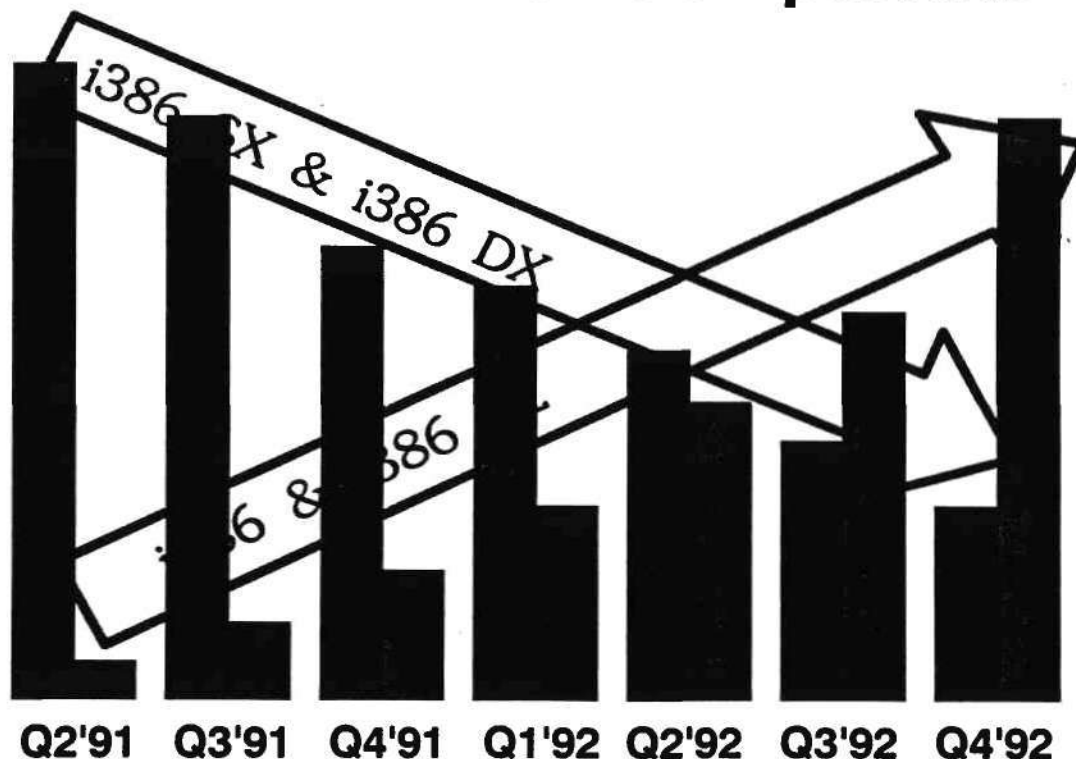
# Software Power Spiral

“The Next Generation of Software is Always Developed to Run On The *Current* High-Volume CPU. But it Runs Slow.

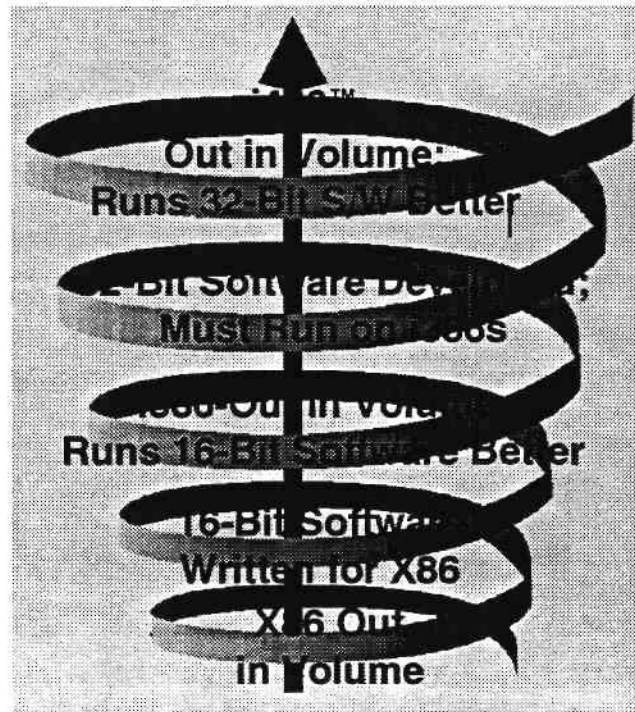
It Takes the *Next* Generation of CPUs to Run it Properly.”

Andy Grove

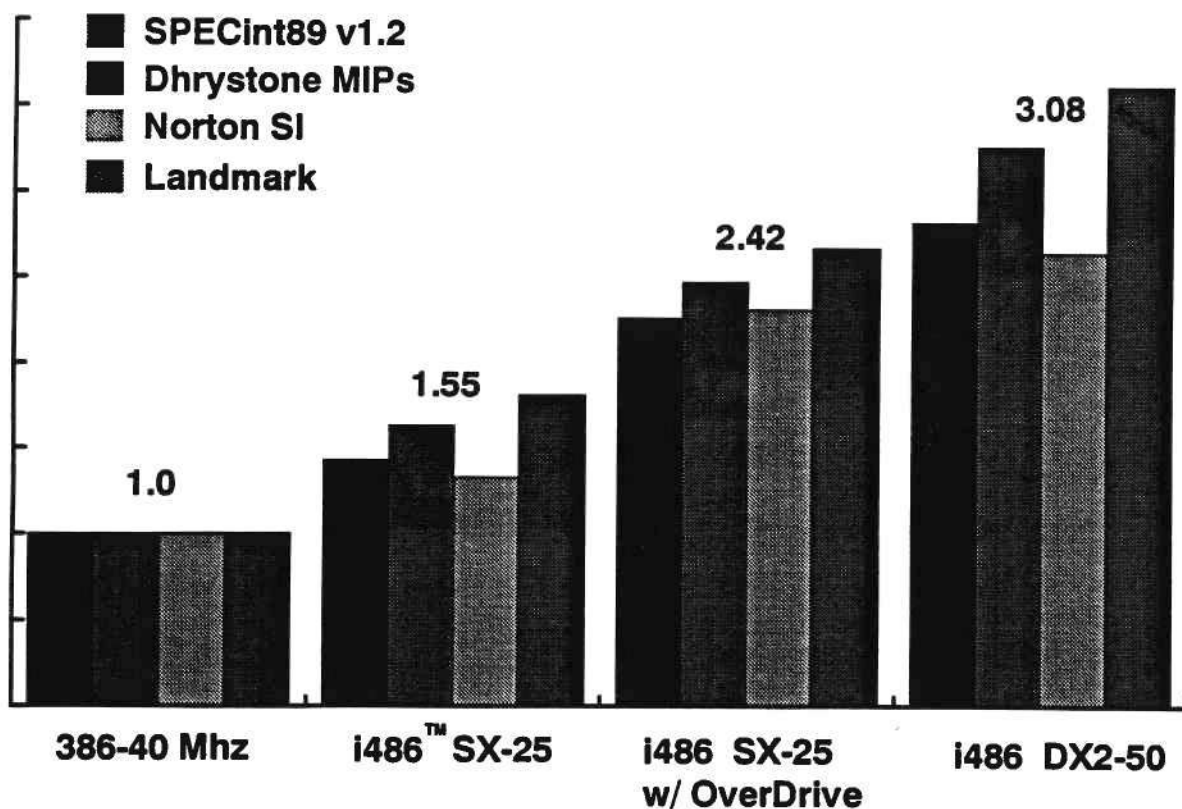
## Second Wave Unit Shipments



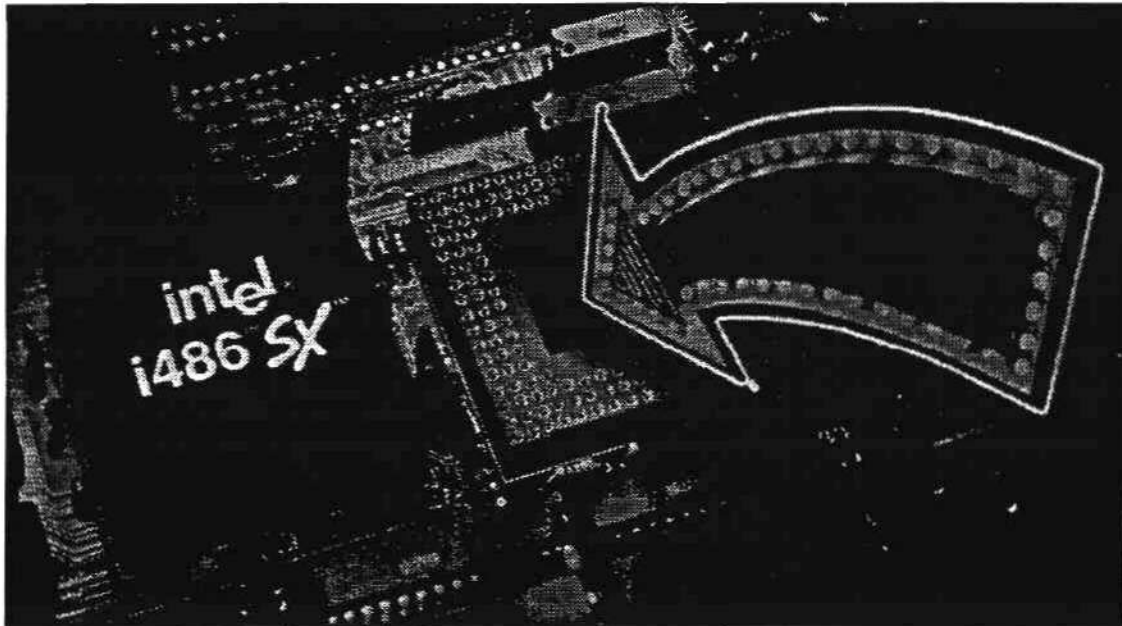
# New Software Drives Intel486™ Family Volumes



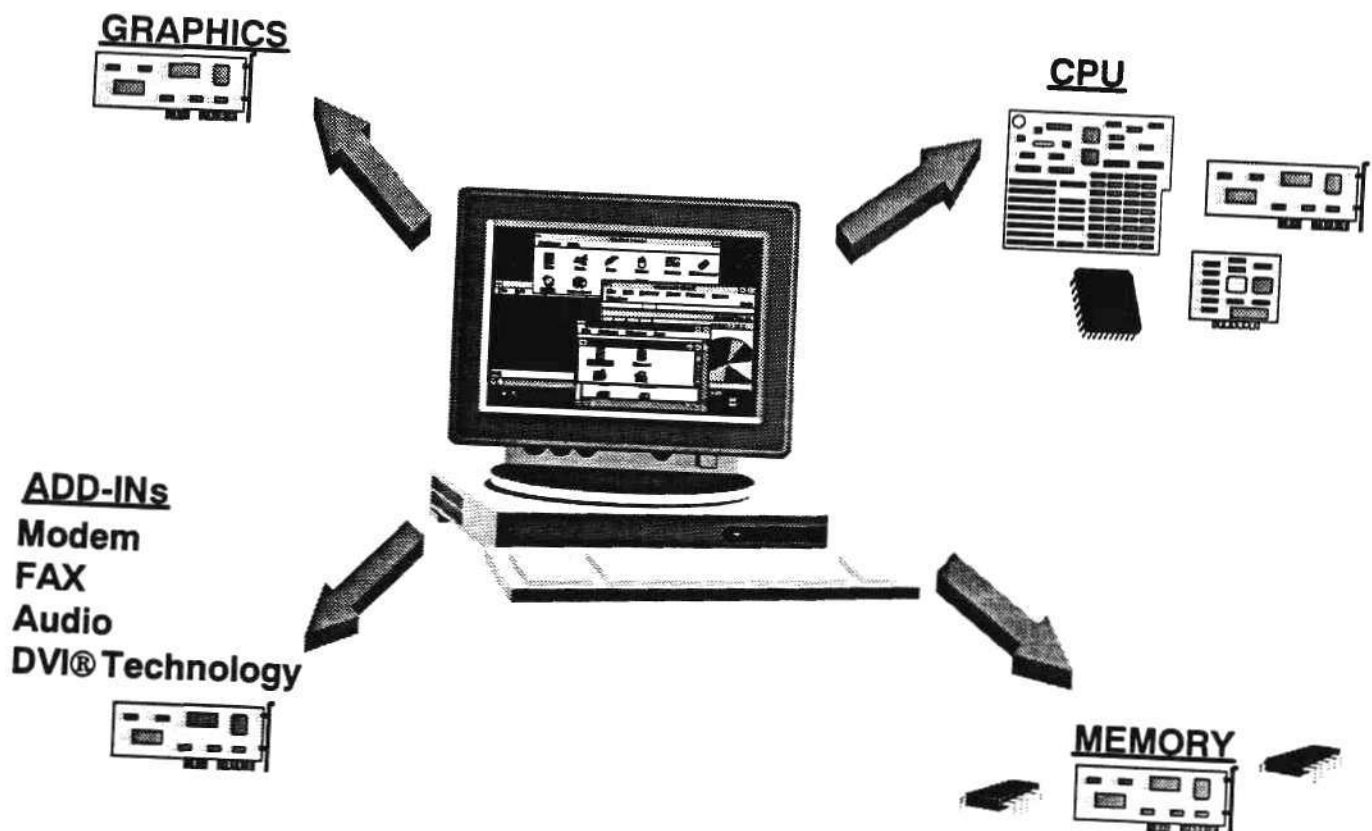
## Synthetic Benchmarks



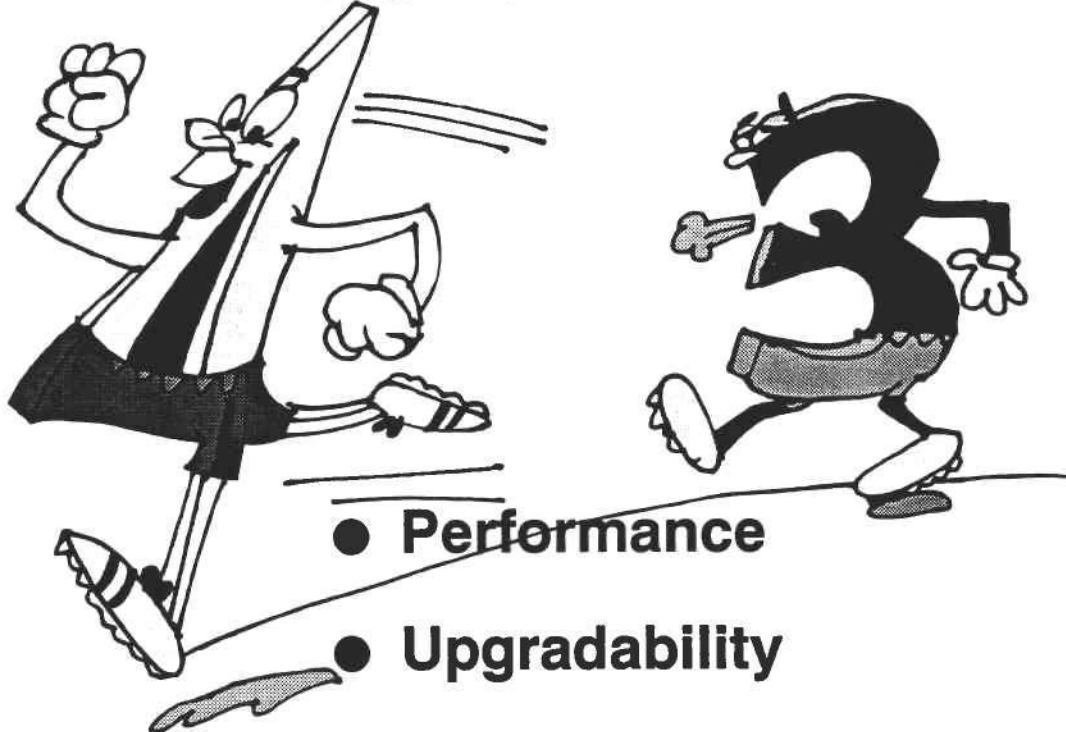
# Intel486™ Processors are Upgradable



## End Users Want Upgrade Options



# 4 is Better Than 3



● Performance

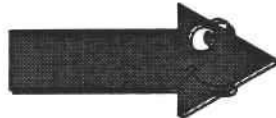
● Upgradability

128K cache RAM  
4MB 70ns RAM  
supports up to 32MB RAM  
52MB Plus Impulse HD  
9ms\*  
c/w 64K on-board DisCache  
3.5" 1.44MB FD  
14" Panasync VGA  
1024x768 colour monitor  
Fujitsu 102 key keyboard  
Orchid Prodesigner II  
1024x768 VGA card  
1 Parallel & 2 serial ports  
AMI bios, 1 games port  
5 sixteen bit & 1 eight bit  
expansion slots available  
Maths Co-processor socket

**£1145**

80486SX-20MHz U/A processor  
128K cache RAM  
4MB 70ns RAM  
supports up to 32MB RAM  
105MB Plus Impulse HD  
9ms\*  
c/w 64K on-board DisCache  
3.5" 1.44MB FD  
14" Panasync VGA  
1024x768 colour monitor  
Fujitsu 102 key keyboard  
Orchid Prodesigner II  
1024x768 VGA card  
1 Parallel & 2 serial ports  
AMI bios, 1 games port  
5 sixteen bit & 1 eight bit  
expansion slots available  
Maths Co-processor socket

**£1245**



## **TOWER 386-DX33**

■ 80386-DX Microproz.  
■ 33 MHz Taktfrequenz  
■ 4 MB Arbeitsspeicher  
■ 105 MB wechselbare  
Festplatte < 15 ms  
■ incl. Komplette  
software

**2599,-**

## **TOWER 486-SX20**

■ 486-DX Microproz.  
■ 20 MHz Taktfrequenz  
■ 4 MB Arbeitsspeicher  
■ 105 MB wechselbare  
Festplatte < 15 ms  
■ incl. Komplette  
software

**2699,-**

# **P5: Next Generation Microprocessor**

- **Performance in the 100 MIPS Range**
- **Superscalar ("RISC") Technology**
- **Mainframe-Class Capabilities**

## **Agenda**

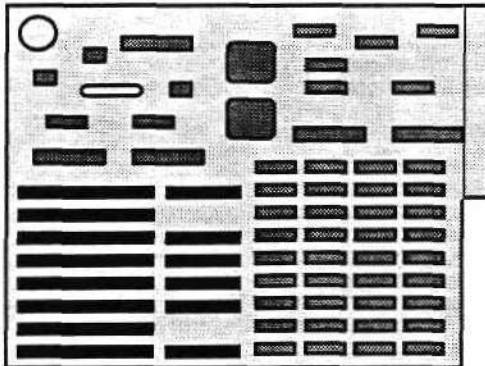
- **PC Market**
- **Move To The Second Wave**
- ➔ ● **European Procurement Trends**
- **Future Of Business Computing**
- **Manufacturing In Europe**



# Agenda

- PC Market
- Move To The Second Wave
- ➔ ● European Procurement Trends
- Future Of Business Computing
- Manufacturing In Europe

## Reducing Duty Charges



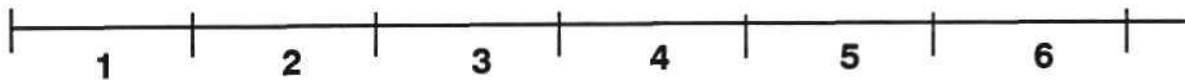
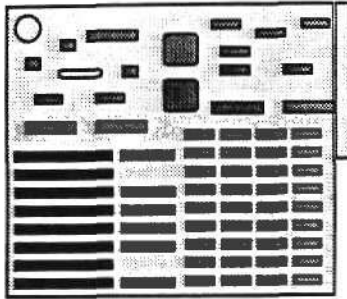
**4.8 %**



**0%**

# Reducing Inventory Costs

## CPU On The Motherboard

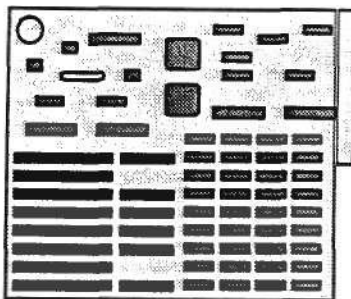


### Weeks of Inventory Cost

$$6 \times (\$MB \text{ inv} + \$ \text{CPU inv})$$

# Reducing Inventory Costs

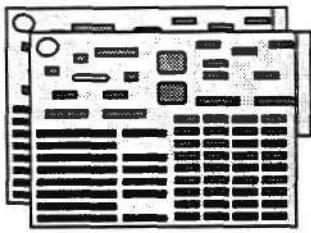
## CPU and Motherboard Separate



### Weeks of Inventory Cost

$$(6 \times \$MB) + (1 \times \$ \text{CPU})$$

## Result: Better Money Flow



\$

=



\$

$$6 \times (1 + 1-2) =$$

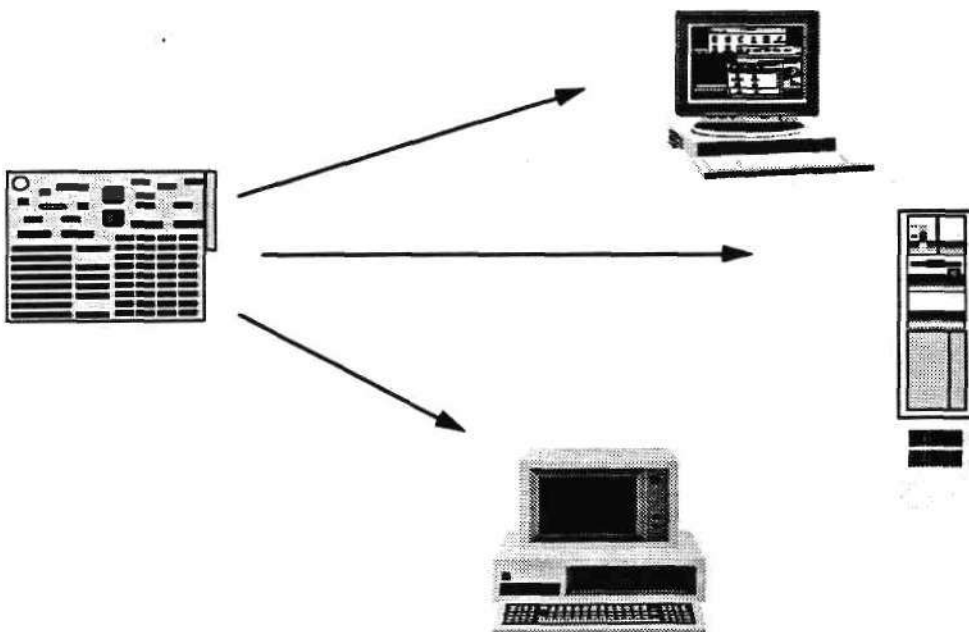
12-18 inv. units

$$(6 \times 1) + 1-2 =$$

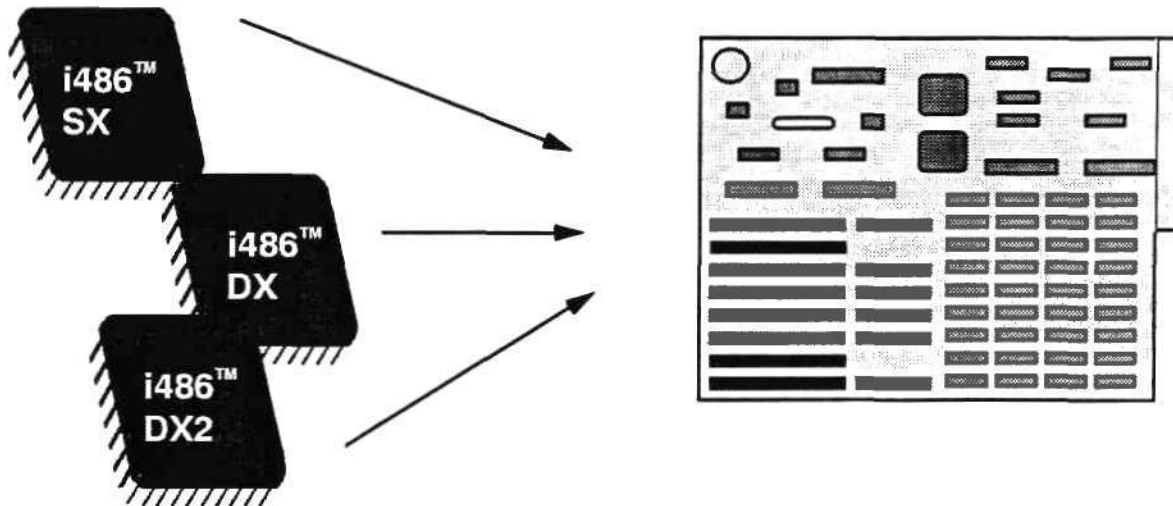
7-8 inv. units

1/2 to 1/3 Inventory Cost Reduction

## Customizing At Time Of Purchase



# Broad Product Range With Minumum Inventory

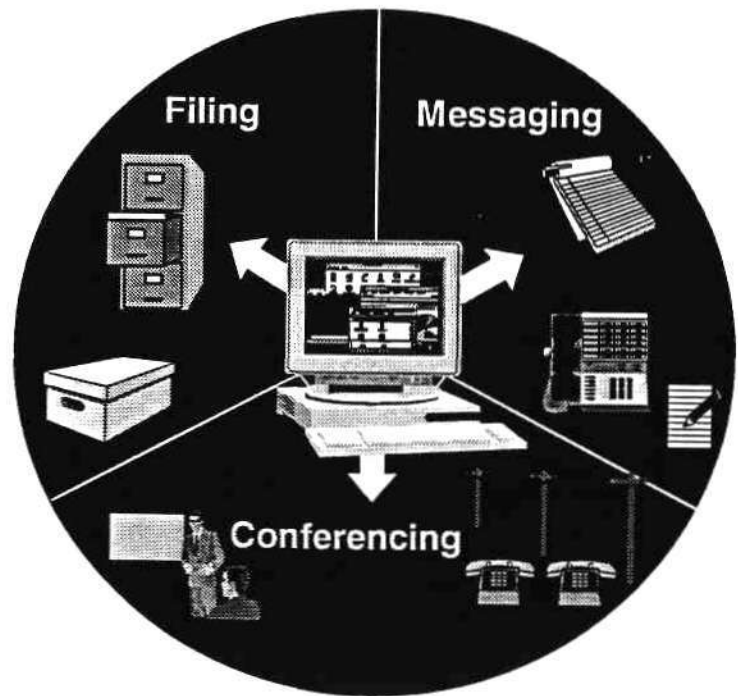


## Agenda

- PC Market
- Move To The Second Wave
- European Procurement Trends
- ➔ ● Future Of Business Computing
- Manufacturing In Europe

# Computer Supported Collaboration

- More Chips
- Higher Performance CPUs

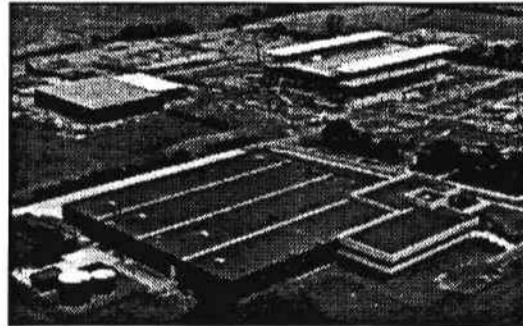


## Agenda

- PC Market
- Move To The Second Wave
- European Procurement Trends
- Future Of Business Computing
- ➔ ● Manufacturing In Europe

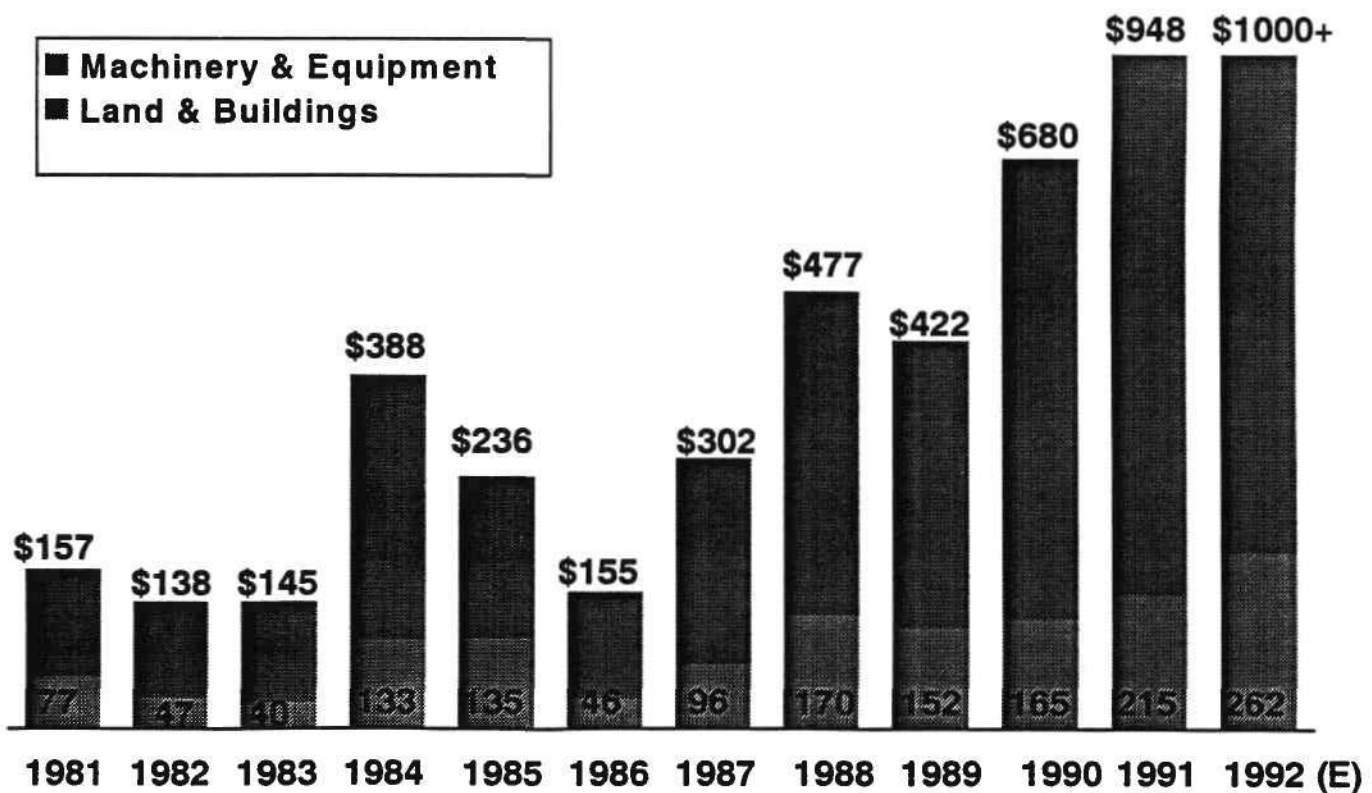
# Intel In Ireland

- Our newest technology making our most advanced chips
- First major production facility for 8-inch wafers
- Our largest single clean room
- \$800 million investment when fully operational
- Employment of 1,000 Irish nationals



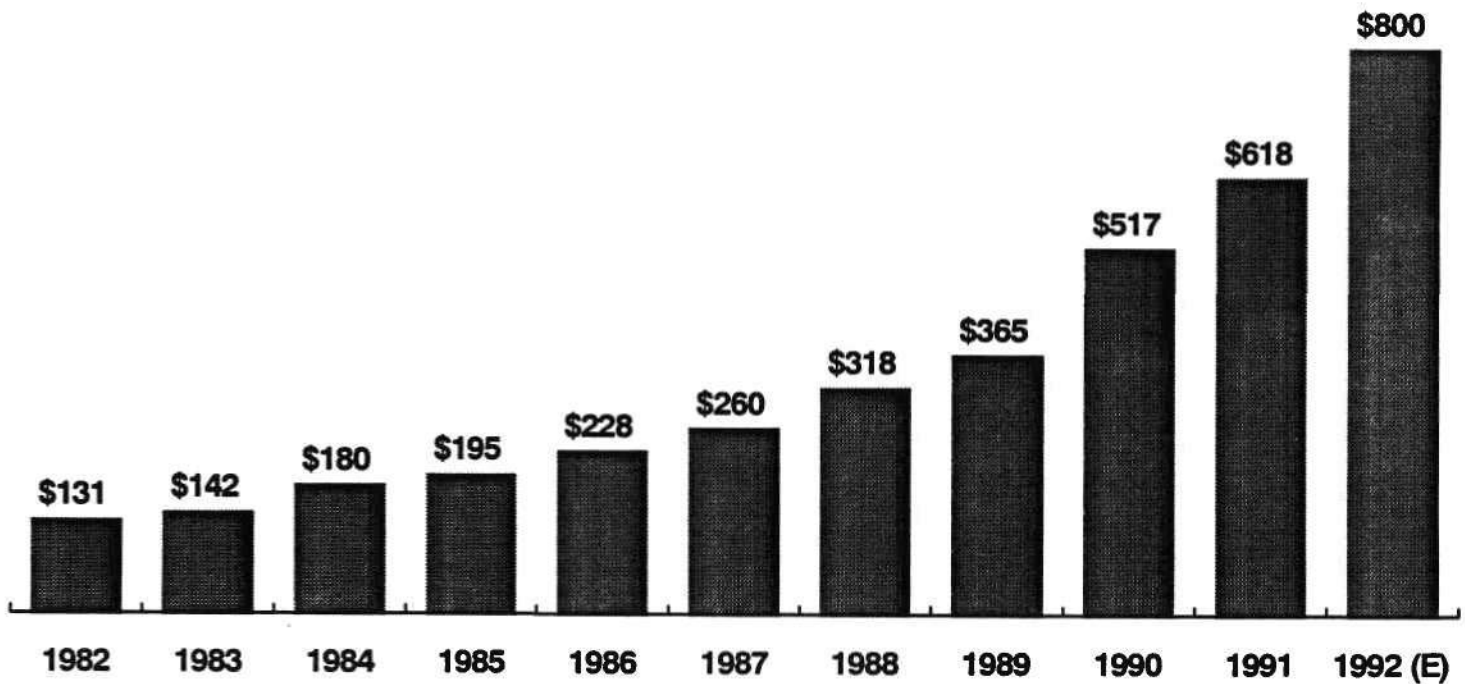
## Capital Investment

(Dollars in Millions)



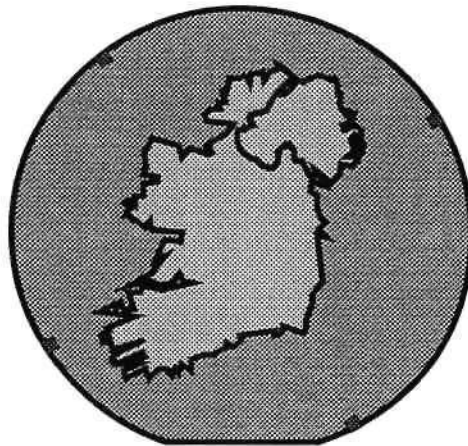
# Research and Development

(Dollars in Millions)



## Summary

- Intel Is Committed To Manufacturing In Europe
- Intel Is Committed To Moving The Market To The Second Wave



## HOW TO SAFEGUARD EUROPE'S HIGH-TECHNOLOGY FUTURE

***Heinz W. Hagmeister***  
Chairman and CEO  
Philips Semiconductors International BV

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## HOW TO SAFEGUARD EUROPE'S HIGH-TECHNOLOGY FUTURE



Heinz W. Hagmeister  
Chairman and CEO  
Philips Semiconductors International BV

Mr. Hagmeister is Senior Managing Director, Chairman and CEO of Philips Semiconductors Product division. His experience prior to this was gained in a range of engineering and management positions for Philips in Germany and the Netherlands in the field of integrated circuits and discrete semiconductors. Mr. Hagmeister holds an engineering degree in Electronics from Technical University in Aachen, Germany.

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**EUROPEAN SEMICONDUCTOR INDUSTRY CONFERENCE**  
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Dataquest Conference, Dublin, June 1992.

**How to safeguard Europe's High-Tech future**

**H.W. Hagmeister**

**Philips Semiconductors**

In the first part of his presentation Mr. Hagmeister will point out the importance of the European electronics industry and its position compared to other regions.

Subjects addressed are: IC consumption related to GNP, the electronics trade balance, major semiconductor application markets as well as the costs associated with participation in these markets. Among the "challenges of the 90's" are horizontal and vertical partnerships.

In the second part a number of actions will be indicated, considered necessary to safeguard the European participation in current and future electronics markets.

-----

# **How to safeguard Europe's High-Tech future**

**H.W. Hagmeister**

**Dataquest conference 1992**

Philips Semiconductors



**PHILIPS**

C 92052603-01

## *Three level scenario*

Economics

Electronics

Semiconductors

Philips Semiconductors

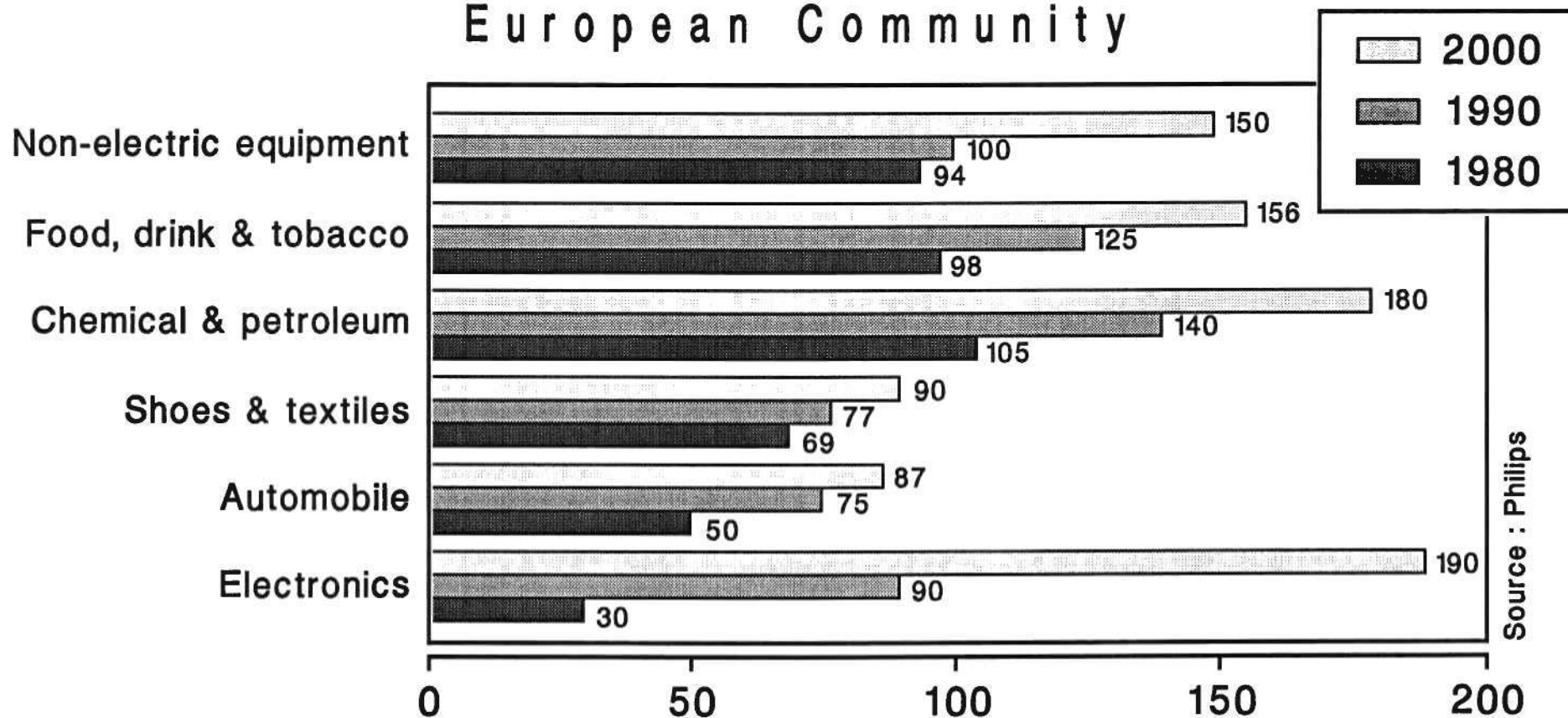


**PHILIPS**

C 92052603-03

## *Comparison of electronics (B. \$)*

With other manufacturing industries in  
European Community



Philips Semiconductors

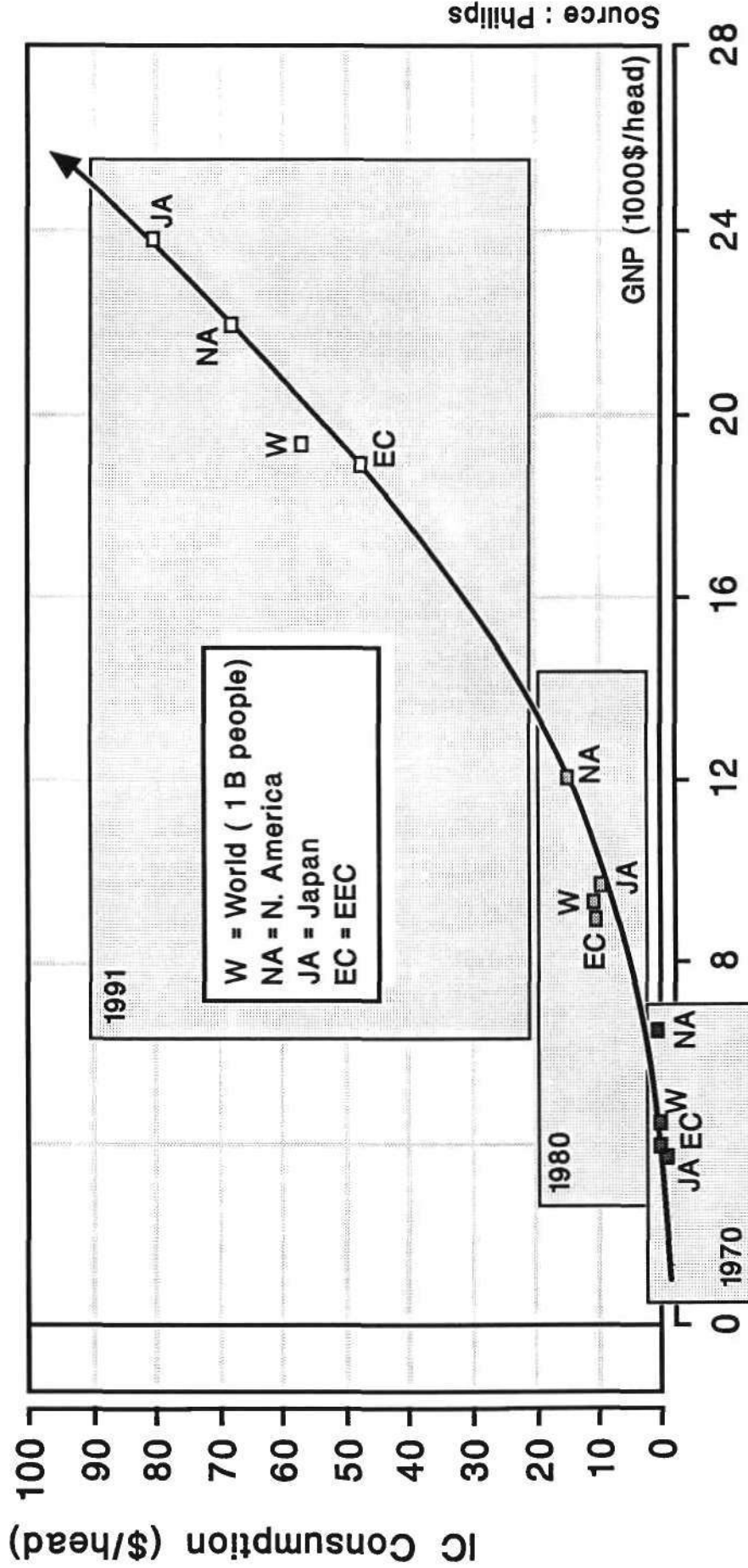


**PHILIPS**

C 92052603-02

# IC Consumption related to GNP / Capita

1970 - 1980 - 1991



Source : Philips

Philips Semiconductors



**PHILIPS**

C 92052603-04

## ***Electronics : a base industry for Europe***

- **The electronics industry is know-how intensive and fits European demography**
- **The electronics industry is the cornerstone of an industrial society**
- **It represents a considerable part of Europe's future wellbeing**
- **It guarantees future economic and political sovereignty**

Philips Semiconductors

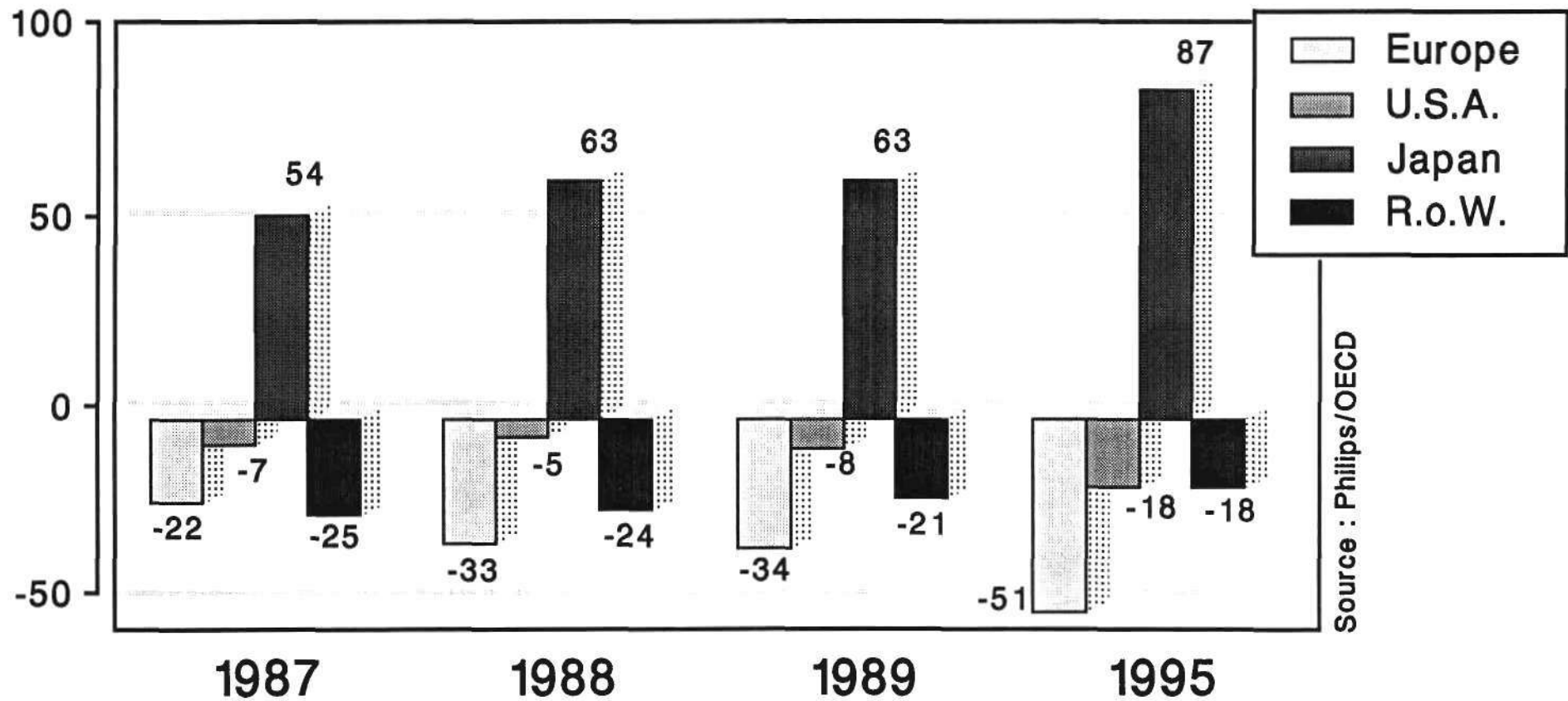


**PHILIPS**

C 92052603-06

# Tradebalance Electronics Industry

Surplus/deficit in B.\$



Philips Semiconductors



**PHILIPS**

C 92052603-07



## *Three level scenario*

Economics

Electronics

Semiconductors

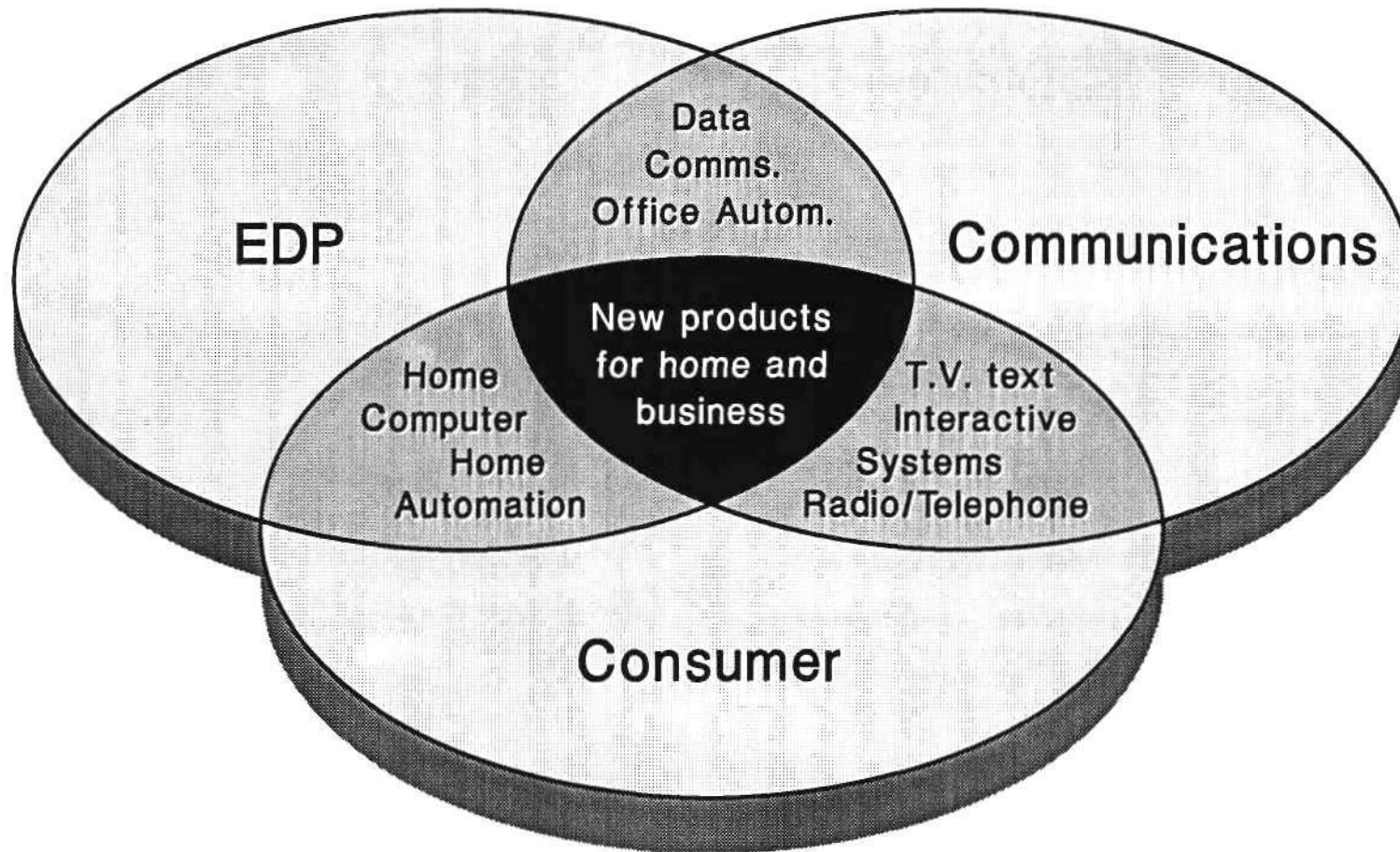
Philips Semiconductors



**PHILIPS**

C 92052603-05

## *Market Evolution of the 90's*



Philips Semiconductors



**PHILIPS**

C 92052603-08

## *Challenges of the 90's (1)*

- High Performance TV
- Telecommunication
- EDP-Multimedia
- Automotive

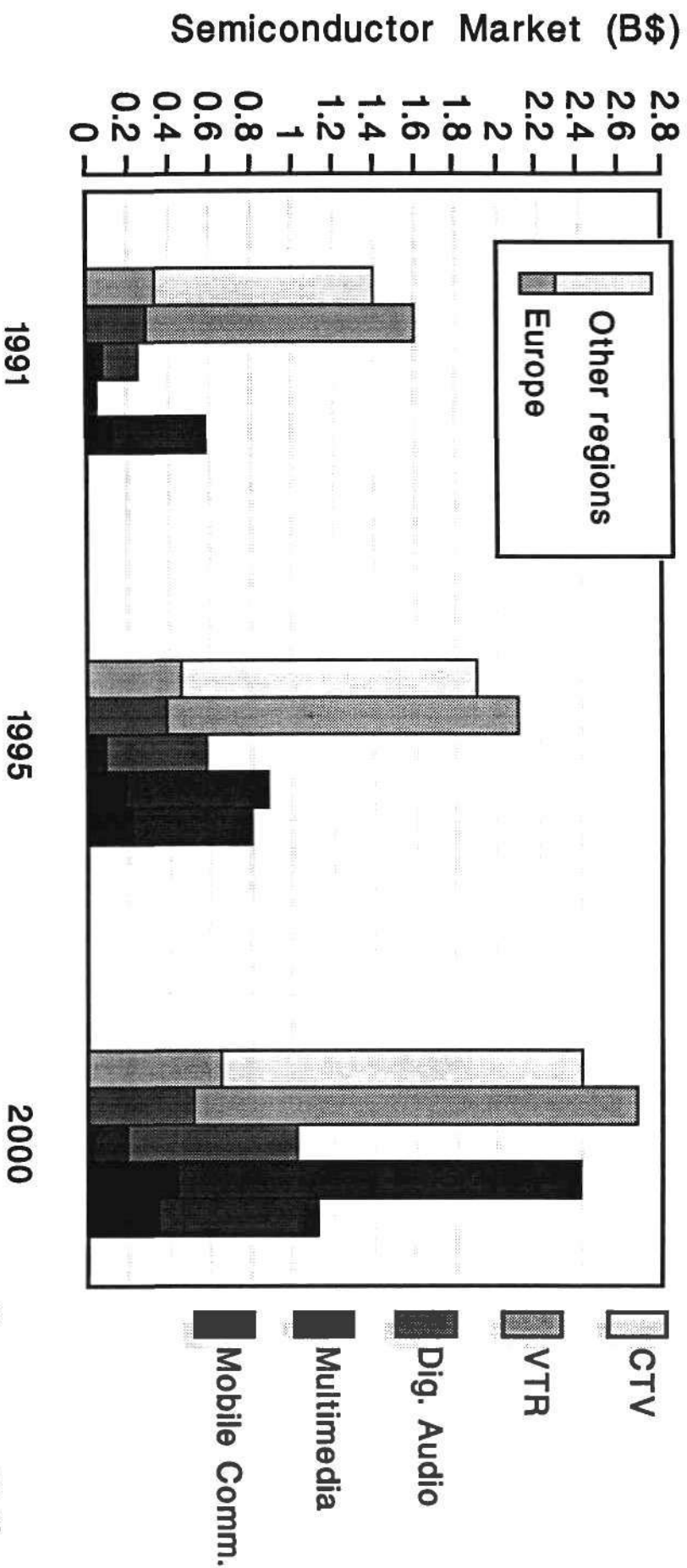
Philips Semiconductors



**PHILIPS**

C 92052603-09

# *Semiconductor Markets* **Selected Major Applications / Europe vs World**



Source : Philips

Philips Semiconductors



**PHILIPS**

C 92052603-11

## *Three level scenario*

Economics

Electronics

Semiconductors

Philips Semiconductors



**PHILIPS**

C 92052603-10

## *Products and processes*

- Linear, logic, memory, micro controllers
- Analog and digital technologies
- Bipolar, CMOS, BiCMOS technology
- Manufacturing equipment
- Miniaturisation of packages



## *Capabilities & tools*

- Design tools / design libraries
- Quality management (ISO 9000, TQE)
- User friendly software
- JIT / STS capability
- Global marketing & sales



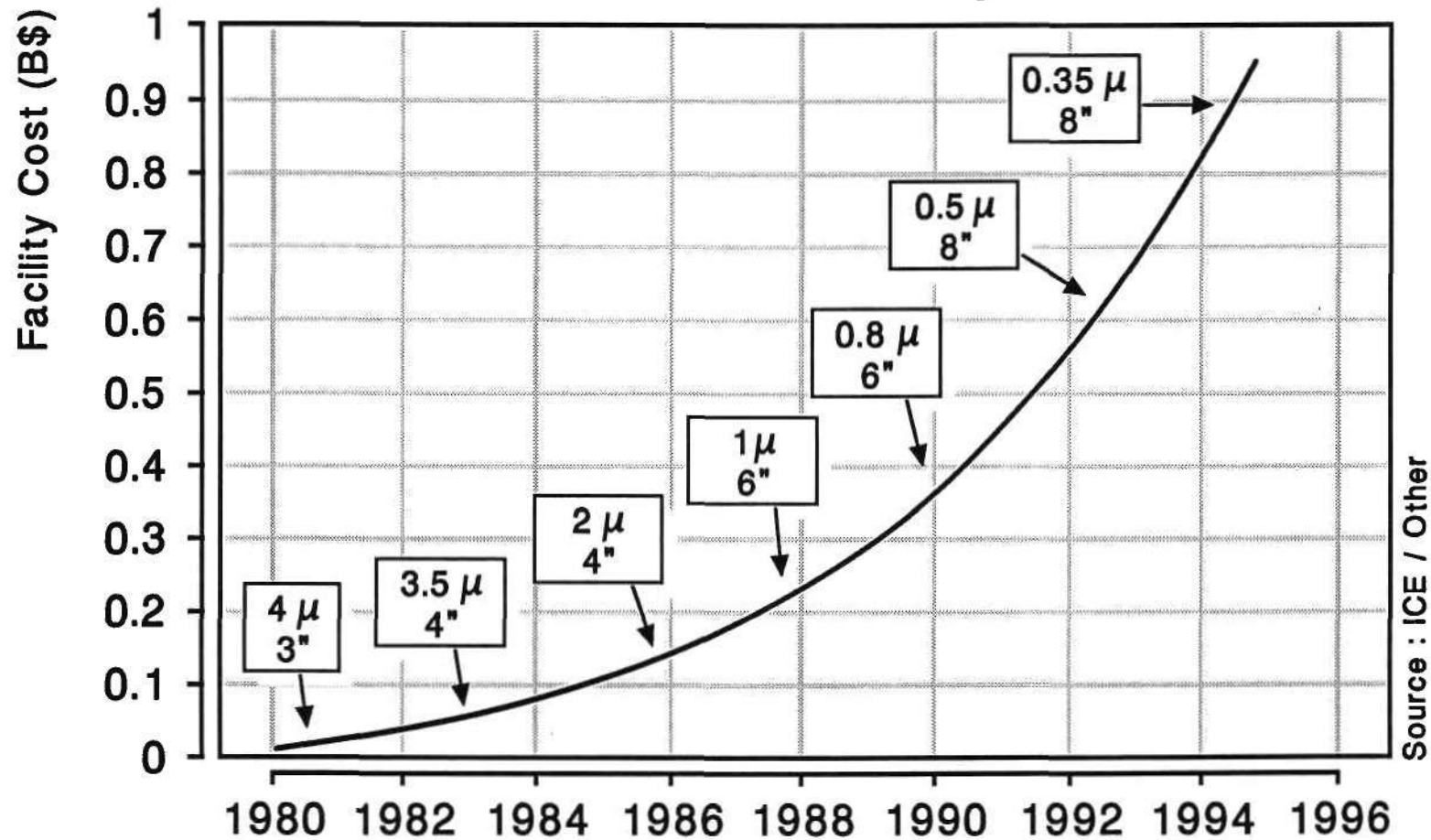
## *Challenges of the 90's (2)*

- Partnering
- Manufacturing excellence
- Process technology





## Fab Cost Development



Philips Semiconductors



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## *Three level scenario*

Economics

Electronics

Semiconductors

Philips Semiconductors



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## ***Actions on Semiconductor industry level***

- **Relations with Semiconductor equipment and materials suppliers**
- **Manufacturing Excellence**
- **Improve competitiveness of setmakers**
- **Joint process development**
- **Share CAD tools and libraries**
- **Create selective European centres of competence**



## *Three level scenario*

Economics

Electronics

Semiconductors

Philips Semiconductors



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## *Actions on electronics industry level*

- **Create common standards**
- **Create European centres of competence**
- **Develop user friendliness and software competence**
- **Form vertical, risk sharing partnerships**

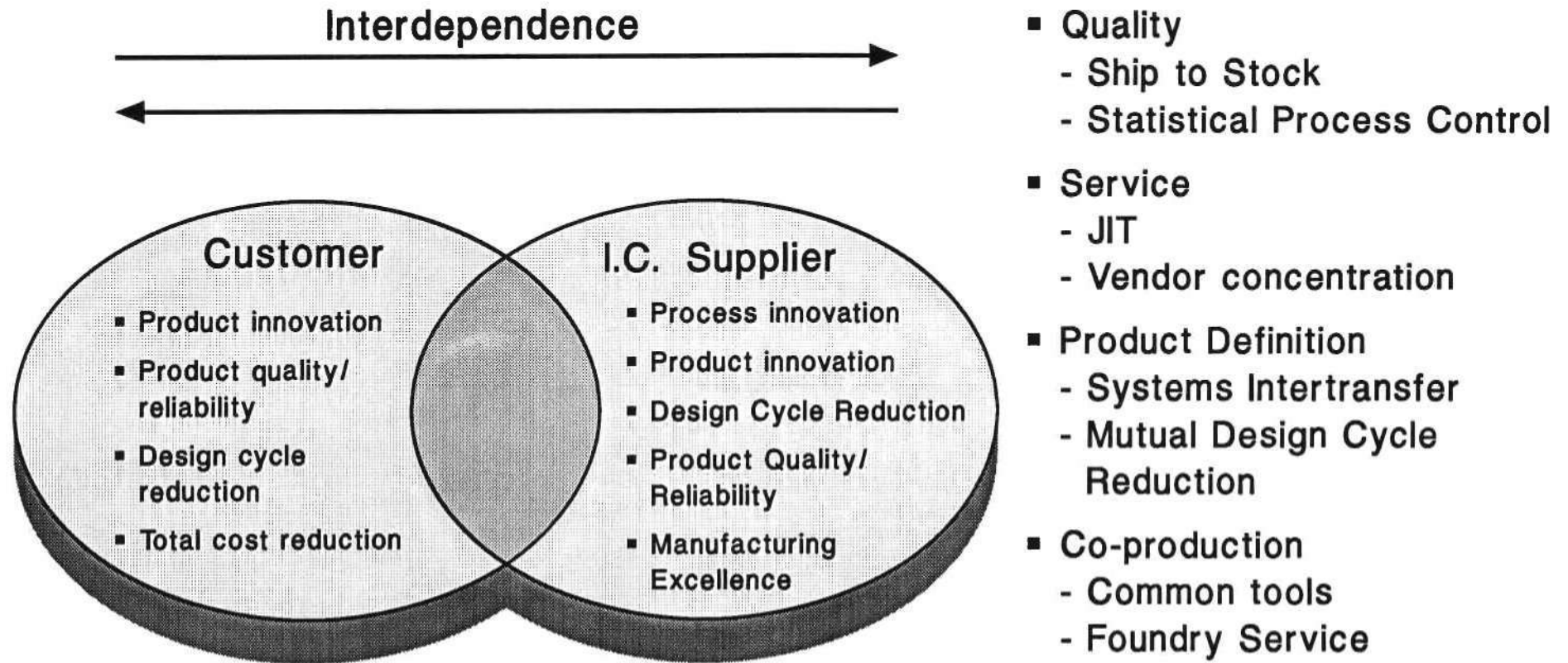
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# *Partnering in the 90's*



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## *Three level scenario*

**Economics**

Electronics

Semiconductors

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## *Economic platform*

### **Active, fast and focussed support policy**

- **Push policy (R&D programmes)**
- **Pull policy (Trans-European infrastructural networks)**
- **Standardisation (economy of scale)**
- **Skills and education**
- **Open trade / anti-dumping policy**
- **Sustainable co-existence with Japan**





## ***Awareness of national and European authorities***

### **Electronics :**

- **Strongest driving force of economy**
- **Prime weapon for competitiveness**
- **Key for sovereignty of Europe**

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## *Europe - USA - Japan*

- Co-operation, not confrontation
- Interdependence, not dependence
- Free trade on a fair basis

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